

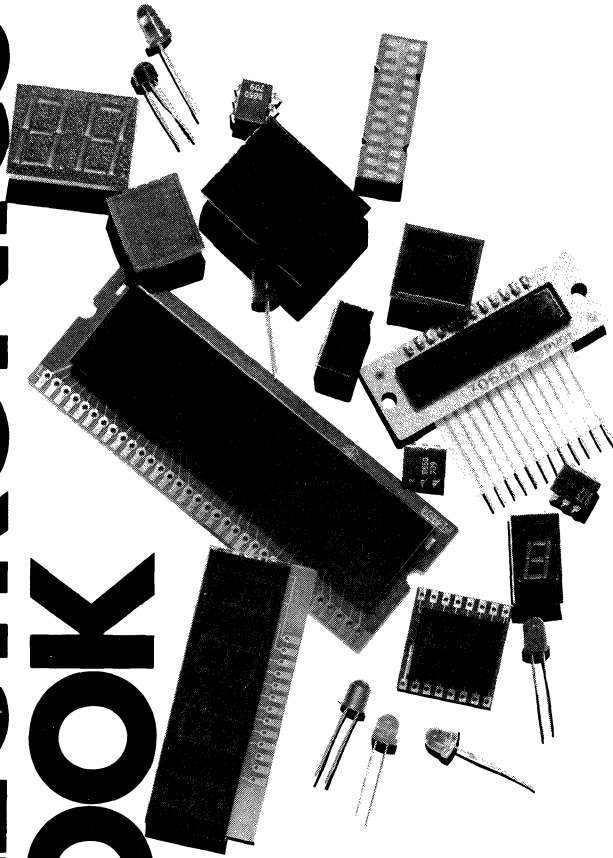
OPTOELECTRONICS DATA BOOK



\$3.00

FAIRCHILD

OPTOELECTRONICS DATA BOOK



FAIRCHILD

464 Ellis Street, Mountain View, California 94042

OPTOELECTRONICS DATA BOOK INTRODUCTION

Fairchild Camera & Instrument Corporation is one of the world's largest semiconductor device producers, and is a recognized leader in semiconductor technology. As part of this organization, which has pioneered the development of many products that have become industry standards, the Optoelectronics Division benefits from broad capabilities in device design and manufacture. These benefits are passed on to you, the customer, in the form of advanced design, excellence of performance, continuity of supply, and cost-effectiveness.

As the customer, you and your needs have dictated the form and content of this Optoelectronic Data Book. This book has been sectioned for your convenience and organized as follows:

SELECTION GUIDES

Quick reference guides and short form data for designers seeking devices to meet their needs. These selection guides are arranged by product to make the location of information easy. They also contain basic parameter information for each device and indicate the page number of the complete data sheet.

CHAPTERS 1 AND 2

Basic technical information concerning the structure and manufacture of optoelectronic devices, soldering and cleaning considerations for those devices, and the reliability of LED digits.

PRODUCT INFORMATION

Optoelectronic devices arranged in chapters by product type. Each chapter contains a short introduction to, and cross-reference index for, devices within a particular device category, and complete data sheets for individual devices.

The wide range of Fairchild-developed optoelectronic products, along with a deliberate program to second-source many popular configurations produced by other optoelectronic suppliers, affords Fairchild one of the broadest LED lamp, digit, display, and coupler product lines of any supplier. Products manufactured by Fairchild include direct-drive watch, clock, and multimeter displays, and multiplexed calculator, 16-segment alphanumeric, and dot-matrix displays.

Most of the products in this Data Book are multiple-sourced industry-standard devices with availability assured for years to come.

Not included in this book are Fairchild's liquid crystal display (LCD) devices. Information on these is currently available in the optoelectronics short-form catalog, and a Data Book covering only LCDs is soon to be issued.

STANDARD DEFINITIONS OF SYMBOLS AND TERMS USED IN SPECIFYING OPTOELECTRONIC DEVICES

ADDRESSES OF FAIRCHILD SALES OFFICES, REPRESENTATIVES, AND DISTRIBUTORS

As well as supplying a full line of standard devices, Fairchild has the capability of supplying custom devices tailored to your application. A complete service organization is available to assist you: a sales force consisting of sales engineers, representatives, and distributors; field application engineers to help you with circuit design or device application; and customer service coordinators to expedite your order. Our goal is to give you reliable, cost-effective optoelectronic devices, timely delivery, and excellent service while maintaining our position on the leading edge of this field of expanding technology.

TABLE OF CONTENTS

NUMERICAL INDEX OF DEVICES	iv	
SELECTION GUIDES	XI	
CHAPTER 1 OPTOELECTRONIC TECHNOLOGY		
Architecture	1-3	
Crystal Growth	1-3	
Processing	1-4	
Epitaxy	1-4	
Wafer Fabrication	1-5	
Encapsulation Materials	1-5	
Soldering Methods	1-8	
Cleaning	1-8	
CHAPTER 2 DISCRETE LED DIGIT RELIABILITY		
Design Considerations	2-2	
Device Testing	2-2	
Reliability Monitor and Control	2-4	
Failure Modes	2-5	
Comprehensive Testing	2-5	
CHAPTER 3 VISIBLE LED LAMPS AND MOUNTING HARDWARE		
Introduction	3-3	
Cross-Reference	3-5	
Data Sheets	3-14	
CHAPTER 4 SEVEN-SEGMENT DISPLAYS AND DISPLAY ARRAYS		
Introduction	4-2	
Cross-Reference	4-4	
Data Sheets	4-9	
CHAPTER 5 PHOTOTRANSISTORS, INFRARED EMITTERS, AND SENSORS		
Introduction	5-2	
Data Sheets	5-3	
CHAPTER 6 PHOTOCOUPERS		
Introduction	6-2	
Cross-Reference Index	6-3	
Data Sheets	6-8	
CHAPTER 7 PACKAGE OUTLINES		7-3
Packages Connection Diagrams	7-20	
CHAPTER 8 DEFINITIONS OF SYMBOLS AND TERMS		8-3
CHAPTER 9 FAIRCHILD FIELD SALES OFFICES, SALES REPRESENTATIVES AND DISTRIBUTOR LOCATIONS		9-3

NUMERICAL INDEX OF DEVICES

Device	Type	Opto Package	Connection Diagram	Data Sheet Page No.
FCD810	Coupler Tx Output	Opto-37	024	6-8
FCD810C	"	Opto-37	024	6-8
FCD820	"	Opto-37	024	6-10
FCD820C	"	Opto-37	024	6-10
FCD825	"	Opto-37	024	6-12
FCD825C	"	Opto-37	024	6-12
FCD830	"	Opto-37	024	6-14
FCD830C	"	Opto-37	024	6-14
FCD831	"	Opto-37	024	6-16
FCD831C	"	Opto-37	024	6-16
FCD836	"	Opto-37	024	6-18
FCD836C	"	Opto-37	024	6-18
FCD850	Coupler, Darl. Output	Opto-37	024	6-20
FCD850C	"	Opto-37	024	6-20
FCD855	"	Opto-37	024	6-20
FCD855C	"	Opto-37	024	6-20
FCD860	"	Opto-37	024	6-22
FCD860C	"	Opto-37	024	6-22
FCD865	"	Opto-37	024	6-22
FCD865C	"	Opto-37	024	6-22
FCD880	Coupler Dual Tx Output	Opto-45	025	6-24
FCD885	"	Opto-45	025	6-24
FCS6400	LED Display	Opto-24	017	4-9
FCS6401	"	Opto-25	018	4-9
FCS8000	"	Opto-17	017	4-11
FCS8024	"	Opto-18	012	4-11
FLS010	Lamp Mounting Hardware	Opto-1		3-51
FLS011	"	Opto-2		3-52
FLS012	"	Opto-2		3-52
FLV104A	LED Lamp	Opto-8		3-14
FLV110	"	Opto-5		3-17
FLV111	"	Opto-5		3-19
FLV112	"	Opto-5		3-19
FLV117	"	Opto-5		3-19
FLV118	"	Opto-5		3-19
FLV140	"	Opto-4		3-17
FLV141	"	Opto-4		3-21
FLV150	"	Opto-4		3-17
FLV151	"	Opto-4		3-21
FLV160	"	Opto-7		3-17
FLV161	"	Opto-7		3-21
FLV251	"	Opto-4		3-23
FLV252	"	Opto-4		3-23
FLV310	"	Opto-5		3-25
FLV311	"	Opto-5		3-27
FLV340	"	Opto-4		3-25
FLV341	"	Opto-4		3-27
FLV350	"	Opto-6		3-25
FLV351	"	Opto-6		3-27
FLV360	"	Opto-7		3-25

NUMERICAL INDEX OF DEVICES (Cont'd)

Device	Type	Opto Package	Connection Diagram	Data Sheet Page No.
FLV361	LED Lamp	Opto-7		3-27
FLV410	"	Opto-5		3-29
FLV411	"	Opto-5		3-31
FLV440	"	Opto-4		3-29
FLV441	"	Opto-4		3-31
FLV450	"	Opto-6		3-29
FLV451	"	Opto-6		3-31
FLV460	"	Opto-7		3-29
FLV461	"	Opto-7		3-31
FLV510	"	Opto-5		3-33
FLV540	"	Opto-4		3-33
FLV550	"	Opto-6		3-33
FLV560	"	Opto-7		3-33
FNA6	LED Display	Optp-43		4-14
FNA12	"	Opto-44		4-16
FNA5420	"	Opto-20	013	4-18
FNA5421	"	Opto-21	014	4-18
FNA5520	"	Opto-22	015	4-18
FNA5521	"	Opto-23	016	4-18
FND350	"	Opto-12		4-20
FND357	"	Opto-12		4-20
FND358	"	Opto-12		4-24
FND360	"	Opto-12		4-20
FND367	"	Opto-12		4-20
FND368	"	Opto-12		4-24
FND500	"	Opto-13		4-26
FND501	"	Opto-13		4-30
FND507	"	Opto-13		4-26
FND508	"	Opto-13		4-30
FND530	"	Opto-13		4-33
FND531	"	Opto-13		4-35
FND537	"	Opto-13		4-33
FND538	"	Opto-13		4-35
FND540	"	Opt-13		4-33
FND541	"	Opto-13		4-35
FND547	"	Opto-13		4-33
FND548	"	Opto-13		4-35
FND550	"	Opto-13		4-33
FND551	"	Opto-13		4-35
FND557	"	Opto-13		4-33
FND558	"	Opto-13		4-35
FND560	"	Opto-13		4-26
FND561	"	Opto-13		4-30
FND567	"	Opto-13		4-26
FND568	"	Opto-13		4-30
FND800	"	Opto-14		4-37
FND800A	"	Opto-14		4-39
FND801A	"	Opto-14		4-42
FND807	"	Opto-14		4-37
FND807A	"	Opto-14		4-39

NUMERICAL INDEX OF DEVICES (Cont'd)

Device	Type	Opto Package	Connection Diagram	Data Sheet Page No.
FND808A	LED Display	Opto-14		4-42
FND846A	"	Opto-14		4-42
FND847	"	Opto-14		4-44
FND847A	"	Opto-14		4-46
FND849A	"	Opto-14		4-42
FND850	"	Opto-14		4-44
FND850A	"	Opto-14		4-46
FND6710	"	Opto-16		4-48
FND6740	"	Opto-16		4-48
FPA100	Reflective Sensor	Opto-32 (2 pcs.)		5-3
FPA101	"	Opto-34 (2 pcs.)		5-3
FPA102	"	Opto-35 (2 pcs.)		5-3
FPA103	Source Sensor Array	Opto-36		5-7
FPA103A	"	Opto-36		5-9
FPA104	"	Opto-36		5-7
FPA104A	"	Opto-36		5-9
FPA105	"	Opto-36		5-7
FPA105A	"	Opto-36		5-9
FPA106	"	Opto-36		5-7
FPA106A	"	Opto-36		5-9
FPA107	"	Opto-36		5-7
FPA107A	"	Opto-36		5-9
FPA108	"	Opto-36		5-7
FPA108A	"	Opto-36		5-9
FPA700	Sensor Array	Opto-33		5-11
FPA700A	"	Opto-33		5-11
FPA710	"	Opto-34		5-14
FPA710A	"	Opto-34		5-14
FPA720	"	Opto-35		5-17
FPA720A	"	Opto-35		5-17
FPE100	Infrared Emitters	Opto-32		5-20
FPE106	"	Opto-31		5-23
FPE500	"	Opto-29		5-25
FPE510	"	Opto-30		5-25
FPE520	"	Opto-29		5-27
FPE530	"	Opto-30		5-27
FPT100	Photo Transistor	Opto-26		5-29
FPT100A	"	Opto-26		5-29
FPT100B	"	Opto-26		5-29
FPT101	"	Opto-27		5-31
FPT102	"	Opto-27		5-35
FPT110	"	Opto-28		5-29
FPT110A	"	Opto-28		5-29
FPT110B	"	Opto-28		5-29
FPT120	"	Opto-26		5-37
FPT130	"	Opto-28		5-37
FPT131	"	Opto-26		5-40
FPT132	"	Opto-26		5-43
FPT136	"	Opto-28		5-40
FPT137	"	Opto-28		5-43

NUMERICAL INDEX OF DEVICES (Cont'd)

Device	Type	Opto Package	Connection Diagram	Data Sheet Page No.
FPT220	Photo Transistor	Opto-26		5-37
FPT230	"	Opto-28		5-37
FPT320	"	Opto-26		5-37
FPT330	"	Opto-28		5-37
FPT400	"	Opto-26		5-45
FPT410	"	Opto-28		5-45
FPT500	"	Opto-29		5-46
FPT500A	"	Opto-29		5-46
FPT510	"	Opto-30		5-48
FPT510A	"	Opto-30		5-48
FPT520	"	Opto-29		5-46
FPT520A	"	Opto-29		5-46
FPT530	"	Opto-30		5-48
FPT530A	"	Opto-30		5-48
FPT540	"	Opto-29		5-46
FPT540A	"	Opto-29		5-46
FPT550	"	Opto-30		5-48
FPT550A	"	Opto-30		5-48
FPT560	"	Opto-29		5-50
FPT570	"	Opto-30		5-50
FPT610	"	Opto-31		5-51
FPT630	"	Opto-31		5-51
H11A1	Coupler Tx Output	Opto-37	024	6-26
H11A2	"	Opto-37	024	6-26
H11A3	"	Opto-37	024	6-26
H11A4	"	Opto-37	024	6-26
H11B1	Coupler Darl. Output	Opto-37	024	6-28
H11B2	"	Opto-37	024	6-28
IL1	Coupler Tx Output	Opto-37	024	6-30
IL12	"	Opto-37	024	6-30
IL15	"	Opto-37	024	6-30
IL16	"	Opto-37	024	6-30
IL74	"	Opto-37	024	6-30
MAN71A	LED Display	Opto-15	07	4-50
MAN72A	"	Opto-15	07	4-50
MAN74A	"	Opto-15	09	4-52
MCA230	Coupler Darl. Output	Opto-37	024	6-32
MCA231	"	Opto-37	024	6-32
MCA255	"	Opto-37	024	6-32
MCT2	Coupler Tx Output	Opto-37	024	6-34
MCT2E	"	Opto-37	024	6-34
MCT26	"	Opto-37	024	6-34
MOC1000	"	Opto-37	024	6-36
MOC1001	"	Opto-37	024	6-36
MOC1002	"	Opto-37	024	6-36
MOC1003	"	Opto-37	024	6-36
MV5050	LED Lamp	Opto-9		3-35
MV5051	"	Opto-9		3-35
MV5052	"	Opto-9		3-35
MV5053	"	Opto-9		3-35

NUMERICAL INDEX OF DEVICES (Cont'd)

Device	Type	Opto Package	Connection Diagram	Data Sheet Page No.
MV5054-1	LED Lamp	Opto-10		3-37
MV5054-2	"	Opto-10		3-37
MV5054-3	"	Opto-10		3-37
MV5054-4	"	Opto-10		3-37
MV5055	"	Opto-10		3-39
MV5056	"	Opto-10		3-39
MV5152	"	Opto-10		3-47
MV5153	"	Opto-9		3-41
MV5154	"	Opto-10		3-41
MV5252	"	Opto-10		3-43
MV5253	"	Opto-9		3-43
MV5254	"	Opto-10		3-43
MV5352	"	Opto-10		3-45
MV5353	"	Opto-9		3-45
MV5354	"	Opto-10		3-45
MV5752	"	Opto-10		3-47
MV5753	"	Opto-9		3-47
MV5754	"	Opto-10		3-47
TIL111	Coupler Tx Output	Opto-37	024	6-38
TIL112	"	Opto-37	024	6-40
TIL113	Coupler Darl. Output	Opto-37	024	6-42
TIL114	Coupler Tx Output	Opto-37	024	6-38
TIL115	"	Opto-37	024	6-40
TIL116	"	Opto-37	024	6-38
TIL117	"	Opto-37	024	6-38
TIL118	"	Opto-37	024	6-40
TIL119	Coupler Darl. Output	Opto-37	024	6-42
TIL209A	LED Lamp	Opto-11		3-49
TIL211	"	Opto-11		3-49
TIL213	"	Opto-11		3-49
4N25	Coupler Tx Output	Opto-37	024	6-44
4N26	"	Opto-37	024	6-44
4N27	"	Opto-37	024	6-44
4N28	"	Opto-37	024	6-44
4N29	Coupler Darl. Output	Opto-37	024	6-46
4N30	"	Opto-37	024	6-46
4N31	"	Opto-37	024	6-46
4N32	"	Opto-37	024	6-46
4N33	"	Opto-37	024	6-46
4N35	Coupler Tx Output	Opto-37	024	6-48
4N36	"	Opto-37	024	6-48
4N37	"	Opto-37	024	6-48

OPTO SELECTION GUIDE

FAIRCHILD OPTOELECTRONICS

OPTO

LED VISIBLE LAMPS

Item	DEVICE NO.	Lens Characteristic	I _F mA Typ	Luminous Intensity I _F = 20mA mcd Typ	V _F I _F = 20mA V Typ	Package No.
1	FLV104A	Clear	100	(4.0mW/sr)	2.0	Opto-8
2	FLV110	Red Diffused	20	2.0	1.7	Opto-5
3	FLV111	Clear Point Source	20	2.0	1.7	Opto-5
4	FLV112	Clear Diffused	20	2.0	1.7	Opto-5
5	FLV117	Red Diffused	50	1.0	1.9	Opto-5
6	FLV140	Red Diffused	20	2.0	1.7	Opto-4
7	FLV141	Red Point Source	20	2.0	1.7	Opto-4
8	FLV150	Red Diffused	20	2.0	1.7	Opto-4
9	FLV151	Red Point Source	20	2.0	1.7	Opto-4
10	FLV152	Red Point Source	20	3.0	1.7	Opto-4
11	FLV160	Red Diffused	20	2.0	1.7	Opto-7
12	FLV161	Red Point Source	20	2.0	1.7	Opto-7
13	FLV251	Red Point Source	10	5.0	2.1	Opto-4
14	FLV252	Red Point Source	10	8.0	2.1	Opto-4
15	FLV310	Green Diffused	20	3.2	2.3	Opto-5
16	FLV311	Green Point Source	20	3.2	2.3	Opto-5
17	FLV315	Green Diffused	20	2.5	3.0	Opto-5
18	FLV340	Green Diffused	20	3.2	2.3	Opto-4
19	FLV341	Green Point Source	20	3.2	2.3	Opto-4
20	FLV350	Green Diffused	20	3.2	2.3	Opto-6
21	FLV351	Green Point Source	20	3.2	2.3	Opto-6
22	FLV355	Green Diffused	20	2.5	3.0	Opto-6
23	FLV360	Green Diffused	20	3.2	2.3	Opto-7
24	FLV361	Green Point Source	20	3.2	2.3	Opto-7
25	FLV365	Green Diffused	20	2.5	3.0	Opto-7
26	FLV410	Yellow Diffused	20	3.2	2.3	Opto-5
27	FLV411	Yellow Point Source	20	3.2	2.3	Opto-5
28	FLV440	Yellow Diffused	20	3.2	2.3	Opto-4
29	FLV441	Yellow Point Source	20	3.2	2.3	Opto-4

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OPTO

LED VISIBLE LAMPS (Cont'd)

Item	DEVICE NO.	Lens Characteristic	I _F mA Typ	Luminous Intensity I _F = 20mA mcd Typ	V _F V Typ	Package No.
1	FLV450	Yellow Diffused	20	3.2	2.3	Opto-6
2	FLV451	Yellow Point Source	20	3.2	2.3	Opto-6
3	FLV460	Yellow Diffused	20	3.2	2.3	Opto-7
4	FLV461	Yellow Point Source	20	3.2	2.3	Opto-7
5	FLV510	Red Diffused	10	3.0	1.9	Opto-5
6	FLV511	Red Point Source	10	3.0	1.9	Opto-5
7	FLV540	Red Diffused	10	3.0	1.9	Opto-4
8	FLV541	Red Point Source	10	3.0	1.9	Opto-4
9	FLV550	Red Diffused	10	3.0	1.9	Opto-6
10	FLV551	Red Point Source	10	3.0	1.9	Opto-6
11	FLV560	Red Diffused	10	3.0	1.9	Opto-7
12	FLV561	Red Point Source	10	3.0	1.9	Opto-7
13	MV5050	Clear Point Source	20	2.0	1.7	Opto-9
14	MV5051	Clear Diffused	20	1.6	1.7	Opto-9
15	MV5052	Red Point Source	20	2.0	1.7	Opto-9
16	MV5053	Red Diffused	20	1.6	1.7	Opto-9
17	MV5054-1	Red Semi-Diffused	20	2.0	1.7	Opto-10
18	MV5054-2	Red Semi-Diffused	20	3.0	1.7	Opto-10
19	MV5054-3	Red Semi-Diffused	20	4.0	1.7	Opto-10
20	MV5152	Amber Point Source	20	16.0	1.9	Opto-10
21	MV5153	Amber Diffused	20	4.0	1.9	Opto-9
22	MV5154	Amber Semi-Diffused	20	8.0	1.9	Opto-10
23	MV5252	Green Point Source	20	6.0	2.3	Opto-10
24	MV5253	Green Diffused	20	1.5	2.3	Opto-9
25	MV5254	Green Semi-Diffused	20	3.0	2.3	Opto-10
26	MV5352	Yellow Point Source	20	10.0	2.3	Opto-10
27	MV5353	Yellow Diffused	20	6.0	2.3	Opto-9
28	MV5354	Yellow Semi-Diffused	20	10.0	2.3	Opto-10
29	MV5752	Red Point Source	20	16.0	1.9	Opto-10
30	MV5753	Red Diffused	20	4.0	1.9	Opto-9

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OPTO

LED VISIBLE LAMPS (Cont'd)

Item	DEVICE NO.	Lens Characteristic	I _F mA Typ	Luminous Intensity I _F = 20mA mcd Typ	V _F V Typ	Package No.
1	MV5754	Red Semi-Diffused	20	8.0	1.9	Opto-10
2	TIL209A	Red Diffused T-1	20	2.0	1.7	Opto-11
3	TIL211	Green Diffused T-1	20	0.5	1.7	Opto-11
4	TIL213	Yellow Diffused T-1	20	0.5	1.7	Opto-11

LED LAMP MOUNTING HARDWARE

Item	DEVICE NO.	Panel Thickness	Panel Hole	Description	Package No.
5	FLS010	.060 to .250	.265 ±.002	Single-Part Construction (Flat Black Finish)	Opto-1
6	FLS011	0.187	.250 ±.003	3-Piece Construction: Hex Nut, Threaded Barrel and Bezel (Bezel in Silver Finish)	Opto-2
7	FLS012	0.187	.250 ±.003	3-Piece Construction: Hex Nut, Threaded Barrel and Bezel (Bezel in Black Finish)	Opto-2
8	MP52	0.125	.250 ±.003	Mounting Clip for MV Series Lamps	Opto-3

7-SEGMENT NUMERIC DISPLAYS

Item	DEVICE NO.	Character Height Inches	Polarity	Color	Description	Decimal Point	Peak Current/Seg Pulse = 100 μ s mA	V _F I _F = 20mA/Seg V	Luminous Intensity/Seg I _F = 20mA μ cd	Logic/Connection Diagram	Package No.
9	FND350	0.362	CA	Red	7-Segment Display	RH	200	1.7	450	O1	Opto-12
10	FND351	0.362	CA	Red	Overflow \pm 1 Digit	RH	200	1.7	450	O2	Opto-12
11	FND357	0.362	CC	Red	7-Segment Display	RH	200	1.7	450	O1	Opto-12
12	FND358	0.362	CC	Red	Overflow \pm 1 Digit	RH	200	1.7	450	O2	Opto-12
13	FND360	0.362	CA	Red	7-Segment Display	RH	200	1.7	900	O1	Opto-12
14	FND361	0.362	CA	Red	Overflow \pm Digit	RH	200	1.7	900	O2	Opto-12
15	FND367	0.362	CC	Red	7-Segment Display	RH	200	1.7	900	O1	Opto-12
16	FND368	0.362	CC	Red	Overflow \pm 1 Digit	RH	200	1.7	900	O2	Opto-12
17	FND500	0.500	CC	Red	7-Segment Display	RH	200	1.7	600	O3	Opto-13
18	FND501	0.500	CC	Red	Overflow \pm 1 Digit	RH	200	1.7	600	O4	Opto-13
19	FND507	0.500	CA	Red	7-Segment Display	RH	200	1.7	600	O3	Opto-13
20	FND508	0.500	CA	Red	Overflow \pm 1 Digit	RH	200	1.7	600	O4	Opto-13

FAIRCHILD OPTOELECTRONICS

OPTO

7-SEGMENT NUMERIC DISPLAYS (Cont'd)

Item	DEVICE NO.	Character Height Inches	Polarity	Color	Description	Decimal Point	Peak Current/Seg Pulse = 100 μ s mA	V _F = 20mA/Seg V	Luminous Intensity/Seg I _F = 20mA μ cd	Logic/Connection Diagram	Package No.
1	FND530	0.500	CC	Grn	7-Segment Display	RH	80	2.2	2000	O3	Opto-13
2	FND531	0.500	CC	Grn	Overflow \pm 1 Digit	RH	80	2.2	2000	O4	Opto-13
3	FND537	0.500	CA	Grn	7-Segment Display	RH	80	2.2	2000	O3	Opto-13
4	FND538	0.500	CA	Grn	Overflow \pm 1 Digit	RH	80	2.2	2000	O4	Opto-13
5	FND540	0.500	CC	Yel	7-Segment Display	RH	80	2.2	2000	O3	Opto-13
6	FND541	0.500	CC	Yel	Overflow \pm Digit	RH	80	2.2	2000	O4	Opto-13
7	FND547	0.500	CA	Yel	7-Segment Display	RH	80	2.2	2000	O3	Opto-13
8	FND548	0.500	CA	Yel	Overflow \pm Digit	RH	80	2.2	2000	O4	Opto-13
9	FND550	0.500	CC	Amb	7-Segment Display	RH	80	2.2	2000	O3	Opto-13
10	FND551	0.500	CC	Amb	Overflow \pm 1 Digit	RH	80	2.2	2000	O4	Opto-13
11	FND557	0.500	CA	Amb	7-Segment Display	RH	80	2.2	2000	O3	Opto-13
12	FND558	0.500	CA	Amb	Overflow \pm 1 Digit	RH	80	2.2	2000	O4	Opto-13
13	FND560	0.500	CC	Red	7-Segment Display	RH	200	2.2	1200	O3	Opto-13
14	FND561	0.500	CC	Red	Overflow \pm 1 Digit	RH	200	1.7	1200	O4	Opto-13
15	FND567	0.500	CA	Red	7-Segment Display	RH	200	1.7	1200	O3	Opto-13
16	FND568	0.500	CA	Red	Overflow \pm 1 Digit	RH	200	1.7	1200	O4	Opto-13
17	FND800	0.800	CC	Red	7-Segment Display	RH	200	1.7	600	O5	Opto-14
18	FND807	0.800	CA	Red	7-Segment Display	RH	200	1.7	600	O5	Opto-14
19	FND847	0.800	CA	Red	7-Segment Display	LH	200	1.7	600	O6	Opto-14
20	FND850	0.800	CC	Red	7-Segment Display	LH	200	1.7	600	O6	Opto-14
21	FND6710	0.560	CA	Red	Dual Digit Display	RH	200	1.7	500	O10	Opto-16
22	FND6730*	0.560	CA	Red	1 $\frac{1}{2}$ Digit \pm 18 Display	RH	200	1.7	500	—	—
23	FND6740	0.560	CC	Red	Dual Digit Display	RH	200	1.7	500	O10	Opto-16
24	FND6750*	0.560	CC	Red	1 $\frac{1}{2}$ Digit \pm 18 Display	RH	200	1.7	500	—	—
25	MAN71A	0.300	CA	Red	7-Segment Display	RH	200	1.7	450	O7	Opto-15
26	MAN72A	0.300	CA	Red	7-Segment Display	LH	200	1.7	450	O7	Opto-15
27	MAN73A	0.300	CA	Red	Overflow \pm 1 Digit	None	200	1.7	450	O8	Opto-15
28	MAN74A	0.300	CC	Red	7-Segment Display	RH	200	1.7	450	O9	Opto-15

* Available 2nd Half, 1978

FAIRCHILD OPTOELECTRONICS

OPTO

7-SEGMENT NUMERIC DISPLAY ARRAYS

Item	DEVICE NO.	Digits	AM/PM	V _F I _F = 8.0 mA V Typ	Luminous Intensity/Seg μcd Typ	@mA	Seg/Seg Match Typ	No. of Pins	Logic/ Connection Diagram	Package No.
1	FCS6400	4	No	1.7	200	10	±33%	34	O17	Opto-24
2	FCS6401	3 1/2	Yes	1.7	200	10	±33%	34	O18	Opto-25
3	FCS8000	3 1/2	Yes	1.65	350	8.0	±33%	34	O11	Opto-17
4	FCS8024	4	No	1.65	350	8.0	±33%	34	O12	Opto-18
5	FNA3420 ⁽³⁾	4	No	1.7	600	20	±33%	13	—	—
6	FNA5420	4	No	1.7	600	20	±33%	13	O13	Opto-20
7	FNA5421	3 1/2	No	1.7	600	20	±33%	13	O14	Opto-21
8	FNA5427	4	No	1.7	600	20	±33%	13	O13	Opto-20
9	FNA5428	3 1/2	No	1.7	600	20	±33%	13	O14	Opto-21
10	FNA5520	5	No	1.7	600	20	±33%	14	O15	Opto-22
11	FNA5521	4 1/2	No	1.7	600	20	±33%	14	O16	Opto-23
12	FNA5527	5	No	1.7	600	20	±33%	14	O15	Opto-22
13	FNA5528	4 1/2	No	1.7	600	20	±33%	14	O16	Opto-23

LIQUID CRYSTAL DISPLAYS

Always a leader in high-technology, state-of-the-art electronics, Fairchild has now entered the liquid crystal display (LCD) market. Initial entries are 3 1/2-, 5 1/2-, and 6-digit watch and 8-digit calculator displays, and the product range will continue to expand as customer needs and desires are identified.

In order to properly introduce the LCD products, and to ensure that only the most current data on this rapidly growing line is presented, a separate LCD Data Book is being prepared.

Until the new Data Book is available, please contact our factory for information on how the Fairchild LCDs can meet your needs.

FAIRCHILD OPTOELECTRONICS

OPTO

COUPLERS—TRANSISTOR OUTPUT

Item	DEVICE NO.	MAX RATINGS @ T _A 25°C					
		P _D mW	I _C mA	V _{CEO} V	V _R V	I _F mA	V _{ISO} kV
1	FCD810 ⁽¹⁾	250	25	20	3.0	60	1.5ac
2	FCD810A ⁽¹⁾	250	25	20	3.0	60	1.5
3	FCD810B ⁽¹⁾	250	25	20	3.0	60	2.5
4	FCD810C ⁽¹⁾	250	25	20	3.0	60	5.0
5	FCD810D ⁽¹⁾	250	25	20	3.0	60	6.0
6	FCD820 ^(1,3)	250	25	30	3.0	60	1.5ac
7	FCD820A ⁽¹⁾	250	25	30	3.0	60	1.5
8	FCD820B ⁽¹⁾	250	25	30	3.0	60	2.5
9	FCD820C ⁽¹⁾	250	25	30	3.0	60	5.0
10	FCD820D ⁽¹⁾	250	25	30	3.0	60	6.0
11	FCD825 ^(1,5)	250	25	30	3.0	60	1.5ac
12	FCD825A ^(1,5)	250	25	30	3.0	60	1.5
13	FCD825B ^(1,5)	250	25	30	3.0	60	2.5
14	FCD825C ^(1,5)	250	25	30	3.0	60	5.0
15	FCD825D ^(1,5)	250	25	30	3.0	60	6.0
16	FCD830 ^(2,3)	250	25	30	3.0	60	1.5
17	FCD830A ⁽²⁾	250	25	30	3.0	60	1.5ac
18	FCD830B ⁽²⁾	250	25	30	3.0	60	2.5
19	FCD830C ⁽²⁾	250	25	30	3.0	60	5.0

1. Standard transistor output
2. High speed transistor output
guaranteed 2.0 μs max t_r and t_f with 100 Ω R_L
8.0 μs typ at 1K Ω R_L
3. CTR guaranteed with transistor in saturation
4. JEDEC registered data and conditions
5. CTR typ at 1.0mA 40%

FAIRCHILD OPTOELECTRONICS

COUPLED CHARACTERISTICS				INPUT DIODE CHARACT.		OUTPUT TRANSISTOR CHARACT.			Logic/Connection Diagram	Package No.	
	Min Current Transfer Ratio I _C /I _F %	@ I _F mA	@ V _{CE} V	t _r , t _f μs Typ	V _F V Max	@ I _F mA	V _{CE(sat)} V Max	@ I _C mA			@ I _F mA
	10	10	10	4.0	1.5	10	0.7	2.6	50	O24	Opto-37
	10	10	10	4.0	1.5	10	0.7	2.6	50	O24	Opto-37
	10	10	10	4.0	1.5	10	0.7	1.6	50	O24	Opto-37
	10	10	10	4.0	1.5	10	0.7	2.6	50	O24	Opto-37
	10	10	10	4.0	1.5	10	0.7	2.6	50	O24	Opto-37
	20	10	0.4	2.5	1.5	60	0.4	2.0	10	O24	Opto-37
	20	10	10	2.5	1.5	60	0.4	2.2	15	O24	Opto-37
	20	10	10	2.5	1.5	60	0.4	2.2	15	O24	Opto-37
	20	10	10	2.5	1.5	60	0.4	2.2	15	O24	Opto-37
	20	10	10	2.5	1.5	60	0.4	2.2	15	O24	Opto-37
	50	10	10	3.0	1.5	60	0.4	2.0	10	O24	Opto-37
	50	10	10	3.0	1.5	60	0.4	2.0	10	O24	Opto-37
	50	10	10	3.0	1.5	60	0.4	2.0	10	O24	Opto-37
	50	10	10	3.0	1.5	60	0.4	2.0	10	O24	Opto-37
	50	10	10	3.0	1.5	60	0.4	2.0	10	O24	Opto-37
	20	10	0.4	1.6	1.5	60	0.4	2.0	10	O24	Opto-37
	20	10	10	1.6	1.5	60	0.4	2.2	15	O24	Opto-37
	20	10	10	1.6	1.5	60	0.4	2.2	15	O24	Opto-37
	20	10	10	1.6	1.5	60	0.4	2.2	15	O24	Opto-37

FAIRCHILD OPTOELECTRONICS

OPTO

COUPLERS—TRANSISTOR OUTPUT (Cont'd)

Item	DEVICE NO.	MAX RATINGS @ T _A = 25°C					V _{ISO} kV
		P _D mW	I _C mA	V _{CEO} V	Diode		
					V _R V	I _F mA	
1	FCD830D ⁽²⁾	250	25	30	3.0	60	6.0
2	FCD831 ⁽²⁾	250	25	30	3.0	60	1.5ac
3	FCD831A ⁽²⁾	250	25	30	3.0	60	1.5
4	FCD831B ⁽²⁾	250	25	30	3.0	60	2.5
5	FCD831C ⁽²⁾	250	25	30	3.0	60	5.0
6	FCD831D ⁽²⁾	250	25	30	3.0	60	6.0
7	FCD836 ⁽²⁾	250	25	20	3.0	60	1.5ac
8	FCD836C ⁽²⁾	250	25	20	3.0	60	5.0
9	FCD836D ⁽²⁾	250	25	20	3.0	60	6.0
10	4N25 ⁽⁴⁾	250	—	30	3.0	80	2.5
11	4N26 ⁽⁴⁾	250	—	30	3.0	80	1.5
12	4N27 ⁽⁴⁾	250	—	30	3.0	80	1.5
13	4N28 ⁽⁴⁾	250	—	30	3.0	80	0.5
14	4N35 ⁽⁴⁾	400	—	30	6.0	60	3.5
15	4N36 ⁽⁴⁾	400	—	30	6.0	60	2.5
16	4N37 ⁽⁴⁾	400	—	30	6.0	60	1.5
17	IL1	200	—	30	3.0	150	2.5
18	IL12	200	—	30	3.0	150	1.0
19	IL15	200	—	30	3.0	150	1.5

1. Standard transistor output
2. High speed transistor output
guaranteed 2.0 μs max t_r and t_f with 100 Ω R_L
8.0 μs typ at 1K Ω R_L
3. CTR guaranteed with transistor in saturation
4. JEDEC registered data and conditions
5. CTR typ at 1.0mA = 40%

FAIRCHILD OPTOELECTRONICS

COUPLED CHARACTERISTICS				INPUT DIODE CHARACT.		OUTPUT TRANSISTOR CHARACT.			Logic/Connection Diagram	Package No.	
	Min Current Transfer Ratio			t_r, t_f μs Typ	V_F V Max	@ I_F mA	$V_{CE(sat)}$ V Max	@ I_C mA			@ I_F mA
	I_C/I_F %	@ I_F mA	@ V_{CE} V								
	20	10	10	1.6	1.5	60	0.4	2.2	15	O24	Opto-37
	10	10	10	1.6	1.5	60	0.5	2.0	50	O24	Opto-37
	10	10	10	1.6	1.5	60	0.5	2.0	50	O24	Opto-37
	10	10	10	1.6	1.5	60	0.5	2.0	50	O24	Opto-37
	10	10	10	1.6	1.5	60	0.5	2.0	50	O24	Opto-37
	10	10	10	1.6	1.5	60	0.5	2.0	50	O24	Opto-37
	6.0	10	10	1.6	1.5	20	0.7	2.0	50	O24	Opto-37
	6.0	10	10	1.6	1.5	20	0.7	2.0	50	O24	Opto-37
	6.0	10	10	1.6	1.5	20	0.7	2.0	50	O24	Opto-37
	20	10	10	2.5	1.5	50	0.5	2.0	50	O24	Opto-37
	20	10	10	2.5	1.5	50	0.5	2.0	50	O24	Opto-37
	10	10	10	2.5	1.5	50	0.5	2.0	50	O24	Opto-37
	10	10	10	2.5	1.5	50	0.5	2.0	50	O24	Opto-37
	100	10	10	8.0	1.5	10	0.3	0.5	10	O24	Opto-37
	100	10	10	8.0	1.5	10	0.3	0.5	10	O24	Opto-37
	100	10	10	8.0	1.5	10	0.3	0.5	10	O24	Opto-37
	20	10	10	2.0	1.5	60	0.5	1.6	16	O24	Opto-37
	10	10	5.0	2.0	1.5	10	0.5	2.0	50	O24	Opto-37
	6.0	10	10	2.0	1.5	60	0.5	2.0	50	O24	Opto-37

FAIRCHILD OPTOELECTRONICS

OPTO

COUPLERS—TRANSISTOR OUTPUT (Cont'd)

Item	DEVICE NO.	MAX RATINGS @ T _A = 25°C					V _{ISO} kV
		P _D mW	I _C mA	V _{CEO} V	V _R V	I _F mA	
1	IL16	200	—	30	3.0	150	1.5
2	IL74	150	—	20	3.0	150	1.5
3	H11A1	250	100	30	3.0	60	2.5
4	H11A2	250	100	30	3.0	60	1.5
5	H11A3	250	100	30	3.0	60	2.5
6	H11A4	250	100	30	3.0	60	1.5
7	MCT2	250	—	30	3.0	60	1.5
8	MCT2E	250	—	30	3.0	60	2.5
9	MCT26	250	—	30	3.0	60	1.5
10	TIL111 ⁽³⁾	250	—	30	3.0	100	1.5
11	TIL112	250	—	20	3.0	100	1.5
12	TIL114 ⁽³⁾	250	—	30	3.0	100	2.5
13	TIL115	250	—	20	3.0	100	2.5
14	TIL116	250	—	30	3.0	100	2.5
15	TIL117	250	—	30	3.0	100	2.5
16	TIL118	250	—	20	3.0	100	1.5
17	MOC1000	250	—	30	3.0	80	1.5
18	MOC1001	250	—	30	3.0	80	2.5
19	MOC1002	250	—	30	3.0	80	1.5
20	MOC1003	250	—	30	3.0	80	0.5

1. Standard transistor output
2. High speed transistor output
guaranteed 2.0 μs max t_r and t_f with 100 Ω R_L
8.0 μs typ at 1K Ω R_L
3. CTR guaranteed with transistor in saturation
4. JEDEC registered data and conditions
5. CTR typ at 1.0mA = 40%

FAIRCHILD OPTOELECTRONICS

COUPLED CHARACTERISTICS				INPUT DIODE CHARACT.		OUTPUT TRANSISTOR CHARACT.			Logic/ Connection Diagram	Package No.	
	Min Current Transfer Ratio I_C/I_F %	@ I_F mA	@ V_{CE} V	t_r, t_f μs Typ	V_F V Max	@ I_F mA	$V_{CE(sat)}$ V Max	@ I_C mA			@ I_F mA
	6.0	10	10	2.0	1.5	60	0.5	1.6	50	O24	Opto-37
	12.5	16	5.0	25.0	—	—	0.5	2.0	16	O24	Opto-37
	50	10	10	2.0	1.5	10	0.4	0.5	10	O24	Opto-37
	20	10	10	2.0	1.5	10	0.4	0.5	10	O24	Opto-37
	20	10	10	2.0	1.5	10	0.4	0.5	10	O24	Opto-37
	10	10	10	2.0	1.5	10	0.4	0.5	10	O24	Opto-37
	20	10	10	2.5	1.5	20	0.4	2.0	16	O24	Opto-37
	20	10	10	2.5	1.5	20	0.4	2.0	16	O24	Opto-37
	6.0	10	10	2.0	1.5	20	0.5	1.6	60	O24	Opto-37
	12	16	0.4	5.0	1.4	16	0.4	2.0	16	O24	Opto-37
	2.0	10	5.0	15.0	1.5	10	0.5	2.0	50	O24	Opto-37
	12	16	0.4	5.0	1.4	16	0.4	2.0	16	O24	Opto-37
	2.0	10	5.0	15.0	1.5	10	0.5	2.0	50	O24	Opto-37
	20	10	10	7.0	1.5	60	0.4	2.2	15	O24	Opto-37
	50	10	10	9.0	1.4	16	0.4	0.5	10	O24	Opto-37
	10	10	5.0	15.0	1.5	10	0.5	2.0	50	O24	Opto-37
	20	10	10	2.8	1.5	50	0.5	2.0	50	O24	Opto-37
	20	10	10	2.8	1.5	50	0.5	2.0	50	O24	Opto-37
	10	10	10	2.8	1.5	50	0.5	2.0	50	O24	Opto-37
	10	10	10	2.8	1.5	50	0.5	2.0	50	O24	Opto-37

FAIRCHILD OPTOELECTRONICS

OPTO

COUPLERS—DARLINGTON OUTPUT

Item	DEVICE NO.	MAX RATINGS @ T _A = 25°C					V _{ISO} kV
		P _D mW	I _C mA	V _{CEO} V	V _R V	I _F mA	
1	FCD850	250	125	30	3.0	80	1.5ac
2	FCD850C	250	125	30	3.0	80	5.0
3	FCD850D	250	125	30	3.0	80	6.0
4	FCD855	250	125	55	3.0	80	1.5ac
5	FCD855C	250	125	55	3.0	80	5.0
6	FCD855D	250	125	55	3.0	80	6.0
7	FCD860 ⁽³⁾	250	125	30	3.0	80	1.5ac
8	FCD860C ⁽³⁾	250	125	30	3.0	80	5.0
9	FCD860D ⁽³⁾	250	125	30	3.0	80	6.0
10	FCD865 ⁽³⁾	250	125	30	3.0	80	1.5ac
11	FCD865C ⁽³⁾	250	125	30	3.0	80	5.0
12	FCD865D ⁽³⁾	250	125	30	3.0	80	6.0
13	4N29 ⁽⁴⁾	250	125	30	3.0	80	2.5
14	4N30 ⁽⁴⁾	250	125	30	3.0	80	1.5
15	4N31 ⁽⁴⁾	250	125	30	3.0	80	1.5
16	4N32 ⁽⁴⁾	250	125	30	3.0	80	2.5
17	4N33 ⁽⁴⁾	250	125	30	3.0	80	1.5
18	H11B1	250	100	25	3.0	60	2.5
19	H11B2	250	100	25	3.0	60	1.5
20	TIL113 ⁽³⁾	250	—	30	3.0	100	1.5
21	TIL119	250	—	30	3.0	100	1.5
22	MCA230	250	—	30	3.0	60	1.5
23	MCA231 ⁽³⁾	250	50	30	3.0	60	1.5
24	MCA255	250	—	55	3.0	60	1.5

1. Standard transistor output
2. High speed transistor output
guaranteed 2 μs max t_r and t_f with 100Ω R_L
8μs typ at 1KΩ R_L
3. CTR guaranteed with transistor in saturation
4. JEDEC registered data and conditions
5. CTR typ at 1.0mA = 40%

FAIRCHILD OPTOELECTRONICS

COUPLED CHARACTERISTICS						INPUT DIODE CHARACT.		OUTPUT DARLINGTON CHARACT.		Logic/ Connection Diagram	Package No.
Min Current Transfer Ratio			t_r μs Typ	t_f μs Typ	V_F V Max	@ I_F mA	I_{CEO} μA Max	@ V_{CE} V			
I_C/I_F %	@ I_F mA	@ V_{CE} V									
100	10	5.0	15	150	1.5	20	0.1	10	O24	Opto-37	
100	10	5.0	15	150	1.5	20	0.1	10	O24	Opto-37	
100	10	5.0	15	150	1.5	20	0.1	10	O24	Opto-37	
100	10	5.0	15	150	1.5	20	0.1	10	O24	Opto-37	
100	10	5.0	15	150	1.5	20	0.1	10	O24	Opto-37	
100	10	5.0	15	150	1.5	20	0.1	10	O24	Opto-37	
200	1.0	1.0	80	150	1.5	20	0.1	10	O24	Opto-37	
200	1.0	1.0	80	150	1.5	20	0.1	10	O24	Opto-37	
200	1.0	1.0	80	150	1.5	20	0.1	10	O24	Opto-37	
400	0.5	1.0	80	150	1.5	20	0.1	10	O24	Opto-37	
400	0.5	1.0	80	150	1.5	20	0.1	10	O24	Opto-37	
400	0.5	1.0	80	150	1.5	20	0.1	10	O24	Opto-37	
100	10	10	10	45	1.5	50	0.1	10	O24	Opto-37	
100	10	10	10	45	1.5	50	0.1	10	O24	Opto-37	
50	10	10	10	45	1.5	50	0.1	10	O24	Opto-37	
500	10	10	10	120	1.5	50	0.1	10	O24	Opto-37	
500	10	10	10	120	1.5	50	0.1	10	O24	Opto-37	
500	1.0	5.0	125	100	1.5	10	0.1	10	O24	Opto-37	
200	1.0	5.0	125	100	1.5	10	0.1	10	O24	Opto-37	
300	10	1.0	50	50	1.5	10	0.1	10	O24	Opto-37	
300	10	2.0	50	50	1.5	10	0.1	10	O24	Opto-37	
100	10	5.0	5.0	35	1.5	20	0.1	10	O24	Opto-37	
200	5.0	1.0	5.0	35	1.5	10	0.1	10	O24	Opto-37	
100	10	5.0	5.0	35	1.5	20	0.1	10	O24	Opto-37	

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PHOTO TRANSISTORS

Item	DEVICE NO.	Description	V _{CEO} I _C = 1.0mA V		I _{CE(It)} V _{CE} = 5.0V mA			V _{CE(sat)} H = 20mW/cm ² V			t _r /t _f μs Typ	Package No.
			Min	Typ	Min	Typ	Max	Min	Typ	Max		
1	FPT100	Plastic, Dome Lens General Purpose	30	50	H = 5.0mW/cm ² 0.2	1.4	—	I _C = 500μA —	0.16	0.3	2.8	Opto-26
2	FPT100A	Plastic, Dome Lens 1:3 Sensitivity	30	50	H = 5.0mW/cm ² 1.0	1.4	3.0	I _C = 500μA —	0.16	0.3	2.8	Opto-26
3	FPT100B	Plastic, Dome Lens 1:2 Sensitivity	30	50	H = 5.0mW/cm ² 1.3	1.4	2.6	I _C = 500μA —	0.16	0.3	2.8	Opto-26
4	FPT101	Miniature, .080" Dia. Hermetic Package	I _C = 0.1mA, H ≤ 0.1μW/cm ² 30	60	H = 20mW/cm ² 0.8	3.5	—	I _C = 0.4mA —	0.25	0.3	2.8	Opto-27
5	FPT102	Photodiode Hermetic Package	I _R = 5.0μA, H ≤ 0.1μW/cm ² 50	120	V _R = -10.0V, H ≤ 0.1μW/cm ² —	0.1nA	25nA	V _R = -10V 12μA	20μA	—	0.2	Opto-27
6	FPT110	Plastic Flat Lens General Purpose	30	50	H = 5.0mW/cm ² 0.2	0.88	—	I _C = 500μA —	0.16	0.33	2.8	Opto-28
7	FP110A	Plastic Flat Lens 1:3 Sensitivity	30	50	H = 5.0mW/cm ² 0.6	0.88	1.8	I _C = 500μA —	0.16	0.33	2.8	Opto-28
8	FPT110B	Plastic Flat Lens 1:2 Sensitivity	30	50	H = 5.0mW/cm ² 0.8	0.88	1.6	I _C = 500μA —	0.16	0.33	2.8	Opto-28
9	FPT120	Plastic, Dome Lens High Sensitivity	20	50	H = 1.0mW/cm ² 0.4	1.5	—	I _C = 1.0mA —	0.25	0.55	18	Opto-26
10	FPT120A	Plastic, Dome Lens 1:3 Sensitivity	15	30	H = 1.0mW/cm ² 1.5	2.4	4.5	I _C = 1.0mA —	0.25	0.55	18	Opto-26
11	FPT120B	Plastic, Dome Lens 1:1.5 Sensitivity	15	30	H = 1.0mW/cm ² 2.0	2.4	4.0	I _C = 1.0mA —	0.25	0.55	18	Opto-26
12	FPT120C	Plastic Cup, Dome Lens	11	20	H = 5.0mW/cm ² 16	—	25	I _C = 1.0mA —	0.35	0.55	18	Opto-26
13	FPT130	Plastic, Flat Lens High Sensitivity	20	50	H = 1.0mW/cm ² 0.4	0.9	—	I _C = 1.0mA —	0.25	0.55	18	Opto-28
14	FPT130A	Plastic, Flat Lens 1:3 Sensitivity	15	30	H = 1.0mW/cm ² 0.9	1.5	2.7	I _C = 1.0mA —	0.25	0.55	18	Opto-28
15	FPT130B	Plastic, Flat Lens 1:2 Sensitivity	15	30	H = 1.0mW/cm ² 1.2	1.5	2.4	I _C = 1.0mA —	0.25	0.55	18	Opto-28
16	FPT131	Plastic, Dome Lens	15	50	H = 5.0mW/cm ² 0.1	1.4	—	I _C = 500μA —	0.16	0.7	2.8	Opto-26
17	FPT132	Plastic, Dome Lens	10	30	H = 1.0mW/cm ² 0.2	1.5	—	I _C = 1.0mA —	0.15	0.7	18	Opto-26
18	FPT136	Plastic, Flat Lens	15	50	H = 5.0mW/cm ² 0.1	0.88	—	I _C = 500μA —	0.16	0.7	2.8	Opto-28

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PHOTO TRANSISTORS (Cont'd)

Item	DEVICE NO.	Description	V _{CEO} I _C = 1.0mA V		I _{CE} (It) V _{CE} = 5.0V mA			V _{CE} (sat) H = 20mW/cm ² V			t _r /t _f μs Typ	Package No.
			Min	Typ	Min	Typ	Max	Min	Typ	Max		
1	FPT137	Plastic, Flat Lens	10	30	H = 1.0mW/cm ² 0.2 0.9 —			I _C = 1.0mA — 0.15 0.7			18	Opto-28
2	FPT220	Plastic, Dome Lens 1:2 Sensitivity	20	50	H = 1.0mW/cm ² 1.0 1.5 2.0			I _C = 1.0mA — 0.25 0.55			18	Opto-26
3	FPT230	Plastic Flat Lens 1:2 Sensitivity	20	50	H = 1.0mW/cm ² 0.6 0.9 1.2			I _C = 1.0mA — 0.25 0.55			18	Opto-28
4	FPT320	Plastic, Dome Lens 1:3 Sensitivity	20	50	H = 1.0mW/cm ² 0.75 1.5 2.25			I _C = 1.0mA — 0.25 0.55			18	Opto-26
5	FPT330	Plastic, Flat Lens 1:3 Sensitivity	20	50	H = 1.0mW/cm ² 0.45 0.9 1.35			I _C = 1.0mA — 0.25 0.55			18	Opto-28
6	FPT400	Plastic, Dome Lens Photo Darlington	30	50	H = 1.0mW/cm ² 7.5 12 —			— 0.9 1.0			100	Opto-26
7	FPT410	Plastic, Flat Lens Photo Darlington	30	50	H = 1.0mW/cm ² 5.0 8.0 —			— 0.9 1.0			100	Opto-28
8	FPT500	TO-18, Dome Lens	45	60	H = 1.0mW/cm ² 1.0 — —			— 0.2 0.33			3.0	Opto-29
9	FPT500A	TO-18, Dome Lens 1:3 Sensitivity	45	60	H = 1.0mW/cm ² 2.0 — 6.0			— 0.2 0.33			3.0	Opto-29
10	FPT510	TO-18, Flat Lens	45	60	H = 5.0mW/cm ² 0.5 — —			— 0.2 0.33			3.0	Opto-30
11	FPT510A	TO-18, Flat Lens 1:3 Sensitivity	45	60	H = 5.0mW/cm ² 1.0 — 3.0			— 0.2 0.33			3.0	Opto-30
12	FPT520	TO-18, Dome Lens	30	50	H = 1.0mW/cm ² 5.0 — —			— 0.2 0.33			10	Opto-29
13	FPT520A	TO-18, Dome Lens 1:3 Sensitivity	30	50	H = 1.0mW/cm ² 6.0 — 18			— 0.2 0.33			10	Opto-29
14	FPT530	TO-18, Flat Lens	30	50	H = 5.0mW/cm ² 3.0 — —			— 0.2 0.33			10	Opto-30
15	FPT530A	TO-18, Flat Lens 1:3 Sensitivity	30	50	H = 5.0mW/cm ² 4.0 — 12			— 0.2 0.33			10	Opto-30
16	FPT540	TO-18, Dome Lens	12	20	H = 1.0mW/cm ² 8.0 — —			— 0.35 0.55			18	Opto-29
17	FPT540A	TO-18, Dome Lens 1:3 Sensitivity	12	20	H = 1.0mW/cm ² 10 — 30			— 0.35 0.55			18	Opto-29
18	FPT550	TO-18, Flat Lens	12	20	H = 5.0mW/cm ² 8.0 — —			— 0.35 0.55			18	Opto-30

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PHOTO TRANSISTORS (Cont'd)

Item	DEVICE NO.	Description	V _{CEO} I _C = 1.0mA V		I _{CE} (It) V _{CE} = 5.0V mA			V _{CE} (sat) H = 20mW/cm ² V			t _r /t _f μs Typ	Package No.
			Min	Typ	Min	Typ	Max	Min	Typ	Max		
1	FPT550A	TO-18, Flat Lens 1:3 Sensitivity	12	20	H = 5.0mW/cm ² 8.0	—	24	—	0.35	0.55	18	Opto-30
2	FPT560	TO-18, Dome Lens Photo Darlington	30	50	H = 0.5mW/cm ² 10	15	—	—	0.9	1.0	100	Opto-29
3	FPT570	TO-18, Flat Lens Photo Darlington	30	50	H = 0.5mW/cm ² 1.0	6.0	—	—	0.9	1.0	100	Opto-30
4	FPT610	Miniature, .085" x .150"	30	50	H = 5.0mW/cm ² 0.2	1.4	—	I _C = 500μA —	0.16	0.3	2.8	Opto-31
5	FPT630	X .095" Tall Flat Lens	20	50	H = 1.0mW/cm ² 0.4	0.9	—	I _C = 1.0mA —	0.25	0.55	18	Opto-31

INFRARED EMITTERS

Item	DEVICE NO.	Description	I _F mA Max	V _F I _F = 100mA V Typ	Wave Length @ Peak Emission nm Typ	Axial Intensity I _F = 100mA mW/sr Typ	Package No.
6	FPE100	Metal Header Package Wide Beam	100	1.35	890	0.3	Opto-32
7	FPE104	Lead Frame Package Narrow Beam	100	1.35	890	10	Opto-8
8	FPE106	Miniature .085" x .150" x .095" Tall Flat Lens	100	1.35	890	0.4	Opto-31
9	FPE500	TO-18, Dome Lens	250	1.35	890	10.0	Opto-29
10	FPE510	TO-18, Flat Lens	250	1.35	890	1.0	Opto-30
11	FPE520	TO-18, Dome Lens	250	1.35	940	50	Opto-29
12	FPE530	TO-18, Flat Lens	250	1.35	940	5.0	Opto-30

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SOURCE/SENSOR ARRAYS

Item	DEVICE NO.	Description	Source		Sensor		Matching Factor		Package No.
			I_F mA/cell Max	V_F $I_F = 50\text{mA}$ V Typ	$I_{CE(I)}$ $H = 1.0\text{mW/cm}^2$ (GaAs) $V_{CE} = 5.0\text{V}$ mA Typ	$V_{CE(sat)}$ $I_{CE} = 4.0\text{mA}$ V Typ	$\frac{I_{OUT(Min)}}{I_{OUT(Max)}}$ $I_F = 50\text{mA}, V_{CE} = 5.0\text{V}$ distance = 0.05" Min Typ		
1	FPA100	9-Element Source/ Sensor Array 0.100" Centers	75	1.25	4.5	0.4	0.5	0.65	Opto-33 (2 pcs.)
2	FPA101	12-Element Source/ Sensor Array 0.250" Centers	75	1.25	4.5	0.4	0.5	0.65	Opto-34 (2 pcs.)
3	FPA102	10-Element Source/ Sensor Array 0.087" Centers	75	1.25	4.5	0.4	0.5	0.65	Opto-35 (2 pcs.)

SENSOR ARRAYS

Item	DEVICE NO.	Description	I_{CE} mA Max	V_{CEO} $I_C = 1.0\text{mA}$ V Typ	$I_{CE(I)}$ $H = 10\text{mW/cm}^2$ Tung. @ 2854°K mA Typ	$V_{CE(sat)}$ $H = 20\text{mW/cm}^2$ $I_C = 500\text{mA}$ V Typ	Matching Factor		Package No.
							$\frac{I_{OUT(Min)}}{I_{OUT(Max)}}$ $I_F = 50\text{mA}, V_{CE} = 5.0\text{V}$ distance = 0.05" Min Typ		
4	FPA700	9-Element Sensor Array 0.100" Centers	25	20	1.75	0.16	0.5	0.65	Opto-33
5	FPA700A	9-Element Sensor Array 0.100" Centers	25	20	1.75	0.16	0.75	0.85	Opto-33
6	FPA710	12-Element Sensor Array 0.250" Centers	25	20	1.75	0.16	0.5	0.65	Opto-34
7	FPA710A	12-Element Sensor Array 0.250" Centers	25	20	1.75	0.16	0.75	0.85	Opto-34
8	FPA720	10-Element Sensor Array 0.087" Centers	25	20	1.75	0.16	0.5	0.65	Opto-35
9	FPA720A	10-Element Sensor Array 0.87" Centers	25	20	1.75	0.16	0.75	0.85	Opto-35

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REFLECTIVE SENSORS

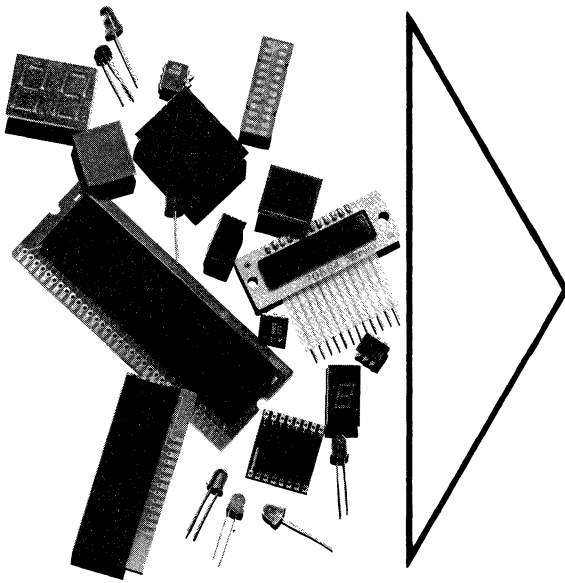
Item	DEVICE NO. ⁽¹⁾	Description	Diode		Photo-Transistor	Combined		Package No.
			I _F mA Max	V _F I _F = 20mA V Typ	V _{CEO} I _{CE} = 1.0mA V Min	I _{OUT} I _F = 50mA, V _{CE} = 5V distance = .40" μA Min	μA Max	
1	FPA103/106	Light Reflective Transducer	75	1.25	12	20	—	Opto-36
2	FPA104/107	Light Reflective Transducer	75	1.25	12	60	180	Opto-36
3	FPA105/108	Light Reflective Transducer	75	1.25	12	80	160	Opto-36

DICE

Item	DEVICE NO.	Die Size Inches	Description
4	FLX2121	.015 x .015	A high-efficiency, long life red GaAsP LED. Typical luminous intensity = 0.7 mcd @ V _F = 1.7 V and I _F = 20 mA.
5	FNX8019	.116 x .070	GaAsP monolithic 7/9 segment display with a 5° slant. Dimensions given are digit sizes—die is larger by .008" vertical and no more than .016" in horizontal direction. Half digits (numeral-one) are available for the 0.100", and 0.116" display. The FNX8019, 8009 and 8039 are 9-segment and can be used as 7-segment. The other is 7-segment only.
6	FNX8009	.100 x .062	
7	FNX8039	.080 x .049	
8	FNX8041	.040 x .026	
9	FNX8209	.050 x .063	A current-sinking digit driver for common-cathode LED displays. The monolithic chip contains four independent npn transistors, each capable of sinking 63 mA with I _B = 1.0 mA.
10	FPX1010	.040 x .040	An npn Planar ⁽²⁾ phototransistor, h _{FE} = 100 Min; V _{CEO} = 30 V Min; V _{CBO} = 50 V Min; I _{CE(it)} = 0.3 mA Min @ H = 5.0 mW/cm ² (tungsten @ 2854°K); typical t _r and t _f = 3.0 μs @ I _{CE} = 4.0 mA and R _L = 100 Ω; V _{CE(sat)} = 0.4 V Max @ I _C = 500 μA.
11	FPX1011	.040 x .040	An npn Planar phototransistor with high illumination sensitivity h _{FE} = 500 Min; V _{CEO} = 12 V Min; V _{CBO} = 30 V Min; I _{CE(it)} = 0.3 mA Min @ H = 1.0 mW/cm ² (tungsten @ 2854°K), typical t _r and t _f = 18 μs @ I _{CE} = 4.0 mA and R _L = 100 Ω; V _{CE(sat)} = 0.5 V Max @ I _C = 500 μA.

1. FPA 106, 107, 108 have infrared filters.

2. Planar is a patented Fairchild process.



OPTOELECTRONIC TECHNOLOGY	1
DISCRETE LED DIGIT RELIABILITY	2
VISIBLE LED LAMPS AND MOUNTING HARDWARE	3
SEVEN-SEGMENT DISPLAYS AND DISPLAY ARRAYS	4
PHOTOTRANSISTORS, INFRARED EMITTERS, AND SENSORS	5
PHOTOCOUPERS	6
PACKAGE OUTLINES	7
DEFINITIONS OF SYMBOLS AND TERMS	8
FAIRCHILD FIELD SALES OFFICES, SALES REPRESENTATIVES AND DISTRIBUTOR LOCATIONS	9

CHAPTER 1

OPTOELECTRONIC TECHNOLOGY

Solid state optoelectronic technology has significantly improved the capabilities, reliability, and life expectancy of all types of displays and indicators. Several techniques, each seeking to optimize a different set of parameters, have been developed for manufacturing specific optoelectronic devices. Preparation of the basic materials is essentially the same for all techniques, with the major differences being in the assembly processes and materials selected for final device fabrication.

ARCHITECTURE

Optoelectronics is based upon the ability of certain semiconductor materials to change the form of energy. For example, in such light-sensitive devices as photodiodes and phototransistors, electromagnetic energy in the form of photons is absorbed by the p-type region of a pn junction. When absorbed in this manner, the photons release holes and electrons; the movement of the released electrons across the junction constitutes the current produced by the device.

The complementary device is the light-emitting diode (LED). The structure of the LED is such that, when current is applied to it, electrons and holes combine and effectively annihilate one another as charge carriers. The energy is released from the LED in the form of photons. As would be expected, different semiconductor materials have different absorption and emission characteristics.

Generally, LED devices emitting light in the visible spectrum consist of a gallium arsenide (GaAs) or gallium phosphide (GaP) substrate with an epitaxial layer (a single crystal, grown on the substrate, that duplicates the orientation of the substrate) of gallium arsenide phosphide (GaAs) tailored to give the desired color and light emission characteristics. The GaAs and GaP materials are frequently referred to as III—V compounds because of their positions in the chemical periodic table. Devices that emit light in the infrared spectrum (IRLED's) typically are formed by diffusing an element, such as zinc, into a gallium arsenide compound.

Photodiodes and phototransistors use either bulk or epitaxial silicon, depending upon the final device configuration and desired characteristics. Optically coupled isolators consist of a GaAs infrared LED and a silicon phototransistor that are electrically isolated but optically coupled.

CRYSTAL GROWTH

The majority of visible LED products have a gallium arsenide substrate. The single crystals necessary for reproducible-device manufacture are prepared by either a Bridgman or Czochralski method. In the former, a seed of single-crystal GaAs, previously prepared and oriented in the appropriate crystal-line direction, is placed in a "boat" that has a semi-cylindrical cross-section. The boat is placed at one end of a quartz reaction vessel into which, at a high temperature (approximately 1250°C), is introduced high-purity gallium and arsenic. The gallium and arsenic combine and, with the continued application of heat, become a homogenous liquid. As the heat source is slowly moved away from the seed end of the vessel, a crystal begins to grow onto the seed. If all parameters are correct, the new crystal assumes the orientation of the seed. To give the crystal the desired electrical properties, the material is doped with special impurity atoms. Unwanted impurities are held to a level of less than one part per million.

In the Czochralski method, polycrystalline GaAs material is first synthesized separately, using the Bridgman technique. This material is then placed in a quartz cup or crucible, covered with liquid glass, and melted. An overpressure of inert gas over the glass prevents the gallium arsenide from breaking down into separate elements. A seed crystal, prepared in a manner similar to that used in the Bridgman technique, is lowered on a rotating rod to the surface of the molten GaAs. When the correct temperature has been established, the rotating seed is slowly pulled up, causing a crystal to grow onto it. The diameter and shape of the new crystal are determined by controlling the temperature of the liquid GaAs and the speed with which the seed is raised; electrical properties are determined by doping. Gallium phosphide single-crystal ingots are produced by the Czochralski method in much the same manner as gallium arsenide crystals, except that a higher liquid temperature and much greater overpressure are required.

The Czochralski process takes a great deal of operator skill and experience, but can be used to grow larger and longer crystals than is possible with the Bridgman technique. The Bridgman method, however, lends itself more readily to automation. At Fairchild, both techniques are used to achieve an optimum product mix and the lowest possible materials cost.

PROCESSING

After the single-crystal ingot has cooled, it is visually inspected and its electrical properties measured. The ingot is then placed on a precision diamond saw, aligned with a laser to the orientation needed for the next process step (epitaxy), and a slice removed from the exposed end. This slice is examined with an x-ray diffractometer to verify that proper orientation has been achieved. If orientation is correct, the entire ingot is cut into thin slices. These slices are cleaned, lapped, and chemically polished to a damage-free finish. After a final cleaning, the slices, or substrate wafers, are inspected for thickness, parallelism, and polish quality.

EPITAXY

In one of the most critical steps in the LED manufacturing process, each polished GaAs or GaP substrate wafer next has an epitaxial layer deposited on it. This layer is an alloy of GaAs and GaP, the final composition of which determines the color of the light emitted by the LED.

To grow the epitaxial layer, the wafer is placed in a chemical vapor deposition (CVD) reactor, through which gases can flow. The wafer is heated in hydrogen and etched with hydrogen chloride gas to clean its surfaces to a greater degree than is possible with mechanical devices in air. Very-high-purity atoms of arsenic, phosphorous, gallium, and dopant material are then deposited on the wafer in a manner that duplicates the single-crystal nature of the wafer. The composition of the alloy is varied to attain the desired final composition, with the dopant depositing the correct amount of impurity atoms in the layer.

With the layer deposited, the epitaxial wafer is inspected and tested to ensure that it emits the correct light color. The epi wafer then becomes the starting material for the wafer fabrication process.

WAFER FABRICATION

The first step in wafer fabrication is growing a layer of silicon nitride over the epi-wafer surface. Windows are then defined on the wafer using photolithographic techniques, and the necessary impurities diffused into the surface at a high temperature. The shape of the junctions thus formed is dictated by the type of device being manufactured. The nitride layer not only defines the junctions, or dice, but also provides passivation to ensure long-term reliability and high light output.

Again using photolithography, aluminum metal patterns are deposited on the wafer to make contact with the dice. The wafer is then lapped from its back side to a final thickness, which depends upon required die size. Gold and germanium are evaporated onto the back of the wafer and alloyed into the substrate in a furnace. A final layer of gold is applied to provide the best surface for subsequent steps.

After further visual and electrical testing, lines are scribed between the dice on the wafer. This puts a fracture along the crystallographic planes so that a small strain breaks the wafer into individual dice. The dice are bonded onto headers, lead frames, or printed circuit boards to form a strong mechanical connection, as well as to make good electrical contact. Wires are bonded to the front-side metallization to make electrical contact between the device and the package leads. The device is then packaged by encapsulation, or by attaching a light pipe and lens to the lead frame or printed circuit board.

ENCAPSULATION MATERIALS

The plastic materials used in die encapsulation must exhibit the following properties:

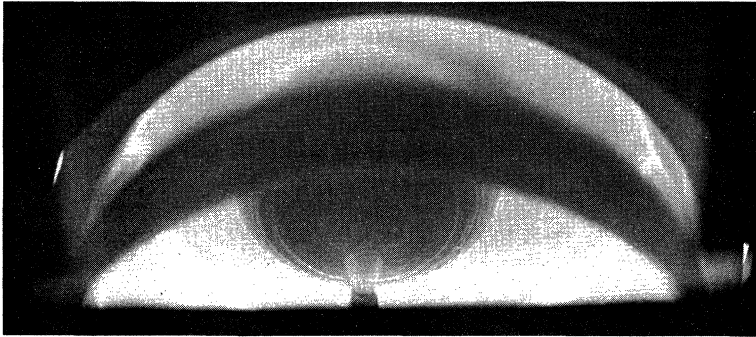
A high degree of light transmission within the rated environmental conditions for the life of the device.

Good adherence of the material to the die, including protection of the die from moisture.

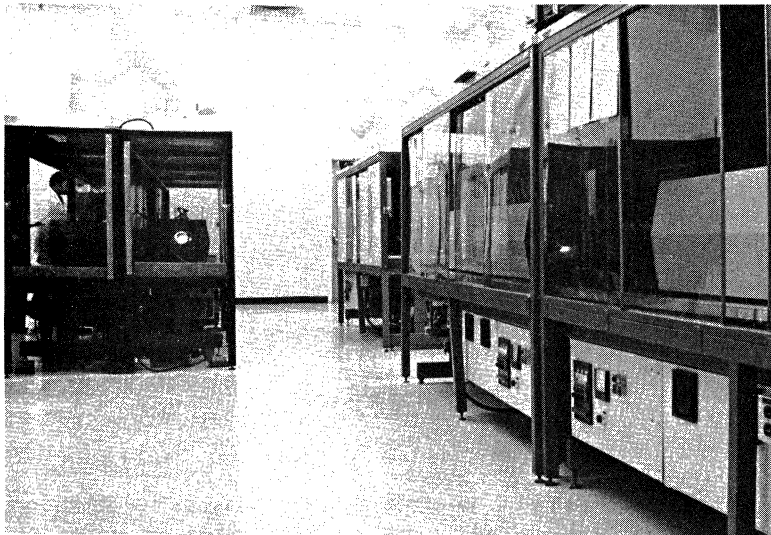
Thermal expansion coefficients approximating those of the other materials in the device.

Handling and curing properties that are practical for high-volume manufacturing.

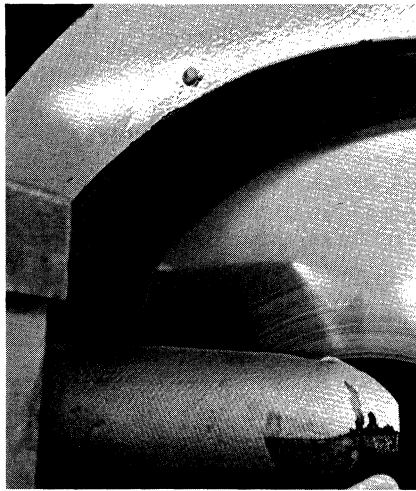
The choice of materials having all of these properties is limited. Additionally, digits that use internal reflecting cavities or light pipes require plastic parts that either have intrinsically high reflectance or are capable of being plated to obtain high reflectance. This further limits the choice of materials in those applications, and often precludes the use of fillers. These fillers, which are used in the epoxies and silicones added to the encapsulations of other electronic components, can tailor the expansion, viscosity, and adhesion properties of plastics to promote compatibility of the various piece parts and improve environmental ratings. Because of the limitations on the use of fillers, the maximum temperature rating for LED lamps is typically 100° C and for digits is typically 85° C. These temperatures are lower than those normally encountered in the soldering operation.



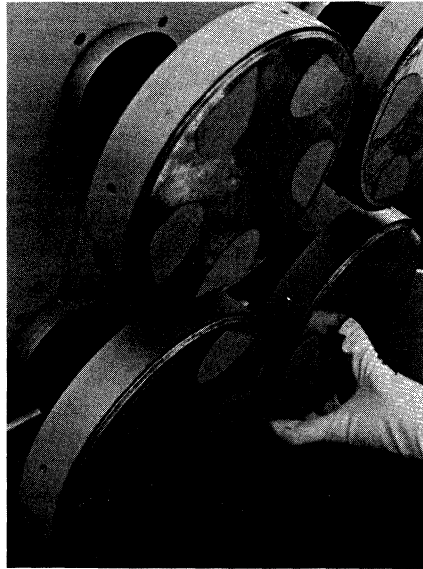
CZOCHELSKI CRYSTAL GROWER



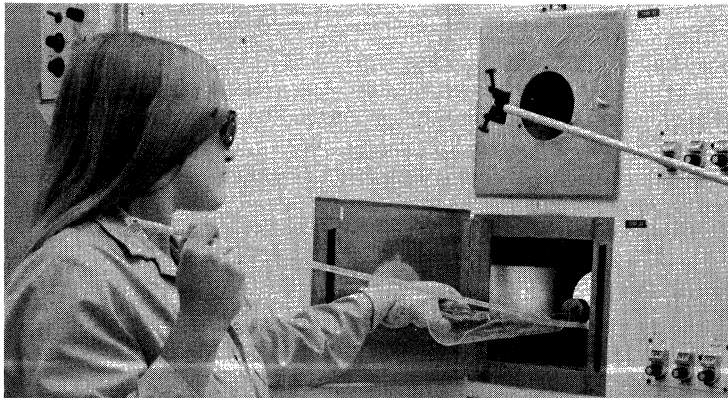
BRIDGMAN GaAs CRYSTAL GROWING ROOM



SLICING A GaAs INGOT WAFER



WAFER POLISHING



LOADING DIFFUSION FURNACE

Since material choice is so limited, the range of cleaning solvents that do not attack the lamp or digit is also reduced. Some popular solvents produce minor cosmetic blemishes, while others destroy the effective use of the device.

SOLDERING METHODS

When incorporating LED devices into circuits, care must be taken that the maximum temperature rating and maximum solder temperature-time rating are not exceeded. The latter specification is the point at which the maximum temperature internal to the device is reached, allowing in the case of digits, for example, a slightly increased ambient temperature of approximately 40°C. If the digit temperature exceeds 40°C prior to soldering, such as occurs with the preheat step sometimes used in wave soldering, a reduced soldering time is necessary.

For example, with the digit temperature initially at 55°C, the maximum soldering time would be about 2 1/2 seconds. Wave soldering conditions, in particular, vary widely, and the preheat temperature itself may exceed the digit maximum temperature rating. Elimination of preheating might be considered in such a case; at a minimum, the heating should be greatly reduced and soldering time minimized within acceptable soldering criteria. Alternative solutions are to place a thermal shield over the devices during the preheat stage, to use sockets or socket pins, or to change to hand soldering.

Stress on leads during soldering should also be considered. Bending of leads to hold devices in place is satisfactory, but care should be taken in bending the leads in printed circuit board holes to avoid high tensile forces. Over-heating during soldering could then weaken the device internally, possibly causing a board assembly or field failure.

CLEANING

For pre-solder cleaning and fluxing, chemicals should be chosen that do not damage the device case or leads. If the customary chemicals are unsatisfactory, it will be readily apparent from a visual examination of the package and lead surfaces. For example, leads are commonly silver-plated; an unsatisfactory flux generally forms silver sulfide, which turns the plated leads a dark brown or black and may interfere with solderability.

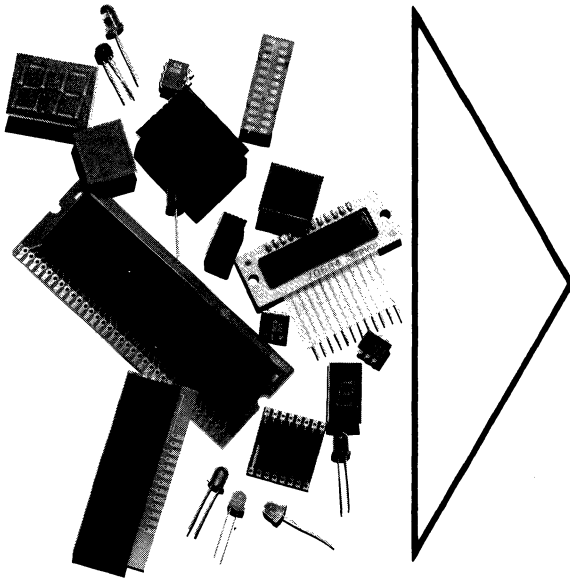
For devices having polycarbonate cases, cleaning solvents should be limited to such non-corrosive types as Freon* TF, isopropyl alcohol, and methyl alcohol. Lead-frame lamps may also be cleaned with acetone, chlorobenzene, chloroethane N.U., toluene, or xylene. Care should be taken in all cases to avoid contamination of the solvent. Freon* TE is also satisfactory; however, it may result in minor cosmetic defects, such as softening or blistering of the device back-fill epoxy surface.

*Trademark of E.I. duPont De Nemours Company

Another consideration, especially in the case of digits with air cavities, is the possibility of the solvent leaking into the package. The emitting die is enclosed in epoxy, so solvent within the digit should not present a reliability problem. Instead, the appearance of the digit may be affected, either in the off condition, the on condition, or both. The effect may be of a minor, acceptable nature.

A more pronounced leakage situation occurs when a heated digit is immersed in a cool solvent, creating a siphonage of solvent into the package. This leakage can be minimized by avoiding device immersion. Instead, for example, water, detergent, and other cleaners may be sprayed onto the bottom of the printed circuit board with the digit seating plane in a horizontal, downward position so that the solvents would tend to flow over the board surface.





OPTOELECTRONIC TECHNOLOGY	1
DISCRETE LED DIGIT RELIABILITY	2
VISIBLE LED LAMPS AND MOUNTING HARDWARE	3
SEVEN-SEGMENT DISPLAYS AND DISPLAY ARRAYS	4
PHOTOTRANSISTORS, INFRARED EMITTERS, AND SENSORS	5
PHOTOCOUPLEDERS	6
PACKAGE OUTLINES	7
DEFINITIONS OF SYMBOLS AND TERMS	8
FAIRCHILD FIELD SALES OFFICES, SALES REPRESENTATIVES AND DISTRIBUTOR LOCATIONS	9

CHAPTER 2

DISCRETE LED DIGIT RELIABILITY

Display digits are typically used in groups, and the failure of a single element represents a failure of the entire display. Reliability must therefore be a major consideration in digit development and manufacture.

The design and production of Fairchild digits draws upon expertise gained through years of experience in high-volume production of plastic-encapsulated integrated circuits and optical products, for which a high level of reliability has been established.

DESIGN CONSIDERATIONS

The LED die used for each digit segment of decimal point is identical to that used in individual LED lamp products, so that extensive experience with design criteria for reliable performance is directly applicable. Also directly applicable are years of working with the metal contact systems of silicon integrated circuits, which require much the same level of ohmic contact and mechanical integrity as die metallization.

The inherent die reliability is preserved through careful selection of the materials and processes used to attach the die to the leadframe. The die and bonding wires, for example, are protected by complete encapsulation, and an encapsulated header allows the die and bonding wires to withstand mechanical and thermal stresses. The lens cap likewise has adequate dimensional tolerances to assure minimal mechanical stress on the integral header lenses under environmental stress conditions. The epoxy back-fill encapsulation used to attach the header and lens cap provide a good moisture seal.

All purchased materials for Fairchild digits are controlled through Optoelectronics Division product engineering, and through reliability and quality assurance (R&QA). Materials are purchased and inspected per control documents approved by R&QA; three methods are used to determine quality:

Direct inspection per control documents, in which emphasis is placed on checking dimensions and physical properties of plastic piece parts and lead frames.

Functional testing, in which tests are conducted to assure die attachment and bonding quality of the lead frames and dice.

Chemical inspection, in which a scanning electron microscope (SEM) and an Auger electron spectroscope are used for detailed chemical analysis.

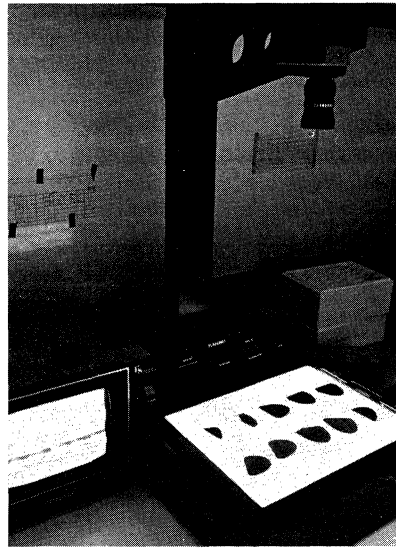
DEVICE TESTING

The following QA sample inspection levels are applied both before a digit batch is shipped and after 100% production testing to customer specifications:

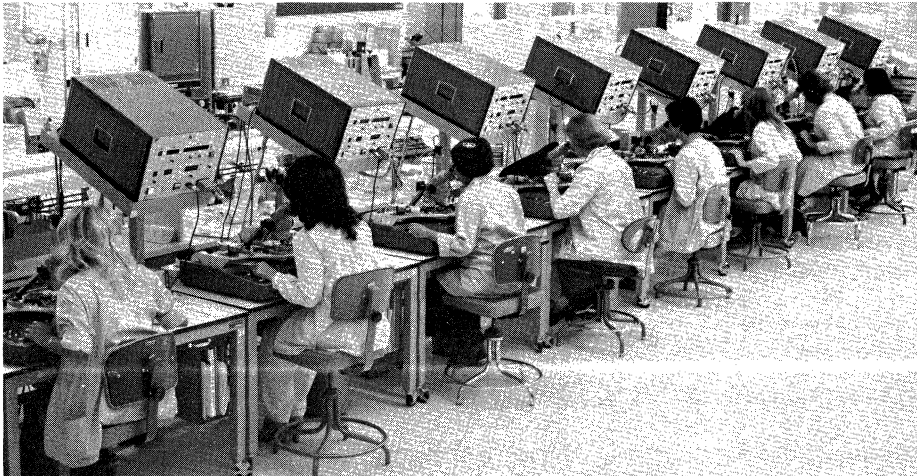
Catastrophic (opens and shorts) - 0.25% AQL
Optoelectrical parameters - 1.0% AQL
Mechanical/visual light-up - 1.0% AQL
Mechanical/visual non-light-up - 1.5% AQL



WAFER INSPECTION



MEASURING WAFER FOR YIELD



RELIABILITY TESTING

Additionally, special customer requirements are accommodated through an internal specification system. All internal test specifications are verified as satisfying customer requirements before being forwarded to the test area.

Fairchild provides digits that meet or exceed customer reliability requirements. However, reliability in the customer application is the final measure of performance. Besides digit design, assembly, and testing, therefore, digit end reliability is also affected by the customer's processes for handling the digit, the digit operating circuit, and the equipment that contains the digit.

The analysis of assembly and system failures by customers and by Fairchild on returned digits provides one of the most important inputs to the Fairchild total reliability program.

RELIABILITY MONITOR AND CONTROL

Reliability monitor programs are established in each of Fairchild's manufacturing facilities, as well as at the reliability engineering facility. Functional testing is conducted under simulated environmental conditions, and accelerated stress testing is conducted to highlight any latent failure mechanisms. Several of these tests, described below, are part of Fairchild's continuing stress test program. The results presented typify those for the accelerated life test conditions applied in the tests and should not be used as an implied warranty of performance in any given application.

Burn-In

A high-temperature burn-in test has been conducted weekly with an average sample size of over 3000 digits per month. The test consists of operation at a bias of 20 mA per segment and decimal point with an ambient temperature of 70°C for two hours duration. As most early failures occur within this period, this test has had good correlation with failures in customer burn-in. As shown in Table 2-1, results are almost the same for longer-term tests. Compared to the indicated failure rate of about 1/4%, the customer-reported system burn-in failure rate generally averages in the range of 1/4%, to 1/2%, due to the various processes used in printed circuit board assembly. This is in addition to incoming and printed circuit board assembly failures, prior to burn-in, which have been reported to be about 0.4%.

Temperature Cycling and Shock

Subjecting digits to recurring thermal stress measures the dimensional and thermal expansion compatibility of internal parts. Results of reduced cycle, air-to-air temperature cycling tests and thermal-shock tests, shown in Tables 2-2 and 2-3, are used to assure continued control of assembly operations and piece-part acceptability.

Mechanical Shock

Another dimensional compatibility test used for assembly process and piece-part monitoring consists of a one-meter drop of digits in two axes in a test fixture. Significant failures quickly flag a problem for prompt action. Table 2-4 shows representative test results.

Gross Leak

Although back-fill epoxy encapsulation protects the digit from moisture, this encapsulation is not always totally effective. As a result, a small part of the production distribution will leak if immersed in fluid. This must be considered if, for example, thermal shock is likely to occur in a liquid bath or flux removal is accomplished in a bath. A weekly monitor measures the integrity of the back seal in a gross leak test. This test consists of preheating digits at 60°C and immersing them in Freon* TF for 30 seconds. This test functionally evaluates an assumed immersion cleaning technique. Accumulated test results are given in Table 2-5.

Solderability

Frequent solderability monitoring is conducted. This test criterion is 90% solder coverage in a 260°C, 5-second solder dip. Table 2-6 shows typical test results.

FAILURES MODES

Failures generated by the monitoring tests, life tests, and in the field are analyzed to identify needed corrective action in device design, assembly, or testing. The major failure mode has been found to be an open segment, which is often caused by excessive heating either during printed circuit board soldering or during operation when a bias exceeding the device ratings is applied.

COMPREHENSIVE TESTING

Several times a year, all digit types are evaluated in a series of comprehensive reliability tests, including extended temperature cycling, thermal shock, and operating life tests.

New LED digit types are qualified prior to introduction by an even more extensive series of reliability tests. Acceptance criteria are established for each test to assure good performance in the variety of environments expected in each application.

NOTE: The data in the following tables represents results obtained in recent history. LED digit reliability is expected to show the continued improvement evidenced in past data.

**TABLE 2-1.
OPERATING MONITOR TEST RESULTS**

I_F = 20 mA/Segment and Decimal Point

DEVICE	CONDITIONS	SAMPLE	FAILURES	PERCENTAGE
FND357	70°C, 2 hrs*	16,383	26	0.16
FND500/507	70°C, 2 hrs*	6,321	11	0.17
FND357	25°C, 100 hrs	1,090	2	0.18
FND500/507	25°C, 100 hrs	3,323	6	0.18

*Long term failure rates should not be based on these results since they are only a measure of infant mortality.

*Trademark of E.I. duPont De Nemours Company

**TABLE 2-2.
TEMPERATURE CYCLING MONITOR RESULTS**

T_A = 25°C to +85°C, 2 Cycles

DEVICE TYPE	SAMPLE	FAILURES	PERCENTAGE
FND357	4,721	18	0.4
FND500/507	3,365	6	0.2

**TABLE 2-3.
THERMAL SHOCK MONITOR RESULTS**

T_A = 0 °C +85°C Water Baths, 15 Cycles

DEVICE TYPE	SAMPLE	FAILURES	PERCENTAGE
FND357	2,500	5	0.20
FND500/507	4,824	14	0.29
FND800/807	450	1	0.22

**TABLE 2-4.
MECHANICAL SHOCK MONITOR RESULTS**

One Meter Drop in Two Axes (Concrete Surface)

DEVICE TYPE	SAMPLE	FAILURES	PERCENTAGE
FND357	3,960	16	0.40
FND500/507	440	2	0.45

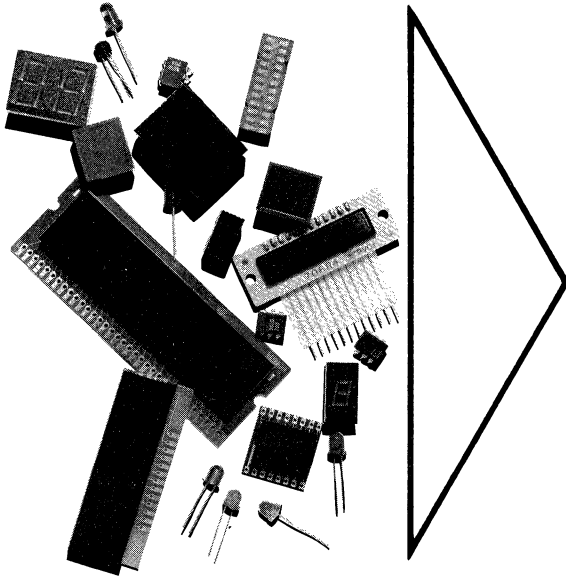
**TABLE 2-5.
GROSS LEAK MONITOR RESULTS**

60°C Bake, Immersion in 25°C Freon TF for 30 Seconds

DEVICE TYPE	SAMPLE	FAILURES	PERCENTAGE
FND357	2,199	47	2.1
FND500/507	3,296	80	2.4
FND800/807	1,900	11	0.6

**TABLE 2-6.
SOLDERABILITY MONITOR RESULTS**

DEVICE TYPE	SAMPLE	FAILURES	PERCENTAGE
FND357	1,600	1	0.1
FND500/507	2,300	5	0.2
FND800/807	1,050	0	0



OPTOELECTRONIC TECHNOLOGY	1
DISCRETE LED DIGIT RELIABILITY	2
VISIBLE LED LAMPS AND MOUNTING HARDWARE	3
SEVEN-SEGMENT DISPLAYS AND DISPLAY ARRAYS	4
PHOTOTRANSISTORS, INFRARED EMITTERS, AND SENSORS	5
PHOTOCOUPLEDERS	6
PACKAGE OUTLINES	7
DEFINITIONS OF SYMBOLS AND TERMS	8
FAIRCHILD FIELD SALES OFFICES, SALES REPRESENTATIVES AND DISTRIBUTOR LOCATIONS	9

CHAPTER 3 INTRODUCTION

A solid state, or light-emitting diode (LED), lamp is a pn junction that emits light when forward-biased. These lamps have a multitude of uses, from complex array displays to simple on/off status indicators.

The Fairchild LED lamp products that emit light in the visible spectrum are made of complex gallium phosphide or gallium arsenide phosphide compounds. The light output of such compounds typically peaks at a wave-length of from 565 to 670 nanometers (nm); this peak can be varied by changing the exact composition for a particular purpose (see Table 31-).

Since these devices characteristically resemble a forward-biased diode with a break-down voltage of approximately 1.6 V, they are ideal for use in all forms of low-voltage, low-power circuits. Among the other advantages solid state lamps have over other light sources are:

- Very fast response times (rise and fall times in the submicrosecond range).
- Small size
- Low power consumption
- Light weight
- Long life (typically greater than 100,000 hours)
- Low impedance (compatible with most semiconductor circuitry)
- Low heat generation

**TABLE 3-1.
VISIBLE LED PERFORMANCE**

LED TYPE	COLOR OF LIGHT	WAVELENGTH OF LIGHT (nm)	RELATIVE OPTICAL SENSITIVITY (LUMENS/OPTICAL W)	EFFICIENCY (PERCENT)	VISUAL MERIT (LUMENS/ELECTRICAL W)
GaAsP/GaAs	Red	670	20	0.1	0.02
GaAsP/GaAs	Red	660	40	0.03	0.012
GaAsP/GaP	Amber	635	140	0.14	0.2
GaAsP/GaP	Yellow	585	500	0.04	0.2
GaP/GaP	Green	565	590	0.05	0.30

**COMMERICAL DEVICE
PERFORMANCE**

FAIRCHILD LED LAMP CROSS REFERENCE KEY

COMPETITOR:

HP	Hewlett-Packard
MON	Monsanto
NAT	National Semiconductor
DIA	Dialight
TI	Texas Instruments
LIT	Litronix
XCT	Xciton

3

CODE:

NC-P	Not Crossable Because of Package Differences
NC-C	Not Crossable Because of Color Differences
NC-E	Not Crossable Because of Electrical Differences
A	Fairchild Device is a Direct Replacement
B	Fairchild Device is Easily Crossable with Minor Electrical Deviations as Noted
C	Fairchild Device is Easily Crossable with Minor Mechanical Deviations as Noted
D	Significant Electrical Differences Between Devices as Noted
E	Significant Mechanical Differences Between Devices as Noted

NOTES:

1	Fairchild Device is Screened for Intensity
2	Competitor Device is Point Source
3	Competitor Device has Pins Bent 90 Degrees
4	Competitor Device has .090" Pin Spacing
5	Competitor Device is Clear Diffused Package
6	Competitor Device is Water Clear Package
7	Package Height/Dimension Difference Between Devices
8	Pin Length Difference Between Devices
9	.025" Square Pins and .285" Lens on Competitor Device
10	Viewing Angle Difference Between Devices
11	Wavelength Difference Between Devices
12	.025" Square Pins with Standoffs on Competitor Device
13	Competitor Device is T-1 1/2 Lamp Size
14	Competitor Lamp is Flangeless Lamp
15	Competitor Lamp is Subminiature Sized with Radial Pins
16	Competitor Lamp has Metal Base
17	Fairchild Device is GaP Technology
18	Competitor Device has .075" Pin Spacing

FAIRCHILD LED CROSS REFERENCE

DEVICE	COMPETITOR	DESCRIPTION	FAIRCHILD		NOTES
			DEVICE	CODE	
1N5765	HP	Hermetic LED Lamp, Red		NC-P	TO-46 pkg.
JANTX 1N5765	HP	Hermetic LED Lamp, Red		NC-P	TO-46 pkg.
JAN 1N5765	HP	Hermetic LED Lamp, Red		NC-P	TO-46 pkg.
5082-4100	HP	LED Lamp, Red		NC-P	15
5082-4101	HP	LED Lamp, Red		NC-P	15
5082-4150	HP	LED Lamp, Yellow		NC-P	15
5082-4160	HP	LED Lamp, Red		NC-P	15
5082-4190	HP	LED Lamp, Green		NC-P	15
5082-4403	HP	LED Lamp, Red	FLV160	C	8,16
5082-4415	HP	LED Lamp, Red	FLV160	E	3,16
5082-4420	HP	Hermetic LED Lamp, Red		NC-P	TO-46 pkg.
5082-4440	HP	LED Lamp, Red	FLV160	C	8,16
5082-4444	HP	LED Lamp, Red	FLV160	E	3,16
5082-4468	HP	LED Lamp, Red		NC-E	Resistor
5082-4480	HP	LED Lamp, Red	TIL209A	C	4,8
5082-4483	HP	LED Lamp, Red	TIL209A	E	4,5,8
5082-4484	HP	LED Lamp, Red	TIL209A	C	4,8
5082-4486	HP	LED Lamp, Red	TIL209A	E	4,6,8
5082-4487	HP	LED Lamp, Red	TIL209A	E	4,5,7,8
5082-4488	HP	LED Lamp, Red	TIL209A	E	4,5,7,8
5082-4494	HP	LED Lamp, Red	TIL209A	C	4,8
5082-4520	HP	Hermetic LED Lamp, Yellow		NC-P	TO-46 pkg.
5082-4550	HP	LED Lamp, Yellow	MV5353	C	8
5082-4555	HP	LED Lamp, Yellow	MV5353	C	8
5082-4557	HP	LED Lamp, Yellow	MV5354	C	8
5082-4558	HP	LED Lamp, Yellow	MV5354	B/C	1,8
5082-4570	HP	Rectangular LED, Yellow		NC-P	
5082-4584	HP	LED Lamp, Yellow	TIL213	C	4,8
5082-4590	HP	LED Lamp, Yellow	FLV440	C	8
5082-4592	HP	LED Lamp, Yellow	FLV440	B/C	1,8
5082-4595	HP	LED Lamp, Yellow	FLV441	C	8
5082-4597	HP	LED Lamp, Yellow	FLV441	B/C	1,8
5082-4620	HP	Hermetic LED Lamp, Red		NC-P	TO-46 pkg.
5082-4650	HP	LED Lamp, Red	MV5753	C	8
5082-4655	HP	LED Lamp, Red	MV5753	C	8
5082-4657	HP	LED Lamp, Red	MV5754	C	8
5082-4658	HP	LED Lamp, Red	MV5752	C	8
5082-4670	HP	Rectangular LED, Red		NC-P	
5082-4684	HP	LED Lamp, Red	TIL209A	B/C	4, Super GaAsP
5082-4690	HP	LED Lamp, Red	FLV540	C	8
5082-4693	HP	LED Lamp, Red	FLV540	B/C	1,8
5082-4694	HP	LED Lamp, Red	FLV540	E	2,8
5082-4695	HP	LED Lamp, Red	FLV540	E	2,8
5082-4707	HP	Mounting Clip	MP52	A	
5082-4732	HP	Voltage Sensing LED Lamp, Red		NC	
5082-4790	HP	LED Lamp, Red	FLV140	C	8
5082-4791	HP	LED Lamp, Red	FLV140	B/C	1,8
5082-4850	HP	LED Lamp, Red	MV5053	C	12
5082-4855	HP	LED Lamp, Red	MV5053	C	12
5082-4860	HP	LED Lamp, Red		NC-E	Resistor

FAIRCHILD LED CROSS REFERENCE

DEVICE	COMPETITOR	DESCRIPTION	FAIRCHILD		NOTES
			DEVICE	CODE	
5082-4880	HP	LED Lamp, Red	MV5054-1	C	12,16
5082-4881	HP	LED Lamp, Red	MV5054-1	C	12,16
5082-4882	HP	LED Lamp, Red	MV5054-2	C	12,16
5082-4883	HP	LED Lamp, Red	MV5054-1	E	6,12,16
5082-4884	HP	LED Lamp, Red	MV5054-1	E	6,12,16
5082-4885	HP	LED Lamp, Red	MV5054-2	E	6,12,16
5082-4886	HP	LED Lamp, Red	MV5054-1	E	5,12,16
5082-4887	HP	LED Lamp, Red	MV5054-1	E	5,12,16
5082-4888	HP	LED Lamp, Red	MV5054-2	E	5,12,16
5082-4920	HP	LED Lamp, Green		NC-P	TO-46 pkg.
5082-4950	HP	LED Lamp, Green	MV5253	C	8
5082-4955	HP	LED Lamp, Green	MV5253	B/C	1,8
5082-4957	HP	LED Lamp, Green	MV5254	B/C	1,8
5082-4958	HP	LED Lamp, Green	MV5252	B/C	1,8
5082-4970	HP	Rectangular LED, Green		NC-P	
5082-4984	HP	LED Lamp, Green	TIL211	C	4
5082-4990	HP	LED Lamp, Green	FLV340	C	8
5082-4992	HP	LED Lamp, Green	FLV340	B/C	1,8
5082-4995	HP	LED Lamp, Green	FLV341	C	8
5082-4997	HP	LED Lamp, Green	FLV341	B/C	1,8
MV 10B	MON	LED Lamp, Red		NC-P	
MV 50	MON	LED Lamp, Red		NC-P	
MV 52	MON	LED Lamp, Green		NC-P	
MV 53	MON	LED Lamp, Green		NC-P	
MV 54	MON	LED Lamp, Red		NC-P	
MV 55	MON	LED Lamp, Red		NC-P	
MV 5020	MON	LED Lamp, Red	FLV161	E	6,10
MV 5021	MON	LED Lamp, Red	FLV160	E	5,10
MV 5022	MON	LED Lamp, Red	FLV161	C	10
MV 5023	MON	LED Lamp, Red	FLV160	C	10
MV 5024	MON	LED Lamp, Red	FLV160	C	10
MV 5025	MON	LED Lamp, Red	FLV160	C	10
MV 5026	MON	LED Lamp, Red	FLV160	C	10
MV 5050	MON	LED Lamp, Red	MV5050	A	8
MV 5051	MON	LED Lamp, Red	MV5051	A	8
MV 5052	MON	LED Lamp, Red	MV5052	A	8
MV 5053	MON	LED Lamp, Red	MV5053	A	8
MV 5054-1	MON	LED Lamp, Red	MV5054-1	A	8
MV 5054-2	MON	LED Lamp, Red	MV5054-2	A	8
MV 5054-3	MON	LED Lamp, Red	MV5054-3	A	8
MV 5055	MON	LED Lamp, Red	MV5055	A	8
MV 5056	MON	LED Lamp, Red	MV5056	A	8
MV 5074B	MON	LED Lamp, Red	TIL209A	C	8
MV 5074C	MON	LED Lamp, Red	TIL209A	C	8
MV 5075B	MON	LED Lamp, Red	TIL209A	C	8
MV 5075C	MON	LED Lamp, Red	TIL209A	C	8
MV 5077B	MON	LED Lamp, Red	TIL209A	E	7,8

3

FAIRCHILD LED CROSS REFERENCE

DEVICE	COMPETITOR	DESCRIPTION	FAIRCHILD		NOTES
			DEVICE	CODE	
MV 5077C	MON	LED Lamp, Red	TIL209A	E	7,8
MV 5152	MON	LED Lamp, Orange	MV5152	A	8
MV 5153	MON	LED Lamp, Orange	MV5153	A	8
MV 5154	MON	LED Lamp, Orange	MV5154	A	8
MV 5252	MON	LED Lamp, Green	MV5252	A	8
MV 5253	MON	LED Lamp, Green	MV5253	A	8
MV 5254	MON	LED Lamp, Green	MV5254	A	8
MV 5352	MON	LED Lamp, Yellow	MV5352	A	8
MV 5353	MON	LED Lamp, Yellow	MV5353	A	8
MV 5354	MON	LED Lamp, Yellow	MV5354	A	8
MV 5752	MON	LED Lamp, Red	MV5752	A	8
MV 5753	MON	LED Lamp, Red	MV5753	A	8
MV 5754	MON	LED Lamp, Red	MV5754	A	8
MV 5174B	MON	LED Lamp, Orange		NC-P	
MV 5174C	MON	LED Lamp, Orange		NC-P	
MV 5177B	MON	LED Lamp, Orange		NC-P	
MV 5177C	MON	LED Lamp, Orange		NC-P	
MV 5274B	MON	LED Lamp, Green	TIL211	C	8
MV 5274C	MON	LED Lamp, Green	TIL211	C	8
MV 5277B	MON	LED Lamp, Green	TIL211	E	7,8
MV 5277C	MON	LED Lamp, Green	TIL211	E	7,8
MV 5374B	MON	LED Lamp, Yellow	TIL213	C	8
MV 5374C	MON	LED Lamp, Yellow	TIL213	C	8
MV 5377B	MON	LED Lamp, Yellow	TIL213	E	7,8
MV 5377C	MON	LED Lamp, Yellow	TIL213	E	7,8
MV 5774B	MON	LED Lamp, Red	TIL209A	B/C	8,11
MV 5774C	MON	LED Lamp, Red	TIL209A	B/C	8,11
MV 5777B	MON	LED Lamp, Red	TIL209A	D/E	1,7,8,11
MV 5777C	MON	LED Lamp, Red	TIL209A	D/E	1,7,8,11
MV 5094	MON	LED Lamp, Red/Green		NC-P	Bipolar
MV 5491	MON	LED Lamp, Red/Green		NC-P/E	Tri-state
MP 21	MON	Mounting Hardware, Clear		NC-P	
MP 22	MON	Mounting Hardware, Black		NC-P	
MP 51	MON	Mounting Hardware, Clear	MP52	E	Clear
MP 52	MON	Mounting Hardware, Black	MP52	A	
NSL 4944	NAT	LED Lamp, Red		NC-E	
NSL 5072A	NAT	LED Lamp, Red	TIL209A	E	2,7
NSL 5076A	NAT	LED Lamp, Red	TIL209A	A	
NSL 5020	NAT	LED Lamp, Red	FLV161	E	6,12,13
NSL 5022	NAT	LED Lamp, Red	FLV161	E	13
NSL 5023	NAT	LED Lamp, Red	FLV160	E	13
NSL 5024	NAT	LED Lamp, Red	FLV160	E	13
NSL 5026	NAT	LED Lamp, Red	FLV160	E	13
NSL 5027	NAT	LED Lamp, Red	FLV160	B/E	1,13
NSL 5040	NAT	LED Lamp, Red	FLV141	E	6,7,14
NSL 5041	NAT	LED Lamp, Red	FLV140	E	5,7,14
NSL 5042	NAT	LED Lamp, Red	FLV141	C	7,14

FAIRCHILD LED CROSS REFERENCE

DEVICE	COMPETITOR	DESCRIPTION	FAIRCHILD DEVICE	CODE	NOTES
NSL 5043	NAT	LED Lamp, Red	FLV140	C	7,14
NSL 5046	NAT	LED Lamp, Red	FLV140	C	7,14
NSL 5050	NAT	LED Lamp, Red	MV5050	C	12
NSL 5052	NAT	LED Lamp, Red	MV5052	C	12
NSL 5053	NAT	LED Lamp, Red	MV5053	C	12
NSL 5056	NAT	LED Lamp, Red	MV5053	C	12
NSL 5057	NAT	LED Lamp, Red		NC-P	
NSL 5080	NAT	LED Lamp, Red	TIL209A	E	6
NSL 5081	NAT	LED Lamp, Red	TIL209A	E	1,5
NSL 5082	NAT	LED Lamp, Red	TIL209A	E	2
NSL 5086	NAT	LED Lamp, Red	TIL209A	B	1
NSL 5252	NAT	LED Lamp, Green	MV5252	C	8
NSL 5253	NAT	LED Lamp, Green	MV5253	C	8
NSL 5352	NAT	LED Lamp, Green	MV5253	C	8
NSL 5353	NAT	LED Lamp, Green	MV5353	C	8
249-SERIES	DIA	Mini LED Indicator Lights		NC-P	
521-9165	DIA	LED Lamp, Red	FLV110	A	
521-9166	DIA	LED Lamp, Red	FLV112	A	
521-9178	DIA	LED Lamp, Red	FLV160	A	
521-9179	DIA	LED Lamp, Red	FLV160	C	7
521-9180	DIA	LED Lamp, Red	FLV130	A	
521-9181	DIA	LED Lamp, Red		NC-P	
521-9183	DIA	LED Lamp, Red		NC-E	Resistor
521-9184	DIA	LED Lamp, Red		NC-E	Resistor
521-9185	DIA	LED Lamp, Red		NC-P	
521-9186	DIA	LED Lamp, Red		NC-P	
521-9189	DIA	LED Lamp, Red	TIL209A	A	
521-9190	DIA	LED Lamp, Red	FLV111	A	
521-9195	DIA	LED Lamp, Red		NC-P	
521-9200	DIA	LED Lamp, Red	FLV117	A	
521-9201	DIA	LED Lamp, Green		NC-P	
521-9202	DIA	LED Lamp, Green	FLV310	E	2,12
521-9203	DIA	LED Lamp, Green	FLV310	C	12
521-9204	DIA	LED Lamp, Yellow	FLV410	E	2,12
521-9205	DIA	LED Lamp, Yellow	FLV410	C	12
521-9206	DIA	LED Lamp, Green	TIL211	A	
521-9207	DIA	LED Lamp, Yellow	TIL213	A	
521-9208	DIA	LED Lamp, Yellow		NC-P	
521-9214	DIA	LED Lamp, Red	FLV117	E	3
521-9215	DIA	LED Lamp, Red		NC-P	Resistor
521-9216	DIA	LED Lamp, Red	TIL209A	E	4,7
521-9217	DIA	LED Lamp, Red	MV5053	A	
521-9222	DIA	LED Lamp, Red		NC-P	
521-9223	DIA	LED Lamp, Red		NC-P	
521-9230	DIA	LED Lamp, Red	FLV131	A	
521-9253	DIA	LED Lamp, Green	FLV311	A	
521-9254	DIA	LED Lamp, Yellow	FLV411	A	
547-SERIES	DIA	LED Logic Indicators		NC-P	

FAIRCHILD LED CROSS REFERENCE

DEVICE	COMPETITOR	DESCRIPTION	FAIRCHILD		NOTES
			DEVICE	CODE	
549-0101	DIA	LED Lamp, Red		NC-P	
549-0104	DIA	LED Lamp, Red		NC-P	
550-SERIES	DIA	LED Logic Indicators		NC-P	
555-SERIES	DIA	LED Logic Indicators		NC-P	
558-SERIES	DIA	LED Indicators		NC-P	
559-SERIES	DIA	LED Indicators		NC-P	
507-SERIES	DIA	LED Lamp Cartridges		NC-P	
TIL 209A	TI	LED Lamp, Red	TIL209A	A	
TIL 211	TI	LED Lamp, Green	TIL211	A	
TIL 220	TI	LED Lamp, Red	MV5053	C	8,12
TIL 221	TI	LED Lamp, Red	MV5050	C	8,12
TIL 222	TI	LED Lamp, Green	MV5253	C	8,12
TIL 261	TI	LED Light Sources, Red		NC-P	
TIL 262	TI	LED Light Sources, Red		NC-P	
TIL 263	TI	LED Light Sources, Red		NC-P	
TIL 264	TI	LED Light Sources, Red		NC-P	
TIL 265	TI	LED Light Sources, Red		NC-P	
TIL 266	TI	LED Light Sources, Red		NC-P	
TIL 267	TI	LED Light Sources, Red		NC-P	
TIL 268	TI	LED Light Sources, Red		NC-P	
TIL 269	TI	LED Light Sources, Red		NC-P	
TIL 270	TI	LED Light Sources, Red		NC-P	
TIL 271	TI	LED Light Sources, Green		NC-P	
TIL 272	TI	LED Light Sources, Green		NC-P	
TIL 273	TI	LED Light Sources, Green		NC-P	
TIL 274	TI	LED Light Sources, Green		NC-P	
TIL 275	TI	LED Light Sources, Green		NC-P	
TIL 276	TI	LED Light Sources, Green		NC-P	
TIL 277	TI	LED Light Sources, Green		NC-P	
TIL 278	TI	LED Light Sources, Green		NC-P	
TIL 279	TI	LED Light Sources, Green		NC-P	
TIL 280	TI	LED Light Sources, Green		NC-P	
TIL 281	TI	LED Light Sources, Amber		NC-P	
TIL 282	TI	LED Light Sources, Amber		NC-P	
TIL 283	TI	LED Light Sources, Amber		NC-P	
TIL 284	TI	LED Light Sources, Amber		NC-P	
TIL 285	TI	LED Light Sources, Amber		NC-P	
TIL 286	TI	LED Light Sources, Amber		NC-P	
TIL 287	TI	LED Light Sources, Amber		NC-P	
TIL 288	TI	LED Light Sources, Amber		NC-P	
TIL 289	TI	LED Light Sources, Amber		NC-P	
TIL 290	TI	LED Light Sources, Amber		NC-P	
RL 2	LIT	LED Lamp, Red	FLV110	A	
RL 2-02	LIT	LED Lamp, Red	FLV251	B	17
RL 2-03	LIT	LED Lamp, Red	FLV112	A	
RL 2-04	LIT	LED Lamp, Red	FLV111	A	
RL 20	LIT	LED Lamp, Red	MV5054-1	A	

FAIRCHILD LED CROSS REFERENCE

DEVICE	COMPETITOR	DESCRIPTION	FAIRCHILD		NOTES
			DEVICE	CODE	
RL 21	LIT	LED Lamp, Red	MV5053	C	8,12
RL 50	LIT	LED Lamp, Red		NC-P	
RL 50-01	LIT	LED Lamp, Red		NC-P	
RL 50-02	LIT	LED Lamp, Red		NC-P	
RL 50-03	LIT	LED Lamp, Red		NC-P	
RL 54	LIT	LED Lamp, Red		NC-P	
RL 55	LIT	LED Lamp, Red		NC-P	
RL 55-5	LIT	LED Lamp, Red		NC-P	
YL 56	LIT	LED Lamp, Yellow		NC-P	
GL 56	LIT	LED Lamp, Green		NC-P	
RL 209	LIT	LED Lamp, Red	TIL209A	C	8,18
RL T-1	LIT	LED Lamp, Red	TIL209A	E	8,14,18
RL 209-02	LIT	LED Lamp, Red	TIL209A	E	2,8,18
RL 209-03	LIT	LED Lamp, Red	TIL209A	E	5,8,18
RL 209-04	LIT	LED Lamp, Red	TIL209A	E	6,8,18
RL T1-02	LIT	LED Lamp, Red	TIL209A	E	2,8,14,18
RL T1-03	LIT	LED Lamp, Red	TIL209A	E	5,8,14,18
RL T1-04	LIT	LED Lamp, Red	TIL209A	E	6,8,14,18
RL 2000	LIT	LED Lamp, Red	MV5054-2	C	8,12
RL 4403	LIT	LED Lamp, Red	MV5053	C	8,12
RL 4415	LIT	LED Lamp, Red	MV5053	E	3,8,12
GL 4484	LIT	LED Lamp, Green	TIL211	C	8,18
YL 4484	LIT	LED Lamp, Yellow	TIL213	C	8,18
RL 4484	LIT	LED Lamp, Red	TIL209A	C	8,18
GL 4850	LIT	LED Lamp, Green	MV5253	C	8
YL 4850	LIT	LED Lamp, Yellow	MV5353	C	8
RL 4850	LIT	LED Lamp, Red	MV5053	C	8,12
RL 5054-1	LIT	LED Lamp, Red	MV5054-1	C	8,12
RL 5054-2	LIT	LED Lamp, Red	MV5054-2	C	8,12
RL C200	LIT	LED Lamp, Red		NC-E	
RL C201	LIT	LED Lamp, Red		NC-E	
RL C210	LIT	LED Lamp, Red		NC-E	
RL C410	LIT	LED Lamp, Red		NC-E	
OL 30	LIT	LED Lamp, Orange		NC-E	
XC 212	XCT	LED Lamp, Red		NC-P	T 3/4
XC 212G	XCT	LED Lamp, Green		NC-P	T 3/4
XC 212Y	XCT	LED Lamp, Yellow		NC-P	T 3/4
XC 212A	XCT	LED Lamp, Amber		NC-P	T 3/4
XC 209	XCT	LED Lamp, Red	TIL209A	A	
XC 209G	XCT	LED Lamp, Green	TIL211	A	
XC 209Y	XCT	LED Lamp, Yellow	TIL 213	A	
XC 209A	XCT	LED Lamp, Amber		NC-C	
XC 209-02	XCT	LED Lamp, Red	TIL209A	E	2
XC 209G-02	XCT	LED Lamp, Green	TIL211	E	2
XC 209Y-02	XCT	LED Lamp, Yellow	TIL213	E	2
XC 209A-02	XCT	LED Lamp, Amber		NC-C	
XC 209-03	XCT	LED Lamp, Red	TIL209A	E	5
XC 209G-03	XCT	LED Lamp, Green	TIL211	E	5

FAIRCHILD LED CROSS REFERENCE

DEVICE	COMPETITOR	DESCRIPTION	FAIRCHILD		NOTES
			DEVICE	CODE	
XC 209Y-03	XCT	LED Lamp, Yellow	TIL213	E	5
XC 209-04	XCT	LED Lamp, Red	TIL209A	E	6
XC 209G-04	XCT	LED Lamp, Green	TIL211	E	6
XC 209Y-04	XCT	LED Lamp, Yellow	TIL213	E	6
XC 520	XCT	LED Lamp, Red	FLV161	E	6,7,8
XC 521	XCT	LED Lamp, Red	FLV160	E	5,7,8
XC 521G	XCT	LED Lamp, Green	FLV360	E	5,7,8
XC 521Y	XCT	LED Lamp, Yellow	FLV460	E	5,7,8
XC 522	XCT	LED Lamp, Red	FLV161	C	7,8
XC 522G	XCT	LED Lamp, Green	FLV361	C	7,8
XC 522Y	XCT	LED Lamp, Yellow	FLV461	C	7,8
XC 522A	XCT	LED Lamp, Amber		NC-C	
XC 524	XCT	LED Lamp, Red	FLV161	E	1,7,8,10
XC 524G	XCT	LED Lamp, Green	FLV361	E	1,7,8,10
XC 524Y	XCT	LED Lamp, Yellow	FLV461	E	1,7,8,10
XC 524A	XCT	LED Lamp, Amber		NC-C	
XC 526	XCT	LED Lamp, Red	FLV160	C	7,8
XC 526G	XCT	LED Lamp, Green	FLV360	C	7,8
XC 526Y	XCT	LED Lamp, Yellow	FLV460	C	7,8
XC 526A	XCT	LED Lamp, Amber		NC-C	
XC 526-2	XCT	LED Lamp, Red	FLV560	C	7,8
XC 526G-2	XCT	LED Lamp, Green	FLV360	B/C	1,7,8
XC 526Y-2	XCT	LED Lamp, Yellow	FLV460	B/C	1,7,8
XC 526A-2	XCT	LED Lamp, Amber		NC-C	
XC 5025	XCT	LED Lamp, Red	FLV160	E	7,8,10
XC 5025G	XCT	LED Lamp, Green	FLV360	E	7,8,10
XC 5025Y	XCT	LED Lamp, Yellow	FLV460	E	7,8,10
XC 5025A	XCT	LED Lamp, Amber		NC-C	
XC 110	XCT	LED Lamp, Red	FLV110	C	8
XC 110G	XCT	LED Lamp, Green	FLV310	C	8
XC 110Y	XCT	LED Lamp, Yellow	FLV410	C	8
XC 110A	XCT	LED Lamp, Amber		NC-C	
XC 111	XCT	LED Lamp, Red	FLV111	C	8
XC 111G	XCT	LED Lamp, Green		NC-P	2
XC 111Y	XCT	LED Lamp, Yellow		NC-P	2
XC 111A	XCT	LED Lamp, Amber		NC-C	
XC 112	XCT	LED Lamp, Red	FLV112	C	8
XC 112G	XCT	LED Lamp, Green		NC-P	5
XC 112Y	XCT	LED Lamp, Yellow		NC-P	5
XC 554-3	XCT	LED Lamp, Red	MV5752	C	8,12
XC 554G-2	XCT	LED Lamp, Green	MV5252	C	8,12
XC 554Y-2	XCT	LED Lamp, Yellow	MV5352	C	8,12
XC 554A-2	XCT	LED Lamp, Amber		NC-C	
XC 554-6	XCT	LED Lamp, Red	MV5752	C	8,12
XC 554G-4	XCT	LED Lamp, Green	MV5252	C	8,12
XC 554Y-4	XCT	LED Lamp, Yellow	MV5352	C	8,12
XC 554A-4	XCT	LED Lamp, Amber		NC-C	
XC 554-9	XCT	LED Lamp, Red	MV5752	B/C	1,8,12
XC 554G-6	XCT	LED Lamp, Green	MV5252	B/C	1,8,12

FAIRCHILD LED CROSS REFERENCE

DEVICE	COMPETITOR	DESCRIPTION	FAIRCHILD		NOTES
			DEVICE	CODE	
XC 554Y-6	XCT	LED Lamp, Yellow	MV5352	B/C	1,8,12
XC 554A-6	XCT	LED Lamp, Amber		NC-C	
XC 556	XCT	LED Lamp, Red	MV5054-1	C	8,12
XC 556G	XCT	LED Lamp, Green	MV5253	C	8,12
XC 556Y	XCT	LED Lamp, Yellow	MV5353	C	8,12
XC 556A	XCT	LED Lamp, Amber		NC-C	
XC 556-2	XCT	LED Lamp, Red	MV5054-2	C	8,12
XC 556G-2	XCT	LED Lamp, Green	MV5253	B/C	1,8,12
XC 556Y-2	XCT	LED Lamp, Yellow	MV5353	B/C	1,8,12
XC 556A-2	XCT	LED Lamp, Amber		NC-C	
XC 556-3	XCT	LED Lamp, Red	MV5054-3	C	8,12
XC 5053	XCT	LED Lamp, Red	MV5053	C	8,12
XC 5053G	XCT	LED Lamp, Green	MV5253	E	8,10,12
XC 5053Y	XCT	LED Lamp, Yellow	MV5353	E	8,10,12
XC 5053A	XCT	LED Lamp, Amber		NC-C	
XC 5055	XCT	LED Lamp, Red	MV5053	E	8,10,12
XC 5055G	XCT	LED Lamp, Green	MV5053	E	8,10,12
XC 5055Y	XCT	LED Lamp, Yellow	MV5353	E	8,10,12
XC 21	XCT	LED Lamp, Red	FLV141	E	7,8,12
XC 21G	XCT	LED Lamp, Green	FLV341	E	7,8,12
XC 21Y	XCT	LED Lamp, Yellow	FLV441	E	7,8,12
XC 21A	XCT	LED Lamp, Amber		NC-C	
XC 22	XCT	LED Lamp, Red	FLV140	E	7,8,12
XC 22G	XCT	LED Lamp, Green	FLV340	E	7,8,12
XC 22Y	XCT	LED Lamp, Yellow	FLV440	E	7,8,12
XC 22A	XCT	LED Lamp, Amber		NC-C	
XC 22-2	XCT	LED Lamp, Red	FLV540	E	7,8,11,12
XC 22G-2	XCT	LED Lamp, Green	FLV340	E	7,8,12
XC 25	XCT	LED Lamp, Red	FLV140	E	7,8,10,12
XC 25G	XCT	LED Lamp, Green	FLV340	E	7,8,10,12
XC 25Y	XCT	LED Lamp, Yellow	FLV440	E	7,8,10,12
XC 25A	XCT	LED Lamp, Amber		NC-C	
XC 22-5V	XCT	LED Lamp, Red		NC-P	Resistor
XC 22-5VA	XCT	LED Lamp, Amber		NC-P	Resistor
XC 22-5VG	XCT	LED Lamp, Green		NC-P	Resistor
XC 22-5VY	XCT	LED Lamp, Yellow		NC-P	Resistor
XC 209-5V	XCT	LED Lamp, Red		NC-P	Resistor
XC 209-5VG	XCT	LED Lamp, Green		NC-P	Resistor
XC 209-5VY	XCT	LED Lamp, Yellow		NC-P	Resistor
XC 5053-5V	XCT	LED Lamp, Red		NC-P	Resistor
XC 5053-5VA	XCT	LED Lamp, Amber		NC-P	Resistor
XC 5053-5VG	XCT	LED Lamp, Green		NC-P	Resistor
XC 5053-5VY	XCT	LED Lamp, Yellow		NC-P	Resistor

FLV104A

NARROW BEAM GaAsP LAMP

OPTOELECTRONICS PRODUCT GROUP

GENERAL DESCRIPTION — The FLV104A narrow beam visible lamp is a high intensity source specifically intended for excitation of photosensors, especially photo-diodes and transistors, when the separation distances are measured from mm to several meters.

The FLV104A is the visible beam companion device to the FPE104 infrared LED. Both devices have identical optics and therefore identical radiation patterns.

- **VERY HIGH AXIAL INTENSITY**
- **NARROW BEAMWIDTH**
- **DETECTABLE AT 30 FEET**

ABSOLUTE MAXIMUM RATINGS

Maximum Temperatures and Humidity

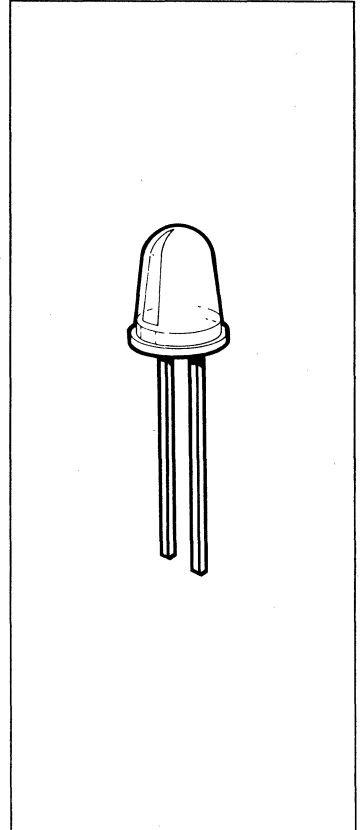
Storage Temperature	-55°C to +100°C
Operating Temperature	-55°C to +125°C
Pin Temperature (Soldering, 5 s)	260°C
Relative Humidity at 65°C	98 %

Maximum Power Dissipation

Total Dissipation at $T_A = 25^\circ\text{C}$	200 mW
Derate Linearly from $T_A = 25^\circ\text{C}$	2.6 mW/°C

Maximum Voltages and Currents

V_R	Reverse Voltage	3.0 V
I_F	Forward Current	1.0 A
i_f	Peak Forward Current (100 μs pulsewidth 1% duty cycle)	100 mA



ELECTRICAL CHARACTERISTICS: $T_A = 25^\circ\text{C}$

SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	TEST COND.
V_F	Forward Voltage		2.0	2.5	Volts	$I_F = 100 \text{ mA}$
BV_R	Reverse Breakdown Voltage	3.0	8.0		Volts	$I_R = 10 \mu\text{A}$

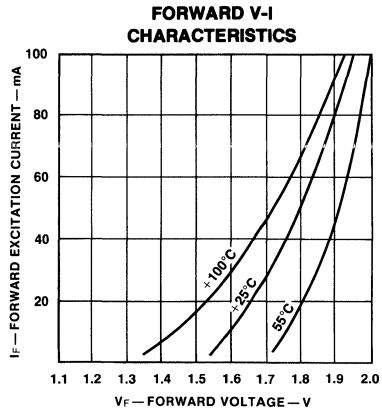
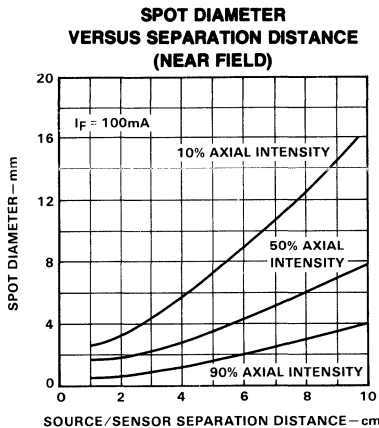
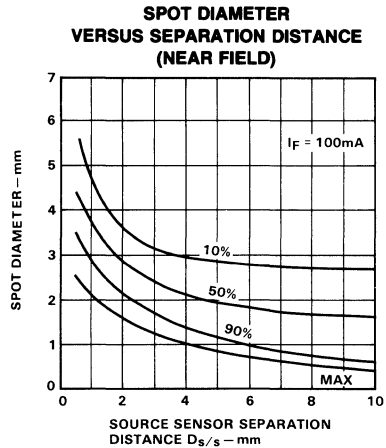
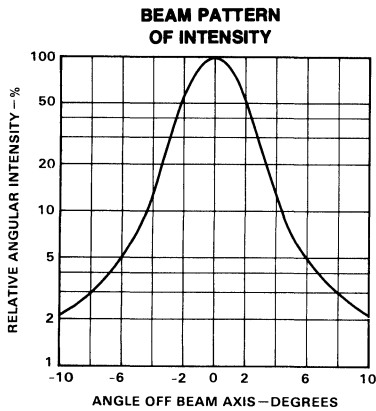
FAIRCHILD • FLV104A

OPTOELECTRONIC CHARACTERISTICS : $I_F = 100 \text{ mA}$, $T_A = 25^\circ\text{C}$

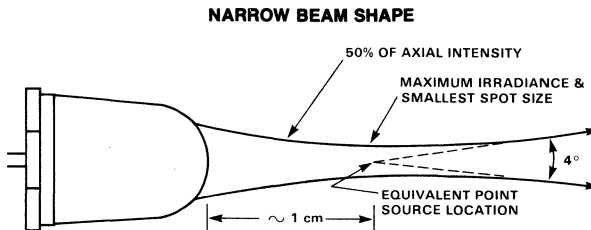
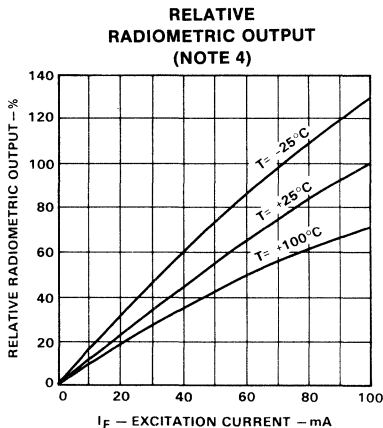
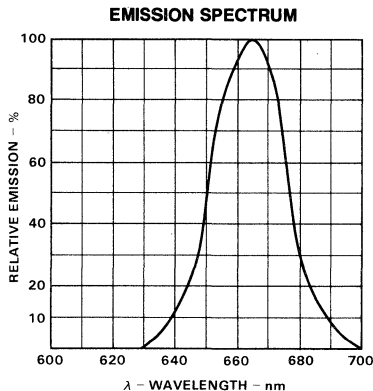
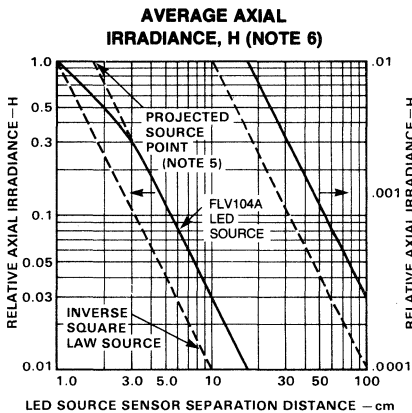
SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS
I_L	Axial Luminous Intensity	50	150		mcd
I	Axial Radiometric Intensity		4.0		mw/sr
L	Average Effective Luminance		5.0		cd/cm ²
N	Average Effective Radiance (Axial)		140		mw/sr/cm ²
A_s	Effective Emitting Source Area (Axial)		.028		cm ²
$\Delta I/\Delta T$	Temperature Coefficient of Intensity (Note 1)		0.5		%/°C
$\Delta I \Delta I_F$	Excitation Coefficient of Intensity (Note 1)		1.0		%/°C
λ_{pk}	Peak Spectral Wavelength		670		nm
$\Delta \lambda$	Spectral Bandwidth		20		nm
$\Delta \lambda_{pk}/\Delta T$	Temperature Spectral Shift Coefficient (Note 2)		0.17		nm/°C
$\Delta \lambda_{pk}/\Delta T_F$	Excitation Spectral Shift Coefficient (Note 2)		0.1		nm/mA
θ_{50}	Beam Angle at 50% Axial Intensity		4.3		Degrees
$\Delta \theta_A$	Beam Axis to Mechanical Axis		1.5		Degrees
t_r and t_f	Light Output Rise and Fall Time (Note 3)		10		ns
C_o	Capacitance ($V=0, f=1.0 \text{ MHz}$)		100		pF

3

TYPICAL CHARACTERISTIC CURVES



TYPICAL CHARACTERISTIC CURVES (Cont'd)



NOTES:

1. $\Delta I/\Delta T$ and $\Delta I/\Delta I_F$ are the percentage derating factors for all radiometric output characteristics referenced to their typical value at 25°C ambient and $I_F = 100$ mA.
2. $\Delta \lambda_{pk}/\Delta T$ and $\Delta \lambda_{pk}/\Delta I_F$ are the derating factors for all wavelength characteristics referenced to their typical value at 25°C ambient and $I_F = 100$ mA.
3. Time for a 10% to 90% change in light intensity with a step change in current.
4. Normalization: LED intensity ≈ 10 mw/sr sensor 1 mm² area.
5. Projected source point is the distance, S_p from which LED inverse square LAW characteristics may be computed for $S \geq 5$ cm.

$$H = \frac{1.0 \text{ mw}}{\text{cm}^2} \times \frac{S_p^2}{(S - S_p)^2}, \quad 1 < S_p < S \text{ cm}$$

6. Irradiance (H) normalized to 4 mw/cm² @ $S = 1$ cm.

FLV110 • FLV140 • FLV150 • FLV160

RED GaAsP LED LAMPS OPTOELECTRONICS PRODUCT GROUP

GENERAL DESCRIPTION — The FLV110, FLV140, FLV150 and FLV160 are red light emitting diodes encapsulated in diffused plastic. These LED devices provide an intense large area light source with wide angle viewing. Visual light emission is in the 600 nm to 700 nm range.

- SOLID STATE THUS NO REPLACEMENT REQUIRED
- NO SOCKET REQUIRED
- HIGH ON/OFF CONTRAST
- FLEXIBLE PINS ON FLV110, FLV140 AND FLV150
FOR GOOD HEAT SINKING
FOR RIGHT ANGLE BENDING
FITS STANDARD SOCKETS AND DRILLED HOLES
- HEAVY COPPER LEADS ON FLV160
FOR WIRE WRAPPING
FOR RIGID STANDOFF FROM PC BOARD
- SINGLE MOLDED BODY ELIMINATES THERMAL CYCLING PROBLEMS
- HIGH TEMPERATURE EPOXY ENCAPSULATION WITHSTANDS SEVERE ENVIRONMENTAL TEMPERATURES
- LOW POWER CONSUMPTION MEANS IC COMPATIBILITY

ABSOLUTE MAXIMUM RATINGS

Maximum Temperature and Humidity

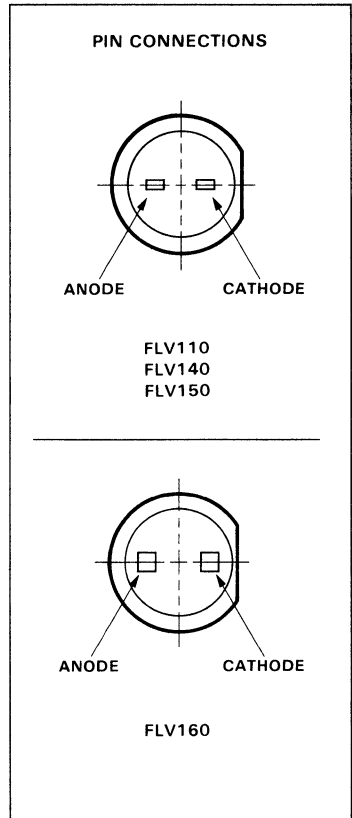
Storage Temperature	-55°C to +100°C
Operating Temperature	-55°C to +100°C
Pin Temperature (Soldering, 5 s)	260°C
Relative Humidity at 85°C	85%

Maximum Power Dissipation

Total Dissipation at $T_A = 25^\circ\text{C}$	120 mW
Derate Linearly from 25°C	1.6 mW/°C

Maximum Voltage and Currents

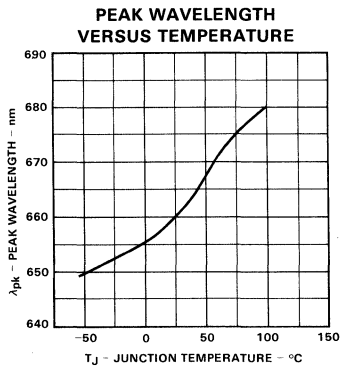
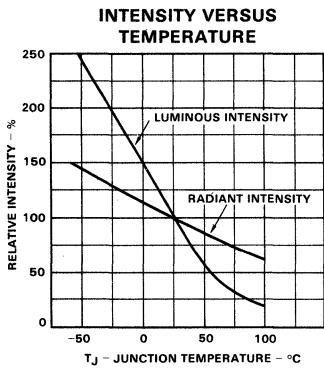
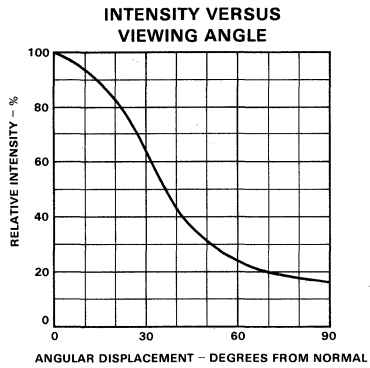
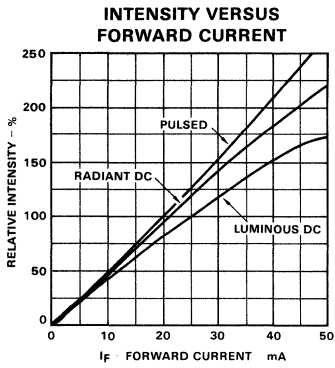
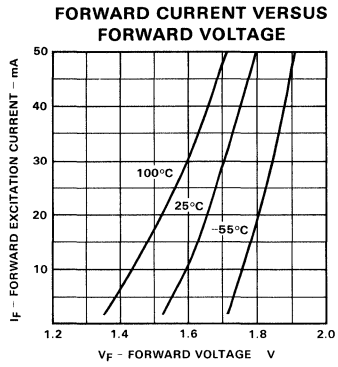
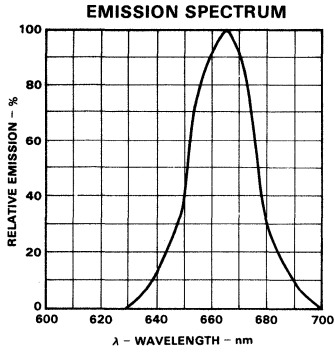
V_R	Reverse Voltage	3.0 V
I_F	Forward dc Current	50 mA
i_f	Peak Forward Current (1.0 μs pulse width)	1.0 A



ELECTRICAL AND RADIANT CHARACTERISTICS: $T_A = 25^\circ\text{C}$

SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	TEST CONDITIONS
V_F	Forward Voltage		1.7	2.0	V	$I_F = 20 \text{ mA}$
BV_R	Reverse Breakdown Voltage	3.0	8.0		V	$I_R = 10 \mu\text{A}$
I_O	Axial Luminous Intensity	0.8	2.0		mcd	$I_F = 20 \text{ mA}$
$\theta_{1/2}$	Angle of Half Intensity		± 35		degrees	$I_F = 20 \text{ mA}$
λ_{pk}	Peak Wavelength		665		nm	$I_F = 20 \text{ mA}$

TYPICAL ELECTRICAL CHARACTERISTIC CURVES



FLV111 • FLV112 • FLV117 • FLV118

RED GaAsP LED LAMPS OPTOELECTRONICS PRODUCT GROUP

GENERAL DESCRIPTION — The FLV111 is a water clear version of the FLV110. The FLV112 is a diffused lens in clear (non-red) epoxy. FLV117 is a low-cost lamp encapsulated in diffused red epoxy. The FLV118 is a water clear version of the FLV117. Visual light emission is in the 600-700 nm range.

- **SOLID STATE — NO REPLACEMENT REQUIRED**
- **NO SOCKET REQUIRED**
- **HIGH ON/OFF CONTRAST**
- **FLEXIBLE PINS FOR GOOD HEAT SINKING AND RIGHT ANGLE BENDING**
- **FITS STANDARD SOCKETS AND DRILLED HOLES**
- **SINGLE MOLDED BODY ELIMINATES THERMAL CYCLING PROBLEMS**
- **HIGH TEMPERATURE EPOXY ENCAPSULATION WITHSTANDS SEVERE ENVIRONMENTAL TEMPERATURES**
- **LOW POWER CONSUMPTION MEANS IC COMPATIBILITY**

ABSOLUTE MAXIMUM RATINGS

Maximum Temperature and Humidity

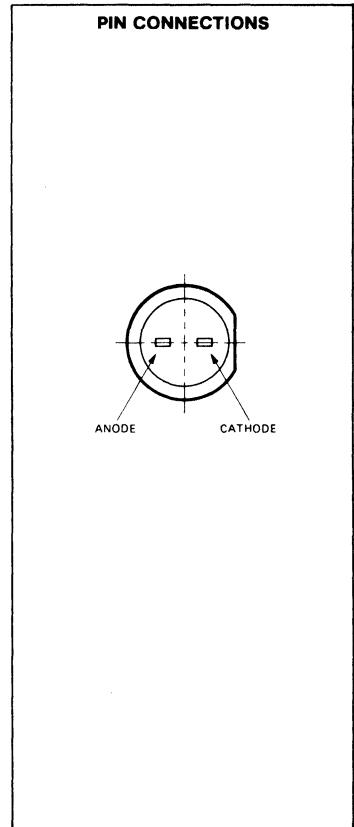
Storage Temperature	-55°C to +150°C
Junction Temperature	125°C
Pin Temperature (Soldering, 5 s)	260°C
Relative Humidity at 85°C	85%

Maximum Power Dissipation

Total Dissipation	100 mW
Derate Linearly from 100°C	4.0 mW/°C

Maximum Voltage and Currents

V _R	Reverse Voltage	3.0 V
I _F	Forward dc Current	50 mA
I _{pk}	Forward Peak Current (1.0 μs pulse)	1.0 A

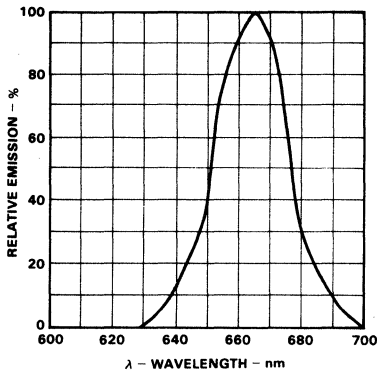


ELECTRICAL AND RADIANT CHARACTERISTICS: T_A = 25°C

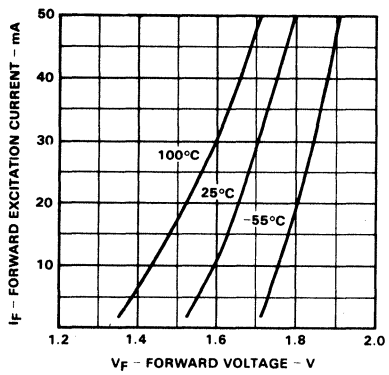
SYMBOL	CHARACTERISTICS	MIN	TYP	MAX	UNITS	TEST CONDITIONS
V _F	Forward Voltage		1.7	3.0	V	I _F = 20 mA
BV _R	Reverse Voltage		8.0		V	I _R = 10 μA
I _o	Axial Luminous Intensity FLV111, FLV112 FLV117, FLV118	0.8	2.0		mcd	I _F = 20 mA
θ _{1/2}	Angle of Half Intensity FLV111, FLV112 FLV117, FLV118		±35 ±20		degrees	I _F = 20 mA
λ _{pk}	Peak Wavelength		665		nm	I _F = 20 mA

TYPICAL ELECTRICAL CHARACTERISTIC CURVES

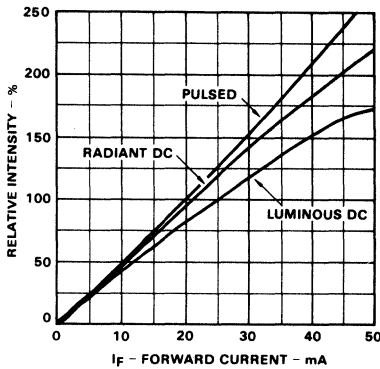
EMISSION SPECTRUM



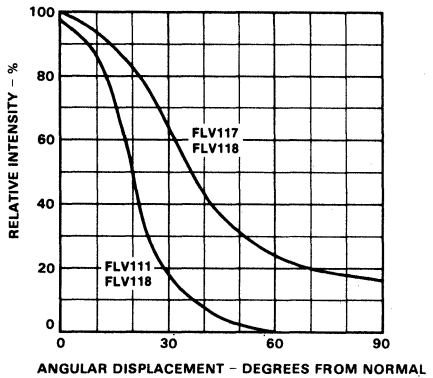
FORWARD CURRENT VERSUS FORWARD VOLTAGE



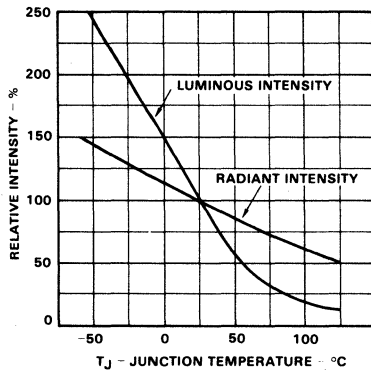
INTENSITY VERSUS FORWARD CURRENT



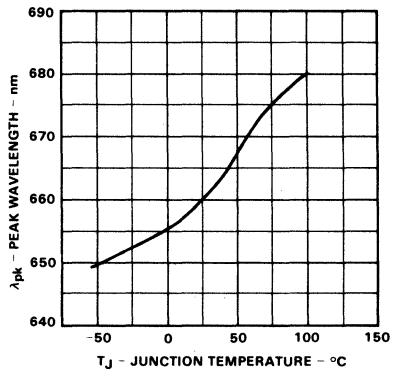
INTENSITY VERSUS VIEWING ANGLE



INTENSITY VERSUS TEMPERATURE



WAVELENGTH VERSUS TEMPERATURE



FLV141 • FLV151 • FLV161

RED GaAsP LED LAMPS

OPTOELECTRONICS PRODUCT GROUP

GENERAL DESCRIPTION — The FLV141, FLV151, and FLV161 are red light emitting diodes encapsulated in non-diffused plastic. These LED devices provide an intense light source for back lighting applications. Visual light emission is in the 600 nm to 700 nm range.

- SOLID STATE THUS NO REPLACEMENT REQUIRED
- NO SOCKET REQUIRED
- HIGH ON/OFF CONTRAST
- FLEXIBLE LEADS ON FLV141, AND FLV151
 - FOR GOOD HEAT SINKING
 - FOR RIGHT ANGLE BENDING
 - FITS STANDARD SOCKETS AND DRILLED HOLES
- HEAVY COPPER LEADS ON FLV161
 - FOR WIRE WRAPPING
 - FOR RIGID STANDOFF FROM PC BOARD
- SINGLE MOLDED BODY ELIMINATES THERMAL CYCLING PROBLEMS
- HIGH TEMPERATURE EPOXY ENCAPSULATION WITHSTANDS SEVERE ENVIRONMENTAL TEMPERATURES
- LOW POWER CONSUMPTION MEANS IC COMPATIBILITY

ABSOLUTE MAXIMUM RATINGS

Maximum Temperature and Humidity

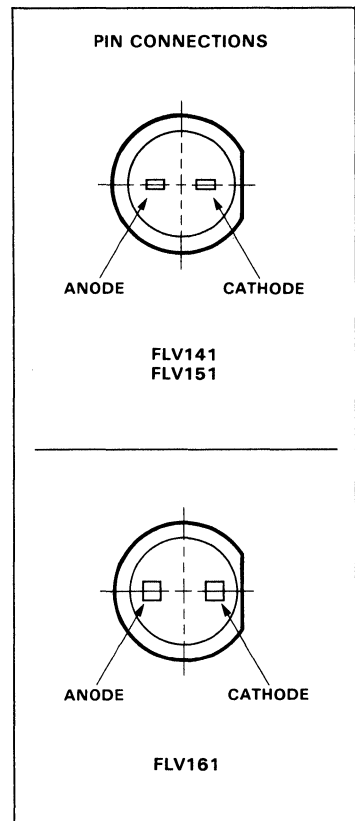
Storage Temperature	-55°C to +125°C
Operating Temperature	-55°C to +100°C
Pin Temperature (Soldering, 5 s)	260°C
Relative Humidity at 85°C	85%

Maximum Power Dissipation

Total Dissipation at $T_A = 25^\circ\text{C}$	125 mW
Derate Linearly from 25°C	1.3 mW/°C

Maximum Voltage and Currents

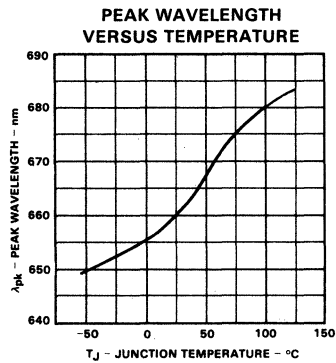
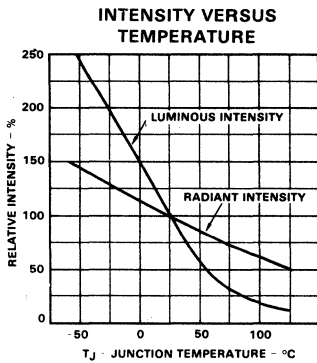
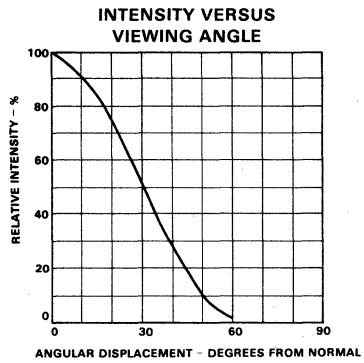
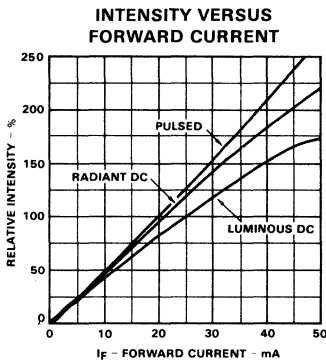
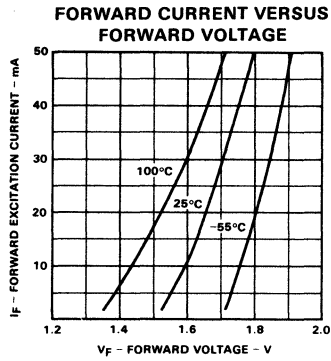
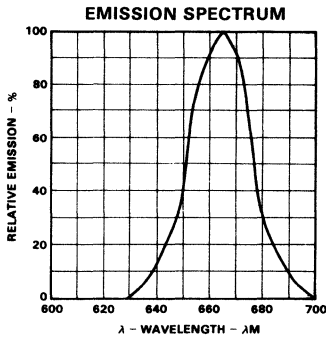
V_R	Reverse Voltage	3.0 V
I_F	Forward dc Current	50 mA
i_f	Peak Forward Current (1.0 μs pulse width)	1.0 A



ELECTRICAL AND RADIANT CHARACTERISTICS: $T_A = 25^\circ\text{C}$

SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	TEST CONDITIONS
V_F	Forward Voltage		1.7	2.0	V	$I_F = 20 \text{ mA}$
BV_R	Reverse Breakdown Voltage	3.0	8.0		V	$I_R = 10 \mu\text{A}$
I_O	Axial Luminous Intensity	0.8	2.0		mcd	$I_F = 20 \text{ mA}$
$\theta_{1/2}$	Angle of Half Intensity		± 35		degrees	$I_F = 20 \text{ mA}$
λ_{pk}	Peak Wavelength		665		nm	$I_F = 20 \text{ mA}$

TYPICAL ELECTRICAL CHARACTERISTIC CURVES



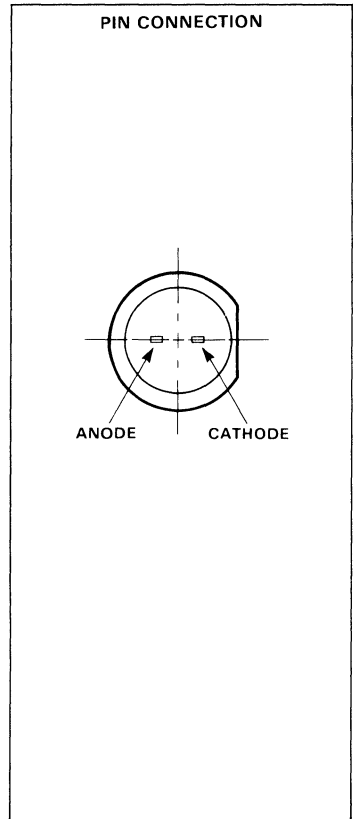
FLV251 • FLV252

RED GaP LED POINT SOURCE LAMPS

OPTOELECTRONICS PRODUCT GROUP

GENERAL DESCRIPTION – The FLV251 and FLV252 are red GaP light emitting diodes encapsulated in red epoxy. These devices provide an intense light source with visual emission in the 600 to 850 nm range.

- THREE TIMES BRIGHTER THAN GaAsP LAMPS AT EQUIVALENT CURRENTS
- SOLID STATE THUS NO REPLACEMENT IS REQUIRED
- HIGH ON/OFF CONTRAST
- FLEXIBLE PINS FOR GOOD HEAT SINKING AND RIGHT ANGLE BENDING
- FITS STANDARD SOCKETS AND DRILLED HOLES
- SINGLE MOLDED BODY ELIMINATES THERMAL CYCLING PROBLEMS
- HIGH TEMPERATURE EPOXY ENCAPSULATION WITHSTANDS SEVERE ENVIRONMENTAL TEMPERATURES
- FLV251 LIGHTS UP 1/4" DIAMETER CIRCLE WITH 3.0 mcd MINIMUM AT 10 mA
- FLV252 LIGHTS UP 1/4" DIAMETER CIRCLE WITH 6.0 mcd MINIMUM AT 10 mA



ABSOLUTE MAXIMUM RATINGS

Maximum Temperature and Humidity

Storage Temperature	-55°C to +100°C
Operating Temperature	-55°C to +100°C
Pin Temperature (Soldering, 5 s)	260°C
Relative Humidity at 85°C	85%

Maximum Power Dissipation

Total Dissipation at $T_A = 25^\circ\text{C}$	120 mW
Derate Linearly from 50°C	1.6 mW/°C

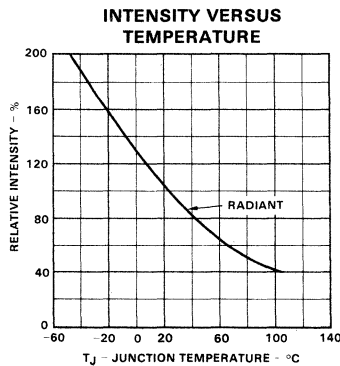
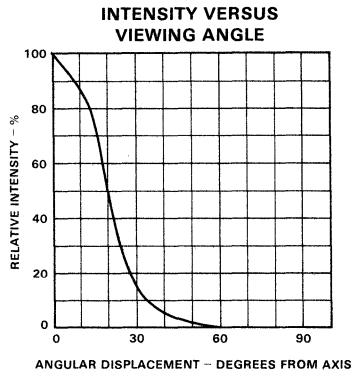
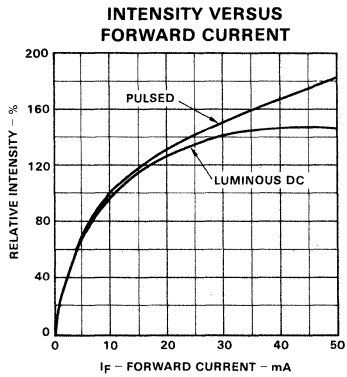
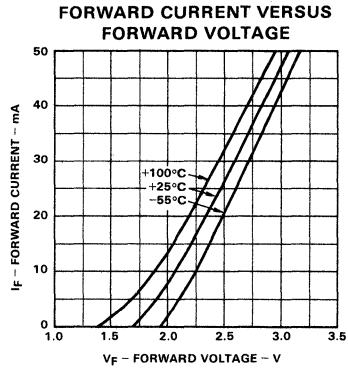
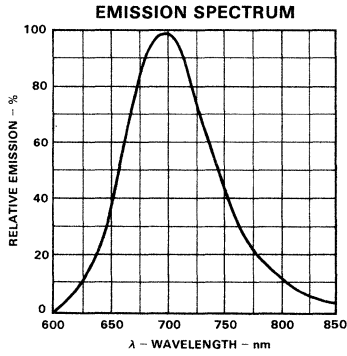
Maximum Voltage and Currents

V _R Reverse Voltage	5.0 V
I _F Forward dc Current	35 mA

ELECTRICAL AND RADIANT CHARACTERISTICS: $T_A = 25^\circ\text{C}$

SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	TEST CONDITIONS
V _F	Forward Voltage		2.1	2.8 3.0	V	I _F = 10 mA
BV _R	Reverse Breakdown Voltage	5.0	15		V	I _F = 20 mA
I _O	Axial Luminous Intensity					I _R = 100 μA
	FLV251	3.0	5.0		mcd	I _F = 10 mA
	FLV252	6.0	8.0		mcd	I _F = 10 mA
$\theta_{1/2}$	Viewing Angle to Half Intensity		±20		degrees	I _F = 20 mA
λ_{pk}	Peak Wavelength		690		nm	I _F = 10 mA

TYPICAL ELECTRICAL CHARACTERISTIC CURVES



FLV310 • FLV340 • FLV350 • FLV360

GREEN GaP LED LAMPS

OPTOELECTRONICS PRODUCT GROUP

GENERAL DESCRIPTION – The FLV310, FLV340, FLV350 and FLV360 are green light emitting diodes encapsulated in green diffused plastic. These devices provide an intense large light source with wide angle viewing. Visual light emission is in the 525 to 625 nm range.

- HIGH LUMINOUS INTENSITY FOR ROOM AMBIENT LIGHT LEVELS
- SOLID STATE THUS NO REPLACEMENT IS REQUIRED
- HIGH ON/OFF CONTRAST
- FLEXIBLE PINS ON FLV310, FLV340 AND FLV350
FOR GOOD HEAT SINKING
FOR RIGHT ANGLE BENDING
FITS STANDARD SOCKETS AND DRILLED HOLES
- HEAVY COPPER PINS ON FLV360 FOR WIRE WRAP APPLICATIONS AND RIGID STANDOFF FROM PC BOARD
- SINGLE MOLDED BODY ELIMINATES THERMAL CYCLING PROBLEMS
- HIGH TEMPERATURE EPOXY ENCAPSULATION WITHSTANDS SEVERE ENVIRONMENTAL TEMPERATURES
- LOW POWER MEANS IC COMPATIBILITY

ABSOLUTE MAXIMUM RATINGS

Maximum Temperature and Humidity

Storage Temperature	-55°C to +100°C
Operating Temperature	-55°C to +100°C
Pin Temperature (Soldering, 5 s)	260°C
Relative Humidity at 85°C	85%

Maximum Power Dissipation

Total Dissipation at $T_A = 25^\circ\text{C}$	120 mW
Derate Linearly from 50°C	1.6 mW/°C

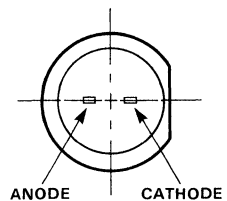
Maximum Voltage and Currents

V_R	Reverse Voltage	5.0 V
I_F	Forward dc Current	35 mA
i_f	Peak Forward Current (1.0 μs pulse width)	1.0 A

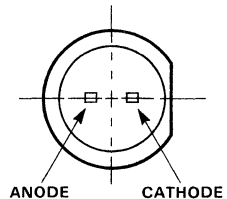
ELECTRICAL AND RADIANT CHARACTERISTICS: $T_A = 25^\circ\text{C}$

SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	TEST CONDITIONS
V_F	Forward Voltage		2.3	3.0	V	$I_F = 20\text{ mA}$
BV_R	Reverse Breakdown Voltage	5.0	18		V	$I_R = 100\ \mu\text{A}$
I_O	Axial Luminous Intensity	1.6	3.2		mcd	$I_F = 20\text{ mA}$
$\theta_{1/2}$	Viewing Angle to Half Intensity		± 25		degrees	$I_F = 20\text{ mA}$
λ_{pk}	Peak Wavelength		565		nm	$I_F = 10\text{ mA}$

PIN CONNECTIONS

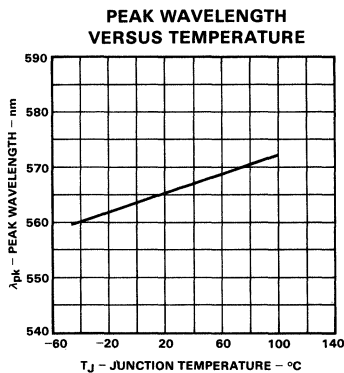
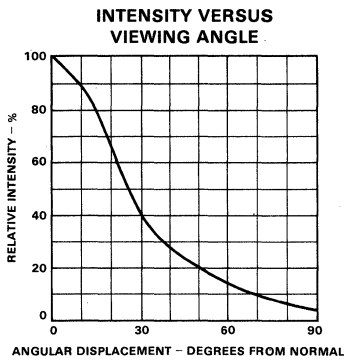
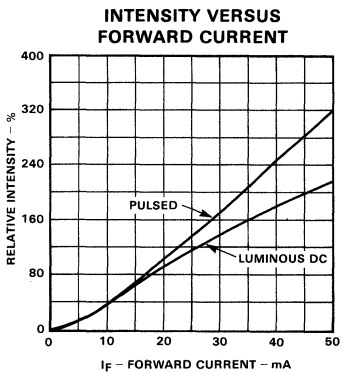
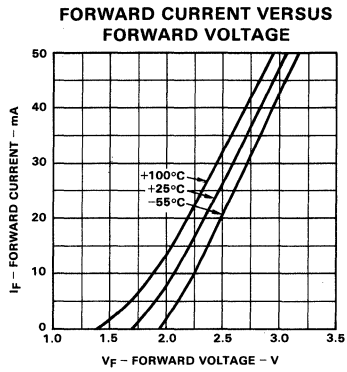
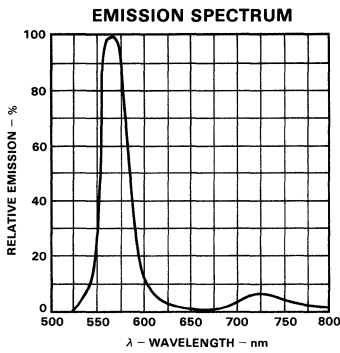


FLV310
FLV340
FLV350



FLV360

TYPICAL ELECTRICAL CHARACTERISTIC CURVES



FLV311 • FLV341 • FLV351 • FLV361

GREEN GaP LED POINT-SOURCE LAMPS

OPTOELECTRONICS PRODUCT GROUP

GENERAL DESCRIPTION – The FLV311, FLV341, FLV351 and FLV361 are green light emitting diodes encapsulated in green plastic for backlighting applications. These devices provide an intense light source with visual light in the 525 to 625 nm range.

- HIGH LUMINOUS INTENSITY
- SOLID STATE THUS NO REPLACEMENT IS REQUIRED
- SINGLE MOLDED BODY ELIMINATES THERMAL CYCLING PROBLEMS
- HIGH TEMPERATURE EPOXY ENCAPSULATION WITHSTANDS SEVERE ENVIRONMENTAL TEMPERATURES
- FLEXIBLE PINS FOR GOOD HEAT SINKING AND RIGHT ANGLE BENDING
- LOW POWER CONSUMPTION MEANS IC COMPATIBILITY
- FLV341 IS LESS THAN 1/4" TALL, FOR LOW PROFILE BACKLIGHTING
- FLV351 HAS A STANDARD MECHANICAL OUTLINE
- FLV361 FEATURES .025" PINS WITH STANDOFF

ABSOLUTE MAXIMUM RATINGS

Maximum Temperature and Humidity

Storage Temperature	-55°C to +100°C
Operating Temperature	-55°C to +100°C
Pin Temperature (Soldering, 5 s)	260°C
Relative Humidity at 85°C	85%

Maximum Power Dissipation

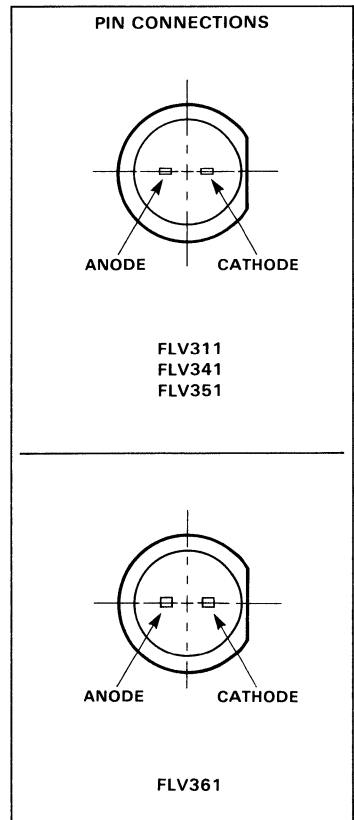
Total Dissipation at $T_A = 25^\circ\text{C}$	120 mW
Derate Linearly from 50°C	1.6 mW/°C

Maximum Voltage and Currents

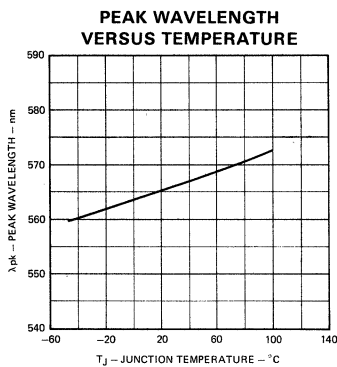
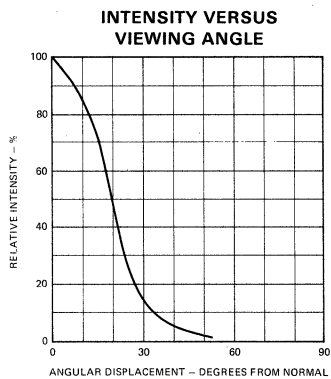
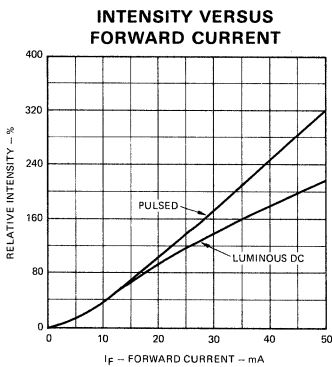
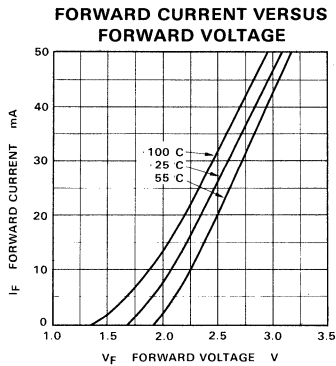
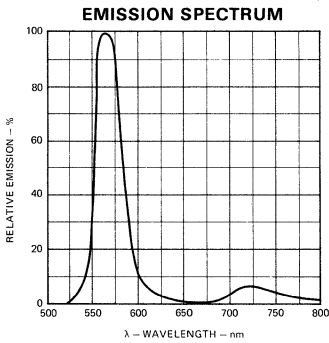
V_R Reverse Voltage	5.0 V
I_F Forward dc Current	35 mA
i_f Peak Forward Current (1.0 μs pulse width)	1.0 A

ELECTRICAL AND RADIANT CHARACTERISTICS: $T_A = 25^\circ\text{C}$

SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	TEST CONDITIONS
V_F	Forward Voltage		2.3	3.0	V	$I_F = 20\text{ mA}$
BV_R	Reverse Breakdown Voltage	5.0	18		V	$I_R = 100\ \mu\text{A}$
I_O	Axial Luminous Intensity	1.6	3.2		mcd	$I_F = 20\text{ mA}$
$\theta_{1/2}$	Viewing Angle to Half Intensity		± 20		degrees	$I_F = 20\text{ mA}$
λ_{pk}	Peak Wavelength		565		nm	$I_F = 20\text{ mA}$



TYPICAL ELECTRICAL CHARACTERISTIC CURVES



FLV410 • FLV440 • FLV450 • FLV460

YELLOW GaP LED LAMPS OPTOELECTRONICS PRODUCT GROUP

GENERAL DESCRIPTION — The FLV410, FLV440, FLV450 and FLV460 are yellow light-emitting diodes encapsulated in yellow diffused plastic. These devices provide an intense large area light source with wide angle viewing. Visual light emission is in the to 625 nm range.

- HIGH LUMINOUS INTENSITY FOR ROOM AMBIENT LIGHT LEVELS
- SOLID STATE THUS NO REPLACEMENT IS REQUIRED
- HIGH ON/OFF CONTRAST
- FLEXIBLE PINS ON FLV410, FLV440 AND FLV450
FOR GOOD HEAT SINKING
FOR RIGHT ANGLE BENDING
FITS STANDARD SOCKETS AND DRILLED HOLES
- HEAVY COPPER PINS ON FLV460 FOR WIRE WRAP APPLICATIONS AND RIGID STANDOFF FROM PC BOARD
- SINGLE MOLDED BODY ELIMINATES THERMAL CYCLING PROBLEMS
- HIGH TEMPERATURE EPOXY ENCAPSULATION WITHSTANDS SEVERE ENVIRONMENTAL TEMPERATURES
- LOW POWER MEANS IC COMPATIBILITY

ABSOLUTE MAXIMUM RATINGS

Maximum Temperature and Humidity

Storage Temperature	-55°C to +100°C
Operating Temperature	-55°C to +100°C
Pin Temperature (Soldering, 5 s)	260°C
Relative Humidity at 85°C	85%

Maximum Power Dissipation

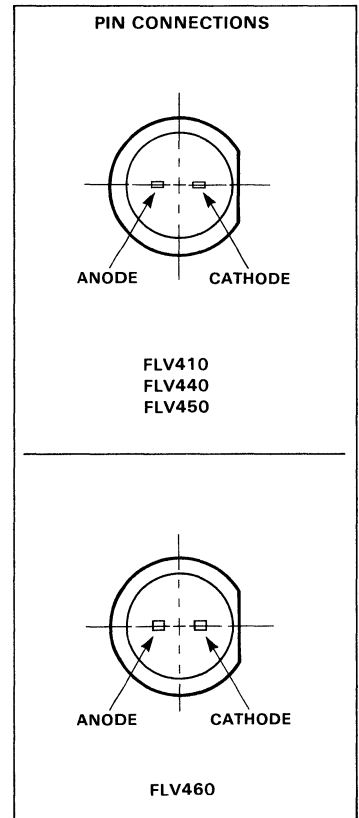
Total Dissipation at $T_A = 25^\circ\text{C}$	120 mW
Derate Linearly from 25°C	1.6 mW/°C

Maximum Voltage and Currents

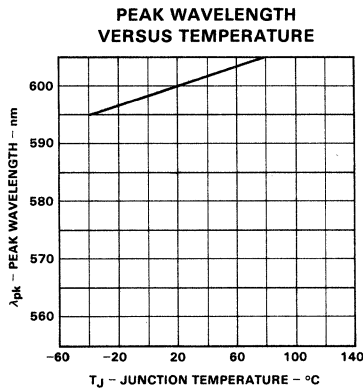
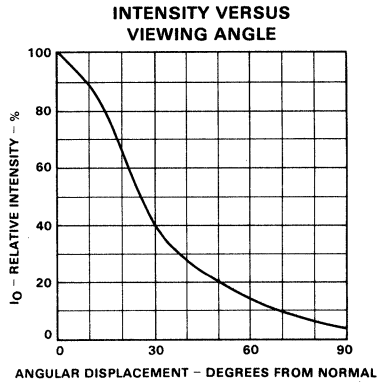
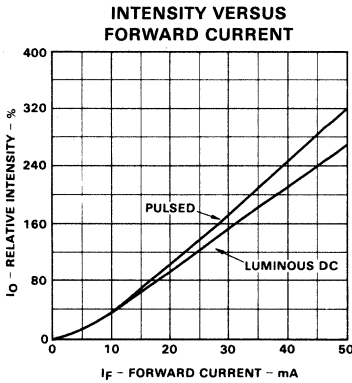
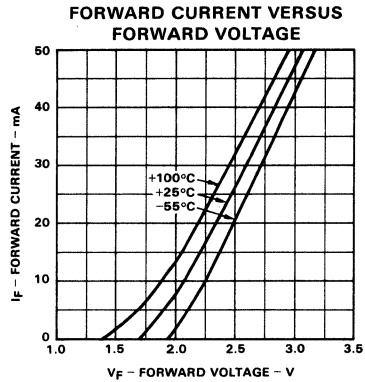
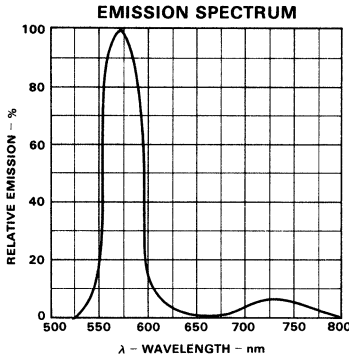
V_R	Reverse Voltage	5.0 V
I_F	Forward dc Current	10 mA
I_{pk}	Peak Forward Current (1.0 μs pulse width)	1.0 A

ELECTRICAL AND RADIANT CHARACTERISTICS: $T_A = 25^\circ\text{C}$

SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	TEST CONDITIONS
V_F	Forward Voltage		2.3	3.0	V	$I_F = 20\text{ mA}$
BV_R	Reverse Breakdown Voltage	5.0	18		V	$I_R = 100\ \mu\text{A}$
I_O	Axial Luminous Intensity	1.6	3.2		mcd	$I_F = 20\text{ mA}$
$\theta_{1/2}$	Viewing Angle to Half Intensity		± 25		degrees	$I_F = 20\text{ mA}$
λ_{pk}	Peak Wavelength		585		nm	$I_F = 20\text{ mA}$



TYPICAL ELECTRICAL CHARACTERISTIC CURVES



FLV411 • FLV441 • FLV451 • FLV461

YELLOW GaP POINT SOURCE LED LAMPS OPTOELECTRONICS PRODUCT GROUP

GENERAL DESCRIPTION — The FLV411, FLV441, FLV451 and FLV461 are yellow light emitting diodes encapsulated yellow non-diffused plastic. These LED devices provide an intense large area light source with narrow angle viewing. Visual light emission is in the 525 to 625 nm range.

- HIGH LUMINOUS INTENSITY FOR ROOM AMBIENT LIGHT LEVELS
- SOLID STATE THUS NO REPLACEMENT IS REQUIRED
- HIGH ON/OFF CONTRAST
- FLEXIBLE PINS ON FLV411, FLV441 AND FLV451 FOR GOOD HEAT SINKING FOR RIGHT ANGLE BENDING FITS STANDARD SOCKETS AND DRILLED HOLES
- HEAVY COPPER PINS ON FLV461 FOR WIRE WRAP APPLICATIONS AND RIGID STANDOFF FROM PC BOARD
- SINGLE MOLDED BODY ELIMINATES THERMAL CYCLING PROBLEMS
- HIGH TEMPERATURE EPOXY ENCAPSULATION WITHSTANDS SEVERE ENVIRONMENTAL TEMPERATURES
- LOW POWER MEANS IC COMPATIBILITY

ABSOLUTE MAXIMUM RATINGS

Maximum Temperature and Humidity

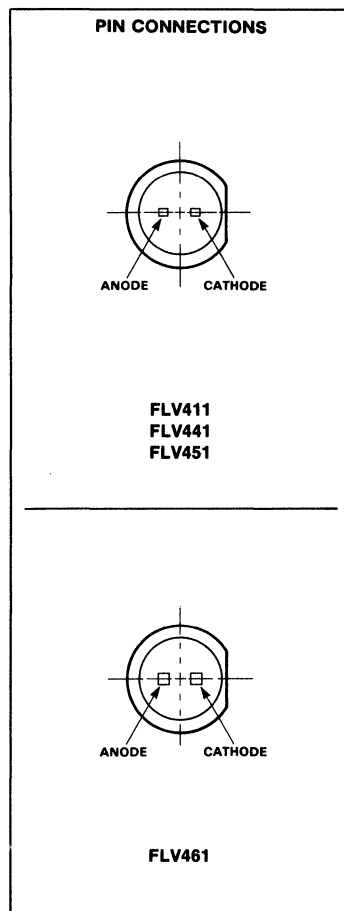
Junction Temperature	125°C
Storage Temperature	-55°C to +150°C
Pin Temperature (Soldering, 5 s)	260°C
Relative Humidity at 85°C	85%

Maximum Power Dissipation

Total Dissipation at $T_A = 25^\circ\text{C}$	100 mW
Derate Linearly from 25°C	1.14 mW/°C

Maximum Voltage and Currents

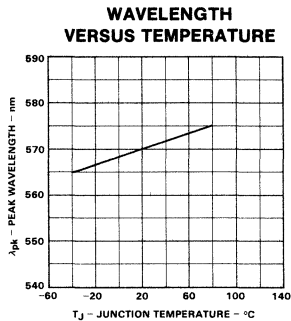
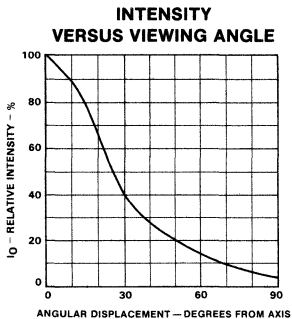
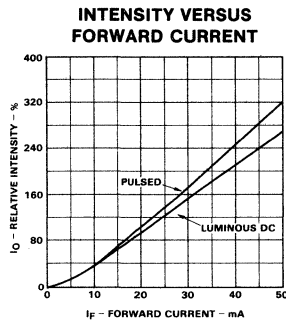
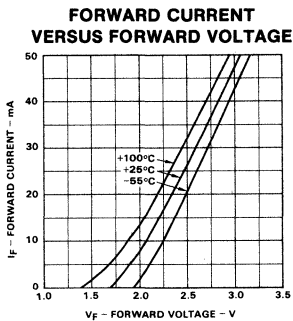
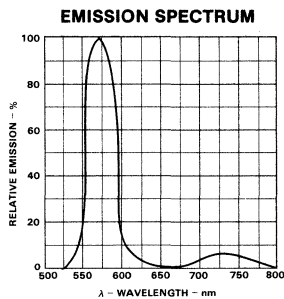
V_R Reverse Voltage	5.0 V
I_F Forward DC Current	35 mA
I_{pk} Forward Peak Current (pulse = 1.0 μs)	1.0 A



ELECTRICAL AND RADIANT CHARACTERISTICS: $T_A = 25^\circ\text{C}$

SYMBOL	CHARACTERISTICS	MIN	TYP	MAX	UNITS	TEST CONDITIONS
V_F	Forward Voltage		2.3	3.0	V	$I_F = 20\text{ mA}$
BV_R	Reverse Voltage	5.0	18		V	$I_R = 100\ \mu\text{A}$
I_o	Axial Luminous Intensity	1.6	3.2		mcd	$I_F = 20\text{ mA}$
$\theta_{1/2}$	Angle of Half Intensity		± 20		degrees	$I_F = 20\text{ mA}$
λ_{pk}	Peak Wavelength		570		nm	$I_F = 20\text{ mA}$

TYPICAL ELECTRICAL CHARACTERISTICS



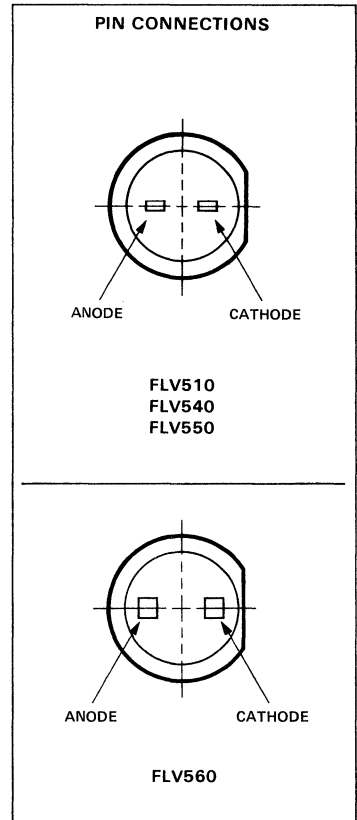
FLV510 • FLV540 • FLV550 • FLV560

RED SUPER GaAsP LED LAMPS

OPTOELECTRONICS PRODUCT GROUP

GENERAL DESCRIPTION – The FLV510, FLV540, FLV550 and FLV560 are red light emitting diodes encapsulated in red diffused plastic. These devices provide an intense large area light source with wide angle viewing. Visual light emission is in the 600 to 700 nm range.

- HIGH LUMINOUS INTENSITY FOR ROOM AMBIENT LIGHT LEVELS
- SOLID STATE THUS NO REPLACEMENT IS REQUIRED
- HIGH ON/OFF CONTRAST
- FLEXIBLE PINS ON FLV510, FLV540 AND FLV550
 - FOR GOOD HEAT SINKING
 - FOR RIGHT ANGLE BENDING
 - FITS STANDARD SOCKETS AND DRILLED HOLES
- HEAVY COPPER PINS ON FLV560 FOR WIRE WRAP APPLICATIONS AND RIGID STANDOFF FROM PC BOARD
- SINGLE MOLDED BODY ELIMINATES THERMAL CYCLING PROBLEMS
- HIGH TEMPERATURE EPOXY ENCAPSULATION WITHSTANDS SEVERE ENVIRONMENTAL TEMPERATURES
- LOW POWER MEANS IC COMPATIBILITY



ABSOLUTE MAXIMUM RATINGS

Maximum Temperature and Humidity

Storage Temperature	-55°C to +100°C
Operating Temperature	-55°C to +100°C
Pin Temperature (Soldering, 5 s)	260°C
Relative Humidity at 85 °C	85%

Maximum Power Dissipation

Total Dissipation at $T_A = 25^\circ\text{C}$	200 mW
Derate Linearly from 25°C	2.6 mW/°C

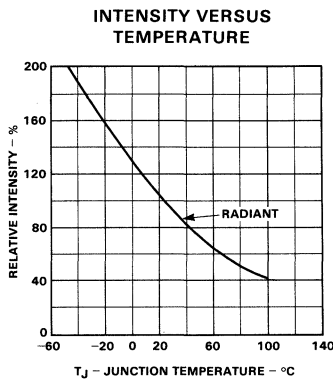
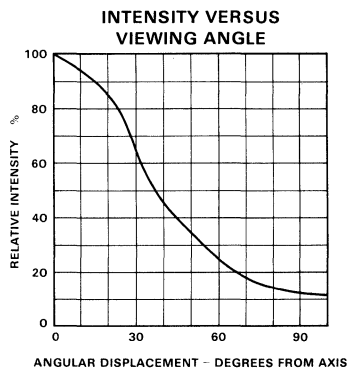
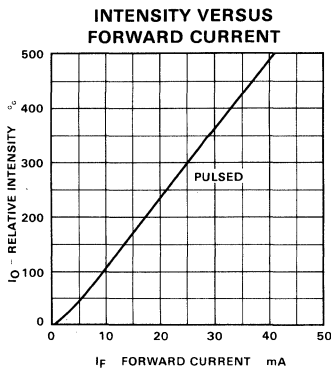
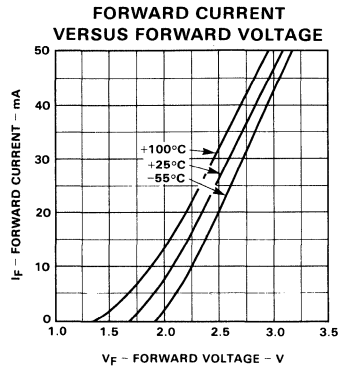
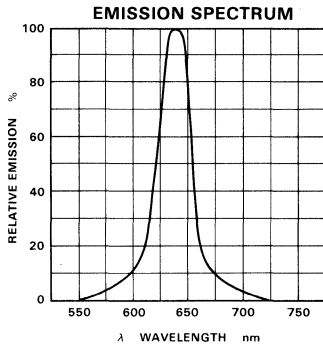
Maximum Voltage and Currents

V_R	Reverse Voltage	5.0 V
I_F	Forward dc Current	35 mA
i_f	Peak Forward Current (1.0 μs pulse width)	1.0 A

ELECTRICAL AND RADIANT CHARACTERISTICS: $T_A = 25^\circ\text{C}$

SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	TEST CONDITIONS
V_F	Forward Voltage		2.1	2.8	V	$I_F = 10\text{ mA}$
BV_R	Reverse Breakdown Voltage	5.0	8.0	3.0	V	$I_F = 20\text{ mA}$
I_O	Axial Luminous Intensity	1.2	3.0		mcd	$I_F = 10\text{ mA}$
		2.0	5.0		mcd	$I_F = 20\text{ mA}$
$\theta_{1/2}$	Viewing Angle to Half Intensity		± 35		degrees	$I_F = 20\text{ mA}$
λ_{pk}	Peak Wavelength		640		nm	$I_F = 10\text{ mA}$

TYPICAL ELECTRICAL CHARACTERISTIC CURVES



MV5050 • MV5051 • MV5052 • MV5053

RED GaAsP LED LAMPS

OPTOELECTRONICS PRODUCT GROUP

GENERAL DESCRIPTION – The MV5050, MV5051, MV5052 and MV5053 are red light emitting diodes encapsulated in diffused plastic. These devices provide an intense large area light source with wide angle viewing. Visual light emission is in the 600 nm to 700 nm range.

- **SOLID STATE THUS NO REPLACEMENT REQUIRED**
- **NO SOCKET REQUIRED**
- **HIGH ON/OFF CONTRAST**
- **FLEXIBLE PINS ON ALL LAMPS**
 - FOR GOOD HEAT SINKING
 - FOR RIGHT ANGLE BENDING
 - FITS STANDARD SOCKETS OR DRILLED HOLES
- **SINGLE MOLDED BODY ELIMINATES THERMAL CYCLING PROBLEMS**
- **HIGH TEMPERATURE EPOXY ENCAPSULATION WITHSTANDS SEVERE ENVIRONMENTAL TEMPERATURES**
- **LOW POWER CONSUMPTION MEANS IC COMPATIBILITY**
- **MV5050 IN CLEAR NON-DIFFUSED EPOXY**
- **MV5051 IN CLEAR DIFFUSED EPOXY**
- **MV5052 IN RED NON-DIFFUSED EPOXY**
- **MV5053 IN RED DIFFUSED EPOXY**

ABSOLUTE MAXIMUM RATINGS

Maximum Temperature and Humidity

Storage Temperature	-55°C to +100°C
Operating Temperature	-55°C to +100°C
Pin Temperature (Soldering, 5 s)	260°C
Relative Humidity at 85°C	85%

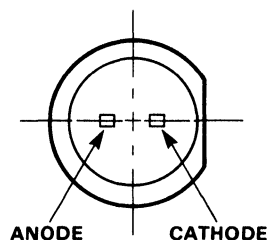
Maximum Power Dissipation

Total Dissipation at $T_A = 25^\circ\text{C}$	125 mW
Derate Linearly from 25°C	1.3 mW/°C

Maximum Voltage and Currents

V_R	Reverse Voltage	5.0 V
I_F	Forward Current at $T_A = 25^\circ\text{C}$	100 mA
	at $T_A = 100^\circ\text{C}$	15 mA
i_f	Peak Forward Current (1.0 μs pulse width, 0.1% duty cycle)	1.0 A

CONNECTION DIAGRAM
(TOP VIEW)

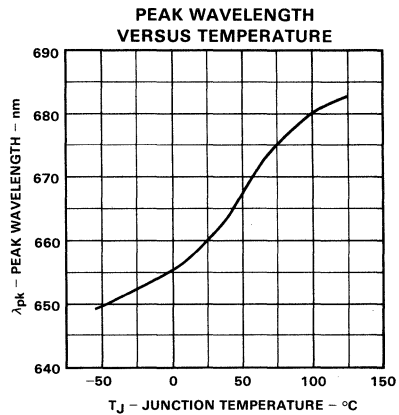
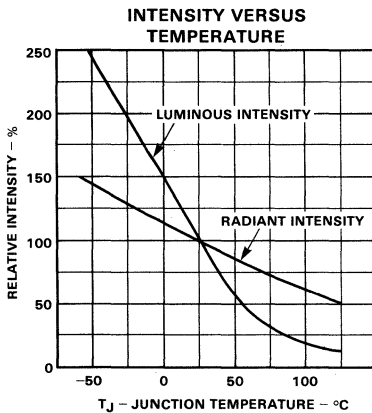
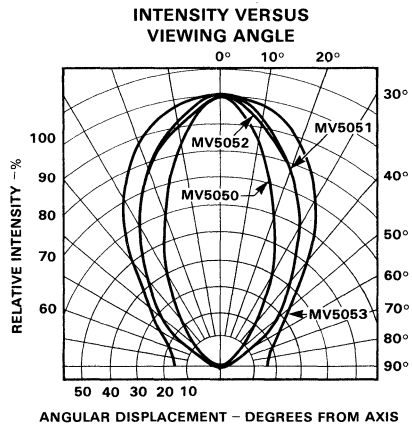
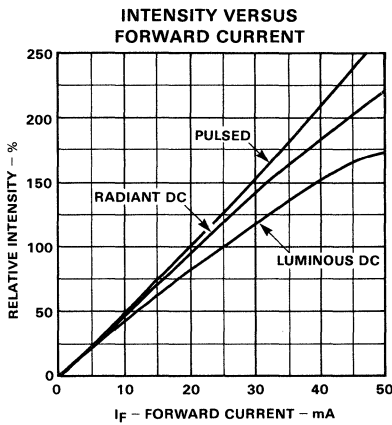
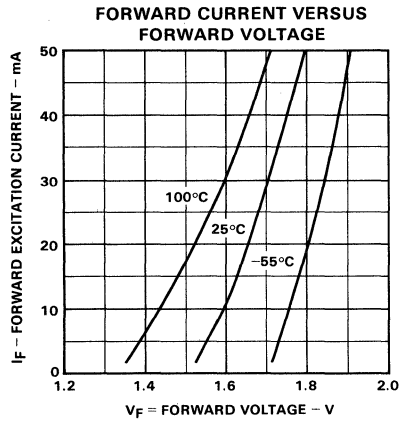
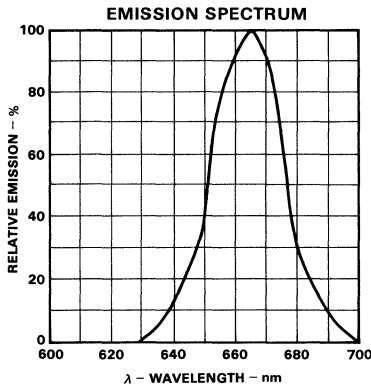


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ELECTRICAL AND RADIANT CHARACTERISTICS: $T_A = 25^\circ\text{C}$

SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	TEST CONDITIONS
V_F	Forward Voltage		1.7	2.2	V	$I_F = 20 \text{ mA}$
BV_R	Reverse Breakdown Voltage	5.0	25		V	$I_R = 100 \mu\text{A}$
I_O	Axial Luminous Intensity				mcd	$I_F = 20 \text{ mA}$
	MV5050/MV5052		2.0			
	MV5051/MV5053		1.6			
$\theta_{1/2}$	Viewing Angle to Half Intensity				degrees	$I_F = 20 \text{ mA}$
	MV5050		± 25			
	MV5051/MV5052		± 35			
	MV5053		± 40			
λ_{pk}	Peak Wavelength		660		nm	$I_F = 20 \text{ mA}$

TYPICAL ELECTRICAL CHARACTERISTIC CURVES



MV5054-1 • MV5054-2 • MV5054-3

RED GaAsP LED LAMPS OPTOELECTRONICS PRODUCT GROUP

GENERAL DESCRIPTION – The MV5054 series lamps are red light emitting diodes encapsulated in red diffused plastic. These devices provide an intense large area light source with wide angle viewing. Visual light emission is in the 600 nm to 700 nm range. Three brightness levels are available.

- **SOLID STATE THUS NO REPLACEMENT REQUIRED**
- **NO SOCKET REQUIRED**
- **HIGH ON/OFF CONTRAST**
- **FLEXIBLE PINS ON ALL LAMPS**
FOR GOOD HEAT SINKING
FOR RIGHT ANGLE BENDING
FITS STANDARD SOCKETS OR DRILLED HOLES
- **SINGLE MOLDED BODY ELIMINATES THERMAL CYCLING PROBLEMS**
- **HIGH TEMPERATURE EPOXY ENCAPSULATION WITHSTANDS SEVERE ENVIRONMENTAL TEMPERATURES**
- **LOW POWER CONSUMPTION MEANS IC COMPATIBILITY**
- **MV5054-1 HAS 2.0 mcd TYP LUMINOUS INTENSITY**
- **MV5054-2 HAS 3.0 mcd TYP LUMINOUS INTENSITY**
- **MV5054-3 HAS 4.0 mcd TYP LUMINOUS INTENSITY**

ABSOLUTE MAXIMUM RATINGS

Maximum Temperature and Humidity

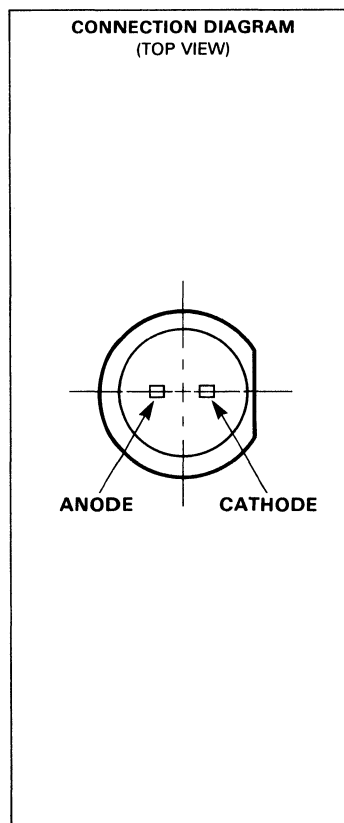
Storage Temperature	-55°C to +100°C
Operating Temperature	-55°C to +100°C
Pin Temperature (Soldering, 5 s)	260°C
Relative Humidity at 85°C	85%

Maximum Power Dissipation

Total Dissipation at $T_A = 25^\circ\text{C}$	125 mW
Derate Linearly from 25°C	1.3 mW/°C

Maximum Voltage and Currents

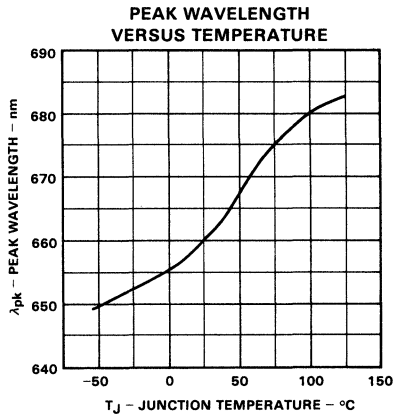
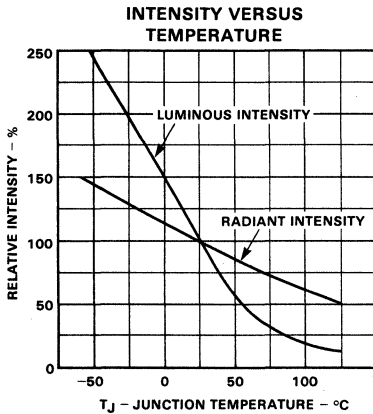
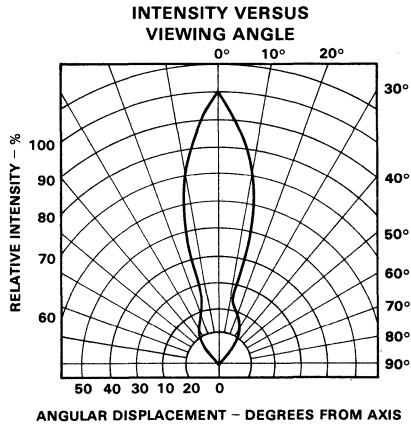
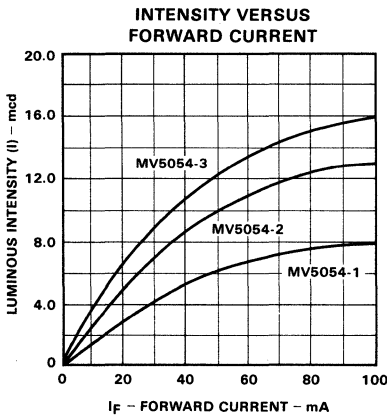
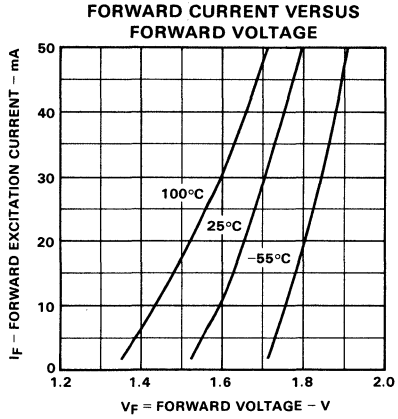
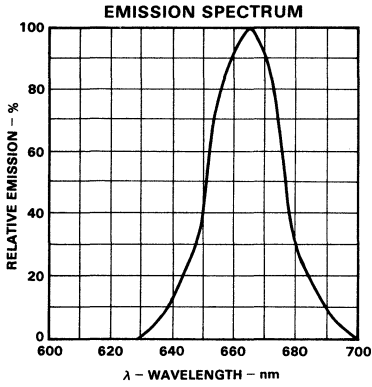
V_R	Reverse Voltage	5.0 V
I_F	Forward Current at $T_A = 25^\circ\text{C}$	100 mA
	at $T_A = 100^\circ\text{C}$	15 mA
i_f	Peak Forward Current (1.0 μs pulse width, 0.1% duty cycle)	1.0 A



ELECTRICAL AND RADIANT CHARACTERISTICS: $T_A = 25^\circ\text{C}$

SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	TEST CONDITIONS
V_F	Forward Voltage		1.8	2.2	V	$I_F = 10\text{ mA}$
BV_R	Reverse Breakdown Voltage	5.0	25		V	$I_R = 100\ \mu\text{A}$
I_O	Axial Luminous Intensity				mcd	$I_F = 10\text{ mA}$
	MV5054-1	1.0	2.0			
	MV5054-2	2.0	3.0			
	MV5054-3	3.0	4.0			
$\theta_{1/2}$	Viewing Angle to Half Intensity		± 12		degrees	$I_F = 20\text{ mA}$
λ_{pk}	Peak Wavelength		660		nm	$I_F = 20\text{ mA}$

TYPICAL ELECTRICAL CHARACTERISTIC CURVES



MV5055 • MV5056

WIDE ANGLE RED GaAsP LED LAMPS

OPTOELECTRONICS PRODUCT GROUP

GENERAL DESCRIPTION — The MV5055 and MV5056 are red light emitting diodes encapsulated in diffused plastic. These LED devices provide an intense large area light source. Visual light emission is in the 600 nm to 700 nm range. The design has maximized viewing angle.

- **SOLID STATE THUS NO REPLACEMENT REQUIRED**
- **NO SOCKET REQUIRED**
- **HIGH ON/OFF CONTRAST**
- **FLEXIBLE PINS ON ALL LAMPS**
 - FOR GOOD HEAT SINKING
 - FOR RIGHT ANGLE BENDING
 - FITS STANDARD SOCKETS FOR DRILLED HOLES
- **SINGLE MOLDED BODY ELIMINATES THERMAL CYCLING PROBLEMS**
- **HIGH TEMPERATURE EPOXY ENCAPSULATION WITHSTAND SEVERE ENVIRONMENTAL TEMPERATURES**
- **LOW POWER CONSUMPTION MEANS IC COMPATIBILITY**
- **MV5055 IN RED DIFFUSED EPOXY**
- **MV5056 IN RED DIFFUSED EPOXY**

ABSOLUTE MAXIMUM RATINGS

Maximum Temperature and Humidity

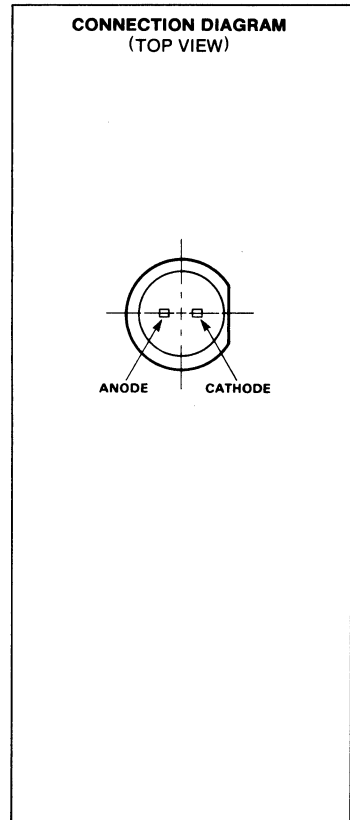
Operating Temperature	-55°C to +110°C
Storage Temperature	-55°C to +100°C
Pin Temperature (Soldering, 5 s)	260°C
Relative Humidity at 85°C	85%

Maximum Power Dissipation

Total Dissipation at $T_A = 25^\circ\text{C}$	125 mW
Derate Linearly from 25°C	1.3 mW/°C

Maximum Voltage and Currents

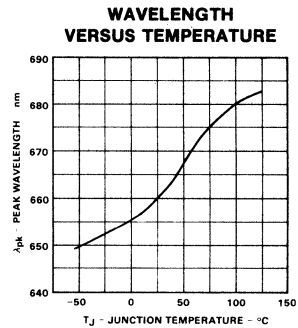
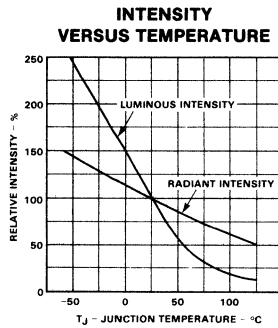
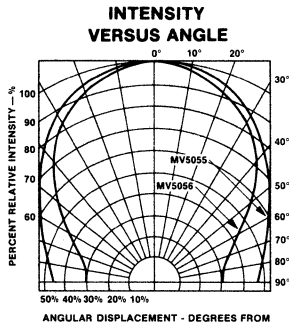
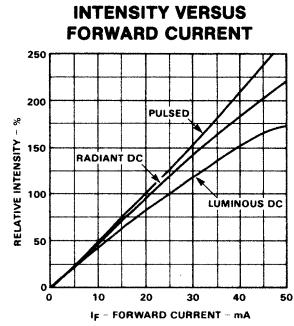
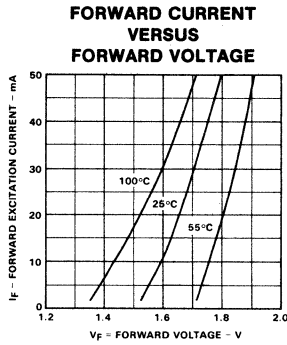
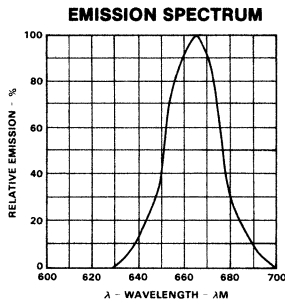
V_R	Reverse Voltage	5.0 V
I_F	Forward Current at $T_A = 25^\circ\text{C}$	100 mA
	at $T_A = 100^\circ\text{C}$	15 mA
I_{PK}	Forward Peak Current (1.0 μs pulse)	1.0 A



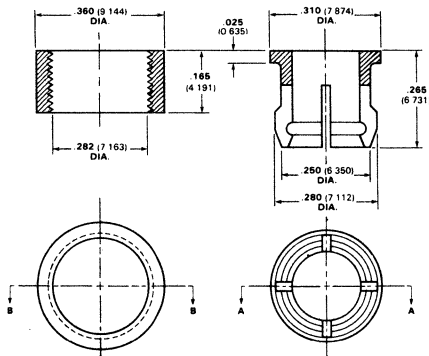
ELECTRICAL AND RADIANT CHARACTERISTICS: $T_A = 25^\circ\text{C}$

SYMBOL	CHARACTERISTICS	MIN	TYP	MAX	UNITS	TEST CONDITIONS
V_F	Forward Voltage		1.7	2.2	V	$I_F = 20\text{ mA}$
V_R	Reverse Voltage	5.0	25		V	$I_R = 100\ \mu\text{A}$
I_O	Axial Luminous Intensity				mcd	$I_F = 20\text{ mA}$
	MV5055		0.6			
	MV5056		0.8			
$\theta_{1/2}$	Viewing Angle to Half Intensity				degrees	$I_F = 20\text{ mA}$
	MV5055		± 75			
	MV5056		± 55			
λ_{pk}	Peak Wavelength		660		nm	$I_F = 20\text{ mA}$

TYPICAL ELECTRICAL CHARACTERISTIC CURVES



MP52 MOUNTING HARDWARE



Material: polypro or equivalent
For mounting drill a .25" hole

MV5152 • MV5153 • MV5154

AMBER SUPER GaAsP LED LAMPS

OPTOELECTRONICS PRODUCT GROUP

GENERAL DESCRIPTION – The MV5152, MV5153 and MV5154 are red light emitting diodes encapsulated in amber epoxy. Viewing angle can be selected from point source to wide angle. Visual light emission is in the 590 nm to 660 nm range.

- HIGH LUMINOUS INTENSITY FOR AMBIENT LIGHT LEVELS
- SOLID STATE – NO REPLACEMENT REQUIRED
- HIGH ON/OFF CONTRAST
- FLEXIBLE PINS ON ALL LAMPS
FOR GOOD HEAT SINKING
FOR RIGHT ANGLE BENDING
FITS STANDARD SOCKETS OR DRILLED HOLES
- SINGLE MOLDED BODY ELIMINATES THERMAL CYCLING PROBLEMS
- LOW POWER FOR IC COMPATIBILITY
- MV5152 FOR POINT SOURCE LAMPS
- MV5153 FOR WIDE ANGLE LAMPS
- MV5154 FOR INTERMEDIATE DISPERSION LAMPS

ABSOLUTE MAXIMUM RATINGS

Maximum Temperature and Humidity

Storage Temperature	-55°C to +100°C
Operating Temperature	-55°C to +100°C
Pin Temperature (Soldering, 5 s)	260°C
Relative Humidity at 85°C	85%

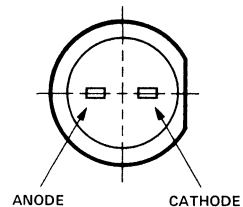
Maximum Power Dissipation

Total Dissipation at $T_A = 25^\circ\text{C}$	105 mW
Derate Linearly from 25°C	1.14 mW/°C

Maximum Voltage and Currents

V_R	Reverse Voltage	5.0 V
I_F	Forward Current at $T_A = 25^\circ\text{C}$	35 mA
i_f	Peak Forward Current (1.0 μs pulse width, 0.1% duty cycle)	1.0 A

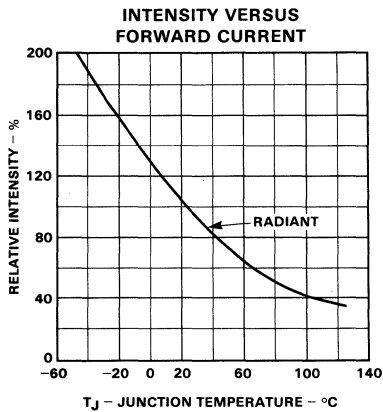
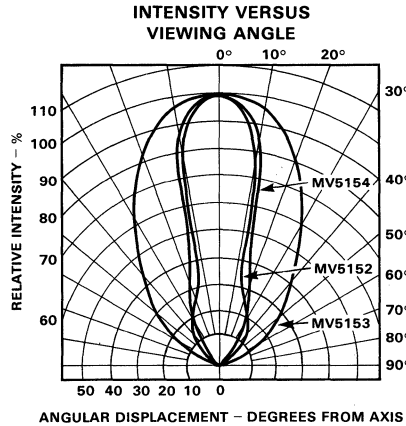
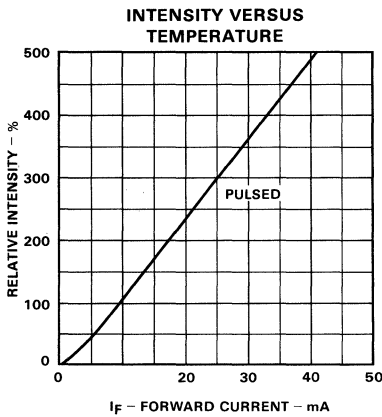
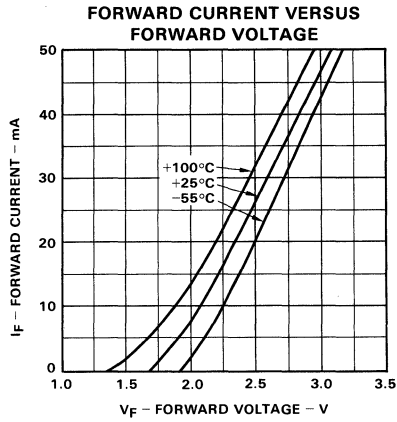
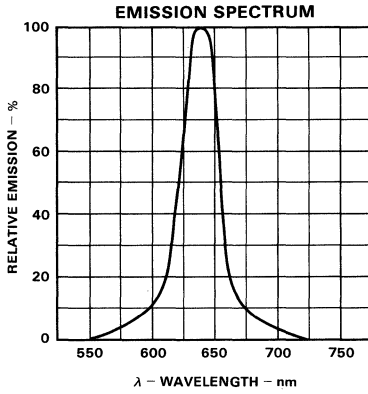
CONNECTION DIAGRAM
(TOP VIEW)



ELECTRICAL AND RADIANT CHARACTERISTICS: $T_A = 25^\circ\text{C}$

SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	TEST CONDITIONS
V_F	Forward Voltage		2.0	3.0	V	$I_F = 20 \text{ mA}$
BV_R	Reverse Breakdown Voltage	5.0	25		V	$I_R = 100 \mu\text{A}$
I_O	Axial Luminous Intensity				mcd	$I_F = 20 \text{ mA}$
	MV5152		20			
	MV5153		4.0			
	MV5154		8.0			
$\theta_{1/2}$	Viewing Angle to Half Intensity				degrees	$I_F = 20 \text{ mA}$
	MV5152		± 10			
	MV5153		± 32			
	MV5154		± 12			
λ_{pk}	Peak Wavelength		635		nm	$I_F = 20 \text{ mA}$

TYPICAL ELECTRICAL CHARACTERISTIC CURVES

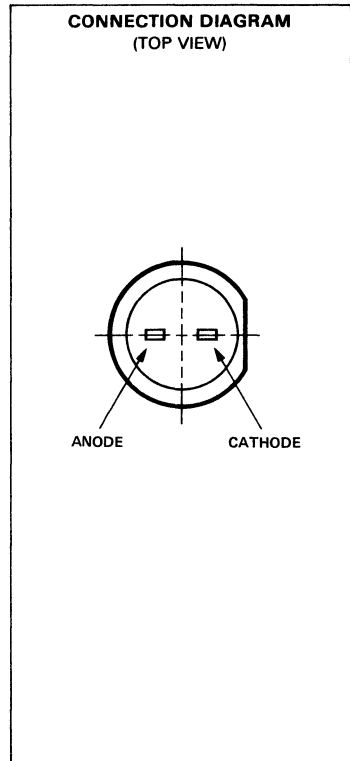


MV5252 • MV5253 • MV5254

GREEN GaP LED LAMPS OPTOELECTRONICS PRODUCT GROUP

GENERAL DESCRIPTION – The MV5252, MV5253 and MV5254 are green light emitting diodes encapsulated in green epoxy. Viewing angle can be selected from point source to wide angle. Visual light emission is in the 530 nm to 590 nm range.

- HIGH LUMINOUS INTENSITY FOR AMBIENT LIGHT LEVELS
- SOLID STATE – NO REPLACEMENT REQUIRED
- HIGH ON/OFF CONTRAST
- FLEXIBLE PINS ON ALL LAMPS
FOR GOOD HEAT SINKING
FOR RIGHT ANGLE BENDING
FITS STANDARD SOCKETS OR DRILLED HOLES
- SINGLE MOLDED BODY ELIMINATES THERMAL CYCLING PROBLEMS
- LOW POWER FOR IC COMPATIBILITY
- MV5252 FOR POINT SOURCE LAMPS
- MV5253 FOR WIDE ANGLE LAMPS
- MV5254 FOR INTERMEDIATE DISPERSION LAMPS



ABSOLUTE MAXIMUM RATINGS

Maximum Temperature and Humidity

Storage Temperature	-55°C to +100°C
Operating Temperature	-55°C to +100°C
Pin Temperature (Soldering, 5 s)	260°C
Relative Humidity at 85°C	85%

Maximum Power Dissipation

Total Dissipation at $T_A = 25^\circ\text{C}$	105 mW
Derate Linearly from 25°C	1.14 mW/°C

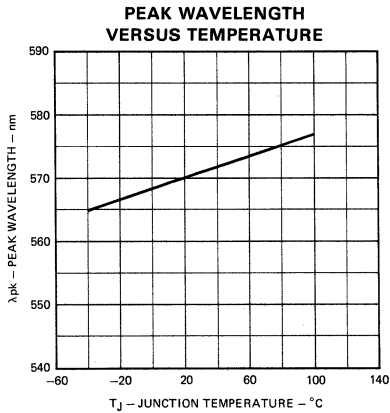
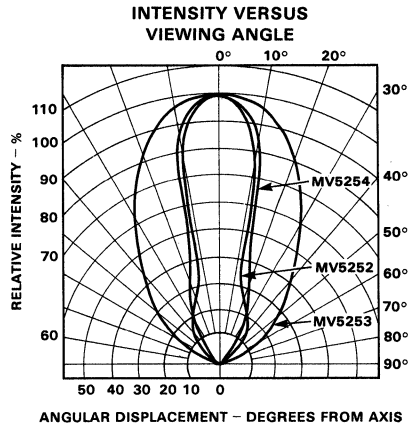
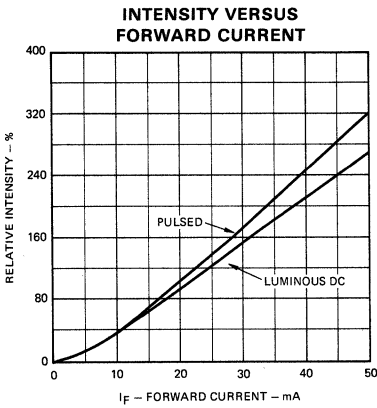
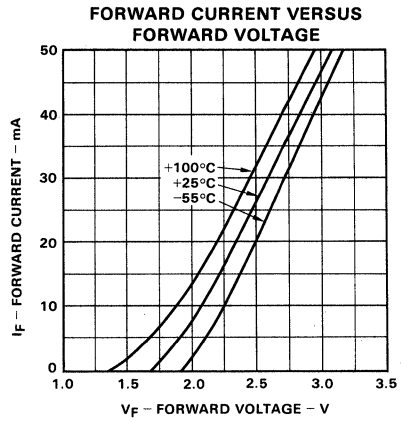
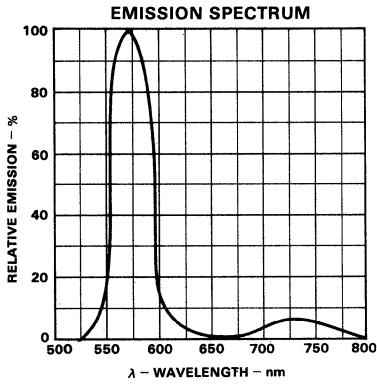
Maximum Voltage and Currents

V_R	Reverse Voltage	5.0 V
I_F	Forward Current at $T_A = 25^\circ\text{C}$	35 mA
i_f	Peak Forward Current (1.0 μs pulse width, 0.1% duty cycle)	1.0 A

ELECTRICAL AND RADIANT CHARACTERISTICS: $T_A = 25^\circ\text{C}$

SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	TEST CONDITIONS
V_F	Forward Voltage		2.2	3.0	V	$I_F = 20\text{ mA}$
BV_R	Reverse Breakdown Voltage	5.0	25		V	$I_R = 100\ \mu\text{A}$
I_O	Axial Luminous Intensity				mcd	$I_F = 20\text{ mA}$
	MV5252		30.0			
	MV5253		3.0			
	MV5254		6.0			
$\theta_{1/2}$	Viewing Angle to Half Intensity				degrees	$I_F = 20\text{ mA}$
	MV5252		± 10			
	MV5253		± 32			
	MV5254		± 12			
λ_{pk}	Peak Wavelength		565		nm	$I_F = 20\text{ mA}$

TYPICAL ELECTRICAL CHARACTERISTIC CURVES



MV5352 • MV5353 • MV5354

YELLOW GaP LED LAMPS

OPTOELECTRONICS PRODUCT GROUP

GENERAL DESCRIPTION – The MV5352, MV5353 and MV5354 are yellow light emitting diodes encapsulated in yellow epoxy. Viewing angle can be selected from point source to wide angle. Visual light emission is in the 525 nm to 625 nm range.

- HIGH LUMINOUS INTENSITY FOR AMBIENT LIGHT LEVELS
- SOLID STATE – NO REPLACEMENT REQUIRED
- HIGH ON/OFF CONTRAST
- FLEXIBLE PINS ON ALL LAMPS
 - FOR GOOD HEAT SINKING
 - FOR RIGHT ANGLE BENDING
 - FITS STANDARD SOCKETS OR DRILLED HOLES
- SINGLE MOLDED BODY ELIMINATES THERMAL CYCLING PROBLEMS
- LOW POWER FOR IC COMPATIBILITY
- MV5352 FOR POINT SOURCE LAMPS
- MV5353 FOR WIDE ANGLE LAMPS
- MV5354 FOR INTERMEDIATE DISPERSION LAMPS

ABSOLUTE MAXIMUM RATINGS

Maximum Temperature and Humidity

Storage Temperature	-55°C to +100°C
Operating Temperature	-55°C to +100°C
Pin Temperature (Soldering, 5 s)	260°C
Relative Humidity at 85°C	85%

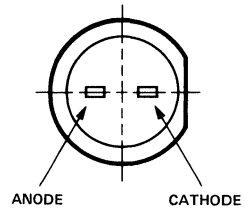
Maximum Power Dissipation

Total Dissipation at $T_A = 25^\circ\text{C}$	105 mW
Derate Linearly from 25°C	1.14 mW/°C

Maximum Voltage and Currents

V_R	Reverse Voltage	5.0 V
I_F	Forward Current at $T_A = 25^\circ\text{C}$	35 mA
if	Peak Forward Current (1.0 μs pulse width, 0.1% duty cycle)	1.0 A

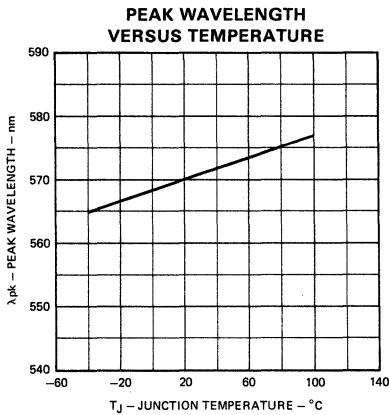
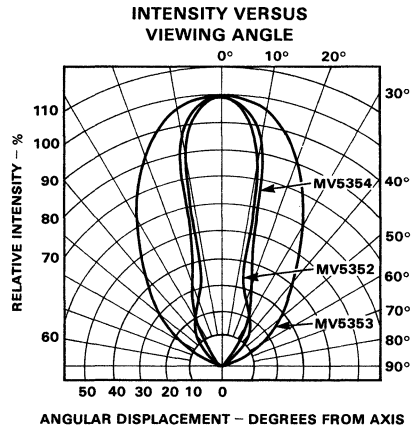
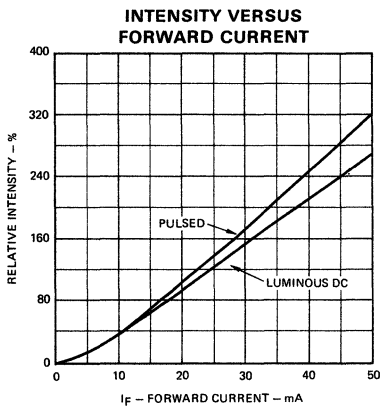
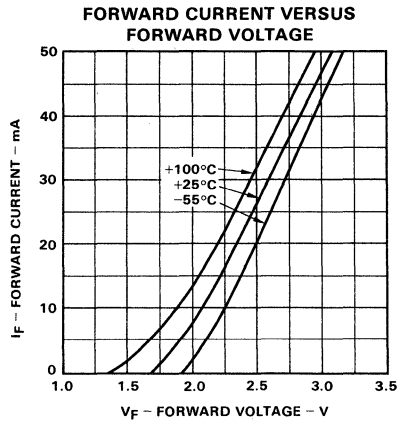
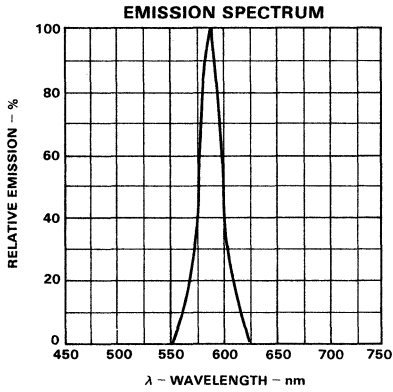
CONNECTION DIAGRAM
(TOP VIEW)



ELECTRICAL AND RADIANT CHARACTERISTICS: $T_A = 25^\circ\text{C}$

SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	TEST CONDITIONS
V_F	Forward Voltage		2.1	3.0	V	$I_F = 20 \text{ mA}$
BV_R	Reverse Breakdown Voltage	5.0	25		V	$I_R = 100 \mu\text{A}$
I_O	Axial Luminous Intensity				mcd	$I_F = 20 \text{ mA}$
	MV5352		20			
	MV5353		6.0			
	MV5354		10			
$\theta_{1/2}$	Viewing Angle to Half Intensity				degrees	$I_F = 20 \text{ mA}$
	MV5352		± 10			
	MV5353		± 32			
	MV5354		± 12			
λ_{pk}	Peak Wavelength		585		nm	$I_F = 20 \text{ mA}$

TYPICAL ELECTRICAL CHARACTERISTIC CURVES



MV5752 • MV5753 • MV5754

RED SUPER GaAsP LED LAMPS

OPTOELECTRONICS PRODUCT GROUP

GENERAL DESCRIPTION – The MV5752, MV5753 and MV5754 are red light emitting diodes encapsulated in red epoxy. Viewing angle can be selected from point source to wide angle. Visual light emission is in the 590 nm to 660 nm range.

- HIGH LUMINOUS INTENSITY FOR AMBIENT LIGHT LEVELS
- SOLID STATE – NO REPLACEMENT REQUIRED
- HIGH ON/OFF CONTRAST
- FLEXIBLE PINS ON ALL LAMPS
FOR GOOD HEAT SINKING
FOR RIGHT ANGLE BENDING
FITS STANDARD SOCKETS OR DRILLED HOLES
- SINGLE MOLDED BODY ELIMINATES THERMAL CYCLING PROBLEMS
- LOW POWER FOR IC COMPATIBILITY
- MV5752 FOR POINT SOURCE LAMPS
- MV5753 FOR WIDE ANGLE LAMPS
- MV5754 FOR INTERMEDIATE DISPERSION LAMPS

ABSOLUTE MAXIMUM RATINGS

Maximum Temperature and Humidity

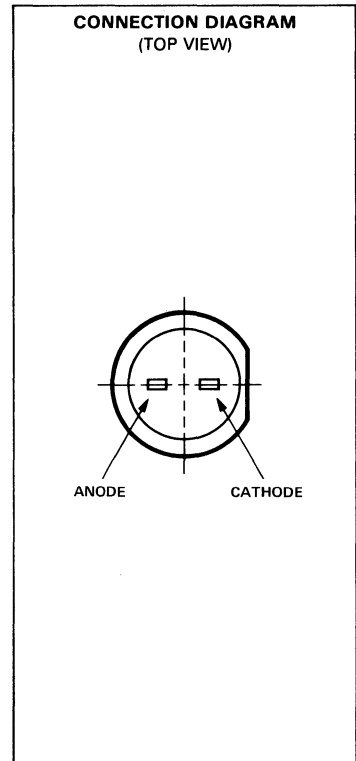
Storage Temperature	-55°C to +100°C
Operating Temperature	-55°C to +100°C
Pin Temperature (Soldering, 5 s)	260°C
Relative Humidity at 85°C	85%

Maximum Power Dissipation

Total Dissipation at $T_A = 25^\circ\text{C}$	105 mW
Derate Linearly from 25°C	1.14 mW/°C

Maximum Voltage and Currents

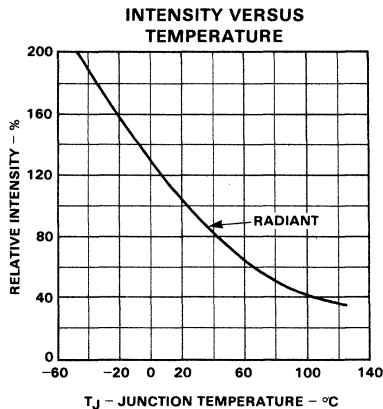
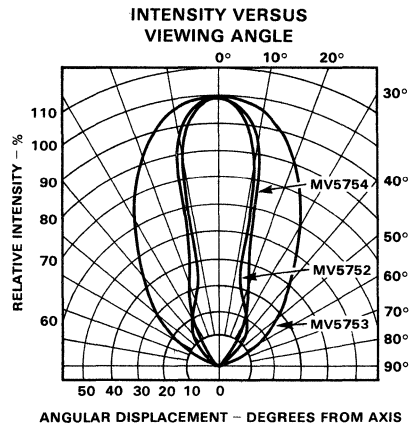
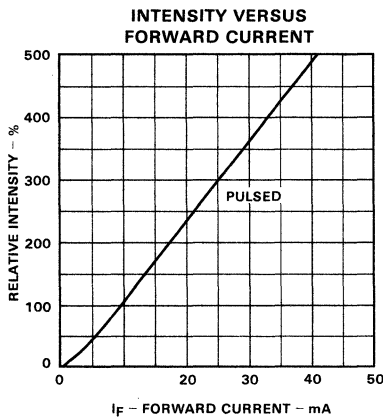
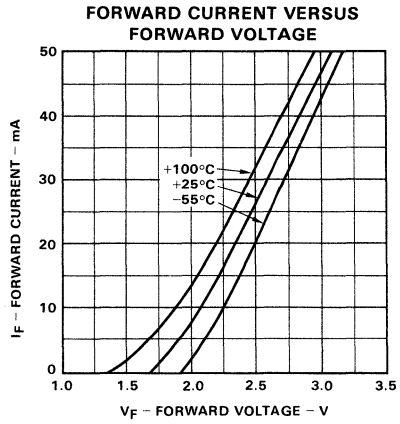
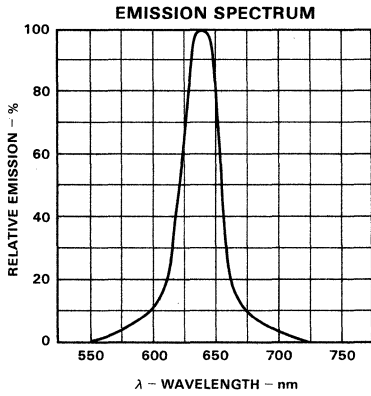
V_R	Reverse Voltage	5.0 V
I_F	Forward Current at $T_A = 25^\circ\text{C}$	35 mA
i_f	Peak Forward Current (1.0 μs pulse width, 0.1% duty cycle)	1.0 A



ELECTRICAL AND RADIANT CHARACTERISTICS: $T_A = 25^\circ\text{C}$

SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	TEST CONDITIONS
V_F	Forward Voltage		2.0	3.0	V	$I_F = 20\text{ mA}$
BV_R	Reverse Breakdown Voltage	5.0	25		V	$I_R = 100\ \mu\text{A}$
I_O	Axial Luminous Intensity				mcd	$I_F = 20\text{ mA}$
	MV5752		16			
	MV5753		4.0			
	MV5754		8.0			
$\theta_{1/2}$	Viewing Angle to Half Intensity				degrees	$I_F = 20\text{ mA}$
	MV5752		± 10			
	MV5753		± 32			
	MV5754		± 12			
λ_{pk}	Peak Wavelength		635		nm	$I_F = 20\text{ mA}$

TYPICAL ELECTRICAL CHARACTERISTIC CURVES



TIL209A • TIL211 • TIL213

RED, GREEN AND YELLOW T-1 LED LAMPS

OPTOELECTRONICS PRODUCT GROUP

GENERAL DESCRIPTION – The TIL209A is a red GaAsP T-1 lamp. The TIL211 is a green GaP T-1 lamp, and the TIL213 is a yellow T-1 lamp. These devices provide a low-cost lamp for applications where space is at a premium.

- SMALL SIZE
- THREE COLORS AVAILABLE
- LOW POWER CONSUMPTION MEANS IC COMPATABILITY
- NO SOCKET REQUIRED

ABSOLUTE MAXIMUM RATINGS

Maximum Temperature and Humidity

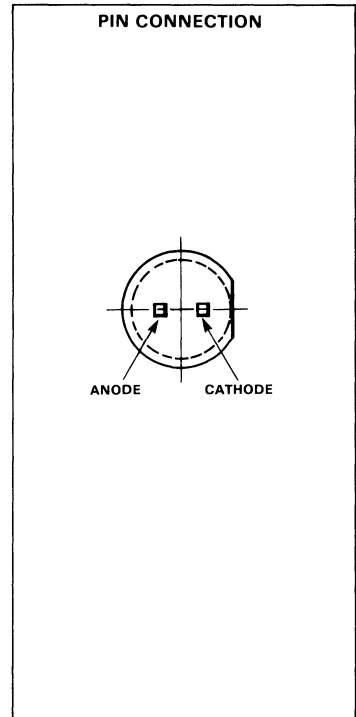
Operating Temperature	-40°C to +80°C
Storage Temperature	-40°C to +80°C
Pin Temperature (Soldering, 5 s)	230°C
Relative Humidity at 85 °C	85%

Maximum Power Dissipation

Total Dissipation at $T_A = 25^\circ\text{C}$	100 mW
Derate Linearly from 25°C	1.33 mW/°C

Maximum Voltage and Currents

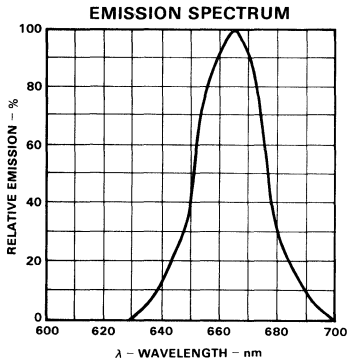
V_R	Reverse Voltage	3.0 V
I_F	Forward dc Current	
	TIL209A	40 mA
	TIL211, TIL213	30 mA
i_f	Peak Forward Current (1.0 μs pulse width)	1.0 A



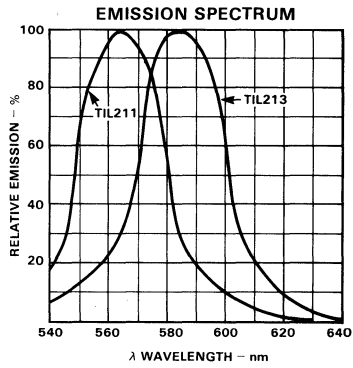
ELECTRICAL AND RADIANT CHARACTERISTICS: $T_A = 25^\circ\text{C}$

SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	TEST CONDITIONS
V_F	Forward Voltage					
	TIL209A		1.6	2.0	V	$I_F = 20 \text{ mA}$
	TIL211, TIL213		2.3	3.0	V	$I_F = 25 \text{ mA}$
V_R	Reverse Voltage					
	TIL209A, TIL211, TIL213	3.0			V	$I_R = 100 \mu\text{A}$
I_O	Axial Luminous Intensity					
	TIL209A	500	1000		μcd	$I_F = 20 \text{ mA}$
	TIL211, TIL213	800	4000		μcd	$I_F = 25 \text{ mA}$
λ_{pk}	Peak Wavelength					
	TIL209A		665		nm	$I_F = 20 \text{ mA}$
	TIL211		565		nm	$I_F = 20 \text{ mA}$
	TIL213		585		nm	$I_F = 20 \text{ mA}$

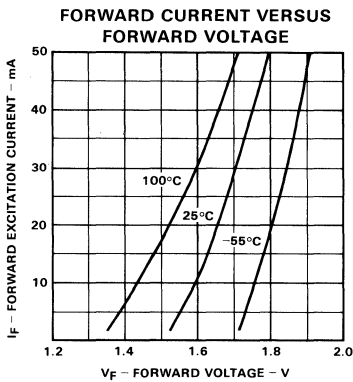
TYPICAL ELECTRICAL CHARACTERISTIC CURVES



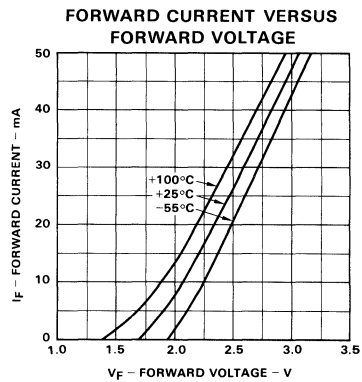
TIL 209A



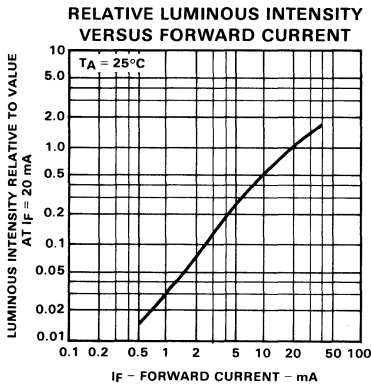
TIL 211, TIL 213



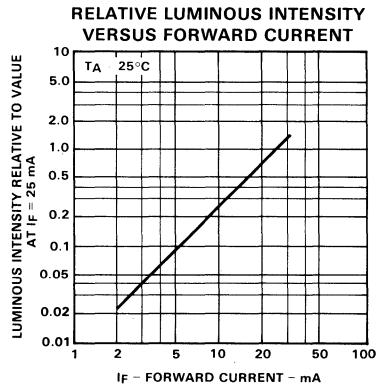
TIL 209A



TIL 211, TIL 213



TIL 209A



TIL 211, TIL 213

FLS010

FRONT PANEL ADAPTER

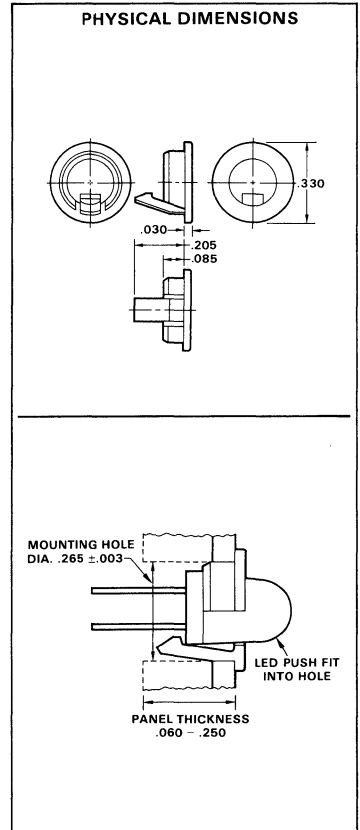
FOR LED LAMP

GENERAL DESCRIPTION – The FLS010 is a panel mount adapter specially designed for use with all Fairchild .200" LED lamps.

- SINGLE PART CONSTRUCTION
- SIMPLE ASSEMBLY TECHNIQUE
- BLACK FINISH GIVES MAXIMUM ON/OFF CONTRAST
- FITS PANELS .060" to .250" THICK
- FITS LAMPS .280" THROUGH .360" TALL
- REMOVABLE FROM EITHER FRONT OR REAR
- ORIENTS TO FLAT ON LED FOR EASY POLARITY INSPECTION
- NEARLY FLUSH WITH FRONT PANEL SURFACE
- REQUIRES STANDARD H-SIZE DRILL HOLE IN PANEL

MOUNTING INSTRUCTIONS

1. The panel hole for the mounting clip should be $0.265'' (\pm 0.002'')$ and the hole edges should be deburred (this permits a 17/64 or H size drill to be used).
2. Insert the LED, lens first, with the flat flush against the tab, into the tab end of the clip. Press firmly until the tab snaps over the flat and locks the unit into the clip.
3. Insert the mounting clip and LED assembly into the panel hole, pins first, from the front side of the panel. Use a hollowed cylinder whose internal diameter is greater than .200" and less than .24" (i.e. either a piece of 3/8" poly-flo tubing or 3/16" nut driver) to "press fit" the clip into the panel until the flange is seated snugly on the panel.



FLS011 • FLS012

PANEL MOUNTING HARDWARE KIT

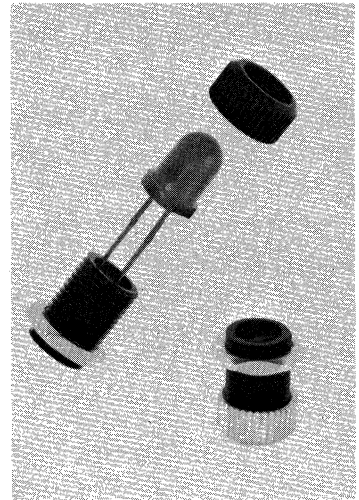
FOR T-1 3/4 LED LAMPS
OPTOELECTRONICS PRODUCT GROUP

GENERAL DESCRIPTION – Simplify the assembly and removal of LED lamps by using the FLS011 or FLS012 mounting hardware kit.

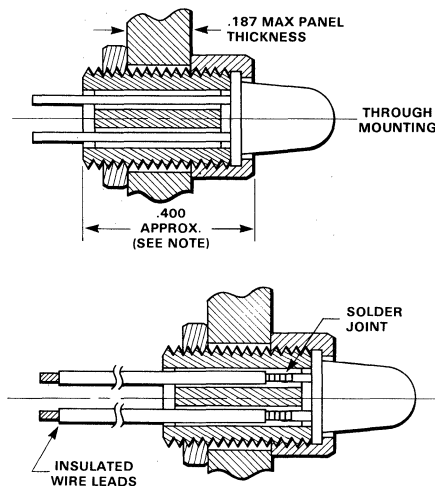
- **THREE PIECES:**
 - A GLASS FILLED BLACK NYLON BARREL.
 - A STEEL HEX NUT, CHROME PLATED.
 - A KNURLED STEEL BEZEL, EITHER CHROME PLATED (FLS011) OR BLACK (FLS012).
- ASSEMBLE THE HARDWARE FROM EITHER THE FRONT OR REAR OF THE PANEL.
- INSTALL THROUGH A STANDARD 1/4 INCH DIAMETER HOLE; EITHER DRILLED OR PUNCHED, WITH NO CRITICAL TOLERANCES.
- ACCOMMODATES STANDARD T-1 3/4 LED LAMPS WITH .185 INCH TO .203 INCH BARREL DIAMETER. ALSO FITS TO-18 CASE LAMPS.
- FINGERS EASILY GRASP THE THICK KNURLED BEZEL.
- LARGE .062 INCH DIAMETER HOLES THROUGH THE BARREL ALLOW SOLDERED OR WIRE WRAPPED PINS TO PASS THROUGH.
- ADJUST TO ANY PANEL THICKNESS UP TO 3/16 INCH.
- FINE THREADS RESIST LOOSENING FROM VIBRATION.
- BLACK BEZEL OFFERS MAXIMUM ON/OFF CONTRAST RATIO.

ORDERING INFORMATION:

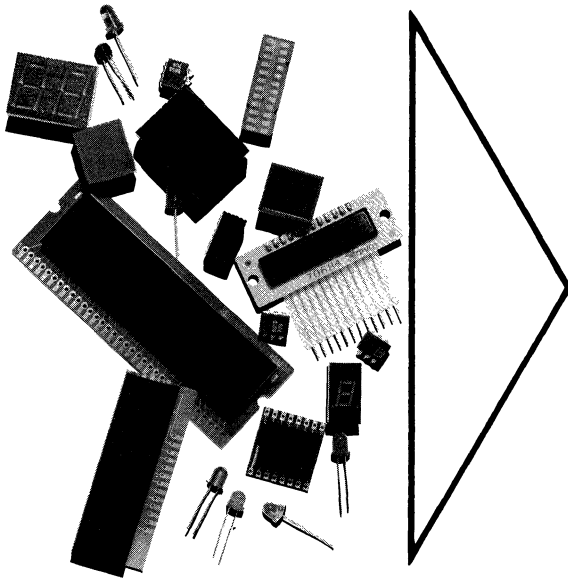
For silver bezel retaining nut version, order FLS011. For black bezel retaining nut version, order FLS012.



MOUNTING OPTIONS



NOTE: .440 Dimension varies with LED used.



OPTOELECTRONIC TECHNOLOGY 1

DISCRETE LED DIGIT RELIABILITY 2

VISIBLE LED LAMPS AND MOUNTING HARDWARE 3

SEVEN-SEGMENT DISPLAYS AND DISPLAY ARRAYS 4

PHOTOTRANSISTORS, INFRARED EMITTERS, AND SENSORS 5

PHOTOCOUPLERS 6

PACKAGE OUTLINES 7

DEFINITIONS OF SYMBOLS AND TERMS 8

FAIRCHILD FIELD SALES OFFICES, SALES REPRESENTATIVES AND DISTRIBUTOR LOCATIONS 9

CHAPTER 4

INTRODUCTION

Automation continues to demand better display readout devices for point-of-sale equipment, digital voltmeters, and a multitude of other applications. Seven-segment-digit displays have become popular in large part because of their low cost, single-plane readout, and modern appearance. The result is availability of seven-segment digits and arrays in a wide variety of shapes, sizes, input drive requirements, and principles of operation. Most electronic readout devices are based upon gas discharge, florescent, incandescent, or solid state technologies. Among the other technologies for making seven-segment displays are electroluminescence and light-emitting thin films. These latter, however, have very high voltage requirements, and integrated circuit decoder/drivers for them are cumbersome and difficult to manufacture.

Light-emitting diode (LED) displays, which are products of solid state technology, are now found in a wide variety of electronic equipment and products. They have gained popularity because of their compact size, voltage and current compatibility with integrated circuits, and solid state reliability.

The primary considerations in manufacturing discrete LED display digits are reliability, ease of construction, quality of appearance, light intensity, and viewing angle. Over the last few years, three major techniques have been developed for assembling discrete LED digits.

The oldest technique is the filled digit, in which the LEDs are wire-bonded to a lead frame. A plastic cover with seven rectangular slots is placed over the lead frame and the entire assembly back filled with a red translucent diffused-plastic encapsulant. Another technique uses a printed circuit board instead of a lead frame to hold the LEDs, segment cover, and lens cap

The third approach is Fairchild's advanced air-filled light pipe process, a newer technique that combines the advantages of substantially lowered manufacturing costs with improved display intensity and appearance.

LED LIGHT PIPE DIGIT CONSTRUCTION

In the air-filled light pipe process, a lead frame provides mechanical support for, and makes electrical contact with, the LEDs that form each digit segment. After die attachment, the entire frame, or die platform, is placed in a mold and encapsulated with a clear optical-grade plastic. Magnifying lenses for the LEDs are cast in indentations in the mold surface.

After encapsulation, a reflector assembly, or light pipe, is placed over the die platform. Light pipes are injection molded from an acrylonitrile-butadiene-styrene (ABS) plastic that contains a reflective compound to increase the brightness of the display. The light pipe contains trapezoidal cavities, and is positioned so that the small ends of the cavities are situated directly over the LEDs and lenses. The larger top ends of the cavities have many times the surface area of the LEDs at the bottom. Finally, a lens cap is mounted over the die platform/light pipe assembly and the entire unit sealed. When one of the LEDs illuminates, light not only passes directly from the die, but is also reflected off the sidewalls of the cavity above it. The light is diffused by a diffusing agent in the lens cap and by the reflecting action of the light pipe. The net effect is that much more light reaches the viewer than would be emitted by a digit without a light pipe.

Regardless of manufacturing technique, all digits need a light-diffusing system to give segment an evenly lighted appearance. In filled digits, a diffusing chemical is mixed into the encapsulation, which then acts as the diffusing surface. Printed-circuit-board digits have a thin diffusing film mounted in back of the lens cap. The light pipe digit, however, incorporates a diffusing agent into the polycarbonate plastic of the lens cap itself. Furthermore, the light pipe acts as a diffuser, since it breaks up and scatters the light by reflection. This scattering of the reflected light, combined with the diffusing agent in the lens cap, results in digits that emit light evenly and pleasantly over the entire segment viewing area.

The light-diffusing lens cap and light pipe combination provides optimum light transmission while simplifying assembly. Polycarbonate was selected as the lens cap material because it offers excellent light transmission along with a high heat-deflection point, chemical resistance, and compatibility with the diffusing agent.

FAIRCHILD DISPLAY CROSS REFERENCE KEY

COMPETITION:

HP	Hewlett-Packard
LIT	Litronix
MON	Monsanto
NAT	National
TI	Texas Instruments

COLOR:

A	Amber
G	Green
O	Orange
R	Red
Y	Yellow

POLARITY:

CC	Common Cathode
CA	Common Anode
U	Universal
M	Monolithic Display

DECIMAL:

RH	Right Hand
LH	Left Hand
C	Center Decimal
N	No Decimal

CODE:

NC-P	Not crossable because of package differences
NC-C	Not crossable because of color wavelength differences
NC-E	Not crossable because of electrical differences
A	Fairchild device is a direct replacement
B	Fairchild device is easily crossable with minor electrical differences as noted
C	Fairchild device is easily crossable with minor mechanical differences as noted
D	Significant electrical differences between devices as noted
E	Significant mechanical differences between devices as noted
W	Display array could be directly crossed with high volume order
X	Direct replacement to be introduced 1st quarter 1978.
Y	Direct replacement to be introduced 4th quarter 1977.

NOTES:

- 1 Fairchild device has different pinout.
- 2 Fairchild device has minor font differences on segments
- 3 Technology differences between devices (light pipe structure vs liquid filled segments)
- 4 Competitor device is 5 x 7 dot matrix
- 5 Competitor device has decimal point on opposite side as FSC.
- 6 Competitor device is .51" character height; FSC is .565" high.
- 7 Competitor device is .63" character height; FSC is .8" high.
- 8 Package thickness difference. Fairchild device is thicker.
- 9 Wired for direct drive: (ie: all segments brought out).
- 10 Wired for multiplexed: (ie: all segments tied together).
- 11 Competitor device is common anode. FSC device is common cathode
- 12 Competitor device uses super GaAsP die. FSC device has GaAsP die
- 13 Logic chip built into competitor device.
- 14 Only right hand decimal available on MAN72A device
- 15 No alarm indicator is on the Fairchild device
- 16 Minor mechanical spacing differences
- 17 Competitor device packaged in vinyl film. FSC device is in vial
- 18 Competitor device is waffle packed. FSC part is packed in vial.
- 19 Minor character height difference in die size

DEVICE CHARACTERISTICS

DEVICE	COMPETITOR	SIZE	COLOR	POLARITY	DESCRIPTION	FAIRCHILD		CODE	NOTES
						DECIMAL	DEVICE		
HDSP-2000	HP	.3	R	M	4-Character Alphanumeric Dis.	N		NC-P	
5082-7010	HP	.27	R	M	Numeric Indicator	LH		NC-P	4
5082-7011	HP	.27	R	M	Overflow ± 1	N		NC-P	
5082-7100	HR	.27	R	M	3-Character Alphanumeric Dis.	N		NC-P	4
5082-7101	HP	.27	R	M	4-Character Alphanumeric Dis.	N		NC-P	4
5082-7102	HP	.27	R	M	5-Character Alphanumeric Dis.	N		NC-P	4
5082-7240	HP	.102	R	M	8-Digit Calculator Display	RH		NC-P	
5082-7241	HP	.102	R	M	9-Digit Calculator Display	RH		NC-P	
5082-7265	HP	.175	R	M	5-Digit Monolithic Indicators	C		NC-P	
5082-7275	HP	.175	R	M	15-Digit Monolithic Indicators	C		NC-P	
5082-7285	HP	.175	R	M	5-Digit Monolithic Indicators	RH		NC-P	
5082-7295	HP	.175	R	M	15-Digit Monolithic Indicators	RH		NC-P	
5082-7300	HP	.29	R	M	Numeric Indicator	RH		NC-P	
5082-7302	HP	.29	R	M	Numeric Indicator	RH		NC-P	
5082-7304	HP	.29	R	M	Overflow + 1 Indicator	N		NC-P	
5082-7340	HP	.29	R	M	Hexadecimal Indicator	N		NC-P	
5082-7356	HP	.29	R	M	Numeric Indicator	RH		NC-P	
5082-7357	HP	.29	R	M	Numeric Indicator	LH		NC-P	
5082-7358	HP	.29	R	M	Overflow + 1 Indicator	N		NC-P	
5082-7359	HP	.29	R	M	Hexadecimal Indicator	N		NC-P	
5082-7391	HP	.29	R	M	Numeric Indicator	RH		NC-P	
5082-7392	HP	.29	R	M	Numeric Indicator	LH		NC-P	
5082-7393	HP	.29	R	M	Overflow + 1	N		NC-P	
5082-7395	HP	.29	R	M	Hexadecimal Display	N		NC-P	
5082-7402	HP	.11	R	M	3-Digit Monolithic Display	C		NC-P	
5082-7403	HP	.11	R	M	3-Digit Monolithic Display	C		NC-P	
5082-7404	HP	.11	R	M	4-Digit Monolithic Display	C		NC-P	
5082-7405	HP	.11	R	M	5-Digit Monolithic Display	C		NC-P	
5082-7412	HP	.11	R	M	3-Digit Monolithic Display	RH		NC-P	
5082-7413	HP	.11	R	M	3-Digit Monolithic Display	RH		NC-P	
5082-7414	HP	.11	R	M	4-Digit Monolithic Display	RH		NC-P	
5082-7415	HP	.11	R	M	5-Digit Monolithic Display	RH		NC-P	
5082-7432	HP	.11	R	M	2-Digit Monolithic Display	N		NC-P	
5082-7433	HP	.11	R	M	3-Digit Monolithic Display	N		NC-P	
5082-7440	HP	.105	R	M	8-Digit Calculator Display	RH		NC-P	
5082-7441	HP	.105	R	M	9-Digit Calculator Display	RH		NC-P	
5082-7442	HP	.100	R	M	12-Digit Calculator Display	RH		NC-P	
5082-7444	HP	.100	R	M	14-Digit Calculator Display	RH		NC-P	
5082-7445	HP	.100	R	M	12-Digit Calculator Display	RH		NC-P	
5082-7446	HP	.115	R	M	16-Digit Calculator Display	RH		NC-P	
5082-7447	HP	.112	R	M	14-Digit Calculator Display	RH		NC-P	
5082-7448	HP	.105	R	M	8-Digit Calculator Display	RH		NC-P	
5082-7449	HP	.105	R	M	9-Digit Calculator Display	RH		NC-P	
5082-7500	HP	1.50	R	M	Numeric Indicator	LH		NC-P	4
5082-7610	HP	.3	R	CA	7-Segment Display	LH	MAN72A	B	12
5082-7611	HP	.3	R	CA	7-Segment Display	RH	MAN71A	B	12
5082-7613	HP	.3	R	CC	7-Segment Display	RH	MAN74A	Y	1,12
5082-7616	HP	.3	R	U	Overflow + 1	RH	MAN73A	X	1,12
5082-7620	HP	.3	Y	CA	7-Segment Display	LH		NC-C	
5082-7621	HP	.3	Y	CA	7-Segment Display	RH		NC-C	
5082-7623	HP	.3	Y	CC	7-Segment Display	RH		NC-C	
5082-7626	HP	.3	Y	U	Overflow + 1	RH		NC-C	
5082-7630	HP	.3	G	CA	7-Segment Display	LH		NC-C	
5082-7631	HP	.3	G	CA	7-Segment Display	RH		NC-C	
5082-7633	HP	.3	G	CC	7-Segment Display	RH		NC-C	
5082-7636	HP	.3	G	U	Overflow + 1	RH		NC-C	
5082-7650	HP	.43	R	CA	7-Segment Display	LH	FND567	B/E	1,3,5,12
5082-7651	HP	.43	R	CA	7-Segment Display	RH	FND567	B/E	1,3,12
5082-7653	HP	.43	R	CC	7-Segment Display	RH	FND560	B/E	1,3,12
5082-7656	HP	.43	R	U	Overflow + 1	RH	FND568	B/E	1,12,13
5082-7660	HP	.43	Y	CA	7-Segment Display	LH		NC-C	
5082-7661	HP	.43	Y	CA	7-Segment Display	RH		NC-C	
5082-7663	HP	.43	Y	CC	7-Segment Display	RH		NC-C	
5082-7666	HP	.43	Y	U	Overflow + 1	RH		NC-C	
5082-7670	HP	.43	G	CA	7-Segment Display	LH	FND537	E	1,3,5
5082-7671	HP	.43	G	CA	7-Segment Display	RH	FND537	E	1,3
5082-7673	HP	.43	G	CC	7-Segment Display	RH	FND530	E	1,3
5082-7676	HP	.43	G	U	Overflow + 1	RH	FND531	E	1,3
5082-7730	HP	.3	R	CA	7-Segment Display	LH	MAN72A	A	
5082-7731	HP	.3	R	CA	7-Segment Display	RH	MAN71A	A	
5082-7736	HP	.3	R	U	Overflow + 1	RH	MAN73A	X	1
5082-7740	HP	.3	R	CC	7-Segment Display	RH	MAN74A	X	1
5082-7750	HP	.43	R	CA	7-Segment Display	LH	FND507	E	1,3,5
5082-7751	HP	.43	R	CA	7-Segment Display	RH	FND507	E	1,3

4

DEVICE CHARACTERISTICS

DEVICE	COMPETITOR	SIZE	COLOR	POLARITY	DESCRIPTION	DECIMAL	FAIRCHILD DEVICE	CODE	NOTES
5082-7756	HP	.43	R	U	Overflow + 1	RH	FND501	E	1,3
5082-7760	HP	.43	R	CC	7-Segment Display	RH	FND500	E	1,3
5082-7811	HP	.053	R	M	7-Segment Monolithic Die	N	FNX8050	C	17
5082-7821	HP	.053	R	M	7-Segment Monolithic Die	N	FNX8050	C	18
5082-7832	HP	.080	R	M	7-Segment Monolithic Die	N	FNX8038	A	17
5082-7842	HP	.080	R	M	7-Segment Monolithic Die	N	FNX8038	A	18
5082-7851	HP	.100	R	M	7-Segment Monolithic Die	N	FNX8008	A	17
5082-7852	HP	.100	R	M	9-Segment Monolithic Die	N	FNX8009	A	17
5082-7853	HP	.100	R	M	1 or Colon Monolithic Die	N	FNX8012	A	17
5082-7861	HP	.100	R	M	7-Segment Monolithic Die	N	FNX8008	A	18
5082-7862	HP	.100	R	M	9-Segment Monolithic Die	N	FNX8009	A	18
5082-7863	HP	.100	R	M	1 or Colon Monolithic Die	N	FNX8012	A	18
5082-7871	HP	.120	R	M	7-Segment Monolithic Die	N	FNX8010	C	17,19
5082-7881	HP	.120	R	M	7-Segment Monolithic Die	N	FNX8010	C	18,19
5082-7890	HP	.011	R	M	Colon Monolithic Die	N	FLX2110	C	
5082-7892	HP	.011	R	M	Colon Monolithic Die	N	FLX2110	C	
DL 10	LIT	.27	R	CA	Monochromatic 7-Seg. Display	LH		NC-P	
DL 101	LIT	.27	R	CA	Monochromatic Overflow + 1	N		NC-P	
DL 10A	LIT	.27	R	CA	Monochromatic 7-Seg. Display	LH		NC-P	
DL 101A	LIT	.27	R	CA	Monochromatic Overflow + 1	N		NC-P	
DL 34M	LIT	.11	R	CC	Lensed Monolithic Display	RH		NC-P	
DL 44M	LIT	.15	R	CC	Lensed Monolithic Display	RH		NC-P	
DL 57	LIT	.32	R		Alpha-Numeric Display	LH		NC-P	4
DL 416	LIT	.160	R	CC	4-Digit Alpha-Numeric Display	N		NC-P	
DL 701	LIT	.3	R	CA	Overflow + 1	N	MAN73A	X	2
DL 702	LIT	.3	R	CC	7-Segment Display	LH	MAN74A	Y	2,5
DL 704	LIT	.3	R	CC	7-Segment Display	RH	MAN74A	Y	2
DL 707	LIT	.3	R	CA	7-Segment Display	LH	MAN72A	A	2
DL 707R	LIT	.3	R	CA	7-Segment Display	RH	MAN71A	A	2
DL 721	LIT	.5	R	CA	1 1/2-Digit, 7-Segment Display	RH	FND6730	E	1,2,6
DL 722	LIT	.5	R	CC	1 1/2-Digit, 7-Segment Display	RH	FND6750	E	1,2,6
DL 727	LIT	.5	R	CA	Dual Digit, 7-Segment Display	RH	FND6710	C	2,6
DL 728	LIT	.5	R	CC	Dual Digit, 7-Segment Display	RH	FND6740	C	2,6
DL 740	LIT	.63	R	CA	Overflow + 1	N		NC-P	
DL 741	LIT	.63	R	CA	7-Segment Display	LH	FND847	C	2,3,7,8
DL 746	LIT	.63	R	CA	Overflow + 1	N		NC-P	
DL 747	LIT	.63	R	CA	7-Segment Display	LH	FND847	C	2,3,7,8
DL 749	LIT	.63	R	CC	Overflow + 1	N		NC-P	
DL 750	LIT	.63	R	CC	7-Segment Display	LH	FND850	C	2,3,7,8
DL 751	LIT	.63	R	CC	7-Segment Display	LH	FND850	C	2,3,7,8
DL 752	LIT	.63	R	CC	Overflow + 1	N		NC-P	
DL 3531	LIT	.5	R	CA	3 1/2-Digit Display Array	RH	FNA5421	E	1,2,10,11
DL 4120	LIT	1.0	R	CC	4-Digit Clock Display Array	RH	FCS8024	E	1,2,9
DL 4500	LIT	.5	R	CC	4-Digit Clock Display Array	N		NC-P	2,10
DL 4520A	LIT	.5	R	CC	4-Digit Clock Display Array	N	FCS5599	E	1,2,9
DL 4530	LIT	.5	R	CA	4-Digit Display Array	RH	FNA5420	E	1,2,10,11
DL 5175	LIT	.102	R	M	Monolithic Watch Displays	N		NC-P	
DL 5179	LIT	.105	R	M	Monolithic Watch Displays	N		NC-P	
MAN 1	MON	.27	R	CA	Monochromatic 7-Seg. Display	LH		NC-P	
MAN 1A	MON	.27	R	CA	Monochromatic 7-Seg. Display	LH		NC-P	
MAN 2A	MON	.32	R	R	Alpha-Numeric Display	LH		NC-P	4
MAN 10	MON	.27	R	CA	Monochromatic 7-Seg. Display	LH		NC-P	
MAN 10A	MON	.27	R	CA	Monochromatic 7-Seg. Display	LH		NC-P	
MAN 51A	MON	.3	G	CA	7-Segment Display	RH		NC-C	
MAN 52A	MON	.3	G	CA	7-Segment Display	LH		NC-C	
MAN 53A	MON	.3	G	CA	Overflow + 1	N		NC-C	
MAN 54A	MON	.3	G	CC	7-Segment Display	RH		NC-C	
MAN 71A	MON	.3	R	CA	7-Segment Display	RH	MAN71A	A	2
MAN 72A	MON	.3	R	CA	7-Segment Display	LH	MAN72A	A	2
MAN 73A	MON	.3	R	CA	Overflow + 1	N	MAN73A	X	2
MAN 74A	MON	.3	R	CC	7-Segment Display	RH	MAN74A	Y	2
MAN 81A	MON	.3	Y	CA	7-Segment Display	RH		NC-C	
MAN 82A	MON	.3	Y	CA	7-Segment Display	LH		NC-C	
MAN 83A	MON	.3	Y	CA	Overflow + 1	N		NC-C	
MAN 84A	MON	.3	Y	CC	7-Segment Display	RH		NC-C	
MAN 1001	MON	.27	R	CA	Monochromatic Overflow + 1	N		NC-P	
MAN 1001A	MON	.27	R	CA	Monochromatic Overflow + 1	N		NC-P	
MAN 101	MON	.27	R	CA	Monochromatic Overflow + 1	N		NC-P	
MAN 101A	MON	.27	R	CA	Monochromatic Overflow + 1	N		NC-P	
MAN 3610A	MON	.3	O	CA	7-Segment Display	RH	MAN3610A	X	2
MAN 3620A	MON	.3	O	CA	7-Segment Display	LH	MAN3620A	X	2
MAN 3630A	MON	.3	O	CA	Overflow + 1	N	MAN3630A	X	2
MAN 3640A	MON	.3	O	CC	7-Segment Display	RH	MAN3640A	X	2
MAN 4610A	MON	.4	O	CA	7-Segment Display	RH	FND558	E	1,2,3

DEVICE CHARACTERISTICS

DEVICE	COMPETITOR	SIZE	COLOR	POLARITY	DESCRIPTION	FAIRCHILD		
						DECIMAL	DEVICE	CODE NOTES
MAN 4630A	MON	.4	O	CA	Overflow + 1	RH	FND557	E 1,2,3
MAN 4640A	MON	.4	O	CC	7-Segment Display	RH	FND550	E 1,2,3
MAN 6610	MON	.56	O	CA	Dual Digit, 7-Segment Display	RH	FND6710	X 2
MAN 6630	MON	.56	O	CA	1 1/2-Digit, 7-Segment Display	RH	FND6730	X 2
MAN 6640	MON	.56	O	CC	Dual Digit, 7-Segment Display	RH	FND6740	X 2
MAN 6650	MON	.56	O	CC	1 1/2-Digit, 7-Segment Display	RH	FND6750	X 2
MAN 6660	MON	.56	O	CA	Single Display, 7-Seg. Display	RH		NC-P
MAN 6680	MON	.56	O	CC	Single Display, 7-Seg. Display	RH		NC-P
MAN 6710	MON	.56	R	CA	Dual Digit, 7-Segment Display	RH	FND6710	A 2
MAN 6730	MON	.56	R	CA	1 1/2 Digit, 7-Segment Display	RH	FND6730	A 2
MAN 6740	MON	.56	R	CC	Dual Digit, 7-Segment Display	RH	FND6740	A 2
MAN 6750	MON	.56	R	CC	1 1/2-Digit, 7-Segment Display	RH	FND6750	A 2
NSN 334	NAT	.3	R	CA	1 1/2-Digit Display Array	RH		W 9
NSN 373	NAT	.3	R	CC	2-Digit Display Array	RH		W 9
NSN 374	NAT	.3	R	CA	2-Digit Display Array	RH		W 9
NSN 381	NAT	.3	R	CC	2-Digit Display Array	RH		W 10
NSN 382	NAT	.3	R	CA	2-Digit Display Array	RH		W 10
NSN 534	NAT	.5	R	CA	1 1/2-Digit Display Array	RH		W 9
NSN 581	NAT	.5	R	CC	2-Digit Display Array	RH		W 10
NSN 582	NAT	.5	R	CA	2-Digit Display Array	RH		W 10
NSN 583	NAT	.5	R	CC	2-Digit Display Array	RH		W 9
NSN 584	NAT	.5	R	CA	2-Digit Display Array	RH		W 9
NSN 734	NAT	.7	R	CA	1 1/2-Digit Display Array	RH		W 9
NSN 781	NAT	.7	R	CC	2-Digit Display Array	RH		W 10
NSN 782	NAT	.7	R	CA	2-Digit Display Array	RH		W 10
NSN 783	NAT	.7	R	CC	2-Digit Display Array	RH		W 9
NSN 784	NAT	.7	R	CA	2-Digit Display Array	RH		W 9
NSB 3382	NAT	.3	R	CA	3 1/2-Digit Display Array	RH		W 10
NSB 3881	NAT	.3	R	CC	4-Digit Display Array	RH	FNA3420	C 1,10
NSB 3882	NAT	.3	R	CA	4-Digit Display Array	RH	FNA3420	E 1,10
NSB 5382	NAT	.5	R	CA	3 1/2-Digit Display Array	RH	FNA5421	E 1,10
NSB 5881	NAT	.5	R	CC	4-Digit Display Array	RH	FNA5420	C 1,10
NSB 5882	NAT	.5	R	CA	4-Digit Display Array	RH	FNA5420	E 1,10
NSB 5917	NAT	.5	R	CA	4 1/2-Digit Display Array	RH	FNA5521	E 1,10
NSB 5921	NAT	.5	R	CC	5-Digit Display Array	RH	FNA5520	C 1,10
NSB 5922	NAT	.5	R	CA	5-Digit Display Array	RH	FNA5520	E 1,10
NSB 7382	NAT	.7	R	CA	3 1/2-Digit Display Array	RH		W 10
NSB 7881	NAT	.7	R	CC	4-Digit Display Array	RH		W 10
NSB 7882	NAT	.7	R	CA	4-Digit Display Array	RH		W 10
NSC 0014	NAT		R		Decimal Pt. Monolithic Die	N	FLX2110	C 19
NSW 3101	NAT		R		Full Colon Monolithic Die	N	FNX8099	A
NSW 9060	NAT	.060	R		9-Segment Monolithic Display			NC-P
NSW 9070	NAT	.070	R		9-Segment Monolithic Display			NC-P
NSW 9075	NAT	.075	R		9-Segment Monolithic Display			NC-P
NSW 1080	NAT	.080	R		11-Segment Monolithic Display			NC-P
NSW 1090	NAT	.090	R		11-Segment Monolithic Display			NC-P
NSW 9100	NAT	.101	R		9-Segment Monolithic Display		FNX8009	A
NSW 1116	NAT	.116	R		9-Segment Monolithic Display		FNX8019	A
TIL 302	TI	.27	R	CA	Monochromatic 7-Seg. Display	LH		NC-P
TIL 303	TI	.27	R	CA	Monochromatic 7-Seg. Display	RH		NC-P
TIL 304	TI	.27	R	CA	Monochromatic Overflow + 1			NC-P
TIL 305	TI	.3	R		Alpha-Numeric Display	LH		NC-P 4
TIL 306	TI	.27	R		Monochromatic 7-Seg. Display	LH		NC-P 13
TIL 307	TI	.27	R		Monochromatic 7-Seg. Display	LH		NC-P 13
TIL 308	TI	.27	R		Monochromatic 7-Seg. Display	LH		NC-P 13
TIL 309	TI	.27	R		Monochromatic 7-Seg. Display	RH		NC-P 13
TIL 311	TI	.3	R		Hexadecimal Display	BS		NC-P 13
TIL 312	TI	.3	R	CA	7-Segment Display	BS	MAN72A	B 14
TIL 313	TI	.3	R	CC	7-Segment Display	RH	MAN74A	Y 1
TIL 314	TI	.3	G	CA	7-Segment Display	BS		NC-C
TIL 315	TI	.3	G	CC	7-Segment Display	RH		NC-C
TIL 316	TI	.3	A	CA	7-Segment Display	BS		NC-C
TIL 317	TI	.3	A	CC	7-Segment Display	RH		NC-C
TIL 321	TI	.5	R	CA	7-Segment Display	RH	FND507	A
TIL 322	TI	.5	R	CC	7-Segment Display	RH	FND500	A
TIL 323	TI	.5	G	CA	7-Segment Display	RH	FND537	A
TIL 324	TI	.5	G	CC	7-Segment Display	RH	FND530	A
TIL 325	TI	.5	A	CA	7-Segment Display	RH	FND557	A
TIL 326	TI	.5	A	CC	7-Segment Display	RH	FND550	A
TIL 327	TI	.3	R	CA	Overflow + 1	LH	MAN73A	Y 1
TIL 328	TI	.3	G	CA	Overflow + 1	LH		NC-C
TIL 329	TI	.3	A	CA	Overflow + 1	LH		NC-C
TIL 330	TI	.5	R	CA	Overflow + 1	RH	FND508	A
TIL 331	TI	.5	G	CA	Overflow + 1	RH	FND538	A

4

DEVICE CHARACTERISTICS

DEVICE	COMPETITOR SIZE	COLOR	POLARITY	DESCRIPTION	DECIMAL	FAIRCHILD		NOTES
						DEVICE	CODE	
TIL 332	TI	.5	A	CA	Overflow + 1	RH	FND558	A
TIL 360	TI	.1	R		6-Digit, 7-Segment Display	RH		NC-P
TIL 361	TI	.5	R	CC	2-Digit, 7-Segment Display	N	FNA5220	C 1
TIL 362	TI	.5	G	CC	2-Digit, 7-Segment Display	N		NC-C
TIL 363	TI	.5	A	CC	2-Digit, 7-Segment Display	N		NC-C
TIL 364	TI	.5	R	CC	3 1/2-Digit, Clock Display	N	FCS5599	E 1,15,16
TIL 365	TI	.5	G	CC	3 1/2-Digit, Clock Display	N		NC-C
TIL 366	TI	.5	A	CC	3 1/2-Digit, Clock Display	N		NC-C
TIL 367	TI	.5	R	CC	3 1/2-Digit, Clock Display	N	FCS5599	C 1,16
TIL 368	TI	.5	G	CC	3 1/2-Digit, Clock Display	N		NC-C
TIL 369	TI	.5	A	CC	3 1/2-Digit, Clock Display	N		NC-C
TIL 370	TI	.5	R	CC	4-Digit, Clock Display	N	FCS5599	E 1,15,16
TIL 371	TI	.5	G	CC	4-Digit, Clock Display	N		NC-C
TIL 372	TI	.5	A	CC	4-Digit, Clock Display	N		NC-C
TIL 373	TI	.5	R	CC	4-Digit, Clock Display	N	FCS5599	C 1,16
TIL 374	TI	.5	C	CC	4-Digit, Clock Display	N		NC-C
TIL 375	TI	.5	A	CC	4-Digit, Clock Display	N		NC-C
TIL 379-12	TI	.106	R		12-Digit, Monolithic Display	RH		NC-P
TIL 380-8	TI	.110	R		8-Digit, Monolithic Display	RH		NC-P
TIL 380-9	TI	.110	R		9-Digit, Monolithic Display	RH		NC-P
TIL 382	TI	.100	R		4-Digit Watch Displays	N		
TIL 383	TI	.100	R		4-Digit Watch Displays	N		
TIL 384	TI	.116	R		4-Digit Watch Displays	N		
TIL 385	TI	.116	R		4-Digit Watch Displays	N		
TIL 392-6	TI	.102	R		6-Digit Calculator Display	RH		NC-P
TIL 392-8	TI	.102	R		8-Digit Calculator Display	RH		NC-P
TIL 392-9	TI	.102	R		9-Digit Calculator Display	RH		NC-P
TIL 393-6	TI	.102	R		6-Digit Calculator Display	RH		NC-P
TIL 393-8	TI	.102	R		8-Digit Calculator Display	RH		NC-P
TIL 393-9	TI	.102	R		9-Digit Calculator Display	RH		NC-P
TIL 394-8	TI	.110	R		8-Digit Calculator Display	RH		NC-P
TIL 394-9	TI	.110	R		9-Digit Calculator Display	RH		NC-P
TIL 396	TI	.100	R		4-Digit Watch Display	N		
TIL 397	TI	.100	R		4-Digit Watch Display	N		
TIL 398	TI	.100	R		4-Digit Watch Display	N		
TIL 399	TI	.100	R		4-Digit Watch Display	N		

FCS6400 • FCS6401

RED GaAsP 0.6" 3 1/2 AND 4-DIGIT LED CLOCK DISPLAYS OPTOELECTRONICS PRODUCT GROUP

GENERAL DESCRIPTION — The FCS6400 (4-digit) and FCS6401 (3 1/2-digit) are common cathode, solid state numeric display modules. The FCS6401 display incorporates AM and PM indication for use in 12 hour operating mode.

All modules are compact and mounted on a board for easy insertion, allowing maximum flexibility to the end user. Their red faceplates combine high contrast with clean, simple appearance.

- **PIN COMPATIBLE WITH TOSHIBA TLR2047/TLR4040**
- **LOW DRIVE CURRENT REQUIREMENTS**
- **IC COMPATIBLE**
- **COMPACT THIN PACKAGE, EASILY INCORPORATED IN THE SYSTEM**
- **PC BOARD TYPE TERMINALS ALLOW EASY CONNECTION BY WIRE OR PIN SOLDERING OR WITH CARD-EDGE CONNECTOR**
- **WIDE VIEWING ANGLE WITH HIGH CONTRAST RED FACEPLATE**
- **APPLICATIONS INCLUDE WALL CLOCKS, DESK CLOCKS, CLOCK RADIOS, INTERVAL TIMERS**
- **COMMON CATHODE DIRECT DRIVE**

ABSOLUTE MAXIMUM RATINGS

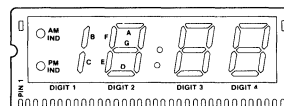
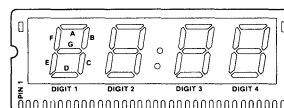
Maximum Temperatures

Storage Temperature	-20°C to +75°C
Operating Temperature	-20°C to +75°C
Pin Temperature (Soldering, 3 s at 1.5 mm from seating plane)	260°C

Maximum Voltages and Currents

V_R	Reverse Voltage	3.0 V
$I_{F(Avg)}$	Average Forward Current (segment or decimal)	20 mA
I_{pk}	Peak Current (segment or decimal)	60 mA

PIN CONNECTIONS



ELECTRICAL AND RADIANT CHARACTERISTICS: $T_A = 25^\circ\text{C}$

SYMBOL	CHARACTERISTICS	MIN	TYP	MAX	UNITS	TEST CONDITIONS
V_F	Forward Voltage		1.9	2.1	V	$I_F = 10.0 \text{ mA/Segment}$
I_λ	Average Luminous Intensity per Segment	0.08	0.20		mcd	$I_F = 10.0 \text{ mA/Segment}$
ΔI	Intensity Matching (Note 1)			3		$I_F = 10.0 \text{ mA/Segment}$
λ_{pk}	Peak Wavelength		665		nm	
$\Delta\lambda$	Spectral Line Half-Width		25		nm	
θ	Viewing Angle		± 30		degrees	

(Note 1: Segment to Segment from average Segment intensity)

FAIRCHILD FCS6400 • FCS6401

PIN ASSIGNMENT

FC6400

1	Com. Cath. Digits 1 & 2	18	Colon Anode
2	N/C	19	Colon Anode
3	N/C	20	Segment F3 Anode
4	Segment A1 Anode	21	Segment G3 Anode
5	Segment F1 Anode	22	Segment A3 Anode
6	Segment G1 Anode	23	Segment B3 Anode
7	Segment E1 Anode	24	Segment D3 Anode
8	Segment D1 Anode	25	Segment E3 Anode
9	Segment C1 Anode	26	Segment C3 Anode
10	Segment B1 Anode	27	Segment F4 Anode
11	Segment F2 Anode	28	Segment G4 Anode
12	Segment G2 Anode	29	Segment A4 Anode
13	Segment A2 Anode	30	Segment B4 Anode
14	Segment B2 Anode	31	Segment E4 Anode
15	Segment E2 Anode	32	Segment D4 Anode
16	Segment D2 Anode	33	Segment C4 Anode
17	Segment C2 Anode	34	Com. Cath. Digits 3 & 4

FC6401

1	Com. Cath. Digits 1 & 2	18	Colon Anode
2	PM IND. Anode	19	Colon Anode
3	AM IND.	20	Segment F3 Anode
4	N/C	21	Segment G3 Anode
5	N/C	22	Segment A3 Anode
6	N/C	23	Segment B3 Anode
7	N/C	24	Segment D3 Anode
8	N/C	25	Segment E3 Anode
9	Segment C1 Anode	26	Segment C3 Anode
10	Segment B1 Anode	27	Segment F4 Anode
11	Segment F2 Anode	28	Segment G4 Anode
12	Segment G2 Anode	29	Segment A4 Anode
13	Segment A2 Anode	30	Segment B4 Anode
14	Segment B2 Anode	31	Segment E4 Anode
15	Segment E2 Anode	32	Segment D4 Anode
16	Segment D2 Anode	33	Segment C4 Anode
17	Segment C2 Anode	34	Com. Cath. Digits 3 & 4

FCS8000 • FCS8024

RED GaAsP 0.8" 3 1/2 AND 4 DIGIT LED CLOCK DISPLAYS

OPTOELECTRONICS PRODUCT GROUP

GENERAL DESCRIPTION — The FCS8000 is a 3-1/2 digit, common-cathode, solid state numeric display module. It includes an AM-PM indicator and pinouts compatible with the Fairchild 3817 MOS clock circuit. The FCS8024 is a 4-digit, common-cathode version for European format. Standard interface circuits will allow operation with TTL, DTL, or CMOS SSI and MSI circuits.

All modules are compact and mounted on a board for easy insertion, allowing maximum flexibility to the end user. Their red faceplates combine high contrast with clean, simple appearance.

- IC COMPATIBLE WITH SIMPLE INTERFACE CIRCUITS
- COMPACT THIN 0.47 INCH PACKAGE, EASILY INCORPORATED IN THE SYSTEM
- PC BOARD TYPE TERMINALS ALLOW EASY CONNECTION BY WIRE OR PIN SOLDERING OR WITH CARD-EDGE CONNECTOR
- WIDE VIEWING ANGLE WITH HIGH CONTRAST RED FACEPLATE
- LOW POWER TYPICALLY 8 mA PER SEGMENT AVERAGE AT ONLY 1.8 V
- APPLICATIONS INCLUDE WALL CLOCKS, DESK CLOCKS, CLOCK RADIOS INTERVAL TIMERS
- COMMON-CATHODE FOR EASY DRIVING

ABSOLUTE MAXIMUM RATINGS

Maximum Temperature and Humidity

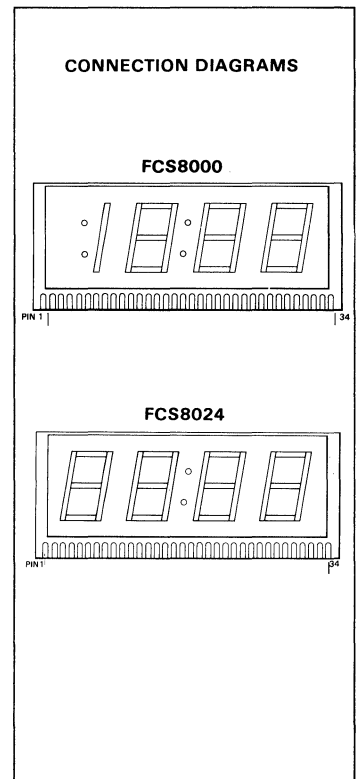
Storage Temperature	-40°C to +80°C
Operating Temperature	-40°C to +80°C
Pin Temperature (Soldering, 5 s)	230°C
Relative Humidity at 60°C	90%

Maximum Voltages and Currents

V_R	Reverse Voltage	3.0 V
I_F (Avg)	Average Forward Current (Segment or Decimal)	20 mA
I_{pk}	Peak Current (Segment or Decimal)	60 mA

ELECTRICAL AND RADIANT CHARACTERISTICS: $T_A = 25^\circ\text{C}$

SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	TEST CONDITIONS
V_F	Forward Voltage		1.65		V	$I_F = 8.0 \text{ mA/Segment}$
I_λ	Average Luminous Intensity per Segment		350		μcd	$I_F = 8.0 \text{ mA/Segment}$
ΔI_λ	Intensity Matching (Note 1)		± 33		%	$I_F = 8.0 \text{ mA/Segment}$
λ_{pk}	Peak Wavelength		660		nm	
$\Delta\lambda$	Spectral Line Half-Width		25		nm	
$\theta_{1/2}$	Viewing Angle at Half Intensity	$> \pm 30$			degrees	



FAIRCHILD • FCS8000 • FCS8024

PIN NAMES

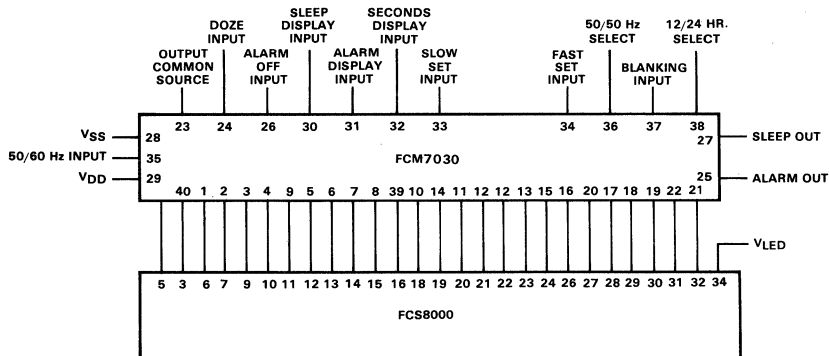
FCS8000

Pin No.	Segment	Pin No.	Segment
1	NC	18	10 Min. F
2	NC	19	10 Min. E
3	Indicator	20	10 Min. G
4	NC	21	10 Min. A
5	Indicator	22	10 Min. D
6	10 Hrs. C	23	10 Min. B
7	10 Hrs. B	24	10 Min. C
8	NC	25	NC
9	Hrs. F	26	Min. F
10	Hrs. G	27	Min. E
11	Hrs. E	28	Min. G
12	Hrs. A	29	Min. A
13	Hrs. B	30	Min. B
14	Hrs. D	31	Min. C
15	Hrs. C	32	Min. D
16	Colons	33	NC
17	NC	34	V _{LED}

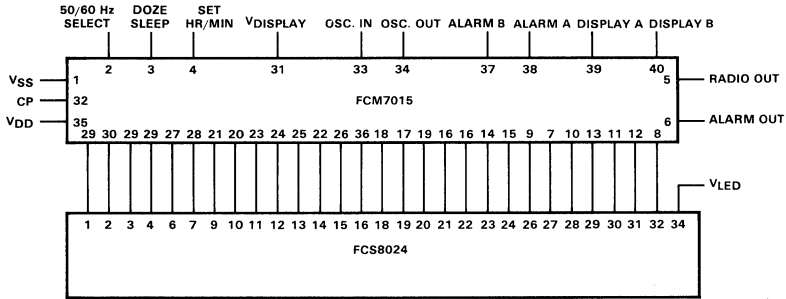
FCS8024

Pin No.	Segment	Pin No.	Segment
1	10 Hrs. A	18	10 Min. F
2	10 Hrs. E	19	10 Min. E
3	10 Hrs. D	20	10 Min. G
4	10 Hrs. G	21	10 Min. A
5	10 Hrs. F	22	10 Min. D
6	10 Hrs. C	23	10 Min. B
7	10 Hrs. B	24	10 Min. C
8	NC	25	NC
9	Hrs. F	26	Min. F
10	Hrs. G	27	Min. E
11	Hrs. E	28	Min. G
12	Hrs. A	29	Min. A
13	Hrs. B	30	Min. B
14	Hrs. D	31	Min. C
15	Hrs. C	32	Min. D
16	Colons	33	NC
17	NC	34	V _{LED}

FCS8000 • FCS8001 BLOCK DIAGRAM

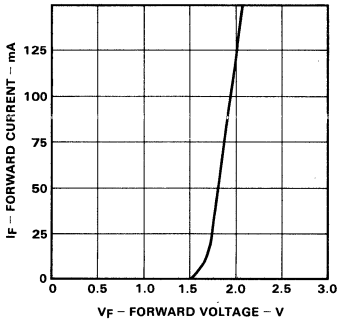


FCS8024 • FCS8025 BLOCK DIAGRAM



4

FORWARD CURRENT VERSUS FORWARD VOLTAGE (T_J)



FNA6

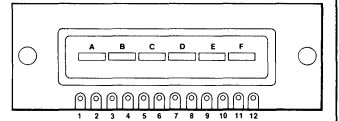
RED GaAsP 6-SEGMENT LED BAR GRAPH DISPLAY

OPTOELECTRONICS PRODUCT GROUP

GENERAL DESCRIPTION — The FNA6 is a 6-segment LED bar graph display with each segment aligned horizontally. This display device is for applications where viewing is within thirty feet of the display.

- LOW CURRENT REQUIREMENTS OF TYPICALLY 10 mA SEGMENT
- LOW VOLTAGE OF TYPICALLY 1.7 V_F
- MAXIMIZED CONTRAST RATIO WITH INTEGRAL LENS CAP
- EACH LED HAS COMMON-ANODE AND COMMON-CATHODE.

CONNECTION DIAGRAM



PIN

- 1 Segment A cathode
- 2 Segment A anode
- 3 Segment B cathode
- 4 Segment B anode
- 5 Segment C cathode
- 6 Segment C anode
- 7 Segment D cathode
- 8 Segment D anode
- 9 Segment E cathode
- 10 Segment E anode
- 11 Segment F cathode
- 12 Segment F anode

ABSOLUTE MAXIMUM RATINGS

Maximum Temperature and Humidity

Operating Temperature	-25°C to +85°C
Storage Temperature	-25°C to +85°C
Pin Temperature (Soldering, 5 s)	260°C
Relative Humidity at 60°C	90%

Maximum Voltage and Currents

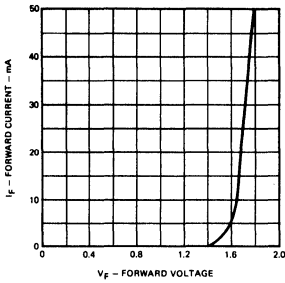
V _R	Reverse Voltage	3.0V
I _{F(AVG)}	Average Forward Current/Segment or Decimal Point Derate from 25°C Ambient Temperature (Fig. 2)	25 mA .03 mA/°C
I _f	Peak Forward Current/Segment or Decimal Point (100 μs pulse width) pps, T _A = 25°C	200 mA

ELECTRICAL AND RADIANT CHARACTERISTICS: T_A = 25°C

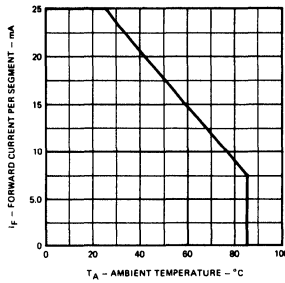
SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	TEST CONDITIONS
V _F	Forward Voltage	1.5	1.7	2.0	V	I _F = 20 mA
BV _R	Reverse Breakdown Voltage	3.0	12		V	I _R = 1.0 mA
I _O	Axial Luminous Intensity, Each Segment	240	450		μcd	I _F = 20 mA
θ _{1/2}	Viewing Angle to Half Intensity		±25		degrees	
λ _{pk}	Peak Wavelength		665		nm	I _F = 20 mA
L _O	Average Segment Luminance		35		ftL	I _F = 20 mA
ΔI _O	Intensity Matching, Segment to Segment		±33		%	I _F = 20 mA

TYPICAL CHARACTERISTICS CURVES

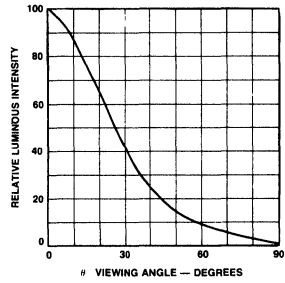
FORWARD CURRENT VERSUS FORWARD VOLTAGE



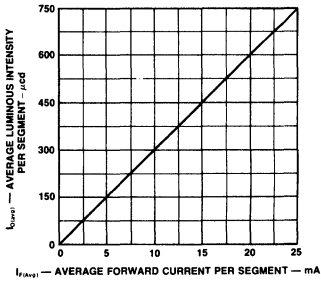
MAXIMUM AVERAGE CURRENT RATING VERSUS AMBIENT TEMPERATURE



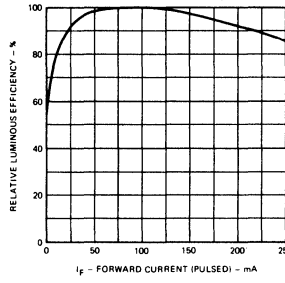
ANGULAR DISTRIBUTION OF LUMINOUS INTENSITY



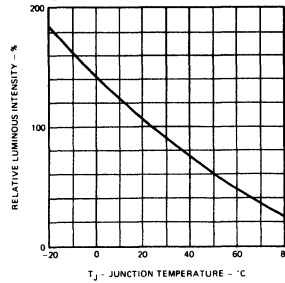
AVERAGE LUMINOUS INTENSITY VERSUS AVERAGE FORWARD CURRENT



RELATIVE LUMINOUS EFFICIENCY (mcd PER mA) VERSUS PEAK CURRENT PER SEGMENT



RELATIVE LUMINOUS INTENSITY VERSUS JUNCTION TEMPERATURE



FNA12

12-ELEMENT BAR DISPLAY

OPTOELECTRONICS PRODUCE GROUP

GENERAL DESCRIPTION - The FNA12 is a red 12-element analog display in a convenient, stackable dual in-line package. Excellent applications include analog meter readouts, radio frequency indicator, or computer register displays.

- 12-ELEMENT DUAL IN-LINE PACKAGE
- END-STACKABLE FOR SCALE EXPANSION
- SEPARATE ANODE AND CATHODE CONNECTIONS FOR WIRING CONVENIENCE
- UP TO 100 mA PEAK DRIVE CURRENT (20% DUTY CYCLE FOR HIGH AMBIENT CONDITIONS)

ABSOLUTE MAXIMUM RATINGS

Maximum Temperature and Humidity

Operating Temperature	-40° C to +80° C
Storage Temperature	-40° C to +80° C
Pin Temperature (Soldering, 5 s)	230° C
Relative Humidity at 85° C	85%

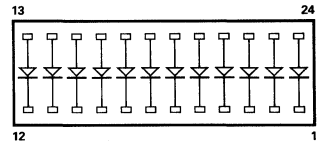
Maximum Power Dissipation

Total Dissipation at $T_A = 25^\circ\text{C}$	100 mW
Derate Linearly from 25° C	1.33 mW/°C

Maximum Voltage and Currents

V_R Reverse Voltage	3.0 V
I_F Average Forward Current per element	20 mA
i_f Peak Forward Current (1.0 μs pulse width)	1.0 A

**CONNECTION DIAGRAM
(BOTTOM VIEW)**

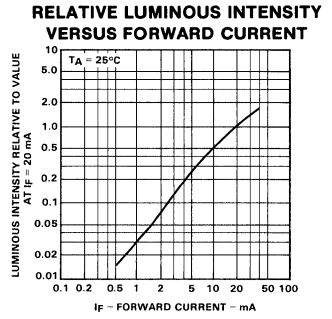
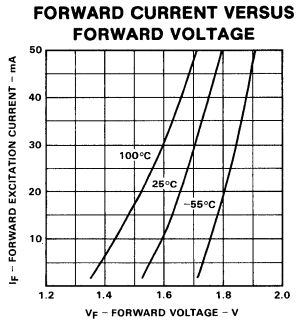
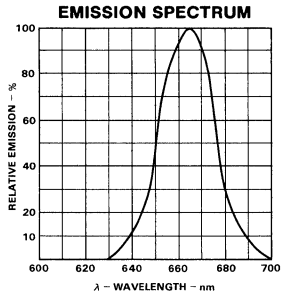


PIN		PIN	
1	CA 1	13	AN 12
2	CA 2	14	AN 11
3	CA 3	15	AN 10
4	CA 4	16	AN 9
5	CA 5	17	AN 8
6	CA 6	18	AN 7
7	CA 7	19	AN 6
8	CA 8	20	AN 5
9	CA 9	21	AN 4
10	CA 10	22	AN 3
11	CA 11	23	AN 2
12	CA 12	24	AN 1

ELECTRICAL AND RADIANT CHARACTERISTICS: $T_A = 25^\circ\text{C}$

SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	TEST CONDITIONS
V_F	Forward Voltage		1.6	2.0	V	$I_F = 20\text{ mA/seg}$
V_R	Reverse Voltage	3.0			V	$I_R = 100\ \mu\text{A}$
I_o	Axial Luminous Intensity	60 100	100 200		μcd μcd	$I_F = 6\text{ mA/seg}$ $I_F = 10\text{ mA}$
λ_{pk}	Peak Wavelength		665		nm	$I_F = 20\text{ mA/seg}$
ΔI	Intensity Matching Maximum Variation		± 33		%	

TYPICAL ELECTRICAL CHARACTERISTIC CURVES



FNA5400 • FNA5500 SERIES

MULTI-DIGIT DISPLAY ARRAYS

OPTOELECTRONICS PRODUCT GROUP

GENERAL DESCRIPTION — Multiplexed multi-digit display arrays available in 3 1/2, 4, 4 1/2 and 5-digit configurations in common-cathode version for use in digital meters, P.O.S. terminals, and other multiple digit applications.

- HALF-INCH TALL DISPLAYS
- DISPLAYS STACKABLE ON .575 INCH CENTERS
- MULTIPLEXED OPERATION
- DECIMAL POINT TO THE RIGHT OF EACH DIGIT
- COMMON CATHODE
- LOW VOLTAGE - V_f TYPICALLY 1.7V

DEVICE DESCRIPTION

FUNCTION	COMMON-CATHODE
3 1/2 Digit Plus Overflow	FNA5421
4 Digit	FNA5420
4 1/2 Digit Plus Overflow	FNA5521
5 Digit	FNA5520

ABSOLUTE MAXIMUM RATINGS

Maximum Temperature and Humidity

Storage Temperature	-25°C to +85°C
Operating Temperature	-25°C to +85°C
Pin Temperature (Soldering 5s)	260°C
Relative Humidity at 60°C	90%

MAXIMUM VOLTAGE AND CURRENTS

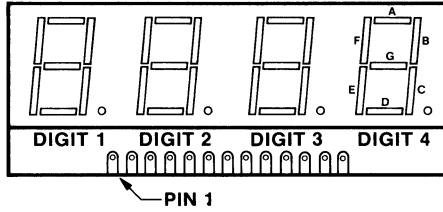
V_R	Reverse Voltage	3.0V
I_F (Avg)	Average Forward Current (Segment or Decimal Points)	20 mA
i_f	Peak Forward Current (Segment or Decimal Points)	200 mA

ELECTRICAL AND RADIANT CHARACTERISTICS: $T_A = 25^\circ\text{C}$

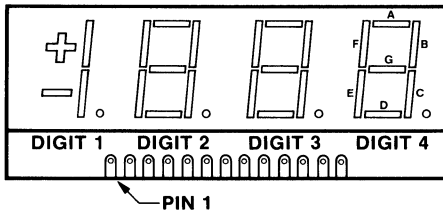
SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	TEST CONDITIONS
V_f	Forward Voltage	1.5	1.7	2.0	V	$I_F = 20\text{ mA}$
BV_R	Reverse Breakdown Voltage	3.0	1.2		V	$I_R = 1.0\text{ mA}$
I_O	Axial Luminous Intensity, Each Segment	300	600		μcd	$I_F = 20\text{ mA}$
$\theta_{1/2}$	Viewing Angle to Half Intensity		± 25		degrees	
λ_{pk}	Peak Wavelength		650		nm	$I_F = 20\text{ mA}$
L_O	Average Segment Luminance		35		ftL	$I_F = 20\text{ mA}$
ΔI_O	Intensity Matching Segment to Segment		± 33		%	$I_F = 20\text{ mA}$

PIN ASSIGNMENTS

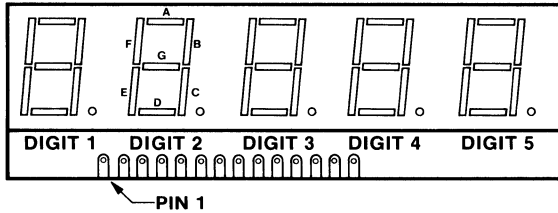
FNA5420/27



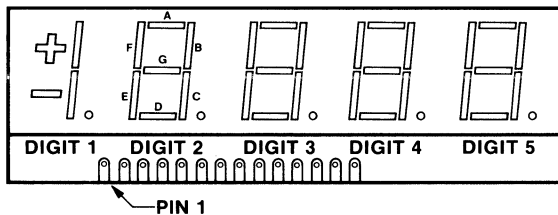
FNA5421/28



FNA5520/27



FNA5521/28



FND350 • FND360 • FND357 • FND367

RED GaAsP 0.362 — INCH SINGLE DIGIT NUMERIC LED DISPLAY OPTOELECTRONICS PRODUCT GROUP

GENERAL DESCRIPTION — The FND350, FND360, FND357 and FND367 are red GaAsP single digit 7-segment displays with a 3/8 inch character height. FND357 and FND367 are common cathode configuration. These displays are designed for applications in which the viewer is within fifteen feet of the display. Each digit has a brightness code (05, 06, 07 . . .) for brightness consistency within a display. The FND360 and FND367 are suitable for applications in high-ambient light.

- **COMPACT** — 10 DIGITS IN 3" PANEL WIDTH
- **LOW CURRENT REQUIREMENTS** 2-20 mA/SEGMENT
- **LOW VOLTAGE** 1.7 V
- **INTENSITY CODE MARKING** FOR UNIFORM DISPLAYS
- **RIGHT-HAND DECIMAL**
- **MAXIMIZED CONTRAST RATIO** WITH INTEGRAL LENS CAP
- **FND360, FND367 SUITABLE FOR USE IN HIGH AMBIENT LIGHT**

ABSOLUTE MAXIMUM RATINGS

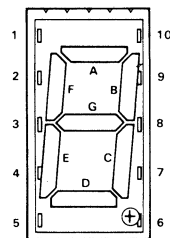
Maximum Temperature and Humidity

Junction Temperature	-25°C to +85°C
Storage Temperature	-25°C to +85°C
Pin Temperature (Soldering, 5 s)	260°C
Relative Humidity at 65°C	98%

Maximum Voltage and Currents

V _R	Reverse Voltage	3.0 V
I _{F(Avg)}	Average Forward Current/Segment or Decimal Point	25 mA
	Derate from 25°C Ambient Temperature	0.3 mA/°C
I _{pk}	Peak Current/Segment or Decimal Point (100 μs pulse) 1000 pps, T _A = 25°C	200 mA

PIN CONNECTIONS (FRONT VIEW)



PIN	FND357/367	FND350/360
1	Common Cath.	Common Anode
2	Segment F	Segment F
3	Segment G	Segment G
4	Segment E	Segment E
5	Segment D	Segment D
6	Common Cath.	Common Anode
7	Decimal Point	Decimal Point
8	Segment C	Segment C
9	Segment B	Segment B
10	Segment A	Segment A

ELECTRICAL CHARACTERISTICS: T_A = 25°C

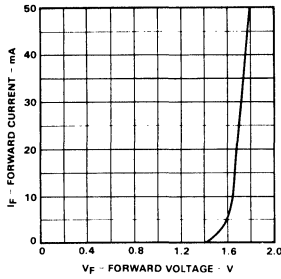
SYMBOL	CHARACTERISTICS	MIN	TYP	MAX	UNITS	TEST CONDITIONS
V _F	Forward Voltage		1.7	2.0	V	I _F = 20 mA
BV _R	Reverse Breakdown Voltage	3.0	12		V	I _R = 1.0 mA
I _o	Axial Luminous Intensity Each Segment (Note 1)				μcd	I _F = 20 mA
	FND350, 357	240	450			
	FND360, 367	590	900			
ΔI _o	Intensity Matching, Segment to Segment (Note 3)		±33		%	I _F = 20 mA
	Intensity Matching Within One Intensity Class		±20		%	I _F = 20 mA, all segments at once
L _o	Average Segment Luminance (Note 2)				ftL	I _F = 20 mA
	FND350, 357		26			
	FND360, 367		52			
θ _{1/2}	Viewing Angle to Half Intensity		±27		degrees	
λ _{pk}	Peak Wavelength		665		nm	I _F = 20 mA

NOTES:

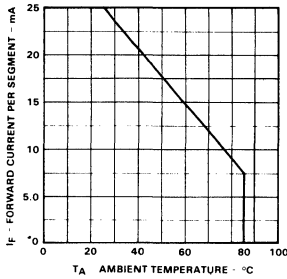
1. Typical operating current under single digit (dc) drive is approximately 2 to 20 mA average per segment for most ambient light conditions. The 125 mA specification is a representative peak current.
2. Measured on mechanical axis of package. See Average Luminous Intensity curve for other forward currents.
3. Segment-to-segment from average segment intensity.

TYPICAL ELECTRICAL CHARACTERISTIC CURVES

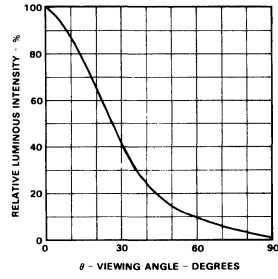
FORWARD CURRENT VERSUS FORWARD VOLTAGE



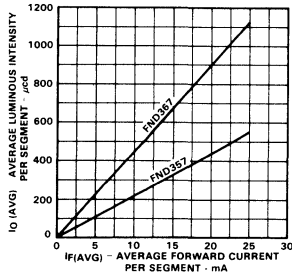
MAXIMUM AVERAGE CURRENT RATING VERSUS AMBIENT TEMPERATURE



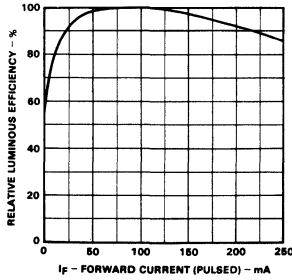
ANGULAR DISTRIBUTION OF LUMINOUS INTENSITY



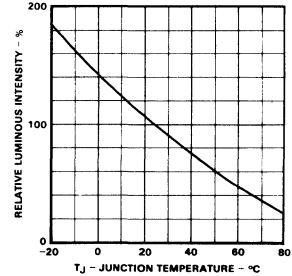
AVERAGE LUMINOUS INTENSITY VERSUS AVERAGE FORWARD CURRENT



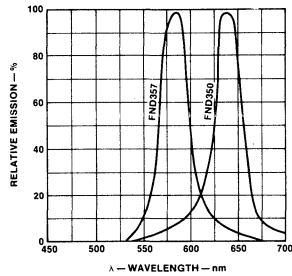
RELATIVE LUMINOUS EFFICIENCY (mcd PER mA) VERSUS PEAK CURRENT PER SEGMENT



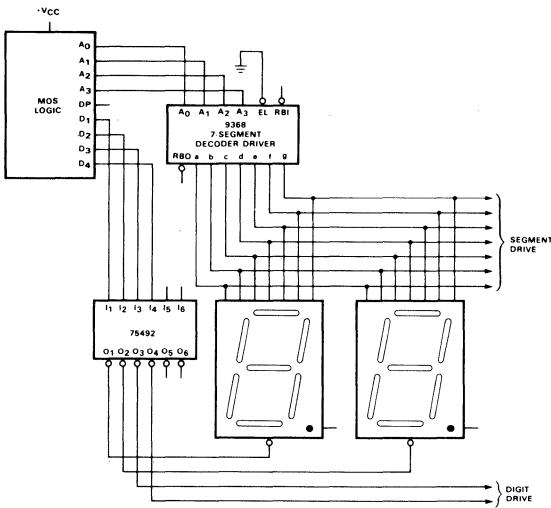
RELATIVE LUMINOUS INTENSITY VERSUS JUNCTION TEMPERATURE



EMISSION SPECTRUM

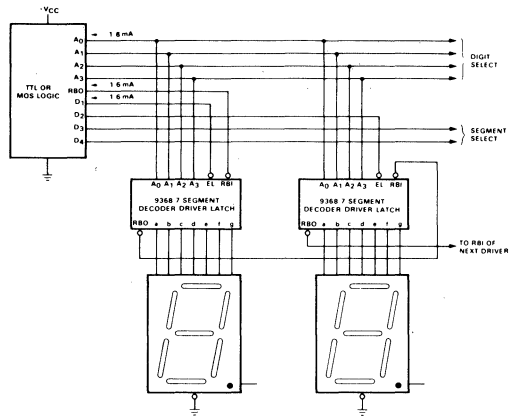


APPLICATIONS



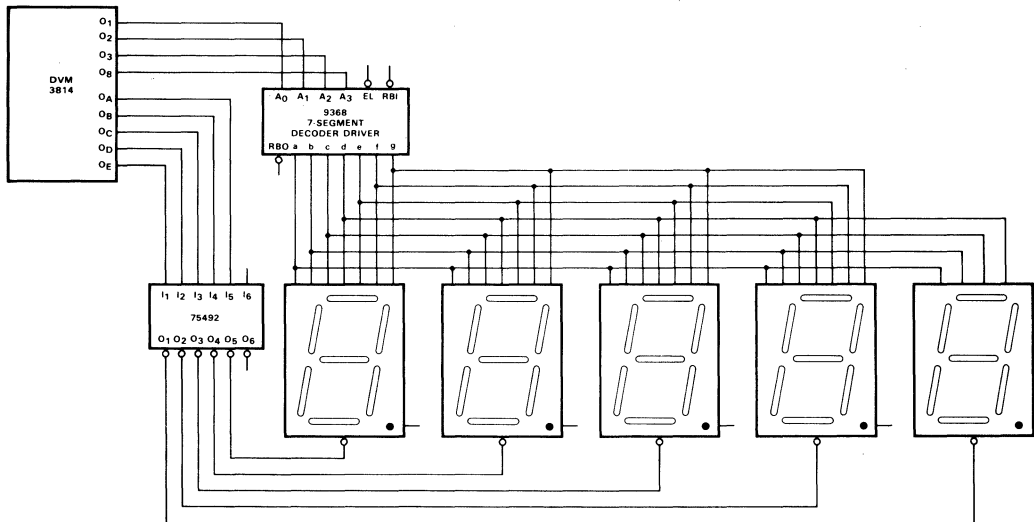
MULTIPLEXING FND357 WITH 9368 7-SEGMENT DECODER DRIVER/LATCH AND 75492 DIGIT DRIVERS

The 9368 7-segment decoder driver/latch can source current up to 19 mA. This may be increased to 38 mA by paralleling two units, both inputs and outputs.



DRIVING THE FND357 WITH THE 9368 LATCH/DECODER/DRIVER FROM BCD LOGIC

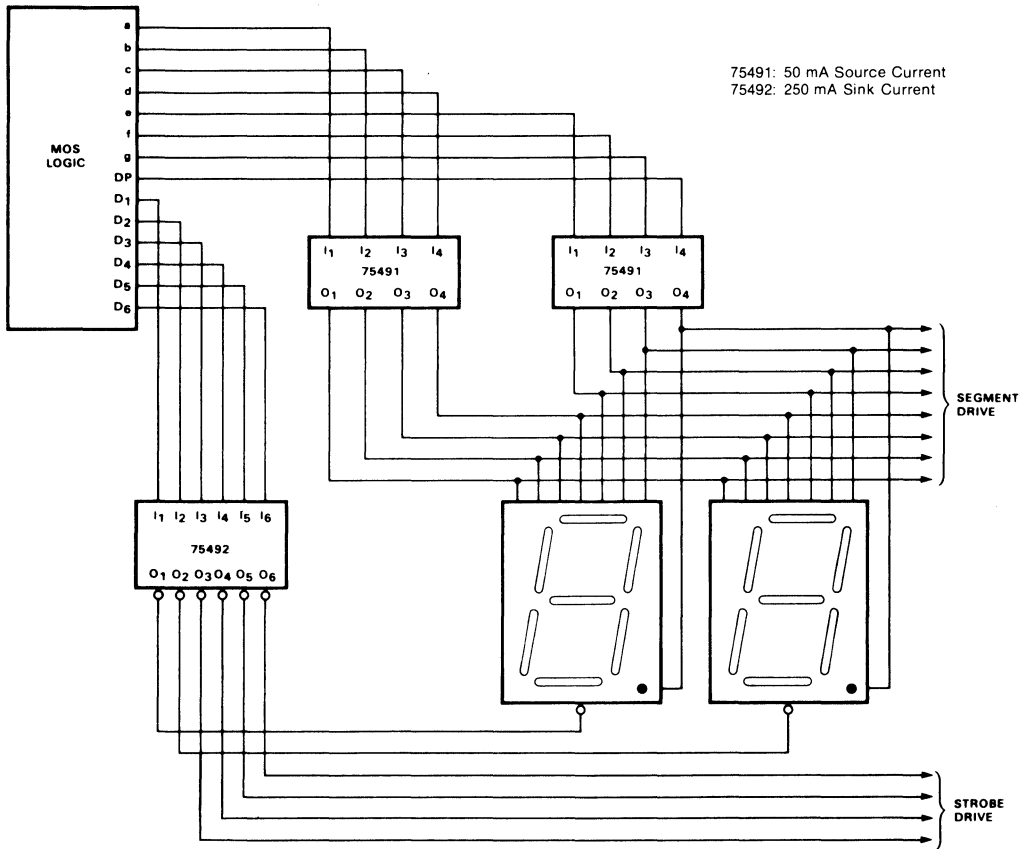
The 9368 contains internal resistors which limit the segment current to 19 mA. High impedance inputs to the 9368 when not enabled, allow party-line drive from either TTL or MOS logic gates.



LOW COST DIGITAL VOLTMETER

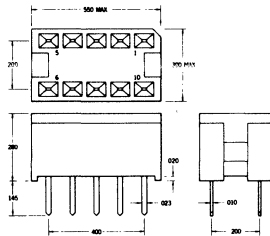
9368 7-Segment Decoder Driver/Latch: Source Current = 19 mA
75492 Hex Digit Driver: Sink Current = 250 mA

APPLICATIONS (Cont'd)



MULTIPLEXING SIX FND357s OR FND367s WITH THE 75491 SEGMENT DRIVER AND 75492 DIGIT DRIVER

FNS700
10-POSITION DIP SOCKET
FOR FND357 OR FND367



- NOTES:
Material
Insulator:
Black Nylon, Glass Filled
Wellamid or Equivalent
Contact
Phosphorous Bronze
Nickel Plate
Gold Plate

The FNS700 is a 10-position DIP socket with 2 rows of 5 positions each which is designed for use with the FND357 and the FND367 3/8" LED digital display.

FND358 • FND368

RED GaAsP \pm 1-DIGIT LED DISPLAY

OPTOELECTRONICS PRODUCT GROUP

GENERAL DESCRIPTION – The FND358 and FND368 are red GaAsP \pm 1-digit, LED displays with nominal 3-8 inch character height in common-cathode configuration. These displays are for applications in which the viewer is within fifteen feet of the display. Each digit has a brightness code (05, 06, 07 ...) for constructing arrays with closely matched digits.

- IDEAL COMPANION TO FND357/FND367
- LOW CURRENT REQUIREMENTS 2–20 mA/SEGMENT
- LOW FORWARD VOLTAGE – TYPICALLY 1.7 V
- INTENSITY CODE MARKING FOR UNIFORM DISPLAYS
- RIGHT-HAND DECIMAL
- FND368 SUITABLE FOR USE IN HIGH AMBIENT LIGHT
- MAXIMIZED CONTRAST RATIO WITH INTEGRAL LENS CAP

ABSOLUTE MAXIMUM RATINGS

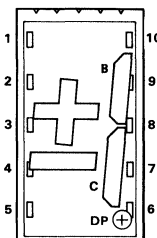
Maximum Temperature and Humidity

Storage Temperature	–25°C to +85°C
Operating Temperature	–25°C to +85°C
Pin Temperature (Soldering, 5 s)	260°C
Relative Humidity at 65°C	98%

Maximum Voltage and Currents

V_R	Reverse Voltage	3.0 V
$I_F(Avg)$	Average Forward Current/Segment or Decimal Point Derate from 25°C Ambient Temperature	25 mA 0.3 mA/°C
I_F	Peak Forward Current/Segment or Decimal Point (100 μ s pulse width) 1000 pps, $T_A = 25^\circ C$	200 mA

PIN CONNECTIONS (TOP VIEW)



PIN

1	Common-Cathode
2	Plus Sign
3	Minus Sign
4	NC
5	Omitted
6	Common-Cathode
7	Decimal Point
8	Segment C
9	Segment B
10	NC

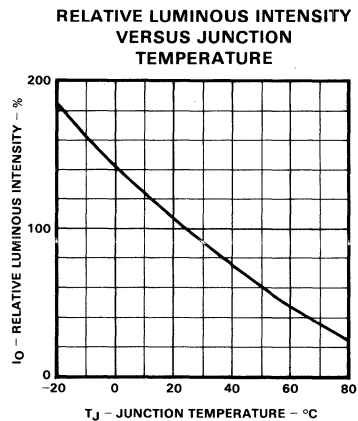
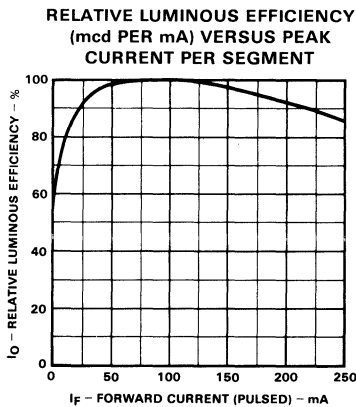
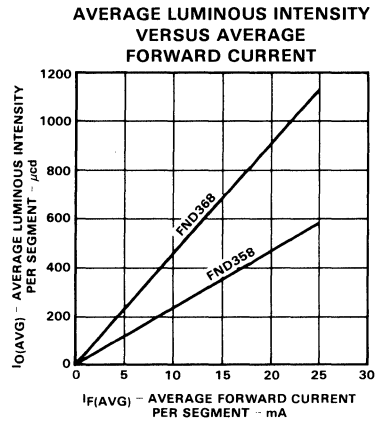
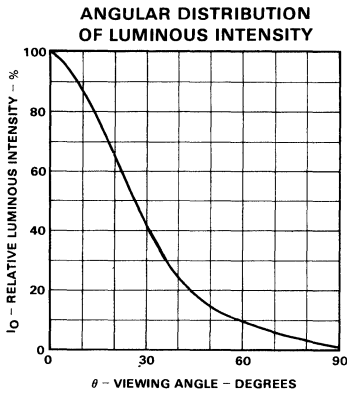
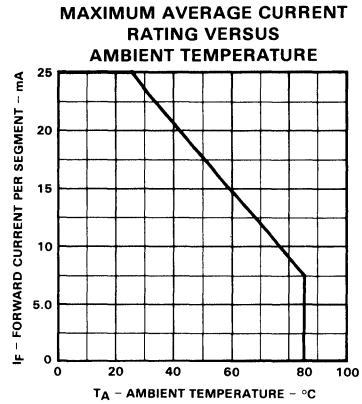
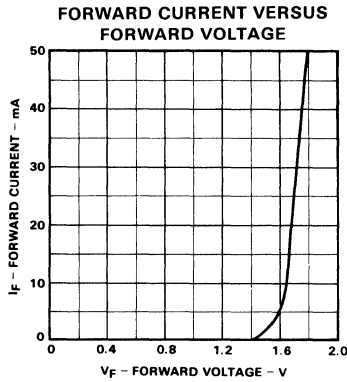
ELECTRICAL AND RADIANT CHARACTERISTICS: $T_A = 25^\circ C$

SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	TEST CONDITIONS
V_F	Forward Voltage	1.5	1.7	2.0	V	$I_F = 20$ mA
BV_R	Reverse Breakdown Voltage	3.0	12		V	$I_R = 1.0$ mA
I_O	Axial Luminous Intensity, Average for Each Segment (Note 1)					
	FND358	240	450		μ cd	$I_F = 20$ mA
	FND368	590	900		μ cd	$I_F = 20$ mA
ΔI_O	Intensity Matching, Segment-to-Segment (Note 3)		± 33		%	$I_F = 20$ mA
	Intensity Matching Within One Intensity Class		± 20		%	$I_F = 20$ mA, all segments at once
L_O	Average Segment Luminance (Note 2)					
	FND357		26		ftL	$I_F = 20$ mA
	FND367		52		ftL	$I_F = 20$ mA
$\theta_{1/2}$	Viewing Angle to Half Intensity		± 27		degrees	
λ_{pk}	Peak Wavelength		665		nm	$I_F = 20$ mA

NOTES:

1. Typical operating current under single digit (dc) drive is approximately 2 to 20 mA average per segment for most ambient light conditions.
2. Measured on mechanical axis of package. See Average Luminous Intensity curve for other forward currents.
3. Segment-to-segment from average segment intensity.

TYPICAL ELECTRICAL CHARACTERISTIC CURVES



FND500 • FND507 • FND560 • FND567

RED GaAsP 0.5-INCH SINGLE DIGIT NUMERIC LED DISPLAY

OPTOELECTRONICS PRODUCTS GROUP

GENERAL DESCRIPTION – The FND500, FND507, FND560 and FND567 are red GaAsP Single Digit 7-segment displays with a 0.5-inch character height. The FND500 and FND560 are common-cathode configuration, and the FND507 and FND567 are common-anode configuration. These displays are designed for applications in which the viewer is within twenty feet of the display. Each digit has a brightness code (05, 06, 07 . . .) for brightness consistency within a display. The FND560 and FND567 are suitable for applications in high ambient light.

- LOW FORWARD VOLTAGE – TYPICALLY 1.7 V
- FITS STANDARD DIP SOCKETS WITH 0.6" PIN ROW
- DECIMAL POINT ON LOWER RIGHT-HAND SIDE
- OVERFLOW POINT ON UPPER LEFT-HAND SIDE WITH DIGIT REVERSED
- MAXIMIZED CONTRAST RATIO WITH INTEGRAL LENS CAP
- HORIZONTAL STACKING 0.6" MINIMUM, 1" TYPICAL
- COMMON-CATHODE OR COMMON-ANODE
- FND560/567 SUITABLE FOR USE IN HIGH AMBIENT LIGHT

ABSOLUTE MAXIMUM RATINGS

Maximum Temperature and Humidity

Storage Temperature	-25°C to +85°C
Operating Temperature	-25°C to +85°C
Pin Temperature (Soldering, 5 s)	260°C
Relative Humidity at 65°C	98%

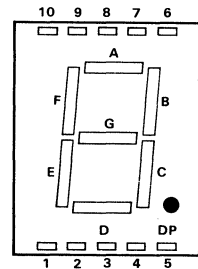
Maximum Voltage and Currents

V_R	Reverse Voltage	3.0 V
$I_{F(Avg)}$	Average Forward Current/Segment or Decimal Point	25 mA
	Derate from 25°C Ambient Temperature	0.3 mA/°C
I_f	Peak Forward Current/Segment or Decimal Point	200 mA
	(100 μ s pulse width) 1000 pps, $T_A = 25^\circ\text{C}$	

ELECTRICAL AND RADIANT CHARACTERISTICS: $T_A = 25^\circ\text{C}$

SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	TEST CONDITIONS
V_F	Forward Voltage	1.5	1.7	2.0	V	$I_F = 20\text{ mA}$
BV_R	Reverse Breakdown Voltage	3.0	12		V	$I_R = 1.0\text{ mA}$
I_O	Axial Luminous Intensity, Average for Each Segment					
	FND500, FND507	300	600		μcd	$I_F = 20\text{ mA}$
	FND560, FND567	740	1200		μcd	$I_F = 20\text{ mA}$
ΔI_O	Intensity Matching, Segment to Segment		± 33		%	$I_F = 20\text{ mA}$
	Intensity Matching Within One Intensity Class		± 20		%	$I_F = 20\text{ mA}$, all segments at once
L_O	Average Segment Luminance					
	FND500, FND507		35		ftL	$I_F = 20\text{ mA}$
	FND560, FND567		70		ftL	$I_F = 20\text{ mA}$
$\theta_{1/2}$	Viewing Angle to Half Intensity		± 27		degrees	
λ_{pk}	Peak Wavelength		665		nm	$I_F = 20\text{ mA}$

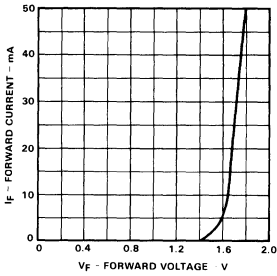
PIN CONNECTIONS (FRONT VIEW)



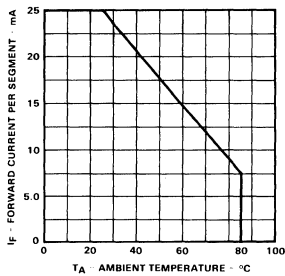
PIN	FND507/567	FND500/560
1	Segment E	Segment E
2	Segment D	Segment D
3	Comm.-Anode	Comm.-Cathode
4	Segment C	Segment C
5	Decimal Point	Decimal Point
6	Segment B	Segment B
7	Segment A	Segment A
8	Comm.-Anode	Comm.-Cathode
9	Segment F	Segment F
10	Segment G	Segment G

TYPICAL CHARACTERISTIC CURVES

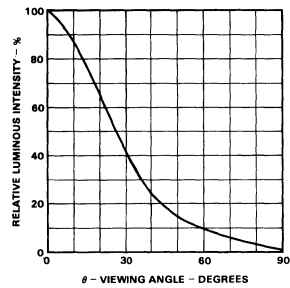
FORWARD CURRENT VERSUS FORWARD VOLTAGE



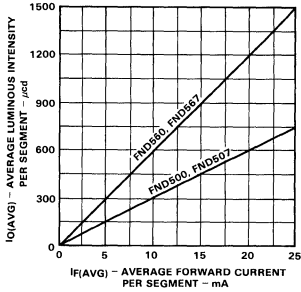
MAXIMUM AVERAGE CURRENT RATING VERSUS AMBIENT TEMPERATURE



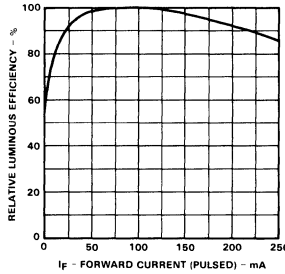
ANGULAR DISTRIBUTION OF LUMINOUS INTENSITY



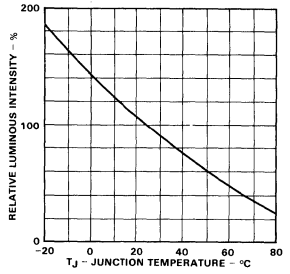
AVERAGE LUMINOUS INTENSITY VERSUS AVERAGE FORWARD CURRENT



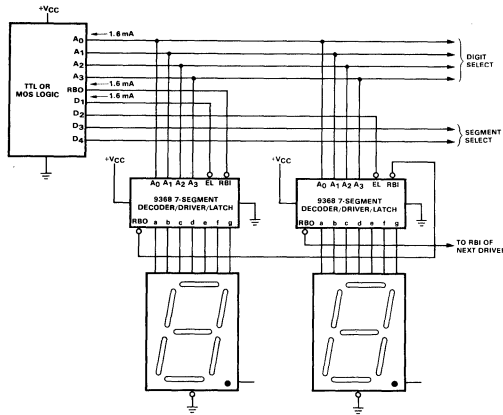
RELATIVE LUMINOUS EFFICIENCY (mcd PER mA) VERSUS PEAK CURRENT PER SEGMENT



RELATIVE LUMINOUS INTENSITY VERSUS JUNCTION TEMPERATURE



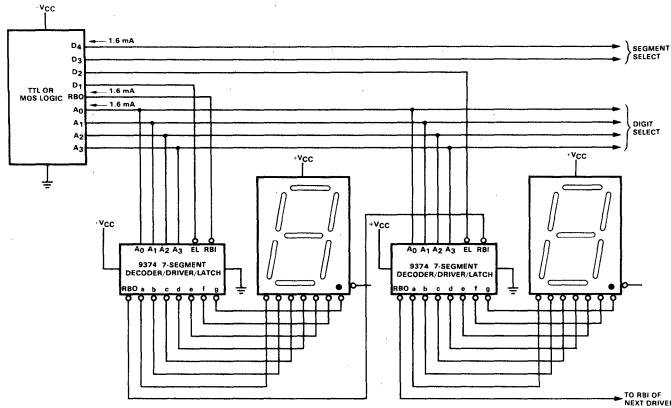
APPLICATIONS



DRIVING THE FND500 WITH THE 9368 LATCH/DECODER/DRIVER FROM BCD LOGIC

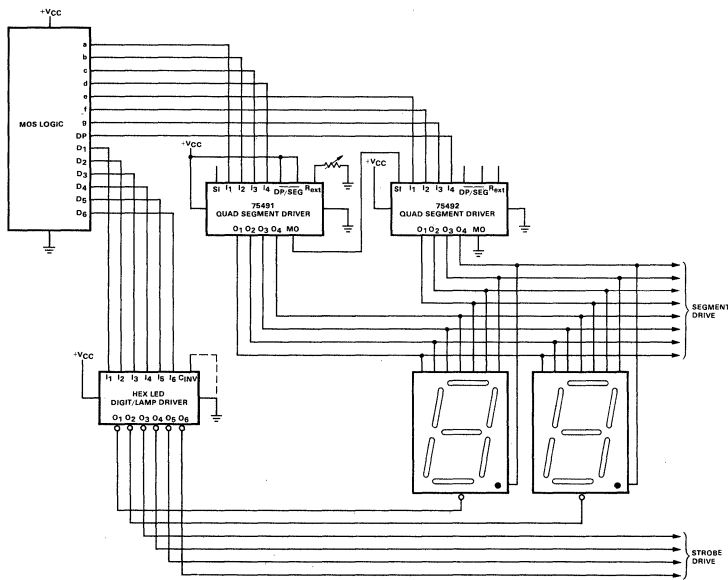
The 9368 contains internal resistors which limit the segment current to 19 mA. High impedance inputs to the 9368 when not enabled, allow party-line drive from either TTL or MOS logic gates.

APPLICATIONS (Cont'd)



**DRIVING THE FND507 WITH THE 9374 LATCH/
DECODER/DRIVER CURRENT LIMITED FROM BCD LOGIC**

High impedance inputs to the 9374 when not enabled, allow party-line driver from either TTL or MOS logic gates.



*Source 5.0 to 50 mA per segment with a programmable resistor to ground.
**Non-inverting output, leave open; inverting logic output; ground this pin.

**MULTIPLEXING SIX FND500s WITH THE 75491
SEGMENT DRIVER AND 75492 DIGIT DRIVER**

The 75491 segment driver has four inputs which are MOS compatible and four outputs. Output current is programmable from 5.0 to 50 mA with one external resistor. A master/slave pin, allows a second 75491 to be tied to the first 75491 and have the same segment drive current. A decimal-point pin reduces the output current in channel four by half. The 75492 digit driver has six channels, is MOS compatible, will sink 600 mA per channel, and has a pin for inverting the drive logic.

MOUNTING INSTRUCTIONS

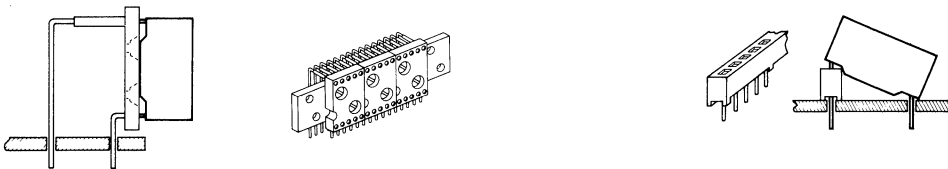


Mount the FND500 directly to a PC board using straight, accurately controlled pins for horizontal and vertical alignment. A 0.0035" standoff allows solder flux removal*. Long pins allow additional cooling behind the digit when mounted vertically.

The FND500 will insert into stackable 40-pin DIP sockets, such as Barnes 821-23013-404.

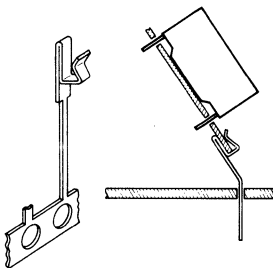
*Only certain cleaning solutions are allowed: Freon TF, methyl alcohol, isopropyl alcohol, or water.

4



Right angle sockets simplify some designs. Vertical alignment of the sockets is necessary, as shown with the Augat socket GX51-73-1G1.

An angled mounting may be obtained by soldering the front pins into the PC board, then raising the back pins with a stackable socket strip such as Robinson Nugent's 24-pin WB-25 with wire-wrap pins, or SB-25 with DIP solder pins.



A convenient method for making a removable display is to first solder all the digits to a 1/32 PC board with appropriate interconnections for multiplexing, then attach the display to the mother board with a substrate clip, such as AMP485092-4.

FND501 • FND508 • FND561 • FND568

RED GaAsP 0.5 INCH ±1 LED DISPLAY

OPTOELECTRONICS PRODUCT GROUP

GENERAL DESCRIPTION — The FND501, FND 561, FND508 and FND568 are Red GaAsP overflow LED displays with a nominal 0.5 inch character height. The FND 501 has common-cathode configuration. The FND508 has common-anode configuration. These display devices are for applications where the viewer is within twenty feet of the display. Each digit has a brightness code (05, 06, 07 ...) for constructing arrays with closely matched digits. The FND561 and FND568 are suitable for applications in high ambient light.

- LOW VOLTAGE OF TYPICALLY 1.7 V_F
- FITS STANDARD DIP SOCKETS WITH 0.6" PIN ROW
- DECIMAL POINT ON LOWER RIGHT-HAND SIDE
- MAXIMIZED CONTRAST RATIO WITH INTEGRAL LENS CAP
- HORIZONTAL STACKING 0.6" MINIMUM, 1" TYPICAL
- COMMON-CATHODE OR COMMON-ANODE

ABSOLUTE MAXIMUM RATINGS

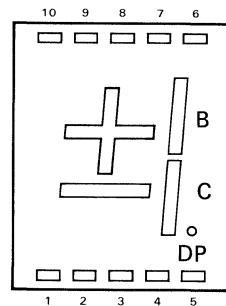
Maximum Temperature and Humidity

Storage Temperature	-25°C to +85°C
Operating Temperature	-25°C to +85°C
Pin Temperature (Soldering, 5 s)	260°C
Relative Humidity at 65°C	98%

Maximum Voltage and Currents

V _R	Reverse Voltage	3.0 V
I _{F(Avg)}	Average Forward Current/Segment or Decimal Point	25 mA
	Derate from 25°C Ambient Temperature	0.3 mA/°C
i _f	Peak Forward Current/Segment or Decimal Point	200 mA
	(100 μs pulse width) 1000 pps, T _A = 25°C	

PIN CONNECTIONS
(TOP VIEW)



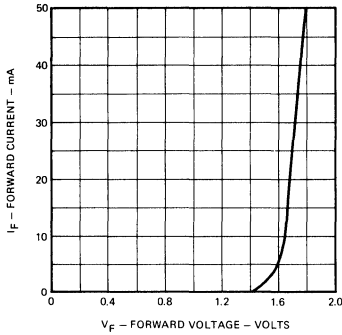
PIN	FND501/561	FND508/568
1	Minus	Minus
2	Cathode ±	Anode ±
3	Segment C	Segment C
4	Cathode 1/D.P.	Anode 1/D.P.
5	D.P.	D.P.
6	Segment B	Segment B
7	Cathode 1/D.P.	Anode 1/D.P.
8	Cathode ±	Anode ±
9	Plus	Plus
10	N.C.	N.C.

ELECTRICAL AND RADIANT CHARACTERISTICS: T_A = 25°C

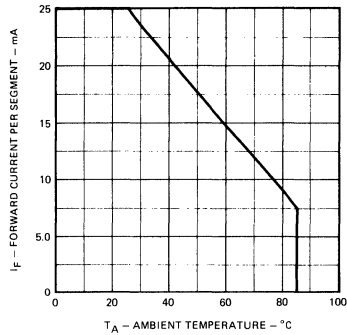
SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	TEST CONDITIONS
V _F	Forward Voltage		1.7	2.0	V	I _F = 20 mA
BV _R	Reverse Breakdown Voltage	3.0	12		V	I _R = 1.0 mA
I _O	Axial Luminous Intensity, Each Segment					
	FND501, FND508	300	600		μcd	I _F = 20 mA
	FND561, FND568	740	1200		μcd	I _F = 20 mA
ΔI _O	Intensity Matching, Segment to Segment		±33		%	I _F = 20 mA
	Intensity Matching Within One Intensity Class		±20		%	I _F = 20 mA, all segments at once
L _O	Average Segment Luminance					
	FND501, FND508		35		ftL	I _F = 20 mA
	FND561, FND568		70		ftL	I _F = 20 mA
θ _{1/2}	Viewing Angle to Half Intensity		±27		degrees	
λ	Peak Wavelength		665		nm	I _F = 20 mA

TYPICAL ELECTRICAL CHARACTERISTIC CURVES

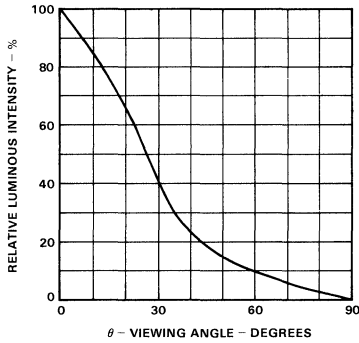
FORWARD CURRENT
VERSUS
FORWARD VOLTAGE



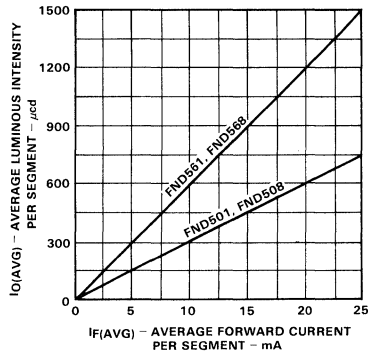
MAXIMUM AVERAGE
CURRENT RATING VERSUS
AMBIENT TEMPERATURE



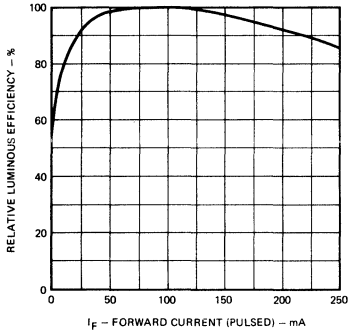
ANGULAR DISTRIBUTION
OF LUMINOUS INTENSITY



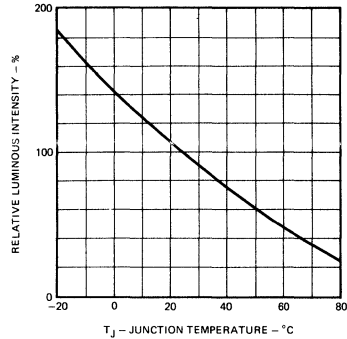
AVERAGE LUMINOUS INTENSITY
VERSUS
AVERAGE FORWARD CURRENT



RELATIVE LUMINOUS EFFICIENCY
(mcg PER mA) VERSUS
PEAK CURRENT PER SEGMENT



RELATIVE LUMINOUS
INTENSITY VERSUS
JUNCTION TEMPERATURE



MOUNTING INSTRUCTIONS

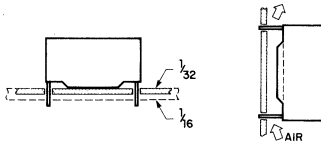


Fig. 1

Mount the FND500 series directly to a PC board using the straight, accurately controlled pins for horizontal and vertical alignment. A 0.035" standoff allows solder flux removal. Long pins allow additional cooling behind the digit when mounted vertically.*

*Only certain cleaning solutions are allowed: Freon TF, methyl alcohol, isopropyl alcohol, or water.

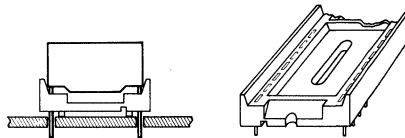


Fig. 2

The FND500 series will insert into stackable 40-pin DIP sockets, such as Barnes 821-23013-404.

FND530 • FND537 FND540 • FND547

GREEN GaP YELLOW SUPER GaAsP

FND550 • FND557

AMBER SUPER GaAsP

1/2-INCH 7-SEGMENT LED DISPLAYS

OPTOELECTRONICS PRODUCT GROUP

GENERAL DESCRIPTION — The FND530 and FND537 are green GaP 7-segment displays with a normal 1/2 inch character height. The FND540 and FND547 are yellow Super GaAsP 1/2-inch digits, common cathode and common anode, respectively. The FND550 and FND557 are amber super GaAsP 7-segment digits with a normal 1/2 inch character height. The FND550 is common-cathode configuration while the FND557 is common-anode. These display devices are for applications where the viewer is within 20 feet of the display. Each digit has a brightness code (09, 10, 11 ...) for constructing arrays with closely matched digits.

- FITS STANDARD SOCKETS WITH 0.6 INCH PIN ROW
- INTENSITY CODE MARKING FOR UNIFORM DISPLAYS
- RIGHT-HAND DECIMAL
- MAXIMIZED CONTRAST RATIO WITH INTEGRAL LENS CAP
- MAXIMIZED USE OF DIGIT FACE
- COMMON-CATHODE OR COMMON-ANODE
- FND550/FND557 SUITABLE FOR USE IN HIGH AMBIENT LIGHT

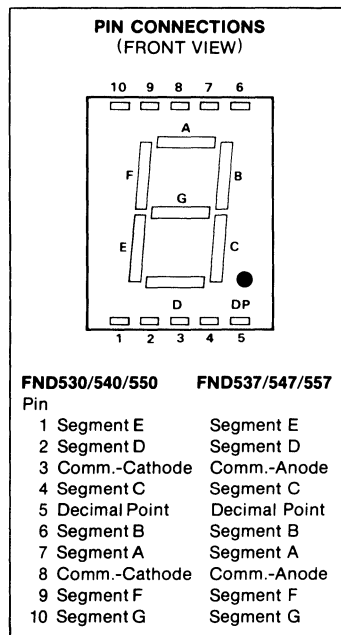
ABSOLUTE MAXIMUM RATINGS

Maximum Temperature and Humidity

Storage Temperature	-25°C to +85°C
Operating Temperature	-25°C to +85°C
Pin Temperature (Soldering, 5 s)	260°C
Relative Humidity at 60°C	90%

Maximum Voltage and Currents

V_R	Reverse Voltage	3.0 V
$I_{F(Avg)}$	Average Forward Current (Segment or Decimal Points)	20 mA
I_{PK}	Peak Forward Current (Segments or Decimals)	80 mA

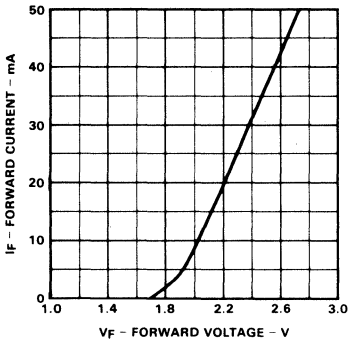


ELECTRICAL AND RADIANT CHARACTERISTICS: $T_A = 25^\circ C$

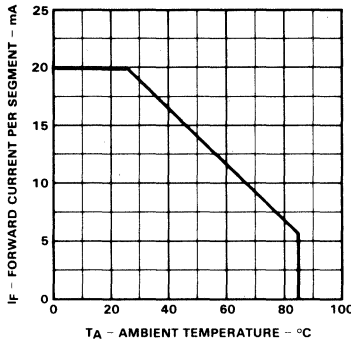
SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	TEST CONDITIONS
V_F	Forward Voltage		2.2	3.2	V	$I_F = 20$ mA
BV_R	Reverse Breakdown Voltage	3.0			V	$I_R = 1.0$ mA
I_o	Axial Luminous Intensity					
	Average each Segment					
	FND530, FND537		600	2000	μ cd	$I_F = 20$ mA
	FND540, FND547		600	1000	μ cd	$I_F = 20$ mA
	FND550, FND557		700	2000	μ cd	$I_F = 20$ mA
$\theta_{1/2}$	Viewing Angle to Half Intensity	± 30			degrees	$I_F = 20$ mA
λ_{pk}	Peak Wavelength					
	FND530, FND537		565		nm	$I_F = 20$ mA
	FND 540, FND547		585		nm	$I_F = 20$ mA
	FND550, FND557		635		nm	$I_F = 20$ mA
I_o	Average Segment Luminance					
	FND530, FND537		104		ftL	$I_F = 20$ mA
	FND540, FND547		52		ftL	$I_F = 20$ mA
	FND550, FND557		104		ftL	$I_F = 20$ mA
ΔT_o	Intensity Matching Segment-to-Segment	± 33			%	$I_F = 20$ mA
	Intensity Matching within one Intensity Class	± 20			%	$I_F = 20$ mA

TYPICAL CHARACTERISTIC CURVES

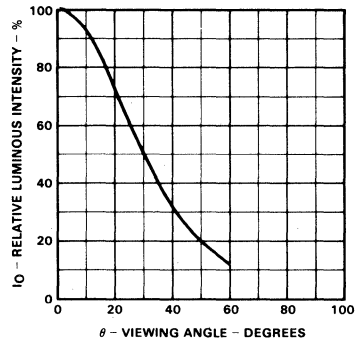
FORWARD CURRENT VERSUS FORWARD VOLTAGE



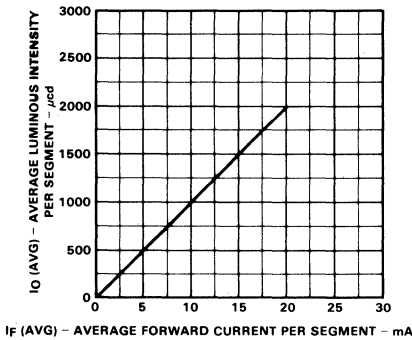
MAXIMUM AVERAGE CURRENT RATING VERSUS AMBIENT TEMPERATURE



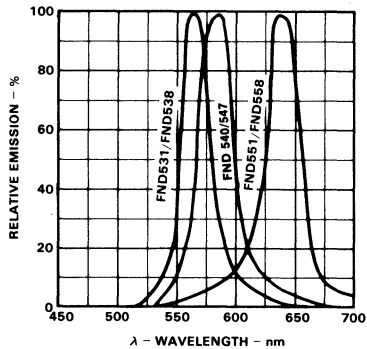
ANGULAR DISTRIBUTION OF LUMINOUS INTENSITY



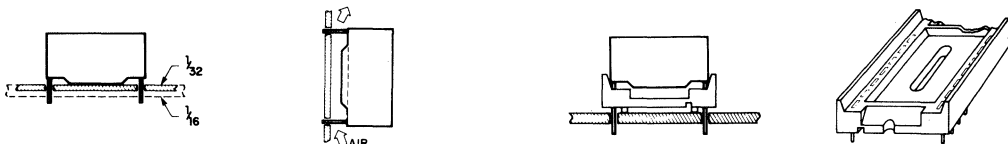
AVERAGE LUMINOUS INTENSITY VERSUS AVERAGE FORWARD CURRENT



EMISSION SPECTRUM



MOUNTING INSTRUCTIONS



Mount the FNS500 series directly to a PC board using the straight, accurately controlled pins for horizontal and vertical alignment. A 0.0035" standoff allows solder flux removal. *Long pins allow additional cooling behind the digit when mounted vertically.

The FND500 series will insert into stackable 40-pin DIP sockets, such as Barnes 821-23013-404.

*Only certain cleaning solutions are allowed: Freon TF, methyl alcohol, isopropyl alcohol, or water.

FND531/538 • FND541/548 • FND551/558

GREEN GaP YELLOW SUPER GaAsP AMBER SUPER GaAsP

OPTOELECTRONICS PRODUCT GROUP

GENERAL DESCRIPTION — The FND531 and FND538 are green GaP \pm displays with a nominal 1/2 inch character height. The FND531 is common-cathode configuration, while the FND538 is common-anode. The FND541 and FND548 are yellow super GaAsP \pm digits with a nominal 1/2 inch character height. The FND541 is common-cathode configuration while the FND548 is common-anode. The FND551 and FND558 are amber super GaAsP \pm digits with a nominal 1/2 inch character height. The FND551 is common-cathode configuration while the FND558 is common-anode. These display devices are for applications where the viewer is within 20 feet of the display. Each digit has a brightness code (09, 10, 11. . .) for constructing arrays with closely matched digits.

- FITS STANDARD SOCKETS WITH 0.6 INCH PIN ROW
- INTENSITY CODE MARKING FOR UNIFORM DISPLAYS
- RIGHT-HAND DECIMAL
- MAXIMIZED CONTRAST RATIO WITH INTEGRAL LENS CAP
- MAXIMIZED USE OF DIGIT FACE
- COMMON-CATHODE OR COMMON-ANODE

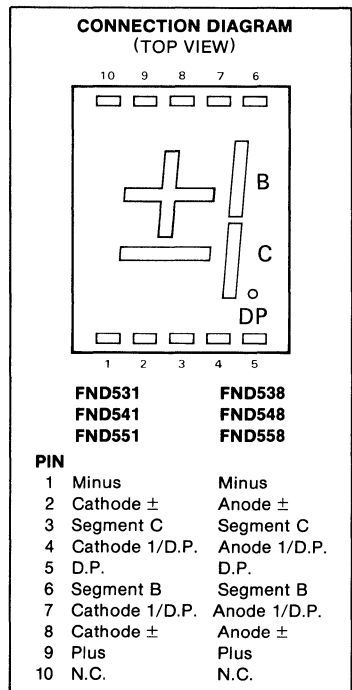
ABSOLUTE MAXIMUM RATINGS

Maximum Temperature and Humidity

Storage Temperature	-25°C to +85°C
Operating Temperature	-25°C to +85°C
Pin Temperature (Soldering, 5 s)	260°C
Relative Humidity at 60°C	90%

Maximum Voltage and Currents

V_R	Reverse Voltage	3.0 V
I_F (Avg)	Average Forward Current (Segment or Decimal Points)	20 mA
I_F	Peak Forward Current (Segments or Decimals)	80 mA



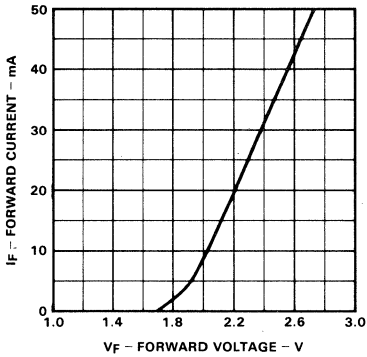
4

ELECTRICAL AND RADIANT CHARACTERISTICS: $T_A = 25^\circ\text{C}$

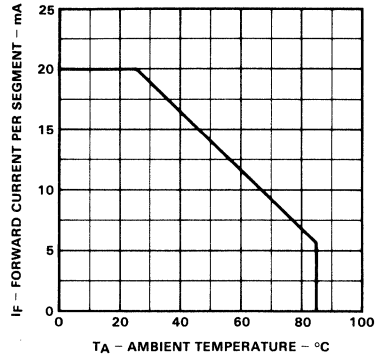
SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	TEST CONDITIONS
V_F	Forward Voltage		2.2	3.2	V	$I_F = 20\text{ mA}$
BV_R	Reverse Voltage Breakdown	3.0			V	$I_R = 1.0\text{ mA}$
I_o	Axial Luminous Intensity					
	Average each Segment					
	FND531, FND538	600	2000		μcd	$I_F = 20\text{ mA}$
	FND541, FND548	700	2000		μcd	$I_F = 20\text{ mA}$
	FND551, FND558	700	2000		μcd	$I_F = 20\text{ mA}$
$\theta_{1/2}$	Viewing Angle to Half Intensity		± 30		degrees	
λ_{pk}	Peak Wavelength					
	FND531, FND538		565		nm	$I_F = 20\text{ mA}$
	FND541, FND548		570		nm	$I_F = 20\text{ mA}$
	FND551, FND558		635		nm	$I_F = 20\text{ mA}$
L_o	Average Segment Luminance		104		ftL	$I_F = 20\text{ mA}$
ΔI_o	Intensity Matching Segment-to-Segment		± 33		%	$I_F = 20\text{ mA}$
	Intensity Matching within one Intensity Class		± 20		%	$I_F = 20\text{ mA}$

TYPICAL CHARACTERISTIC CURVES

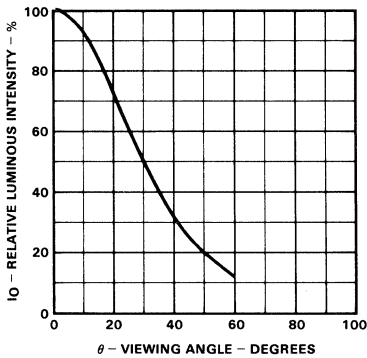
FORWARD CURRENT VERSUS FORWARD VOLTAGE



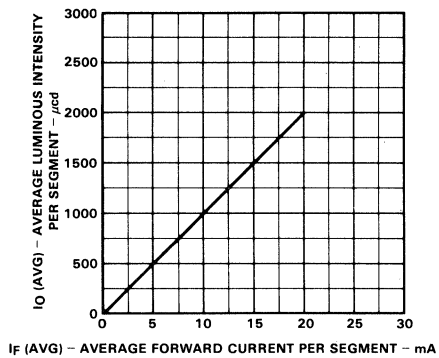
MAXIMUM AVERAGE CURRENT RATING VERSUS AMBIENT TEMPERATURE



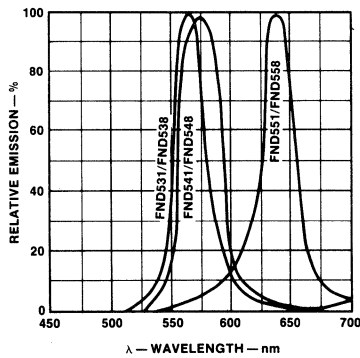
ANGULAR DISTRIBUTION OF LUMINOUS INTENSITY



AVERAGE LUMINOUS INTENSITY VERSUS AVERAGE FORWARD CURRENT



EMISSION SPECTRUM



FND800 • FND807

RED GaAsP 0.8 INCH SINGLE DIGIT NUMERIC LED DISPLAY

OPTOELECTRONICS PRODUCT GROUP

GENERAL DESCRIPTION – The FND800 and FND807 are Red GaAsP Single Digit, 7-Segment LED Displays with a nominal 0.8" character height. The FND800 has common-cathode configuration. The FND807 has common-anode configuration. These display devices are for applications where the viewer is within thirty feet of the display. Each digit has a brightness code (06, 07, 08 ...) for constructing arrays with closely matched digits.

- LOW CURRENT REQUIREMENTS OF TYPICALLY 10 mA/SEGMENT
- LOW VOLTAGE OF TYPICALLY 1.7 V_F
- FITS STANDARD DIP SOCKETS WITH 0.6" PIN ROW
- DECIMAL POINT ON LOWER RIGHT-HAND SIDE
- OVERFLOW POINT ON UPPER LEFT-HAND SIDE WITH DIGIT REVERSED
- MAXIMIZED CONTRAST RATIO WITH INTEGRAL LENS CAP
- HORIZONTAL STACKING 1" TYPICAL
- COMMON-CATHODE OR COMMON-ANODE

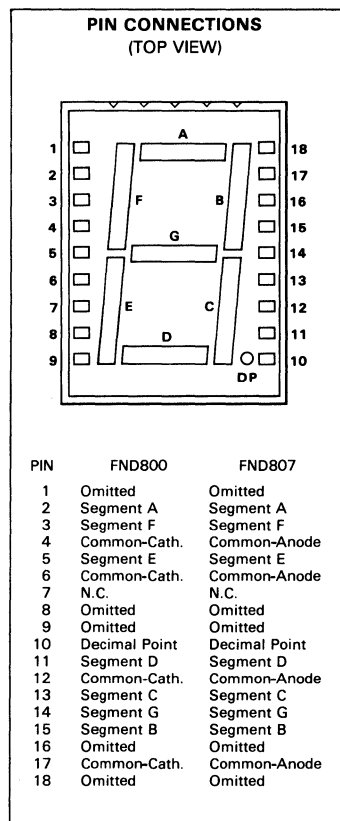
ABSOLUTE MAXIMUM RATINGS

Maximum Temperature and Humidity

Storage Temperature	-25°C to +85°C
Operating Temperature	-25°C to +85°C
Pin Temperature (Soldering, 5 s)	260°C
Relative Humidity at 65°C	98%

Maximum Voltage and Currents

V _R	Reverse Voltage	3.0 V
I _{F(Avg)}	Average Forward Current, Segment or Decimal Point	25 mA
	Derate from 25°C Ambient Temperature	0.3 mA/°C
I _{pk}	Peak Current/Segment or Decimal Point (100 μs pulse width) 1000 pps, T _A = 25°C	200 mA

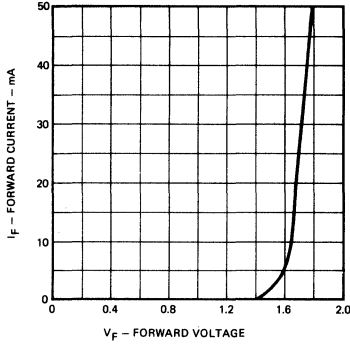


ELECTRICAL AND RADIANT CHARACTERISTICS: T_A = 25°C

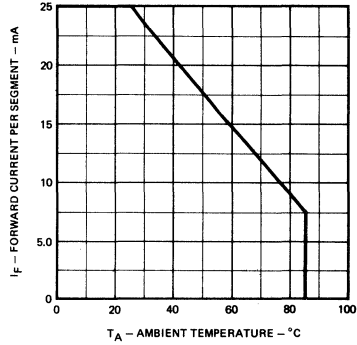
SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	TEST CONDITIONS
V _F	Forward Voltage	1.5	1.7	2.0	V	I _F = 20 mA
BV _R	Reverse Breakdown Voltage	3.0	12		V	I _R = 1.0 mA
I _O	Axial Luminous Intensity, Average for Each Segment	380	1100		μcd	I _F = 20 mA
ΔI _O	Intensity Matching, Segment-to-Segment		±33		%	I _F = 20 mA
	Intensity Matching Within One Intensity Class		±20		%	I _F = 20 mA, all segments at once
L _O	Average Segment Luminance		64		ftL	I _F = 20 mA
θ _{1/2}	Viewing Angle to Half Intensity		±25		degrees	
λ _{pk}	Peak Wavelength		665		nm	I _F = 20 mA

TYPICAL ELECTRICAL CHARACTERISTIC CURVES

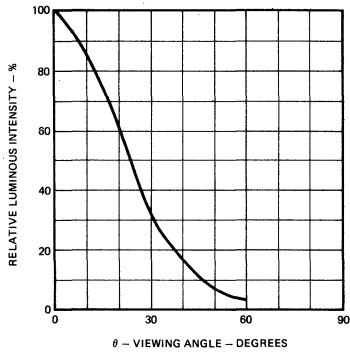
FORWARD CURRENT VERSUS FORWARD VOLTAGE



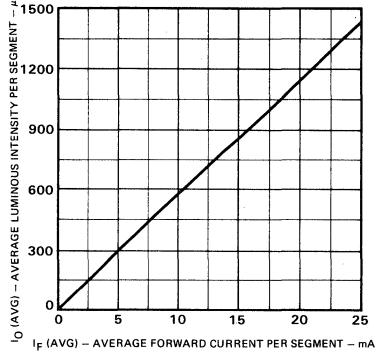
MAXIMUM AVERAGE CURRENT RATING VERSUS AMBIENT TEMPERATURE



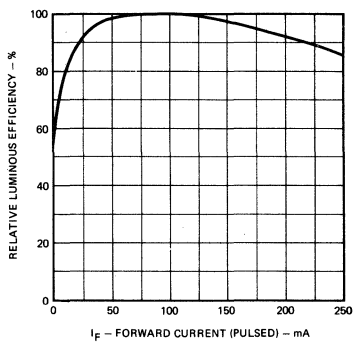
ANGULAR DISTRIBUTION OF LUMINOUS INTENSITY



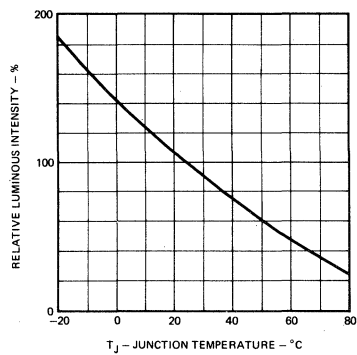
AVERAGE LUMINOUS INTENSITY VERSUS AVERAGE FORWARD CURRENT



RELATIVE LUMINOUS EFFICIENCY (mcd PER mA) VERSUS PEAK CURRENT PER SEGMENT



RELATIVE LUMINOUS INTENSITY VERSUS JUNCTION TEMPERATURE



FND800A • FND807A

RED GaAsP 0.8 INCH SINGLE DIGIT NUMERIC LED DISPLAY OPTOELECTRONICS PRODUCT GROUP

GENERAL DESCRIPTION — The FND800A and FND807A are Red GaAsP Single Digit, 7-Segment LED Displays with a nominal 0.8" character height. The FND 800 has common cathode configuration. The FND807 has common anode configuration. These display devices are for applications where the viewer is within thirty feet of the display. Each digit has a brightness code (05, 06, 07 . . .) for constructing arrays with closely matched digits. This second-generation design maximizes viewing angle.

- **LOW CURRENT REQUIREMENTS OF TYPICALLY 20 mA/SEGMENT**
- **LOW VOLTAGE OF TYPICALLY 1.7 V_F**
- **FITS STANDARD DIP SOCKETS WITH 0.6" PIN ROW**
- **DECIMAL POINT ON LOWER RIGHT-HAND SIDE**
- **OVERFLOW POINT ON UPPER LEFT-HAND SIDE WITH DIGIT REVERSED**
- **MAXIMIZED CONTRAST RATIO WITH INTEGRAL LENS CAP**
- **HORIZONTAL STACKING 1" TYPICAL**
- **COMMON CATHODE OR COMMON ANODE**

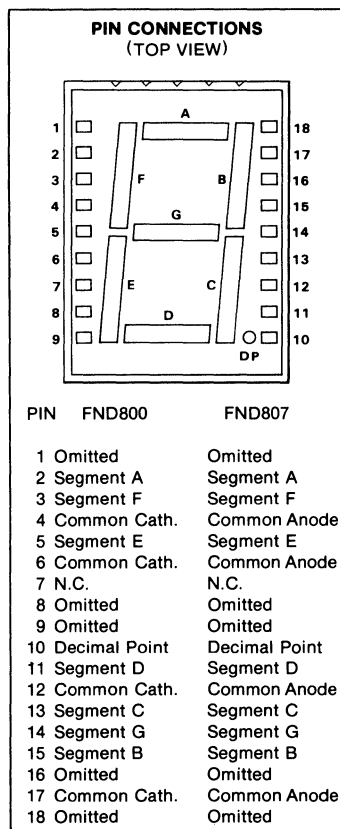
ABSOLUTE MAXIMUM RATINGS

Maximum Temperature and Humidity

Junction Temperature	-25°C to +85°C
Storage Temperature	-25°C to +85°C
Pin Temperature (Soldering, 5 s)	260°C
Relative Humidity @ 65°C	98%

Maximum Voltage and Currents

V _R	Reverse Voltage	3.0 V
I _{F(Avg)}	Average Forward Current, Segment or Decimal Point	25 mA
	Derate from 25°C Ambient Temperature (Fig. 2)	0.3 mA/°C
I _{pk}	Peak Current, Segment or Decimal Point	
	(100 μs pulse width) 1000 PPS, T _A = 25°C	200 mA

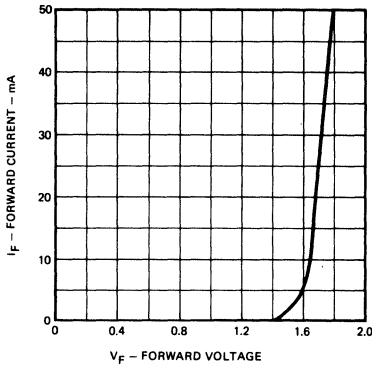


ELECTRICAL AND RADIANT CHARACTERISTICS: T_A = 25°C

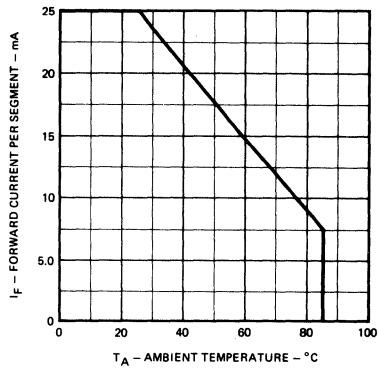
SYMBOL	CHARACTERISTICS	MIN	TYP	MAX	UNITS	TEST CONDITIONS
V _F	Forward Voltage		1.7	2.0	V	I _F = 20 mA
V _R	Reverse Voltage	3.0	12		V	I _R = 1.0 mA
I _o	Axial Luminous Intensity, Each Segment	240	600		μcd	I _F = 20 mA
ΔI _o	Intensity Matching, Segment to Segment		±33		%	I _F = 20 mA
	Intensity Matching, Within One Intensity Class		±15		%	I _F = 20 mA on all segments at once
L _o	Average Segment Luminance		35		ftL	I _F = 20 mA
θ _{1/2}	Viewing Angle to Half Intensity		30		degrees	
λ _{pk}	Peak Wavelength		665		nm	I _F = 20 mA

TYPICAL CHARACTERISTIC CURVES

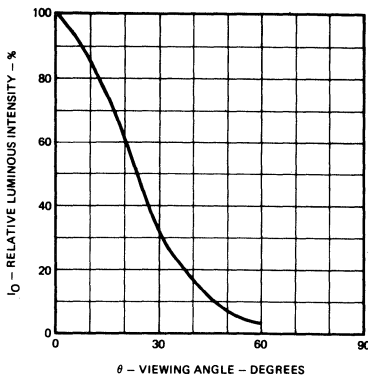
**FORWARD CURRENT
VERSUS
FORWARD VOLTAGE**



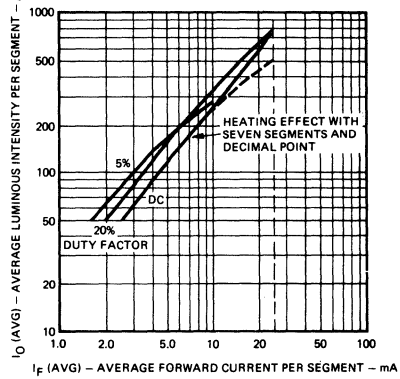
**MAXIMUM AVERAGE
CURRENT RATING VERSUS
AMBIENT TEMPERATURE**



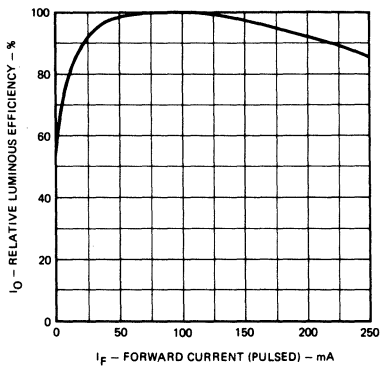
**ANGULAR DISTRIBUTION
OF LUMINOUS INTENSITY**



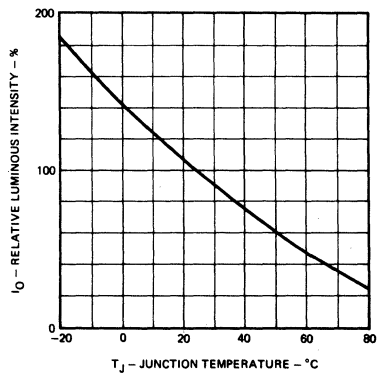
**AVERAGE LUMINOUS INTENSITY
VERSUS
AVERAGE FORWARD CURRENT**



**RELATIVE LUMINOUS EFFICIENCY
(mcd PER mA) VERSUS
PEAK CURRENT PER SEGMENT**



**RELATIVE LUMINOUS
INTENSITY VERSUS
JUNCTION TEMPERATURE**



FND801A • FND808A • FND846A • FND849A

RED GaAsP 0.8 INCH OVERFLOW LED DISPLAYS

OPTOELECTRONICS PRODUCT GROUP

GENERAL DESCRIPTION — The FND801A and FND808A are overflow (± 1) digits for use with the FND800A and FND807A, respectively. The FND846A and FND849A are overflow (± 1) digits for use with the FND847A and FND850A respectively. These display devices are for applications where the viewer is within twenty feet of the display. Each digit has a brightness code for constructing displays with closely matched digits.

- ONE DIE PER SEGMENT INSURES LOW VOLTAGE DROP OF TYPICALLY 1.7 V_F
- LOW CURRENT REQUIREMENTS OF TYPICALLY 20 mA/SEGMENT
- FITS STANDARD DIP SOCKETS WITH 0.6" PIN ROW
- DECIMAL POINT ON RIGHT OR LEFT SIDE
- MAXIMIZED CONTRAST RATIO WITH INTEGRAL LENS CAP
- HORIZONTAL STACKING 1" TYPICAL
- COMMON CATHODE OR COMMON ANODE

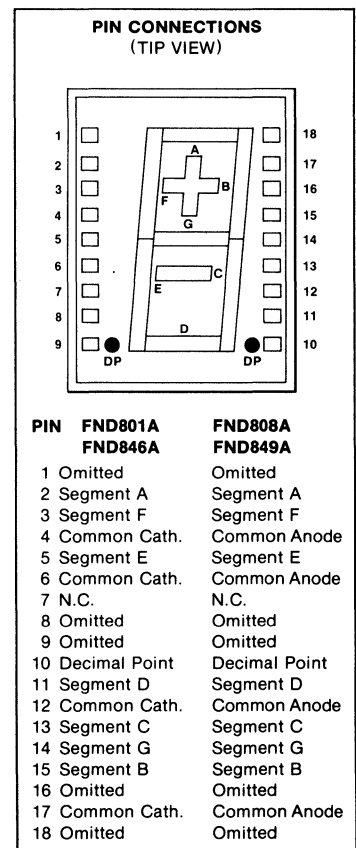
ABSOLUTE MAXIMUM RATINGS

Maximum Temperature and Humidity

Junction Temperature	-25°C to +85°C
Storage Temperature	-25°C to +85°C
Pin Temperature (Soldering, 5 s)	260°C
Relative Humidity @ 65°C	98%

Maximum Voltage and Currents

V _R	Reverse Voltage	3.0 V
I _{F(Avg)}	Average Forward Current, Segment or Decimal Point	25 mA
	Derate from 25°C Ambient Temperature (Fig. 2)	0.3 mA/°C
I _{pk}	Peak Current, Segment or Decimal Point (100 μ s pulse width) 1000 PPS, T _A = 25°C	200 mA

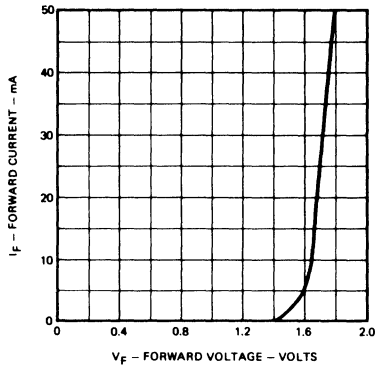


ELECTRICAL AND RADIANT CHARACTERISTICS: T_A = 25°C

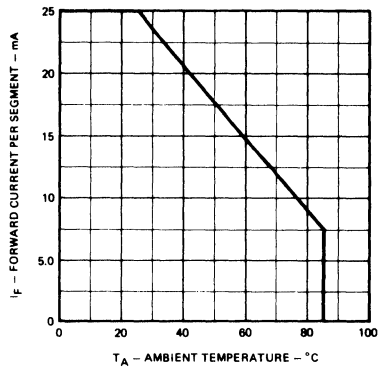
SYMBOL	CHARACTERISTICS	MIN	TYP	MAX	UNITS	TEST CONDITIONS
V _F	Forward Voltage	1.5	1.7	2.0	V	I _F = 20 mA
V _R	Reverse Voltage	3.0	12		V	I _R = 1.0 mA
I _o	Axial Luminous Intensity, Each Segment	240	600		μ cd	I _F = 20 mA
ΔI_o	Intensity Matching, Segment to Segment		± 33		%	I _F = 20 mA
	Intensity Matching, Within One Intensity Class		± 15		%	I _F = 20 mA on all segments at once
L _o	Average Segment Luminance		35		f _L	I _F = 20 mA
$\theta_{1/2}$	Viewing Angle to Half Intensity		+25		degrees	I _F = 20 mA
λ_{pk}	Peak Wavelength		660		nm	I _F = 20 mA

TYPICAL CHARACTERISTIC CURVES

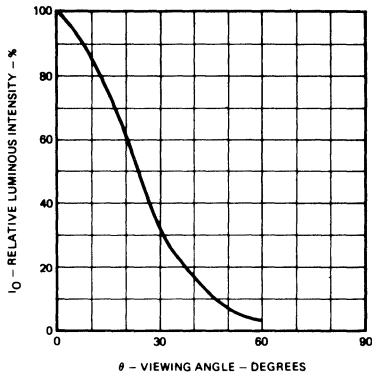
FORWARD CURRENT
VERSUS
FORWARD VOLTAGE



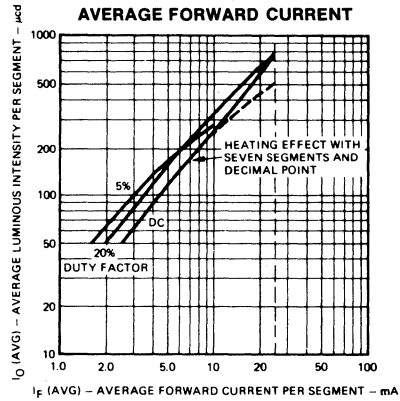
MAXIMUM AVERAGE
CURRENT RATING VERSUS
AMBIENT TEMPERATURE



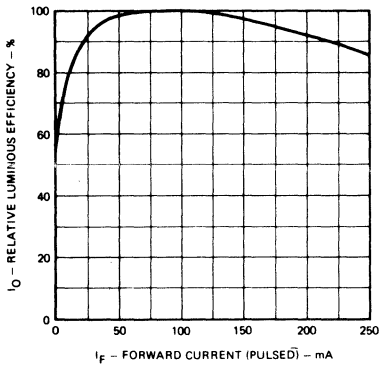
ANGULAR DISTRIBUTION
OF LUMINOUS INTENSITY



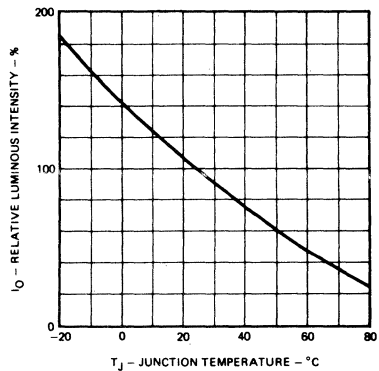
AVERAGE LUMINOUS INTENSITY
VERSUS
AVERAGE FORWARD CURRENT



RELATIVE LUMINOUS EFFICIENCY
(mcd PER mA) VERSUS
PEAK CURRENT PER SEGMENT



RELATIVE LUMINOUS
INTENSITY VERSUS
JUNCTION TEMPERATURE



FND847 • FND850

RED GaAsP 0.8 INCH SINGLE DIGIT NUMERIC LED DISPLAY

OPTOELECTRONICS PRODUCT GROUP

GENERAL DESCRIPTION — The FND847 and FND850 are red GaAsP single digit, 7-segment LED displays with a nominal 0.8" character height. The FND850 has common-cathode configuration. The FND847 has common-anode configuration. These display devices are for applications where the viewer is within thirty feet of the display. Each digit has a brightness code (06, 07, 08 . . .) for constructing arrays with closely matched digits.

- LOW CURRENT REQUIREMENTS OF TYPICALLY 5.0 mA/SEGMENT
- LOW VOLTAGE OF TYPICALLY 1.7 V_F
- FITS STANDARD DIP SOCKETS WITH 0.6" PIN ROW
- DECIMAL POINT ON LOWER LEFT-HAND SIDE
- OVERFLOW POINT ON UPPER RIGHT-HAND SIDE WITH DIGIT REVERSED
- MAXIMIZED CONTRAST RATIO WITH INTEGRAL LENS CAP
- HORIZONTAL STACKING 1" TYPICAL
- COMMON-CATHODE OR COMMON-ANODE

ABSOLUTE MAXIMUM RATINGS

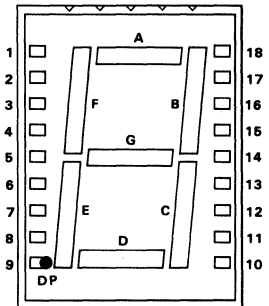
Maximum Temperature and Humidity

Storage Temperature	-25°C to +85°C
Operating Temperature	-25°C to +85°C
Pin Temperature (Soldering, 5 s)	260°C
Relative Humidity at 65°C	98%

Maximum Voltage and Currents

V _R	Reverse Voltage	3.0 V
I _{F(Avg)}	Average Forward Current/Segment or Decimal Point	25 mA
	Derate from 25°C Ambient Temperature	0.3 mA/°C
I _F	Peak Forward Current/Segment or Decimal Point	200 mA
	(100 μs pulse width) 1000 pps, T _A = 25°C	

**PIN CONNECTIONS
(TOP VIEW)**



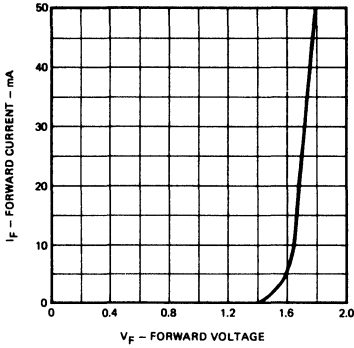
PIN	FND850	FND847
1	Omitted	Omitted
2	Segment A	Segment A
3	Segment F	Segment F
4	Common-Cath.	Common-Anode
5	Segment E	Segment E
6	Common-Cath.	Common-Anode
7	D.P.	D.P.
8	Omitted	Omitted
9	Omitted	Omitted
10	N.C.	N.C.
11	Segment D	Segment D
12	Common-Cath.	Common-Anode
13	Segment C	Segment C
14	Segment G	Segment G
15	Segment B	Segment B
16	Omitted	Omitted
17	Common-Cath.	Common-Anode
18	Omitted	Omitted

ELECTRICAL AND RADIANT CHARACTERISTICS: T_A = 25°C

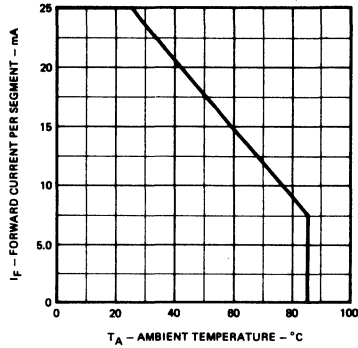
SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	TEST CONDITIONS
V _F	Forward Voltage	1.5	1.7	2.0	V	I _F = 20 mA
BV _R	Reverse Breakdown Voltage	3.0	12		V	I _R = 1.0 mA
I _O	Axial Luminous Intensity, Average for Each Segment	380	1100		μcd	I _F = 20 mA
ΔI _O	Intensity Matching, Segment to Segment		±33		%	I _F = 20 mA
	Intensity Matching Within One Intensity Class		±20		%	I _F = 20 mA, all segments at once
L _O	Average Segment Luminance		64		ftL	I _F = 20 mA
θ _{1/2}	Viewing Angle to Half Intensity		±25		degrees	
λ _{pk}	Peak Wavelength		665		nm	I _F = 20 mA

TYPICAL ELECTRICAL CHARACTERISTIC CURVES

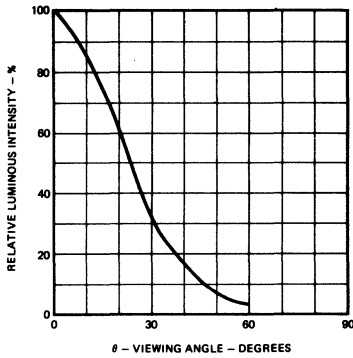
FORWARD CURRENT VERSUS FORWARD VOLTAGE



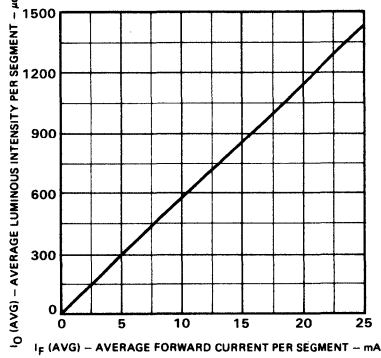
MAXIMUM AVERAGE CURRENT RATING VERSUS AMBIENT TEMPERATURE



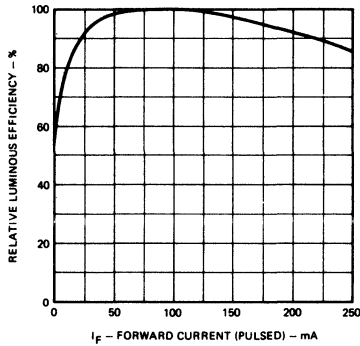
ANGULAR DISTRIBUTION OF LUMINOUS INTENSITY



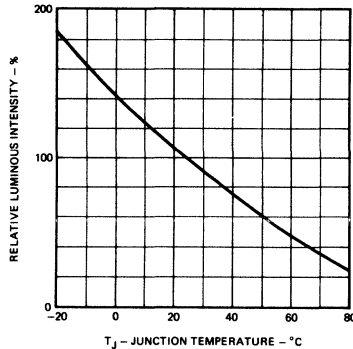
AVERAGE LUMINOUS INTENSITY VERSUS AVERAGE FORWARD CURRENT



RELATIVE LUMINOUS EFFICIENCY (mcd PER mA) VERSUS PEAK CURRENT PER SEGMENT



RELATIVE LUMINOUS INTENSITY VERSUS JUNCTION TEMPERATURE



4

FND847A • FND850A

RED GaAsP 0.8 INCH SINGLE DIGIT NUMERIC LED DISPLAY OPTOELECTRONICS PRODUCT GROUP

GENERAL DESCRIPTION — The FND847A and FND850A are Red GaAsP Single Digit, 7-Segment LED Displays with a nominal 0.8" character height. The FND850A has common cathode configuration. The FND847A has common anode configuration. These display devices are for applications where the viewer is within thirty feet of the display. Each digit has a brightness code (05, 06, 07 . . .) for constructing arrays with closely matched digits. This second-generation design maximizes viewing angle.

- **LOW CURRENT REQUIREMENTS OF TYPICALLY 20 mA/SEGMENT**
- **LOW VOLTAGE OF TYPICALLY 1.7 V_F**
- **FITS STANDARD DIP SOCKETS WITH 0.6" PIN ROW**
- **DECIMAL POINT ON LOWER LEFT-HAND SIDE**
- **OVERFLOW POINT ON UPPER RIGHT-HAND SIDE WITH DIGIT REVERSED**
- **MAXIMIZED CONTRAST RATIO WITH INTEGRAL LENS CAP**
- **HORIZONTAL STACKING 1" TYPICAL**
- **COMMON CATHODE OR COMMON ANODE**

ABSOLUTE MAXIMUM RATINGS

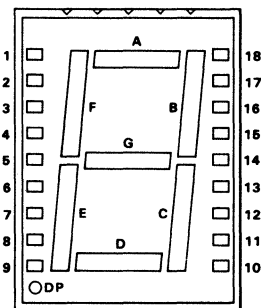
Maximum Temperature and Humidity

Junction Temperature	-25°C to +85°C
Storage Temperature	-25°C to +85°C
Pin Temperature (Soldering, 5 s)	260°C
Relative Humidity @ 65°C	98%

Maximum Voltage and Currents

V _R	Reverse Voltage	3.0 V
I _{F(Avg)}	Average Forward Current/Segment or Decimal Point	25 mA
	Derate from 25°C Ambient Temperature (Fig. 2)	0.3 mA/°C
I _{pk}	Peak Current/Segment or Decimal Point (100 μs pulse width) 1000 PPS, T _A = 25°C	200 mA

**CONNECTION DIAGRAM
(TOP VIEW)**



PIN FND850A FND847A

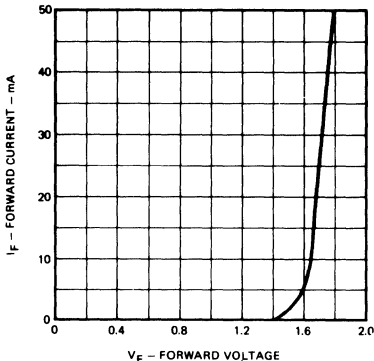
1	Omitted	Omitted
2	Segment A	Segment A
3	Segment F	Segment F
4	Common Cath.	Common Anode
5	Segment E	Segment E
6	Common Cath.	Common Anode
7	D.P.	D.P.
8	Omitted	Omitted
9	Omitted	Omitted
10	N.C.	N.C.
11	Segment D	Segment D
12	Common Cath.	Common Anode
13	Segment C	Segment C
14	Segment G	Segment G
15	Segment B	Segment B
16	Omitted	Omitted
17	Common Cath.	Common Anode
18	Omitted	Omitted

ELECTRICAL CHARACTERISTICS: T_A = 25°C

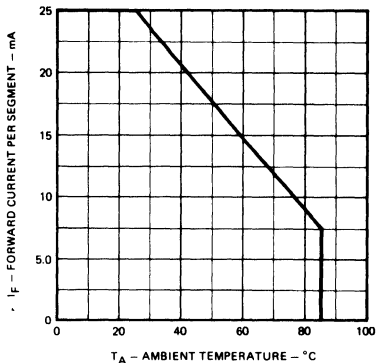
SYMBOL	CHARACTERISTICS	MIN	TYP	MAX	UNITS	TEST CONDITIONS
V _F	Forward Voltage		1.7	2.0	V	I _F = 20 mA
BV _R	Reverse Breakdown Voltage	3.0	12		V	I _R = 1.0 mA
I _o	Axial Luminous Intensity, Each Segment	240	600		μcd	I _F = 20 mA
ΔI _o	Intensity Matching, Segment to Segment		±33		%	I _F = 20 mA
	Intensity Matching, Within One Intensity Class		±20		%	I _F = 20 mA on all segments at once
L _o	Average Segment Luminance		35		ftL	I _F = 20 mA
θ _{1/2}	Viewing Angle to Half Intensity		30		degrees	
λ _{pk}	Peak Wavelength		665		nm	I _F = 20 mA

TYPICAL CHARACTERISTIC CURVES

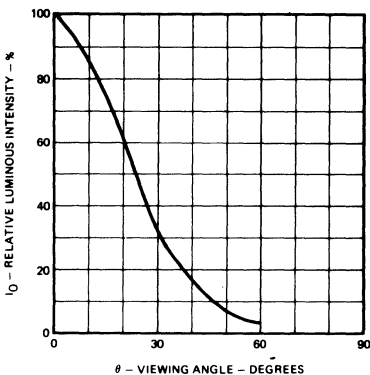
FORWARD CURRENT
VERSUS
FORWARD VOLTAGE



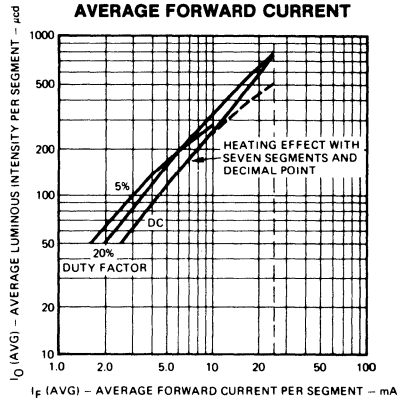
MAXIMUM AVERAGE
CURRENT RATIO VERSUS
AMBIENT TEMPERATURE



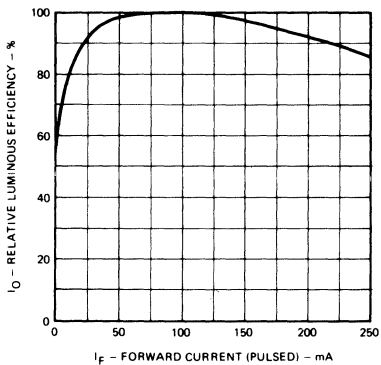
ANGULAR DISTRIBUTION
OF LUMINOUS INTENSITY



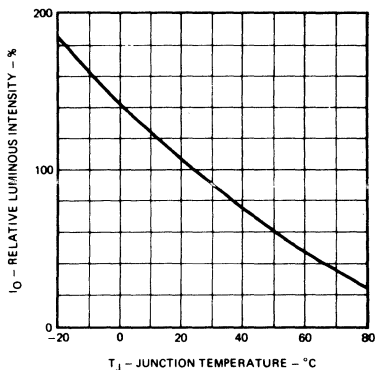
AVERAGE LUMINOUS INTENSITY
VERSUS
AVERAGE FORWARD CURRENT



RELATIVE LUMINOUS EFFICIENCY
(mcd PER mA) VERSUS
PEAK CURRENT PER SEGMENT



RELATIVE LUMINOUS
INTENSITY VERSUS
JUNCTION TEMPERATURE



4

FND6710 • FND6740

RED GaAsP 0.56-INCH

DUAL DIGIT NUMERIC LED DISPLAYS

OPTOELECTRONICS PRODUCTS GROUP

GENERAL DESCRIPTION—FND6710 and FND6740 are high performance red GaAsP 7-segment displays available in two digit form with righthand decimal points. The FND6710 is common anode, the FND6740 is common cathode.

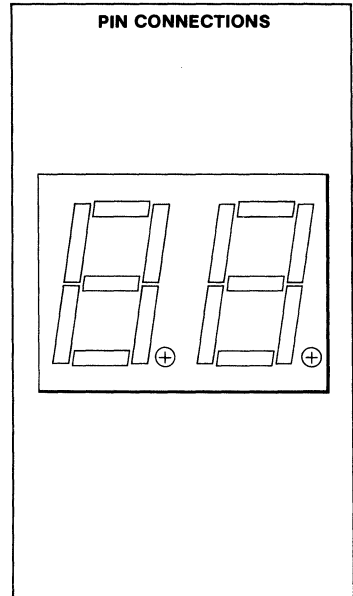
- PIN COMPATIBLE WITH MANG700 SERIES AND DL721/727 SERIES
- LOW CURRENT REQUIREMENTS - TYPICALLY 8 MA/SEG.
- LOW FORWARD VOLTAGE - TYPICALLY 1.7 V
- STANDARD DOUBLE DIP LEAD CONFIGURATION
- STACKABLE ON 0.5 INCH CENTERS
- COMMON-ANODE AND COMMON-CATHODE VERSIONS
- MAXIMIZED CONTRAST RATIO
- WIDE VIEWING ANGLE

ABSOLUTE MAXIMUM RATINGS

Maximum Temperature and Humidity	-40°C to +85°C
Operating Temperature	-40°C to +85°C
Storage Temperature	-40°C to +85°C
Pin Temperature (soldering, 5s)	260°C
Relative Humidity at 65°C	98%

Maximum Voltage and Current

V_R	Reverse Voltage	5.0V
I_F (Avg)	Average Forward Current/Segment or Decimal point Derate from 25°C Ambient Temperature	25 mA
i_f	Peak Current/Segment or Decimal point (100 μ s pulse) 1000 pps, $T_A = 25^\circ\text{C}$	200 mA



PIN ASSIGNMENT

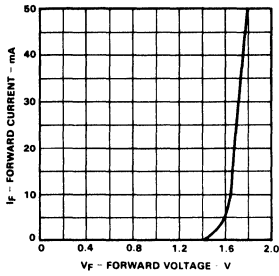
FND6710				FND6740			
PIN ASSIGNMENT				PIN ASSIGNMENT			
1	E Cath. Digit 1	10	B Cath. Digit 2	1	C Cath. Digit 1	10	B Cath. Digit 2
2	D Cath. Digit 1	11	A Cath. Digit 2	2	D Cath. Digit 1	11	A Cath. Digit 2
3	C Cath. Digit 1	12	F Cath. Digit 2	3	B Cath. Digit 1	12	F Cath. Digit 2
4	DP Cath. Digit 1	13	Digit 2 Anode	4	DP Cath. Digit 1	13	Digit 2 Anode
5	E Cath. Digit 2	14	Digit 1 Anode	5	E Cath. Digit 2	14	Digit 1 Anode
6	D Cath. Digit 2	15	B Cath. Digit 1	6	D Cath. Digit 2	15	A Cath. Digit 1
7	G Cath. Digit 2	16	A Cath. Digit 1	7	G Cath. Digit 2	16	No Connection
8	C Cath. Digit 2	17	G Cath. Digit 1	8	C Cath. Digit 2	17	No Connection
9	DP Cath. Digit 2	18	F Cath. Digit 1	9	DP Cath. Digit 2	18	No Connection

ELECTRICAL AND RADIANT CHARACTERISTICS: $T_A = 25^\circ\text{C}$ per digit.

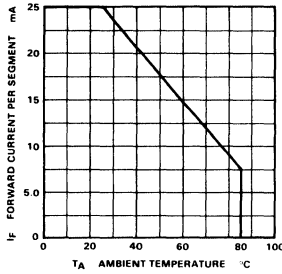
SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	CONDITIONS
V_F	Forward Voltage	1.5	1.7	2.0	V	$I_F = 20\text{ mA}$
I_R	Reverse Current			100	μA	$V_R = 5.0\text{ V}$
ΔI_o	Axial Luminous Intensity, Each Segment	125	250		μcd	$I_F = 10\text{ mA}$
I_o	Intensity Matching, segment to segment		± 33		%	$I_F = 10\text{ mA}$
λ_{pk}	Peak Wavelength		665		nm	$I_F = 20\text{ mA}$

TYPICAL CHARACTERISTIC CURVES

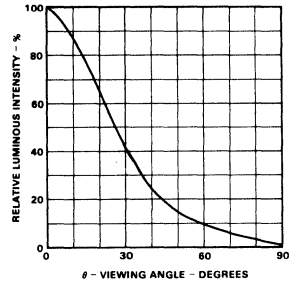
FORWARD CURRENT VERSUS FORWARD VOLTAGE



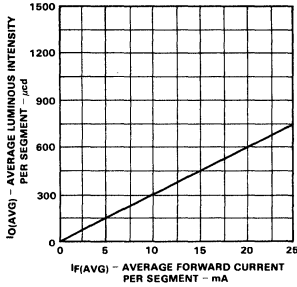
MAXIMUM AVERAGE CURRENT RATING VERSUS AMBIENT TEMPERATURE



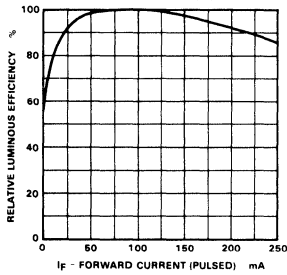
ANGULAR DISTRIBUTION OF LUMINOUS INTENSITY



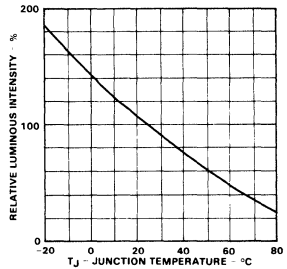
AVERAGE LUMINOUS INTENSITY VERSUS AVERAGE FORWARD CURRENT



RELATIVE LUMINOUS EFFICIENCY (MCD per mA) VERSUS PEAK CURRENT PER SEGMENT



RELATIVE LUMINOUS INTENSITY VERSUS JUNCTION TEMPERATURE



MAN71A • MAN72A

RED GaAsP 0.3 INCH 7-SEGMENT DIGIT

OPTOELECTRONICS GROUP

GENERAL DESCRIPTION — The MAN71A and MAN72A are common-anode gallium arsenide phosphide 7-segment displays with a nominal character height of 0.3 inch. They can be mounted in arrays with 0.400 inch center-to-center spacing.

- LOW POWER CONSUMPTION
- SOLID STATE RELIABILITY — LONG OPERATION LIFE
- IMPACT RESISTANT PLASTIC CASE
- STANDARD 14-PIN DIP CONFIGURATION
- WIDE VIEWING ANGLE
- MAN71A HAS RIGHT HAND DECIMAL POINT
- MAN72A HAS LEFT HAND DECIMAL POINT
- INTENSITY CODING FOR UNIFORM DISPLAYS

ABSOLUTE MAXIMUM RATINGS

Maximum Temperature and Humidity

Storage Temperature	-40°C to +85°C
Operating Temperature	-40°C to +85°C
Pin Temperature (Soldering, 5 s)	260°C
Relative Humidity at 65°C	98%

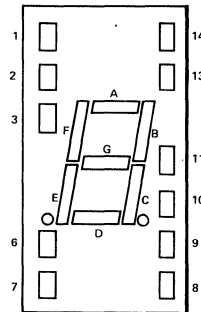
Maximum Voltage and Currents

V _R	Reverse Voltage	5.0 V
I _F (Avg)	Average Forward Current/Segment or Decimal Point	30 mA
	Derate from 25°C Ambient Temperature	2.0 mA/°C
	Peak Forward Current/Segment or Decimal Point (100 μs pulse) 1000 pps, T _A = 25°C	200 mA

ELECTRICAL AND RADIANT CHARACTERISTICS: T_A = 25°C

SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	TEST CONDITIONS
V _F	Forward Voltage, Each Segment		1.6	2.0	V	I _F = 20 mA
I _R	Reverse Current, Each Segment			100	μA	V _R = 5.0 V
I _O	Axial Luminous Intensity, Each Segment	125	250		μcd	I _F = 10 mA
ΔI _O	Intensity Matching, Segment-to-Segment		±33		%	I _F = 20 mA
	Intensity Matching Within One Intensity Class		±20		%	I _F = 20 mA, all segments at once
λ _{pk}	Peak Wavelength		660		nm	I _F = 20 mA

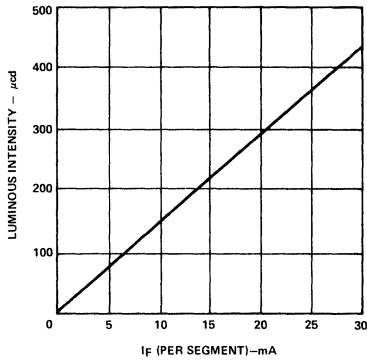
CONNECTION DIAGRAM



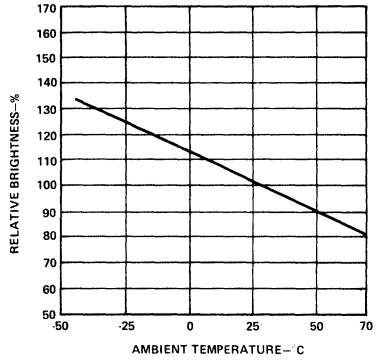
PIN NO.	MAN 71A	PIN NO.	MAN 72A
1	Cathode A	1	Cathode A
2	Cathode F	2	Cathode F
3	Common-anode	3	Common-anode
4	No pin	4	No pin
5	No pin	5	No pin
6	NC	6	Cathode D.P.
7	Cathode E	7	Cathode E
8	Cathode D	8	Cathode D
9	Common-anode	9	NC
10	Cathode C	10	Cathode C
11	Cathode G	11	Cathode G
12	No pin	12	No pin
13	Cathode B	13	Cathode B
14	Common-anode	14	Common-anode

TYPICAL ELECTRICAL CHARACTERISTIC CURVES

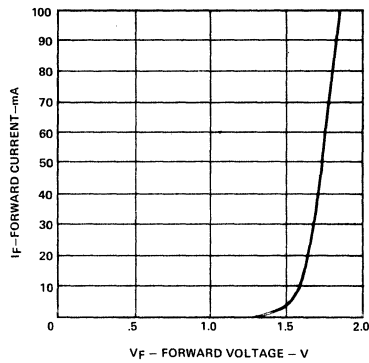
LUMINOUS INTENSITY VERSUS FORWARD CURRENT



LUMINOUS INTENSITY VERSUS TEMPERATURE



FORWARD CURRENT VERSUS FORWARD VOLTAGE



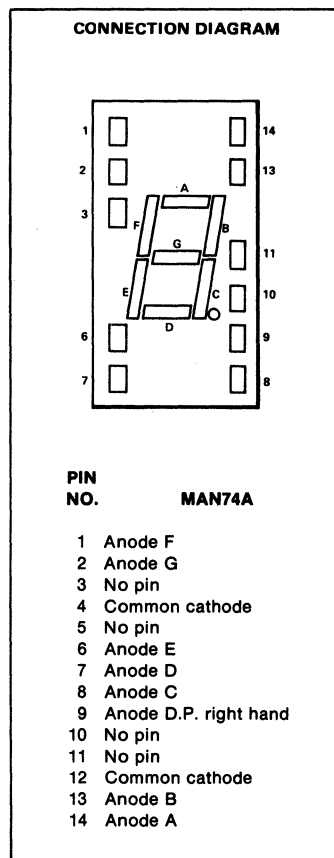
MAN74A

RED GaAsP 0.3 INCH 7-SEGMENT DIGIT

OPTOELECTRONICS GROUP

GENERAL DESCRIPTION — The MAN74A is a common-cathode gallium arsenide phosphide 7-segment display with a nominal character height of 0.3 inch. It can be mounted in arrays with 0.400 inch center-to-center spacing.

- LOW POWER CONSUMPTION
- SOLID STATE RELIABILITY — LONG OPERATION LIFE
- IMPACT RESISTANT PLASTIC CASE
- STANDARD 14-PIN DIP CONFIGURATION
- WIDE VIEWING ANGLE
- **MAN74A HAS RIGHT HAND DECIMAL POINT**
- INTENSITY CODING FOR UNIFORM DISPLAYS



ABSOLUTE MAXIMUM RATINGS

Maximum Temperature and Humidity

Storage Temperature	-40°C to +85°C
Operating Temperature	-40°C to +85°C
Pin Temperature (Soldering, 5 s)	260°C
Relative Humidity at 65°C	98%

Maximum Voltage and Currents

V _R	Reverse Voltage	5.0 V
I _{F(Avg)}	Average Forward Current/Segment or Decimal Point	30 mA
	Derate from 25°C Ambient Temperature	2.0 mA/°C
	Peak Forward Current/Segment or Decimal Point (100 μs pulse) 1000 pps, T _A = 25°C	200 mA

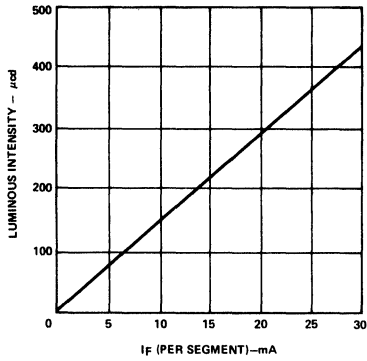
ELECTRICAL AND RADIANT CHARACTERISTICS: T_A = 25°C

SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	TEST CONDITIONS
V _F	Forward Voltage, Each Segment		1.6	2.0	V	I _F = 20 mA
I _R	Reverse Current, Each Segment			100	μA	V _R = 5.0 V
I _O	Axial Luminous Intensity, Each Segment	125	250		μcd	I _F = 10 mA
ΔI _O	Intensity Matching, Segment-to-Segment		±33		%	I _F = 20 mA
	Intensity Matching Within One Intensity Class		±20		%	I _F = 20 mA, all segments at once
λ _{pk}	Peak Wavelength		660		nm	I _F = 20 mA

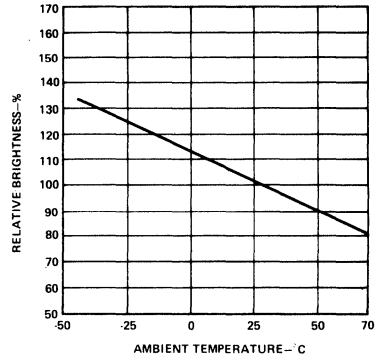
FAIRCHILD MAN74A

TYPICAL ELECTRICAL CHARACTERISTIC CURVES

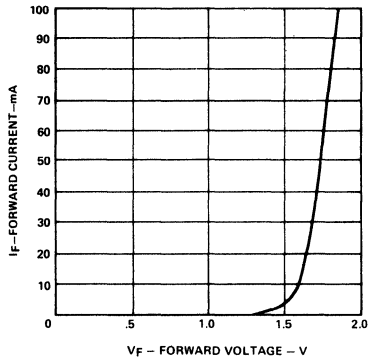
LUMINOUS INTENSITY VERSUS FORWARD CURRENT



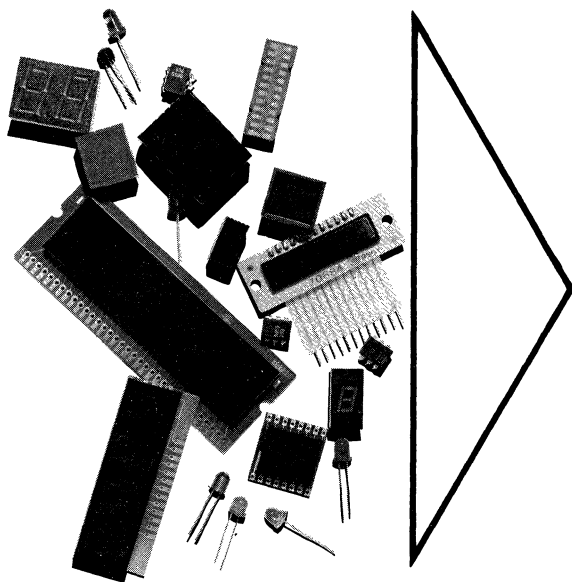
LUMINOUS INTENSITY VERSUS TEMPERATURE



FORWARD CURRENT VERSUS FORWARD VOLTAGE



4



OPTOELECTRONIC TECHNOLOGY	1
DISCRETE LED DIGIT RELIABILITY	2
VISIBLE LED LAMPS AND MOUNTING HARDWARE	3
SEVEN-SEGMENT DISPLAYS AND DISPLAY ARRAYS	4
PHOTOTRANSISTORS, INFRARED EMITTERS, AND SENSORS	5
PHOTOCOUPLEDERS	6
PACKAGE OUTLINES	7
DEFINITIONS OF SYMBOLS AND TERMS	8
FAIRCHILD FIELD SALES OFFICES, SALES REPRESENTATIVES AND DISTRIBUTOR LOCATIONS	9

CHAPTER 5 INTRODUCTION

A photocoupler consists basically of a light-emitting photodiode and a light-sensitive semiconductor detector, optically coupled to enable an optical signal to be transmitted from the emitter to the detector. This optical transmission of the signal enables electrical isolation of several thousands of volts to be achieved between input and output of the photocoupler.

Since the photocoupler (also sometimes referred to as an optically coupled isolator or optocoupler) has no moving parts, such as contacts, to bounce, arc, or erode, it has a considerably increased reliability factor over equivalent mechanical products.

Important features of the photocoupler are:

- On-and-off switching speed in the one-to two-microsecond region.
- Electrical isolation resistance between input and output on the order of 10^{11} ohms, and coupling capacitance of approximately 1 pF.
- Data transmission rates from dc through the MHz frequency ranges.
- Provide unidirectional operation with no feedback to the input.
- Directly interface with other semiconductor components.

The ability of the photocoupler to isolate such sensitive objects as people and delicate instruments from high voltage equipment is generating a rapidly growing, diversified market in such areas as medical monitors, electrostatic paper copiers, power control equipment, and telecommunications systems.

FPA100 • FPA101 • FPA102

EMITTER AND SENSOR MATCHED PAIR ARRAYS

OPTOELECTRONICS PRODUCT GROUP

GENERAL DESCRIPTION — The FPA100, FPA101 and FPA102 are source/sensor arrays each of which consist of a set of two modules: one, an array of infrared emitters and two, an array of infrared sensors.

The source module consists of an array of gallium arsenide infrared emitting diodes. When forward biased, these diodes emit an intense narrow band of infrared (non-visible) radiation at a wavelength of 900 nm. The sensor modules consist of an array of npn phototransistors which are sensitive to visible as well as infrared radiation (400 to 1100 nm). They are most sensitive to infrared radiation so that the source module's emission wavelength is very nearly perfect for maximum coupling efficiency. The source and sensor modules of each set are identical in construction; when the modules are placed facing one another, each infrared emitting diode has a phototransistor directly opposite it.

The FPA100 has nine source/sensor pairs in a single line on 0.100" centers, matching the format of standard punched paper tape. The FPA101 has twelve source/sensor pairs in a single line on 0.250" centers, matching the row spacing of standard tab cards. The FPA102 has ten source/sensor pairs in a single line on 0.087" centers, matching the column spacing of standard tab cards.

- **REDUCES MECHANICAL DESIGN AND PACKAGING PROBLEMS**
- **LOW TEMPERATURE COEFFICIENT**
- **DESIGNED FOR READING PUNCHED CARDS AND PUNCHED TAPES WITH THE SENSOR OUTPUTS OPERABLE DIRECTLY INTO STANDARD DIGITAL INTEGRATED CIRCUITS.**
- **APPLICATIONS: TRANSMISSILE READING SHAFT ENCODING AND MULTI-CHANNEL OPTICAL COUPLING**

ABSOLUTE MAXIMUM RATINGS

Maximum Temperatures and Humidity

Storage Temperature	-40°C to +100°C
Operating Temperature	-40°C to +100°C
Pin Temperature (Soldering, 10 s)	260°C
Relative Humidity at 65°C	98 %

Maximum Power Dissipation (Note 1)

Total Dissipation at $T_A = 25^\circ\text{C}$ for Source Array	110 mW/cell
Derate Linearly from 25°C	1.47mW/°C
Total Dissipation at $T_A = 25^\circ\text{C}$ for Sensor Array	167mW/cell
Derate Linearly from 25°C	2.22 mW/°C

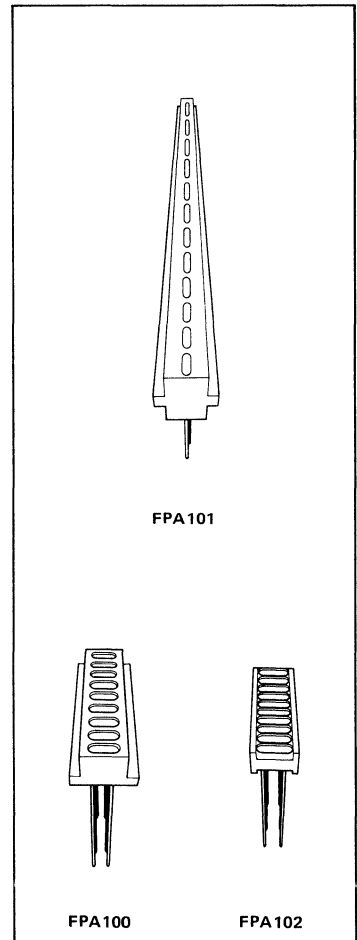
Maximum Voltages and Currents

Source Array		
I_F	Forward dc Current/Cell	75 mA
V_R	Reverse Voltage	3.0 V
Sensor Array		
$V_{CEO(sus)}$	Collector to Emitter Sustaining Voltage (Note 2)	12 V
I_C	Collector Current	25 mA

ELECTRICAL CHARACTERISTICS: $T_A = 25^\circ\text{C}$

SOURCE ARRAY

SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	TEST CONDITIONS
V_F	Forward Voltage		1.25	1.50	V	$I_F = 50 \text{ mA}$
BV_R	Reverse Breakdown Voltage	3.0	6.0		V	$I_R = 100 \mu\text{A}$



SENSOR ARRAY

SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	TEST CONDITIONS
$V_{CE(sus)}$	Sustaining Voltage (Notes 2 and 3)	12	20		V	$I_C = 1.0 \text{ mA}$, (pulsed)
BV_{ECO}	Emitter to Collector Breakdown Voltage (Note 2)		5.0		V	$I_{EC} = 100 \mu\text{A}$
$V_{CE(sat)}$	Saturation Voltage (Note 4)		0.4		V	$I_C = 4 \text{ mA}$, $H = 10 \text{ mW/cm}^2$ (GaAs)
I_{CEO}	Collector Dark Current (Note 2)		10	100	nA	$V_{CE} = 5.0 \text{ V}$, $H \leq 0.1 \mu\text{W/cm}^2$
$I_{CE(It)}$	Photo Current (Note 4)		4.5		mA	$V_{CE} = 5.0 \text{ V}$, $H = 1.0 \text{ mW/cm}^2$ (GaAs)

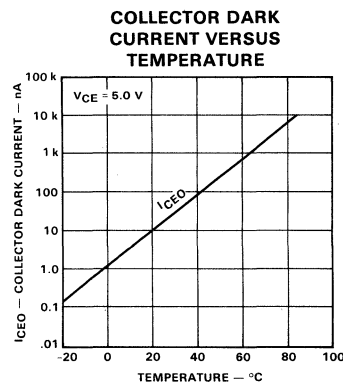
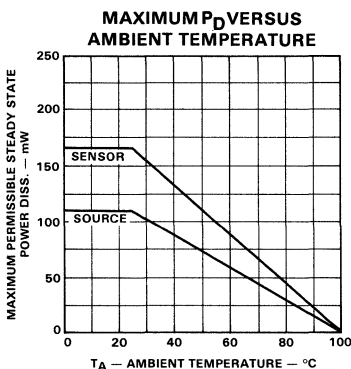
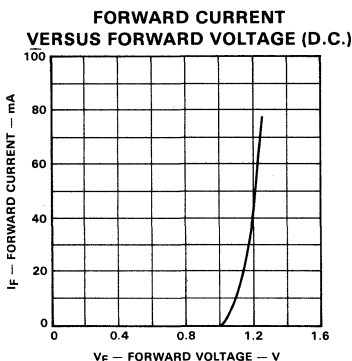
COMBINATION SOURCE/SENSOR ARRAY

SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	TEST CONDITIONS
I_{OUT}	Output Current	4.5	9.0	13.5	mA	$I_{IN} = 50 \text{ mA}$, $d = .050''$, $V_{CE} = 5.0 \text{ V}$
$\frac{I_{OUT \text{ min}}}{I_{OUT \text{ max}}}$	Matching Factor	0.5	0.65			$I_{IN} = 50 \text{ mA}$, $d = .050''$, $V_{CE} = 5.0 \text{ V}$
$V_{CE(sat)}$	Saturation Voltage		0.4	0.7	V	$I_{IN} = 50 \text{ mA}$, $d = .050''$, $I_{OUT} = 3.7 \text{ mA}$
t_r	Light Current Fall Time (Note 5)		40		μs	$I_{IN} = 50 \text{ mA}$, $d = .050''$
t_f	Light Current Rise Time (Note 5)		40		μs	$I_{IN} = 50 \text{ mA}$, $d = .050''$

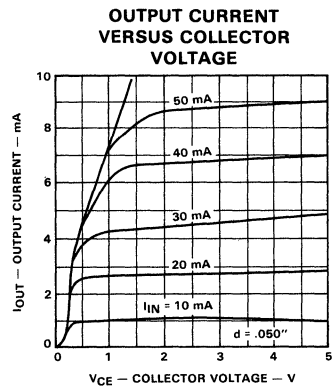
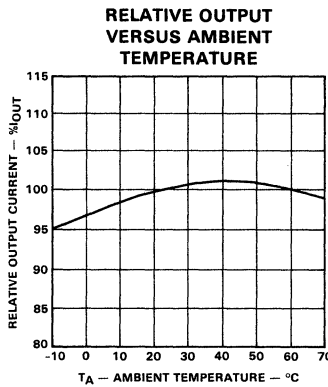
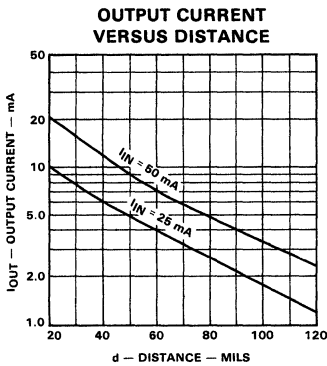
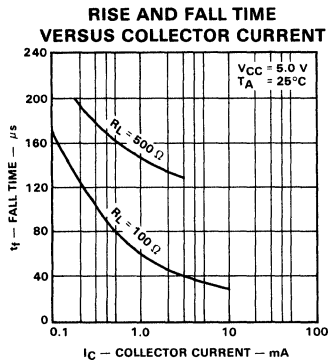
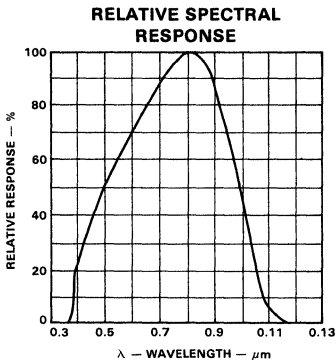
NOTES:

1. These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operation.
2. Measured with radiation flux intensity of less than $.1 \mu\text{W/cm}^2$ over the spectrum from 0.1 micron to 1.5 microns.
3. Rating refers to a high current point where collector to emitter voltage is lowest.
4. Measured at an irradiance of 5.0 mW/cm^2 as emitted from a gallium arsenide diode.
5. Rise time is defined as the time required for I_{CE} to rise from 10% to 90% of the peak value. Fall time is defined as the time required for I_{CE} to decrease from 90% to 10% of the peak value.
6. The center of each element is aligned to $\pm .010''$ along the length and $\pm .005''$ across the width.
7. Emitter terminal side of phototransistor (sensor array) or anode terminal side of diode (source array) defined by white dot.
8. Leads alternate from emitter to collector (sensor) or anode to cathode (source), beginning from this end of the package.
9. The center of each element is aligned to $\pm .010''$ across the width and $\pm .005''$ along the length.

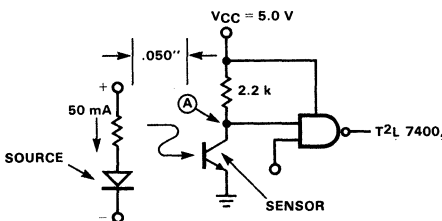
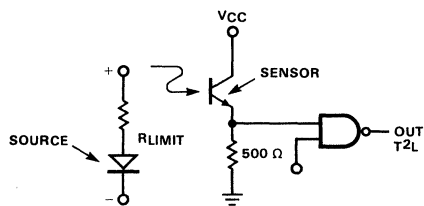
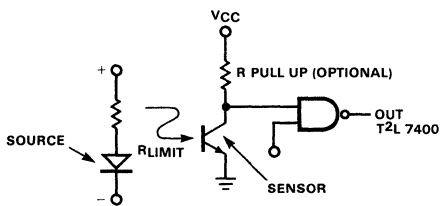
TYPICAL CHARACTERISTIC CURVES



TYPICAL CHARACTERISTIC CURVES (Cont'd)



TYPICAL CIRCUITS

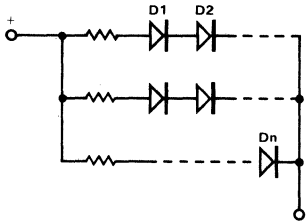


For a "hole" condition, point A for all sensors will be less than 0.8 V. For a "no hole" condition (where signal due to tape transmission is $\leq 15\%$ of "hole"), point A will be greater than 2.0 V. These are the worst case conditions required to switch this type of logic.

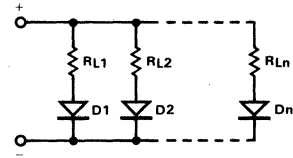
SOURCE CIRCUITS



Use where $V_{supply} > 1.5$ n and transmission $< 20\%$.



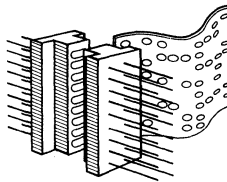
Use where $V_{supply} < 1.5$ n and transmission $< 20\%$. Rows must contain equal number of diodes.



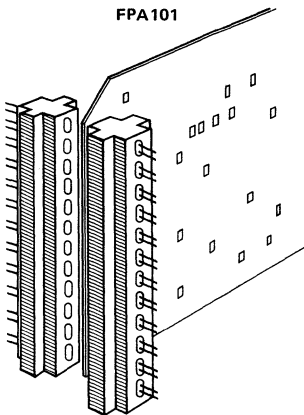
Use where $V_{supply} < 1.5$ n and transmission $> 20\%$. R_L may be adjusted so outputs of sensors are perfectly matched.

TYPICAL APPLICATION

FPA100



FPA101



FPA103 • FPA104 • FPA105 FPA106 • FPA107 • FPA108

LIGHT REFLECTION EMITTER/SENSOR ARRAY

OPTOELECTRONICS PRODUCT GROUP

GENERAL DESCRIPTION—The FPA103/104/105/106/107/108 consists of a gallium arsenide infrared emitting diode and a silicon npn phototransistor. The axial radiant intensity of the diode and the axial response of the phototransistor are both perpendicular to the face of the device. The phototransistor thus responds to radiation emitted from the diode only when a reflective object or surface is in the field of view of the phototransistor.

The diode used in the FPA103/104/105/106/107/108 is similar to Fairchild's FPE100 gallium arsenide infrared emitting diode. It emits an intense, narrow band of radiation, peaking at approximately 900 nm (non-visible) when forward biased. The phototransistor used in this device is sensitive to radiation over the wavelength range of 400 to 1100 nm.

The FPA106/107/108 is electrically equivalent to the FPA103/104/105 respectively with the addition of an infrared filter to prevent visible light from entering the phototransistor.

- REDUCES MECHANICAL DESIGN AND PACKAGING PROBLEMS
- HIGH SENSITIVITY
- EXCELLENT STABILITY
- LOW TEMPERATURE COEFFICIENT

ABSOLUTE MAXIMUM RATINGS

Maximum Temperatures and Humidity

Storage Temperature	-40°C to +100°C
Operating Temperature	-40°C to +100°C
Pin Temperature (Soldering, 10 s)	260°C
Relative Humidity at 65°C	98%

Input Diode

Forward D.C. Current	75 mA
Reverse Voltage	3.0 V
Power Dissipation at $T_A = 25^\circ\text{C}$	110 mW
Derate Linearly from 25°C	1.47 mW/°C

Output Transistor

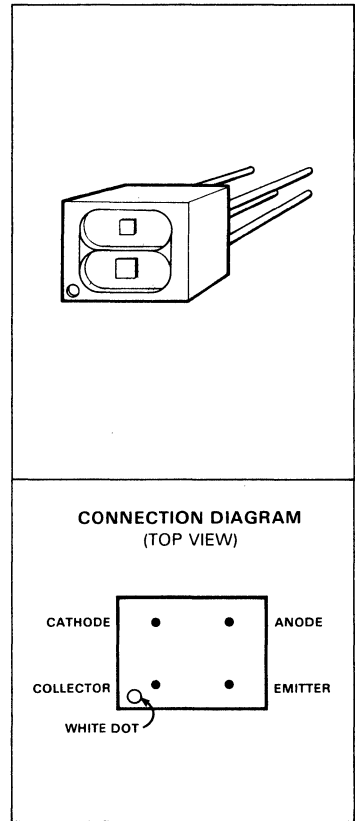
Collector D.C. Current	25 mA
Collector to Emitter Voltage	12 V
Power Dissipation at $T_A = 25^\circ\text{C}$	167 mW
Derate Linearly from 25°C	2.22 mW/°C

ELECTRICAL CHARACTERISTICS—INPUT DIODE: $T_A = 25^\circ\text{C}$

SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	TEST CONDITIONS
V_F	Forward Voltage		1.25	1.5	V	$I_F = 50 \text{ mA}$
BV_R	Reverse Breakdown Voltage	3.0	6.0		V	$I_R = 100 \mu\text{A}$

ELECTRICAL CHARACTERISTICS—OUTPUT TRANSISTOR: $T_A = 25^\circ\text{C}$

SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	TEST CONDITIONS
$V_{CE0(sus)}$	Sustaining Voltage (Note 2)	12	20		V	$I_C = 1.0 \text{ mA (pulsed)}$
BV_{ECO}	Emitter to Collector Breakdown Voltage (Note 2)		5.0		V	$I_{EC} = 100 \mu\text{A}$



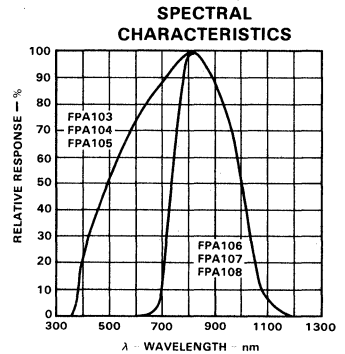
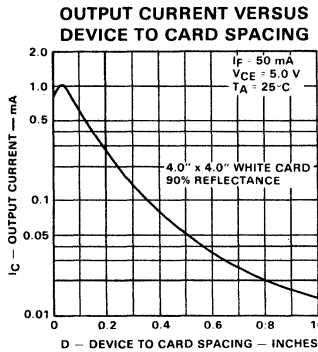
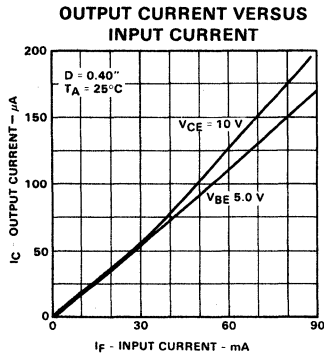
ELECTRICAL CHARACTERISTICS — COMBINATION: $T_A = 25^\circ\text{C}$

SYMBOL	CHARACTERISTICS	MIN	TYP	MAX	UNITS	TEST CONDITIONS
I_C	Photo Current (GaAs Source, Note 1)					$I_F = 50\text{ mA}$, $V_{CE} = 5.0\text{ V}$, $d = 0.40''$
		103 - 106	20	80	μA	
		104 - 107	60	180	μA	
		105 - 108	80	160	μA	
I_{CEO}	Collector Dark Current (Note 2)		10	100	nA	$I_F = 50\text{ mA}$, $V_{CE} = 5.0\text{ V}$, Non-reflecting external surface
$V_{CE(\text{sat})}$	Saturation Voltage (Note 1)		0.3	0.7	V	$I_F = 50\text{ mA}$, $I_C = 5.0\text{ }\mu\text{A}$, $d = 0.40''$
t_r & t_f	Rise & Fall Time (Note 3)		100		μs	$I_C = 80\text{ }\mu\text{A}$, $V_{CC} = 5.0\text{ V}$, $R_L = 1\text{ k}\Omega$

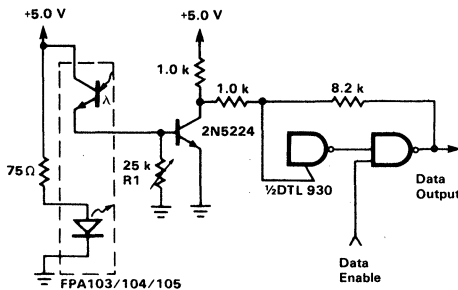
NOTE:

1. Photocurrent is that obtained from a $4.0'' \times 4.0''$ 90% white surface placed at a distance of .40" from the face of the device. For test purposes, an Eastman Kodak neutral white test card with 90% diffuse reflectance was employed.
2. Measured with radiation flux intensity of less than $.1\text{ }\mu\text{W}/\text{cm}^2$ over the spectrum from 0.1 micron to 1.5 microns.
3. Rise time is defined as the time required for I_{CE} to rise from 10% to 90% of the peak value. Fall time is defined as the time required for I_{CE} to decrease from 90% to 10% of the peak value.
4. White dot defines collector of phototransistor. Read pinout clockwise, top view: collector, source cathode, source anode, emitter.

TYPICAL ELECTRICAL CHARACTERISTICS



INTERFACING CIRCUIT



FPA103A • FPA104A • FPA105A FPA106A • FPA107A • FPA108A

LIGHT REFLECTION EMITTER/SENSOR ARRAYS

OPTOELECTRONICS PRODUCT GROUP

GENERAL DESCRIPTION — The FPA103A/104A/105A/106A/107A/108A consists of a gallium arsenide infrared emitting diode and a silicon npn phototransistor. The axial radiant intensity of the diode and the axial response of the phototransistor are both perpendicular to the face of the device. The phototransistor thus responds to radiation emitted from the diode only when a reflective object or surface is in the field of view of the phototransistor.

The diode used in the FPA103A/104A/105A/106A/107A/108A is similar to Fairchild's FPE100 gallium arsenide infrared emitting diode. It emits an intense, narrow band of radiation, peaking at approximately 900 nm (non-visible) when forward biased. The phototransistor used in this device is sensitive to radiation over the wavelength range of 400 to 1100 nm.

The FPA106A/107A/108A is electrically equivalent to the FPA103A/104A/105A respectively with the addition of an infrared filter to prevent visible light from entering the phototransistor.

- **REDUCES MECHANICAL DESIGN AND PACKAGING PROBLEMS**
- **HIGH SENSITIVITY**
- **EXCELLENT STABILITY**
- **LOW TEMPERATURE COEFFICIENT**
- **EXCELLENT CROSS-TALK CHARACTERISTICS**

ABSOLUTE MAXIMUM RATINGS

Maximum Temperatures and Humidity

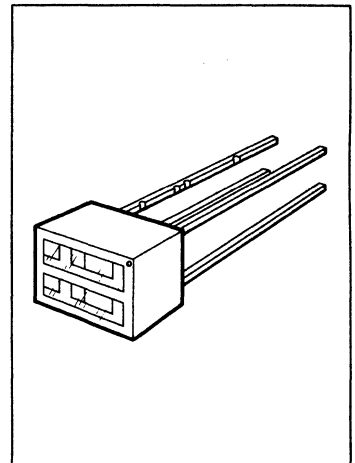
Storage Temperature	-40°C to +100°C
Operating Temperature	-40°C to +100°C
Pin Temperature (Soldering, 10 s)	260°C
Relative Humidity at 65°C	98%

Input Diode

Forward D.C. Current	75 mA
Reverse Voltage	3.0 V
Power Dissipation at $T_A = 25^\circ\text{C}$	110 mW
Derate Linearly from $T_A = 25^\circ\text{C}$	1.47 mW/°C

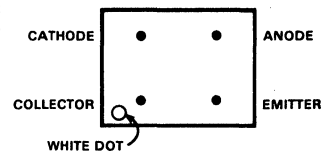
Output Transistor

Collector D.C. Current	25 mA
Collector to Emitter Voltage	12 V
Power Dissipation at $T_A = 25^\circ\text{C}$	167 mW
Derate Linearly from $T_A = 25^\circ\text{C}$	2.22 mW/°C



5

**CONNECTION DIAGRAM
(TOP VIEW)**



ELECTRICAL CHARACTERISTICS — INPUT DIODE: $T_A = 25^\circ\text{C}$

SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	TEST CONDITIONS
V_F	Forward Voltage		1.25	1.5	V	$I_F = 50\text{ mA}$
BV_R	Reverse Breakdown Voltage	3.0	6.0		V	$I_R = 100\mu\text{A}$

ELECTRICAL CHARACTERISTICS — OUTPUT TRANSISTOR: $T_A = 25^\circ\text{C}$

SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	TEST CONDITIONS
$V_{CE(sus)}$	Sustaining Voltage (Note 2)	12	20		V	$I_C = 1.0\text{ mA (pulsed)}$
BV_{ECO}	Emitter to Collector Breakdown Voltage (Note 2)		5.0		V	$I_{EC} = 100\mu\text{A}$

FAIRCHILD FPA103A • FPA104A • FPA105A • FPA106A • FPA107A • FPA108A

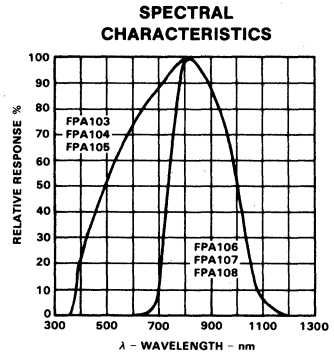
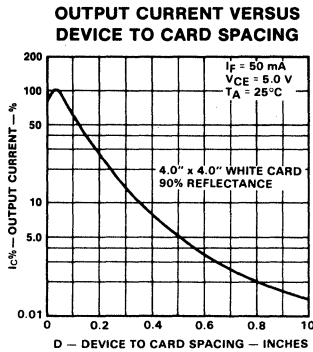
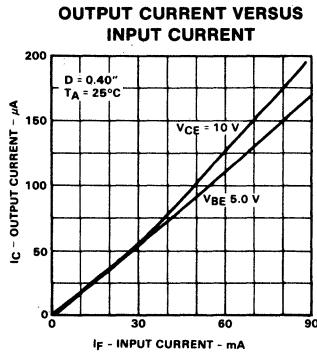
ELECTRICAL CHARACTERISTICS — COMBINATION: $T_A = 25^\circ\text{C}$

SYMBOL	CHARACTERISTICS	MIN	TYP	MAX	UNITS	TEST CONDITIONS
I_c	Photo Current (GaAs Source, Note 1) 103A - 106A 104A - 107A 105A - 108A	100 250 300	300	750 600	μA μA μA	$I_f = 50\text{ mA}$, $V_{CE} = 5.0\text{ V}$, $d = 0.040''$
I_{CEO}	Collector Dark Current (Note 2)		10	100	nA	$I_f = 50\text{ mA}$, $V_{CE} = 5.0\text{ V}$, Non-reflecting external surface
$V_{CE(sat)}$	Saturation Voltage (Note 1)		0.3	0.7	V	$I_f = 50\text{ mA}$, $I_c = 5.0\ \mu\text{A}$, $d = 0.40''$
t_r & t_f	Rise & Fall Time (Note 3)		100		μs	$I_c = 80\ \mu\text{A}$, $V_{CC} = 5.0\text{ V}$, $R_L = 1\text{ k}\Omega$

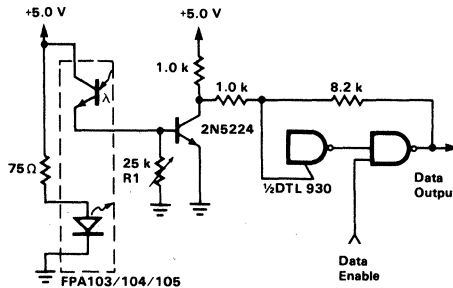
NOTE:

1. Photocurrent is that obtained from a 4.0" x 4.0" 90% white surface placed at a distance of .40" from the face of the device. For test purposes, an Eastman Kodak neutral white test card with 90% diffuse reflectance was employed.
2. Measured with radiation flux intensity of less than $.1\ \mu\text{W}/\text{cm}^2$ over the spectrum of 0.1 micron to 1.5 microns.
3. Rise time is defined as the time required for I_{CE} to rise from 10% to 90% of the peak value. Fall time is defined as the time required for I_{CE} to decrease from 90% to 10% of the peak value.
4. White dot defines collector of phototransistor. Read pinout clockwise, top view; collector, source cathode, source anode, emitter.

TYPICAL ELECTRICAL CHARACTERISTICS



INTERFACING CIRCUIT



FPA700 • FPA700A

9-ELEMENT PHOTOTRANSISTOR TAPE READER ARRAY

OPTOELECTRONICS PRODUCT GROUP

GENERAL DESCRIPTION — The FPA700 and FPA700A are 9-element npn Planar* phototransistor arrays having exceptionally stable characteristics and high illumination sensitivity. Each transistor is electrically isolated and mounted on 100 mil centers. The case is a plastic compound with transparent resin encapsulation which exhibits stable characteristics under high humidity conditions.

- HIGH ILLUMINATION SENSITIVITY
- EXHIBITS STABLE CHARACTERISTICS UNDER HIGH HUMIDITY
- ESPECIALLY DESIGNED FOR PUNCHED OR MARKED CARD READING AND OPTICAL ENCODER APPLICATIONS

ABSOLUTE MAXIMUM RATINGS

Maximum Temperatures and Humidity

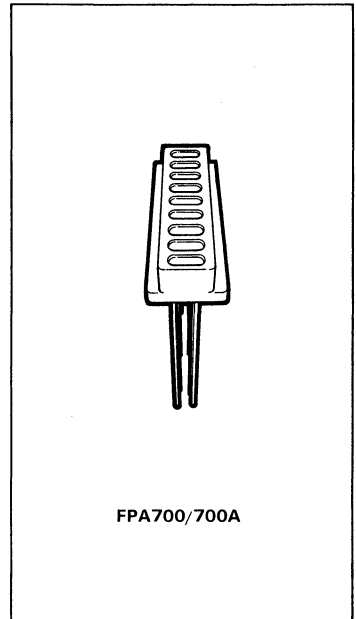
Storage Temperature	-40°C to +100°C
Operating Temperature	-40°C to +85°C
Pin Temperature (Soldering, 10 s)	260°C
Relative Humidity at 65°C	98%

Maximum Power Dissipation per Cell

Total Dissipation at $T_C = 25^\circ\text{C}$	200 mW
Derate Linearly from 25°C	3.33 mW/°C
Total Dissipation at $T_A = 25^\circ\text{C}$	133 mW
Derate Linearly from 25°C	2.22 mW/°C

Maximum Voltages and Currents (Note 1)

$V_{CEO(sus)}$	Collector to Emitter Sustaining Voltage	20 V
I_C	Collector Current	25 mA



FPA700/700A

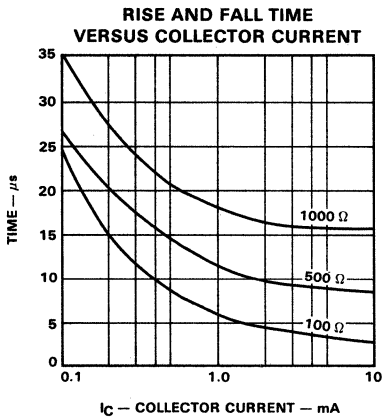
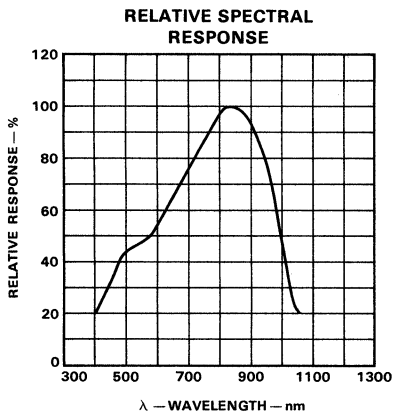
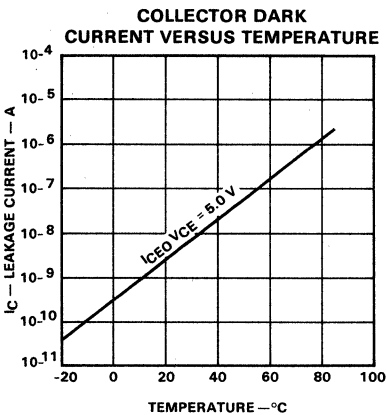
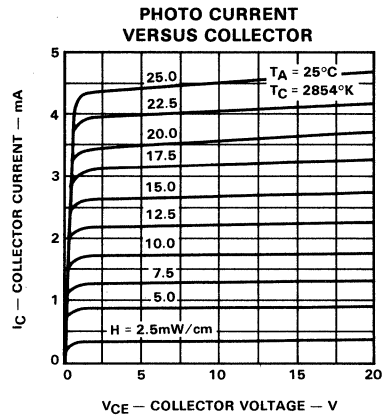
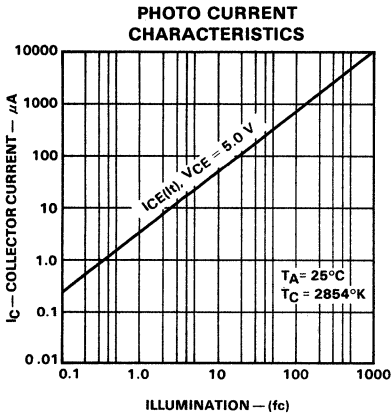
5

ELECTRICAL CHARACTERISTICS: $T_A = 25^\circ\text{C}$

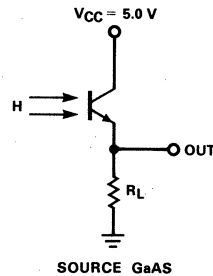
SYMBOL	CHARACTERISTIC	FPA700			FPA700A			UNITS	TEST CONDITIONS
		MIN	TYP	MAX	MIN	TYP	MAX		
$V_{CEO(sus)}$	Collector-Emitter Sustaining Voltage (Note 2)	20	35		20	35		V	$I_C = 1.0 \text{ mA}$
BV_{ECO}	Emitter-Collector Breakdown Voltage (Note 2)		7.0			7.0		V	$I_{EC} = 100 \mu\text{A}$
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage		0.16	0.33		0.16	0.33	V	$I_C = 500 \mu\text{A}$, $H = 20 \text{ mW/cm}^2$
I_{CEO}	Collector Dark Current/Cell (Note 2)		4.0	100		4.0	100	nA	$V_{CE} = 5.0 \text{ V}$
$I_{CE(it)}$	Photo Current, Tungsten Source (Note 3)	200	750		200	750		μA	$V_{CE} = 5.0 \text{ V}$, $H = 5 \text{ mW/cm}^2$
$I_{CE(it)}$	Photo Current, Tungsten Source (Note 3)		1.75			1.75		mA	$V_{CE} = 5.0 \text{ V}$, $H = 10 \text{ mW/cm}^2$
$I_{CE(it)}$	Photo Current, GaAs Source (Note 4)		2.25			2.25		mA	$V_{CE} = 5.0 \text{ V}$, $H = 5 \text{ mW/cm}^2$
t_r	Light Current Rise Time (Note 6)		4.0			4.0		μs	GaAs, $I_C = 2.0 \text{ mA}$,
t_f	Light Current Fall Time (Note 6)		4.0			4.0		μs	$R_L = 100 \Omega$, $V_{CC} = 5.0 \text{ V}$
S_{min}/S_{max}	Matching Factor (Notes 3 and 5)	0.5	0.65	1.0	0.75	0.85	1.0		$V_{CE} = 5.0 \text{ V}$, $H = 5 \text{ mW/cm}^2$

*Planar is a patented Fairchild process.

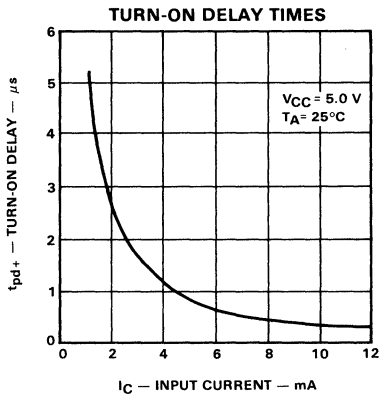
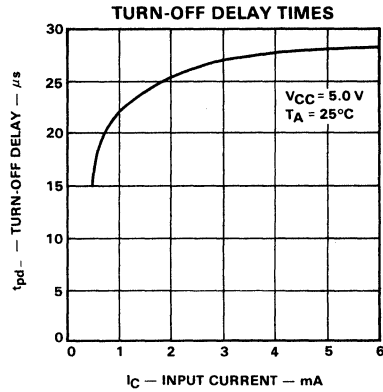
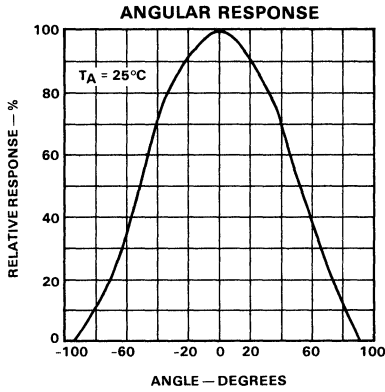
TYPICAL CHARACTERISTIC CURVES



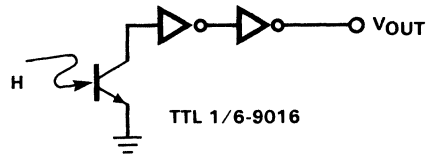
SWITCHING CIRCUIT FOR RISE AND FALL TIMES



TYPICAL CHARACTERISTIC CURVES (Cont'd)



CIRCUIT FOR TURN-ON AND TURN-OFF DELAY



5

NOTES:

1. These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operation.
2. Measured with radiation flux intensity of less than .1 μW/cm² over the spectrum from 0.1 micron to 1.5 microns.
3. Measured at noted irradiance as emitted from a tungsten lamp at a color temperature of 2854°K. The effective photosensitive area is (0.8 mm²).
Illuminance (in lumens/ft²) = irradiance H (in mW/cm²) x 20 at a color temperature of 2854°K.
4. Measured at an irradiance of 5.0 mW/cm² as emitted from a gallium arsenide diode.
5. Matching factor is the ratio of minimum sensitivity to maximum sensitivity of any two cells.
6. Rise time is defined as the time required for I_{CE} to rise from 10% to 90% of the peak value. Fall time is defined as the time required for I_{CE} to decrease from 90% to 10% of the peak value.
7. The center of each element is aligned to ±.010" along the length and ±.005" across the width.
8. Emitter terminal side of phototransistor (sensor array) or anode terminal side of diode (source array) defined by white dot.

FPA710 • FPA710A

12-ELEMENT PHOTOTRANSISTOR CARD READER ARRAY

OPTOELECTRONICS PRODUCT GROUP

GENERAL DESCRIPTION — The FPA710 and FPA710A are 12-element npn Planar* phototransistor arrays having exceptionally stable characteristics and high illumination sensitivity. Each transistor is electrically isolated and mounted on 250 mil centers. The case is a plastic compound with transparent resin encapsulation which exhibits stable characteristics under high humidity conditions.

- **HIGH ILLUMINATION SENSITIVITY**
- **ESPECIALLY DESIGNED FOR PUNCHED OR MARKED CARD READING AND OPTICAL ENCODER APPLICATIONS**

ABSOLUTE MAXIMUM RATINGS

Maximum Temperatures and Humidity

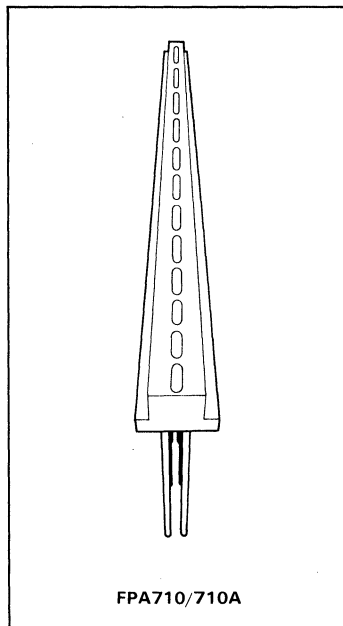
Storage Temperature	-40°C to +100°C
Operating Temperature	-40°C to +85°C
Pin Temperature (Soldering, 10 s)	260°C
Relative Humidity at 65°C	98 %

Maximum Power Dissipation per Cell

Total Dissipation at $T_C = 25^\circ\text{C}$	200 mW
Derate Linearly from 25°C	3.33 mW/°C
Total Dissipation at $T_A = 25^\circ\text{C}$	133 mW
Derate Linearly from 25°C	2.22 mW/°C

Maximum Voltages and Currents (Note 1)

$V_{CEO(sus)}$	Collector to Emitter Sustaining Voltage	20 V
I_C	Collector Current	25 mA

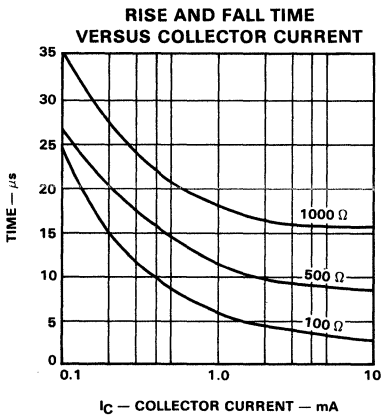
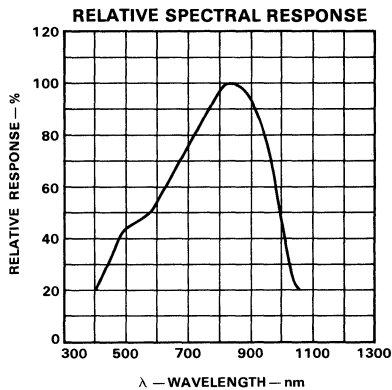
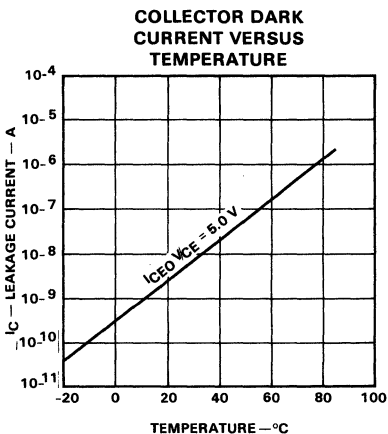
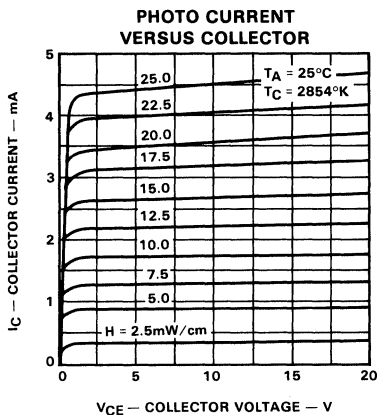
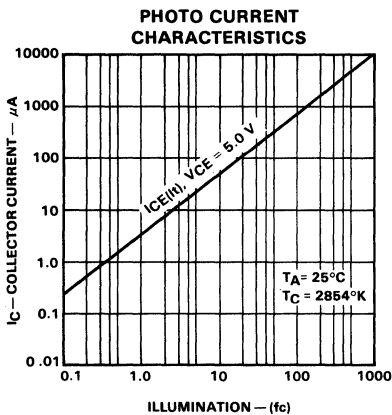


ELECTRICAL CHARACTERISTICS: $T_A = 25^\circ\text{C}$

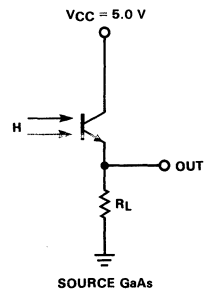
SYMBOL	CHARACTERISTIC	FPA710			FPA710A			UNITS	TEST CONDITIONS
		MIN	TYP	MAX	MIN	TYP	MAX		
$V_{CEO(sus)}$	Collector-Emitter Sustaining Voltage (Note 2)	20	35		20	35		V	$I_C = 1.0 \text{ mA}$ (pulsed)
BV_{ECO}	Emitter-Collector Breakdown Voltage (Note 2)		7.0			7.0		V	$I_{EC} = 100 \mu\text{A}$
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage		0.16	0.33		0.16	0.33	V	$I_C = 500 \mu\text{A}$, $H = 20 \text{ mW/cm}^2$
I_{CEO}	Collector Dark Current (Note 2)		4.0	100		4.0	100	nA	$V_{CE} = 5.0 \text{ V}$
$I_{CE(it)}$	Photo Current, Tungsten Source (Note 3)	200	750		200	750		μA	$V_{CE} = 5.0 \text{ V}$, $H = 5 \text{ mW/cm}^2$
$I_{CE(it)}$	Photo Current, Tungsten Source (Note 3)		1.75			1.75		mA	$V_{CE} = 5.0 \text{ V}$, $H = 10 \text{ mW/cm}^2$
$I_{CE(it)}$	Photo Current, GaAs Source (Note 4)		2.25			2.25		mA	$V_{CE} = 5.0 \text{ V}$, $H = 5 \text{ mW/cm}^2$
t_r	Light Current Rise Time (Note 6)		4.0			4.0		μs	GaAs, $I_C = 2.0 \text{ mA}$,
t_f	Light Current Fall Time (Note 6)		4.0			4.0		μs	$R_L = 100\Omega$, $V_{CC} = 5.0 \text{ V}$
S_{min}/S_{max}	Matching Factor (Notes 3 and 5)	0.5	0.65	1.0	0.75	0.85	1.0		$V_{CE} = 5.0 \text{ V}$, $H = 5 \text{ mW/cm}^2$

*Planar is a patented Fairchild process.

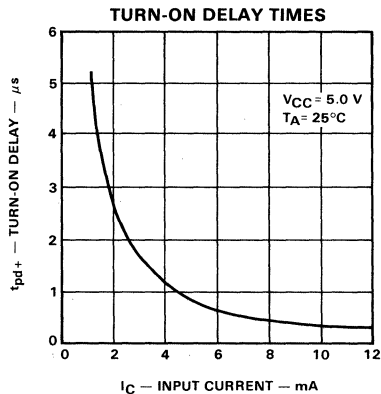
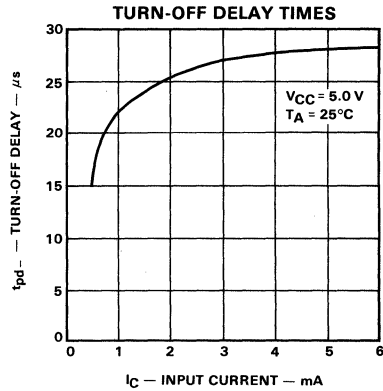
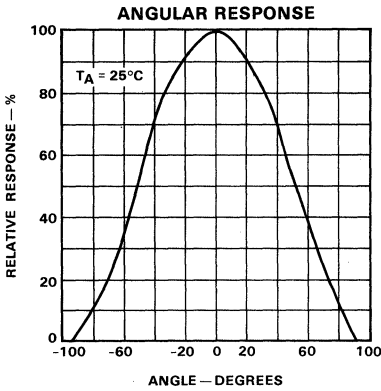
TYPICAL CHARACTERISTIC CURVES



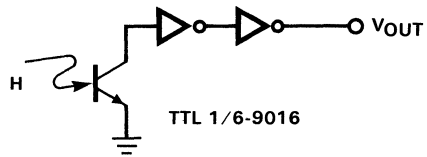
SWITCHING CIRCUIT FOR RISE AND FALL TIMES



TYPICAL CHARACTERISTIC CURVES (Cont'd)



CIRCUIT FOR TURN-ON AND TURN-OFF DELAY



NOTES:

1. These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operation.
2. Measured with radiation flux intensity of less than $.1 \mu\text{W}/\text{cm}^2$ over the spectrum from 0.1 micron to 1.5 microns.
3. Measured at noted irradiance as emitted from a tungsten lamp at a color temperature of 2854°K . The effective photosensitive area is (0.8 mm^2) .
Illuminance (in lumens/ ft^2) = irradiance H (in mW/cm^2) x 20 at a color temperature of 2854°K .
4. Measured at an irradiance of $5.0 \text{ mW}/\text{cm}^2$ as emitted from a gallium arsenide diode.
5. Matching factor is the ratio of minimum sensitivity to maximum sensitivity of any two cells.
6. Rise time is defined as the time required for I_{CE} to rise from 10% to 90% of the peak value. Fall time is defined as the time required for I_{CE} to decrease from 90% to 10% of the peak value.
7. The center of each element is aligned to $\pm 0.010''$ along the length and $\pm 0.005''$ across the width.
8. Leads alternate from emitter to collector (sensor) or anode to cathode (source), beginning from this end of the package.

FPA720 • FPA720A

10-ELEMENT PHOTOTRANSISTOR CARD READER ARRAY

OPTOELECTRONICS PRODUCT GROUP

GENERAL DESCRIPTION — The FPA720 and FPA720A are 9-element npn Planar* phototransistor arrays having exceptionally stable characteristics and high illumination sensitivity. Each transistor is electrically isolated and mounted on 100 mil centers. The case is a plastic compound with transparent resin encapsulation which exhibits stable characteristics under high humidity conditions.

- **HIGH ILLUMINATION SENSITIVITY**
- **ESPECIALLY DESIGNED FOR PUNCHED OR MARKED CARD READING AND OPTICAL ENCODER APPLICATIONS**

ABSOLUTE MAXIMUM RATINGS

Maximum Temperatures and Humidity

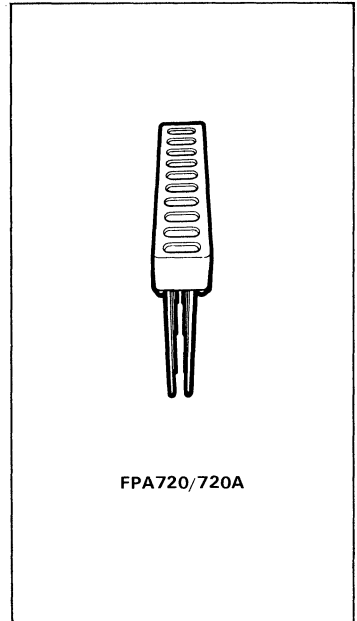
Storage Temperature	-40°C to +100°C
Operating Temperature	-40°C to +85°C
Pin Temperature (Soldering, 10 s)	260°C
Relative Humidity at 65°C	98%

Maximum Power Dissipation per Cell

Total Dissipation at $T_C = 25^\circ\text{C}$	200 mW
Derate Linearly from 25°C	3.33 mW/°C
Total Dissipation at $T_A = 25^\circ\text{C}$	133 mW
Derate Linearly from 25°C	2.22 mW/°C

Maximum Voltages and Currents (Note 1)

$V_{CEO(sus)}$ Collector to Emitter Sustaining Voltage	20 V
I_C Collector Current	25 mA



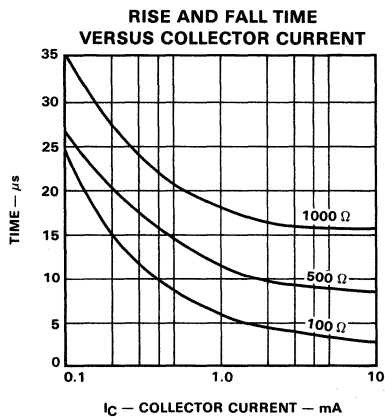
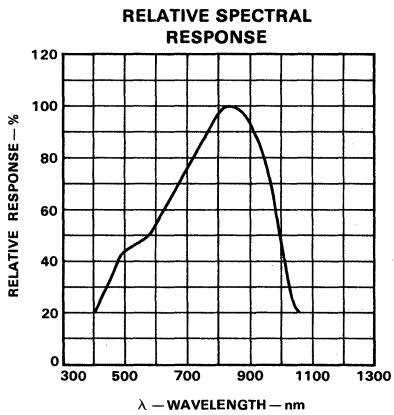
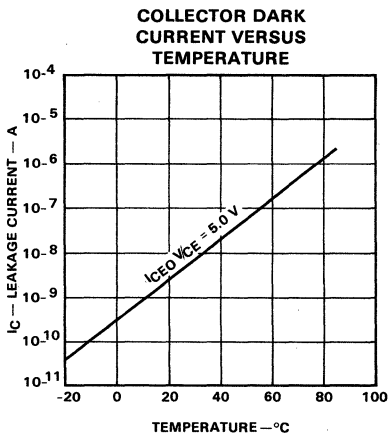
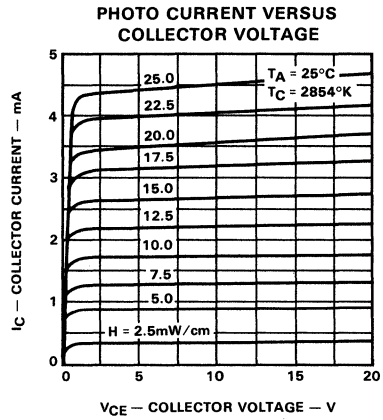
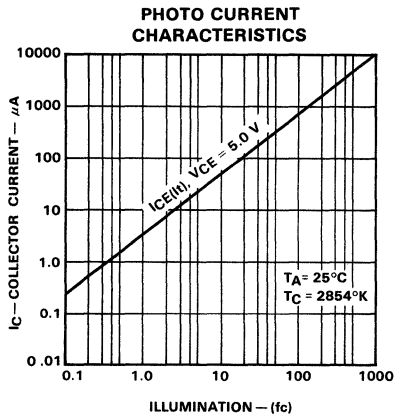
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ELECTRICAL CHARACTERISTICS: $T_A = 25^\circ\text{C}$

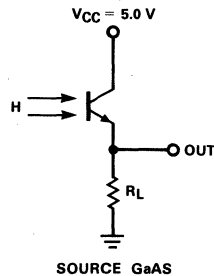
SYMBOL	CHARACTERISTIC	FPA720			FPA720A			UNITS	TEST CONDITIONS
		MIN	TYP	MAX	MIN	TYP	MAX		
$V_{CEO(sus)}$	Collector-Emitter Sustaining Voltage (Note 7)	20	35		20	35		V	$I_C = 1.0 \text{ mA (pulsed)}$
BV_{ECO}	Emitter-Collector Breakdown Voltage (Note 7)		7.0			7.0		V	$I_{EC} = 100 \mu\text{A}$
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage		0.16	0.33		0.16	0.33	V	$I_C = 500 \mu\text{A}, H = 20 \text{ mW/cm}^2$
I_{CEO}	Collector Dark Current/Cell (Note 2)		4.0	100		4.0	100	nA	$V_{CE} = 5.0 \text{ V}$
$I_{CE(tt)}$	Photo Current, Tungsten Source (Note 3)	200	750		200	750		μA	$V_{CE} = 5.0 \text{ V}, H = 5 \text{ mW/cm}^2$
$I_{CE(t)}$	Photo Current, Tungsten Source (Note 3)		1.75			1.75		mA	$V_{CE} = 5.0 \text{ V}, H = 10 \text{ mW/cm}^2$
$I_{CE(lt)}$	Photo Current, GaAs Source (Note 4)		2.25			2.25		mA	$V_{CE} = 5.0 \text{ V}, H = 5 \text{ mW/cm}^2$
t_r	Light Current Rise Time (Note 6)		4.0			4.0		μs	GaAs, $I_C = 2.0 \text{ mA}$,
t_f	Light Current Fall Time (Note 6)		4.0			4.0		μs	$R_L = 100\Omega, V_{CC} = 5.0 \text{ V}$
S_{min}/S_{max}	Matching Factor (Notes 3 and 5)	0.5	0.65	1.0	0.75	0.85	1.0		$V_{CE} = 5.0 \text{ V}, H = 5 \text{ mW/cm}^2$

*Planar is a patented Fairchild process.

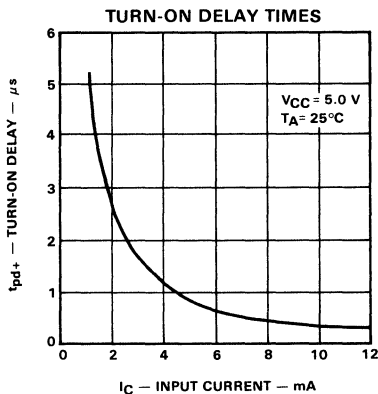
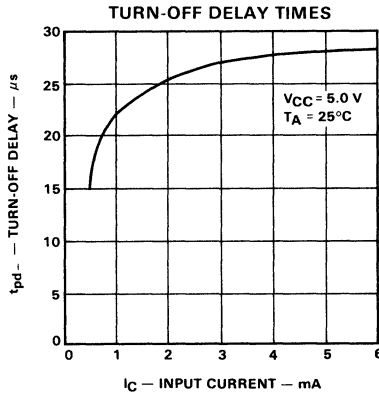
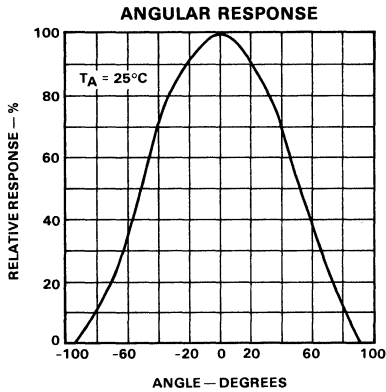
TYPICAL CHARACTERISTIC CURVES



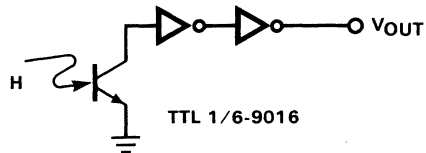
SWITCHING CIRCUIT FOR RISE AND FALL TIMES



TYPICAL CHARACTERISTIC CURVES (Cont'd)



CIRCUIT FOR TURN-ON AND TURN-OFF DELAY



NOTES:

- These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operation.
- Measured with radiation flux intensity of less than $.1 \mu\text{W}/\text{cm}^2$ over the spectrum from 0.1 micron to 1.5 microns.
- Measured at noted irradiance as emitted from a tungsten lamp at a color temperature of 2854°K . The effective photosensitive area is (0.8 mm^2) .
Illuminance (in lumens/ ft^2) = irradiance H (in mW/cm^2) x 20 at a color temperature of 2854°K .
- Measured at an irradiance of $5.0 \text{ mW}/\text{cm}^2$ as emitted from a gallium arsenide diode.
- Matching factor is the ratio of minimum sensitivity to maximum sensitivity of any two cells.
- Rise time is defined as the time required for I_{CE} to rise from 10% to 90% of the peak value. Fall time is defined as the time required for I_{CE} to decrease from 90% to 10% of the peak value.
- Rating refers to a high current point where collector to emitter voltage is lowest.
- The center of each element is aligned to $\pm 0.10^\circ$ along the length and $\pm 0.005^\circ$ across the width.
- Emitter terminal side of phototransistor (sensor array) or anode terminal side of diode (source array) defined by white dot.

FPE100

GaAs INFRARED EMITTER OPTOELECTRONICS PRODUCT GROUP

GENERAL DESCRIPTION - The FPE100 is a gallium arsenide infrared light emitting diode. When forward-biased, it emits an intense, narrow band of radiation peaking at approximately 900 nm non-visible. The device is packaged on a modified TO-46 header with a clear plastic lens dome.

This solid state lamp is ideally suited for use in conjunction with silicon photosensors, since their spectral peaks are closely matched. The FPE100 employs a Planar* process and is especially designed for high reliability and long life.

- **HIGH RELIABILITY**
- **LONG LIFE**
- **IDEALLY SUITED FOR USE IN CONJUNCTION WITH SILICON PHOTOSENSORS**

ABSOLUTE MAXIMUM RATINGS

Maximum Temperatures and Humidity

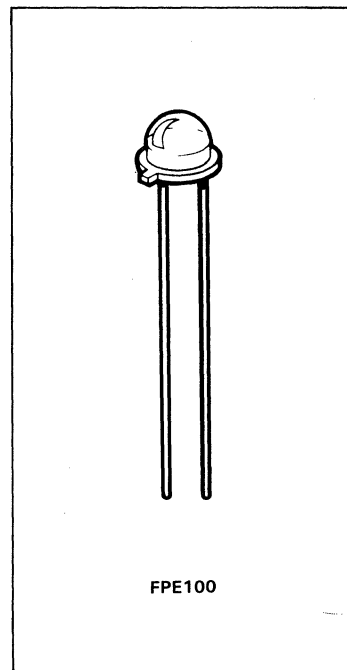
Storage Temperature	-10°C to +100°C
Operating Junction Temperature	-10°C to +100°C
Pin Temperature (Soldering, 10 s)	260°C
Relative Humidity at 65°C	98 %

Maximum Power Dissipation

Total Dissipation at $T_A = 25^\circ\text{C}$	150 mW
Derate Linearly from 25°C	2 mW/°C

Maximum Voltages and Currents

V_R Reverse Voltage	3.0 V
I_F Forward dc Current	100 mA



FPE100

ELECTRICAL CHARACTERISTICS: $T_A = 25^\circ\text{C}$

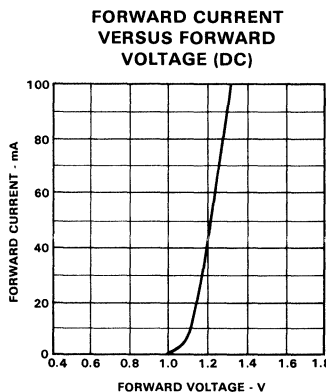
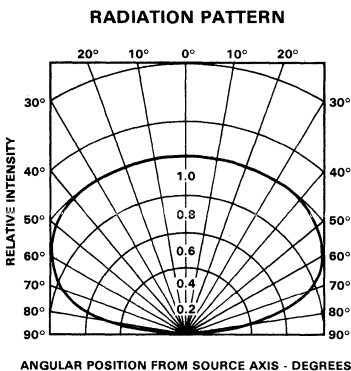
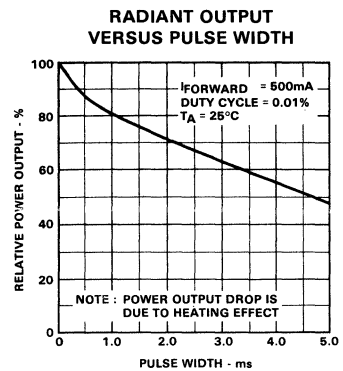
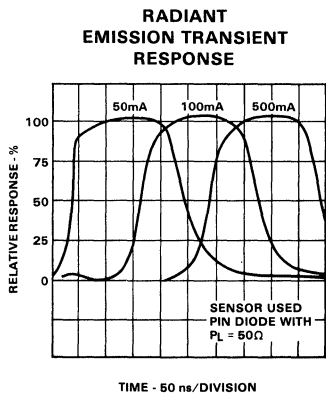
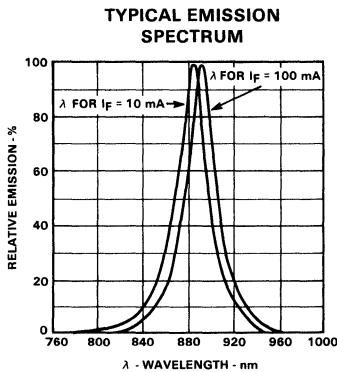
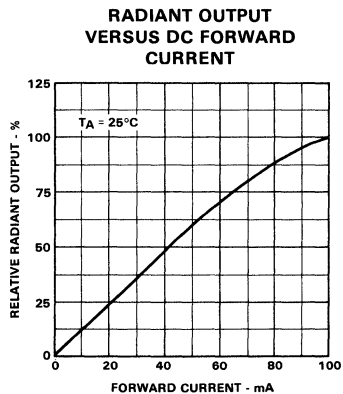
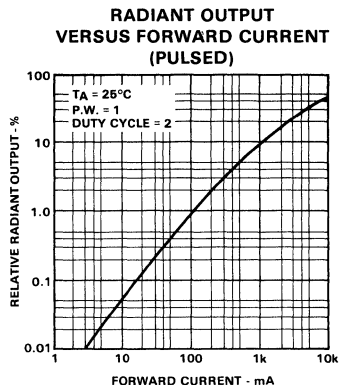
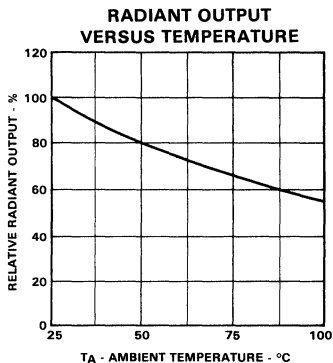
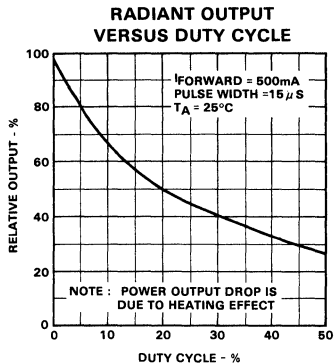
SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS
V_F	Forward Voltage At $I_F = 100\text{ mA}$		1.35	1.9	V
B_{VR}	Reverse Breakdown Voltage ($I_R = 100\ \mu\text{A}$)	3.0	6.0		V

OPTO ELECTRONIC CHARACTERISTICS @ $I_F = 100\text{ mA}$: $T_A = 25^\circ\text{C}$

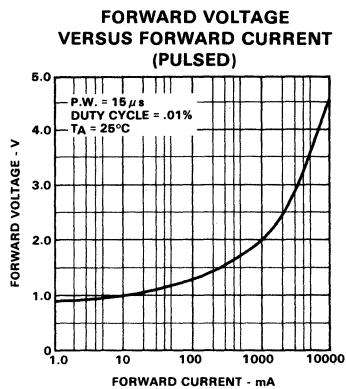
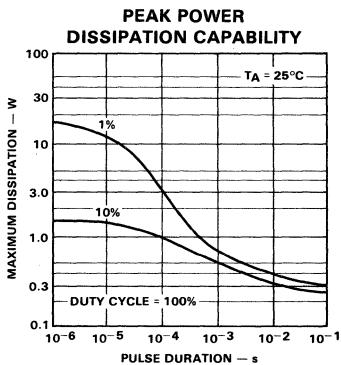
SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS
I_O	Axial Intensity	0.1	0.3		mW/sr
P_O	Infrared Total Power Output		1.2		mW
λ	Quantum Efficiency		1.1		%
$\Delta\lambda$	Spectral Bandwidth		50		nm
$\theta_{1/2}$	Beam angle at 50% Axial Intensity		75		degrees
$\Delta P_O/\Delta T$	Temperature Dependence of Power Output		-0.8		%/°C
t_r	Emission Rise Time ($I_F = 50\text{ mA}$ 10-90%)		50		ns
t_f	Emission Fall Time ($I_F = 50\text{ mA}$ 10-90%)		60		ns

*Planar is a patented Fairchild process.

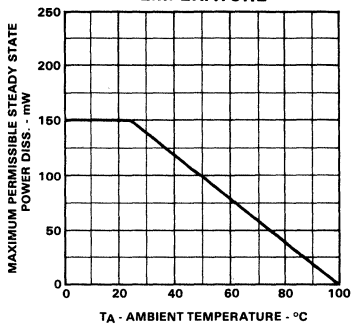
TYPICAL CHARACTERISTIC CURVES



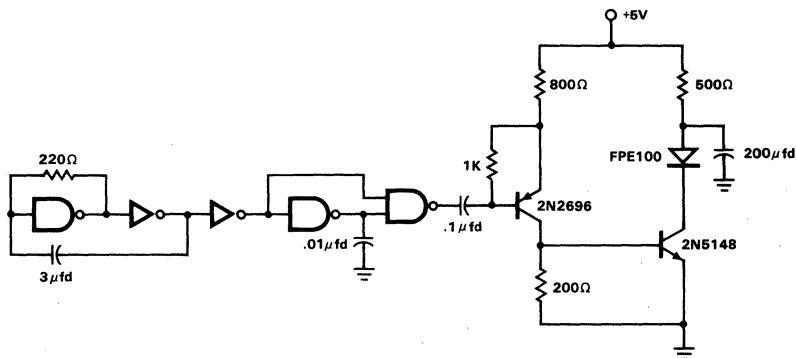
TYPICAL CHARACTERISTIC CURVES (Cont'd)



POWER DISSIPATION VERSUS AMBIENT TEMPERATURE



2 AMP LIGHT PULSER



A light pulser with low voltage low average current requirement
 Peak current through 2 A
 Pulse width = 5 μs
 Period between pulses 20 ms
 Average current drain 20 mA

FPE106

GaAs INFRARED EMITTER OPTOELECTRONICS PRODUCT GROUP

GENERAL DESCRIPTION – The FPE106 is a gallium arsenide infrared light emitting diode in a miniature ceramic case having exceptionally stable characteristics. This device is used in applications where space is limited such as custom tape and card readers.

- EXCEPTIONALLY STABLE CHARACTERISTICS
- MINITATURE – 85 x 185 x 95 MILS
- SUITABLE FOR PC CARD MOUNTING

ABSOLUTE MAXIMUM RATINGS

Maximum Temperature and Humidity

Storage Temperature	-40°C to + 100°C
Operating Temperature	-40°C to +85°C
Pin Temperature (Soldering, 10 s)	260°C
Relative Humidity at 65°C	98%

Maximum Power Dissipation

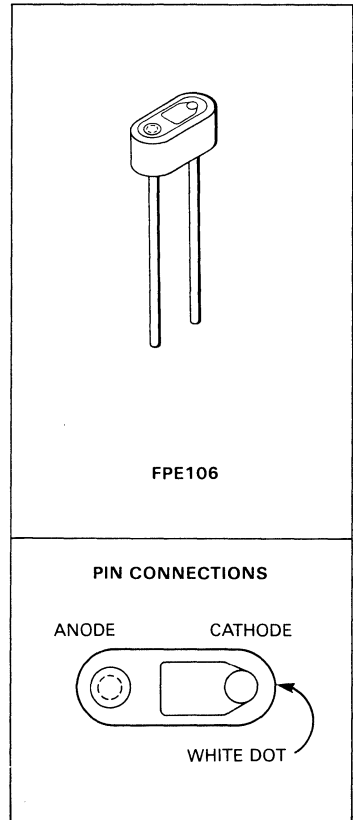
Total Dissipation at $T_A = 25^\circ\text{C}$	150 mW
Derate Linearly from 25°C	2.5 mW/°C

Maximum Voltages and Currents

V_R Reverse Voltage	3.0 V
I_F Forward Current	100 mA

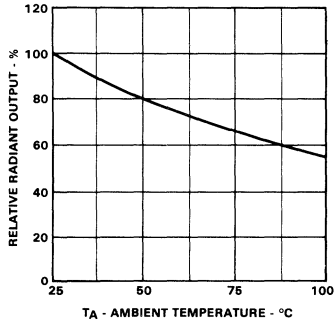
ELECTRICAL CHARACTERISTICS: $T_A = 25^\circ\text{C}$

SYMBOL	CHARACTERISTICS	MIN	TYP	MAX	UNITS	TEST CONDITIONS
V_F	Forward Voltage		1.3	1.5	V	$I_F = 50 \text{ mA}$
V_R	Reverse Voltage	3.0	6.0		V	$I_R = 100 \mu\text{A}$
I_0	Axial Intensity	35	200		$\mu\text{W}/\text{sr}$	$I_F = 50 \text{ mA}$
$\theta_{1/2}$	Beam Angle at Half Power	3.5	80		degrees	
λ_{pk}	Peak Spectral Wavelength		890		nm	

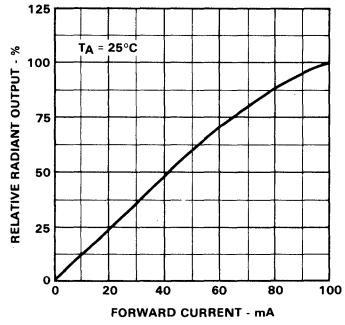


TYPICAL CHARACTERISTIC CURVES

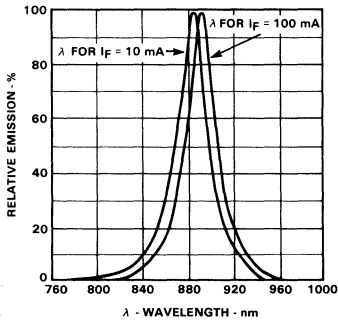
RADIANT OUTPUT
VERSUS TEMPERATURE



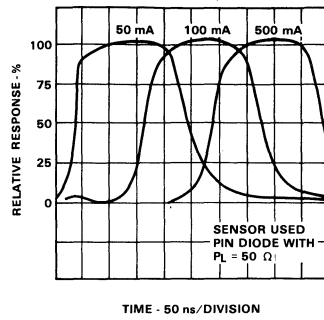
RADIANT OUTPUT
VERSUS DC FORWARD
CURRENT



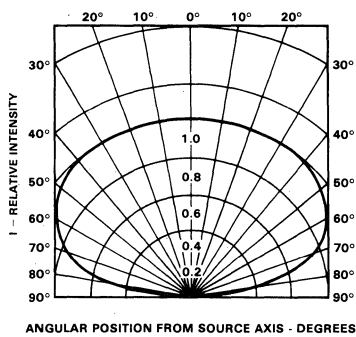
EMISSION SPECTRUM



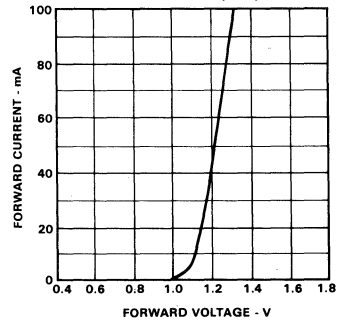
RADIANT
EMISSION TRANSIENT
RESPONSE



RADIATION PATTERN



FORWARD CURRENT
VERSUS FORWARD
VOLTAGE (DC)



FPE500 • FPE510

GaAs INFRARED EMITTERS

OPTOELECTRONICS PRODUCT GROUP

GENERAL DESCRIPTION – The FPE500/FPE510 are gallium arsenide infrared emitting diodes. When forward-biased, they emit an intense, narrow band of radiation peaking at approximately 900 nm (non-visible). The devices are packaged in TO-18 style hermetically sealed packages with a glass lens.

These solid state lamps are ideally suited for use in conjunction with silicon photosensors, since their spectral peaks are closely matched. The FPE500/FPE510 use a Planar* process and are especially designed for high reliability and long life.

- HIGH RELIABILITY
- LONG LIFE
- IDEALLY SUITED FOR USE IN CONJUNCTION WITH SILICON PHOTODIODES
- APPLICATIONS INCLUDE: PUNCHED CARD AND PAPER TAPE READING, OPTICAL SHAFT ENCODERS, CHOPPERS, HIGH-SPEED HIGH VOLTAGE ISOLATION SWITCHES AND HIGH SPEED OPTO-ELECTRONIC SIGNAL LINKS
- HERMETIC METAL PACKAGE FOR STABILITY AND RELIABILITY

ABSOLUTE MAXIMUM RATINGS

Maximum Temperatures and Humidity

Storage Temperature	-65°C to +200°C
Operating Temperature	-65°C to +125°C
Pin Temperature (Soldering, 5 s)	260°C
Relative Humidity at 65°C	85%

Maximum Power Distribution

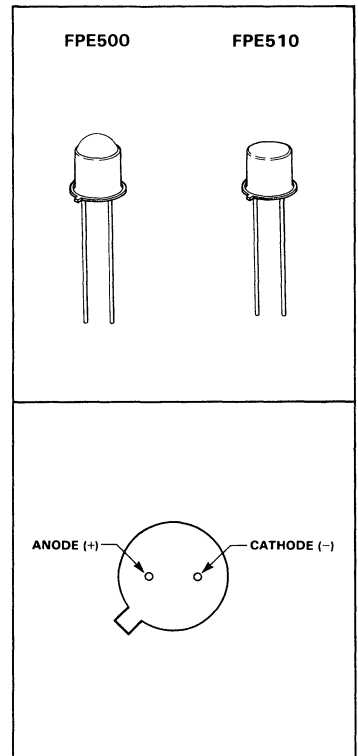
P_D Power Dissipation	250 mW
Derate Linearly from 25°C	2.5 mW/°C

Maximum Voltages and Currents

V_R Reverse Voltage	3.0 V
I_F Forward Current	150 mA

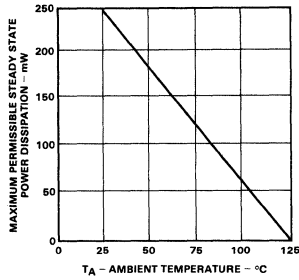
ELECTRICAL CHARACTERISTICS: $T_A = 25^\circ\text{C}$, $I_F = 100\text{ mA}$

SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	TEST CONDITIONS
V_F	Forward Voltage		1.35	1.7	V	
BV_R	Reverse Breakdown Voltage	3.0	6.0		V	$I_R = 100\ \mu\text{A}$
I_O	Axial Intensity				mW/Sr	
	FPE500	3.0	10			
	FPE510	0.3	1.0			
P_O	Infrared Total Power Output		1.2		mW	
$\Delta P_O/\Delta T$	Temperature Dependence of Power, Output		-0.8		%/°C	
BW	Spectral Bandwidth		50		nm	
$\theta_{1/2}$	Viewing Angle to Half Intensity				degrees	
	FPE500		9.0			
	FPE510		30			
t_r, t_f	Emission Rise and Fall Time		10		ns	$I_F = 50\text{ mA}$, 10-90%

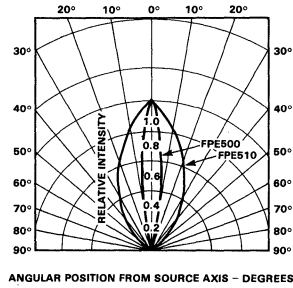


TYPICAL CHARACTERISTIC CURVES

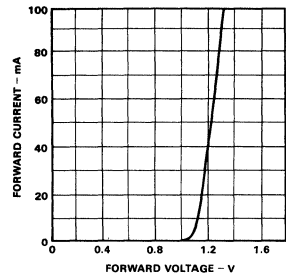
POWER DISSIPATION VERSUS AMBIENT TEMPERATURE



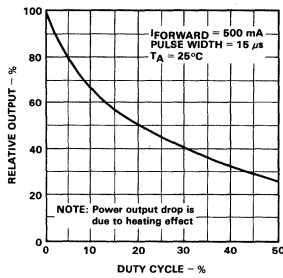
RADIATION PATTERN



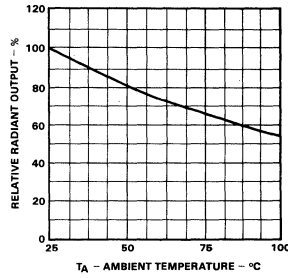
FORWARD CURRENT VERSUS FORWARD VOLTAGE (DC)



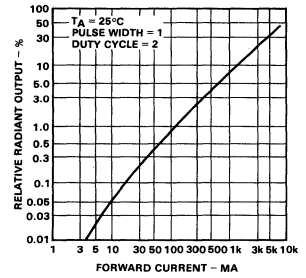
RADIANT OUTPUT VERSUS DUTY CYCLE



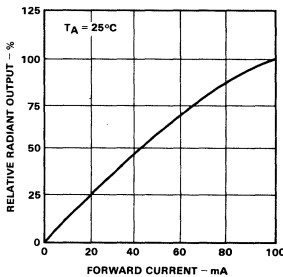
RADIANT OUTPUT VERSUS TEMPERATURE



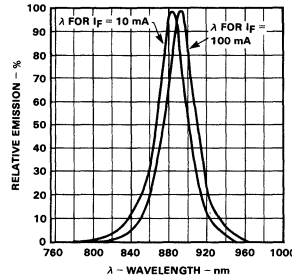
RADIANT OUTPUT VERSUS FORWARD CURRENT (PULSED)



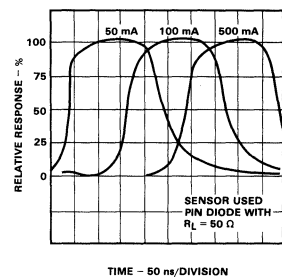
RADIANT OUTPUT VERSUS DC FORWARD CURRENT



TYPICAL EMISSION SPECTRUM



RADIANT EMISSION TRANSIENT RESPONSE



FPE520 • FPE530

GaAs INFRARED EMITTERS

OPTOELECTRONICS PRODUCT GROUP

GENERAL DESCRIPTION – The FPE520 and FPE530 are gallium arsenide infrared emitting diodes. When forward-biased, they emit an intense, narrow band of radiation peaking at approximately 940 nm (non-visible). The devices are packaged in TO-18 style hermetically sealed packages with a glass lens.

These solid state lamps are ideally suited for use in conjunction with silicon photosensors, since their spectral peaks are closely matched.

- HIGH RELIABILITY
- LONG LIFE
- IDEALLY SUITED FOR USE IN CONJUNCTION WITH SILICON PHOTODIODES
- APPLICATIONS: PUNCHED CARD AND PAPER TAPE READING, OPTICAL SHAFT ENCODERS, CHOPPERS, HIGH-SPEED HIGH VOLTAGE ISOLATION SWITCHES AND HIGH-SPEED OPTOELECTRONIC SIGNAL LINKS
- HERMETIC METAL PACKAGE FOR STABILITY AND RELIABILITY

ABSOLUTE MAXIMUM RATINGS

Maximum Temperatures

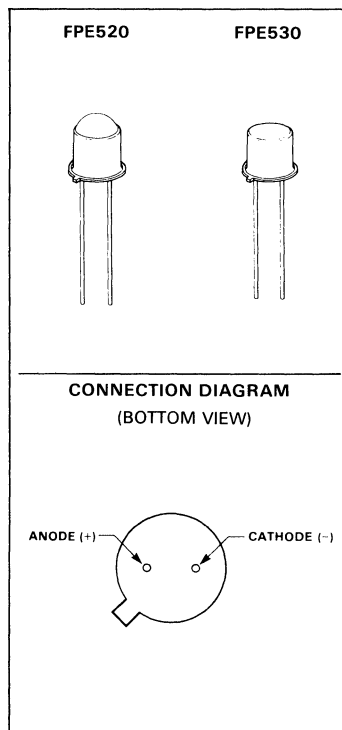
Storage Temperature	–65°C to +200°C
Operating Temperature	–65°C to +150°C
Pin Temperature (Soldering, 5 s)	260°C
Relative Humidity at 85°C	85%

Maximum Power Dissipation

Total Dissipation at $T_A = 25^\circ\text{C}$	250 mW
Derate Linearly from 25°C	2.0 mW/°C

Maximum Voltages and Currents

V_R	Reverse Voltage	3.0 V
I_F	Forward Current	150 mA

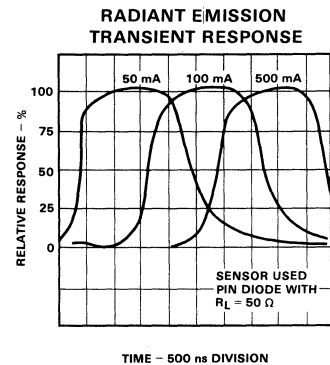
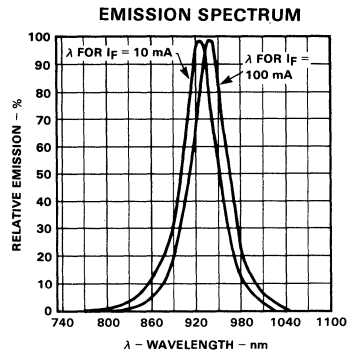
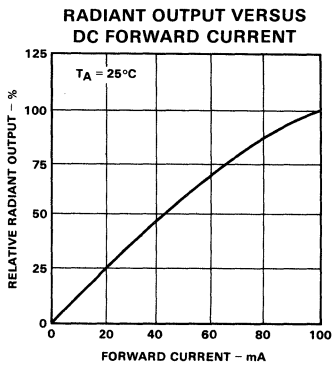
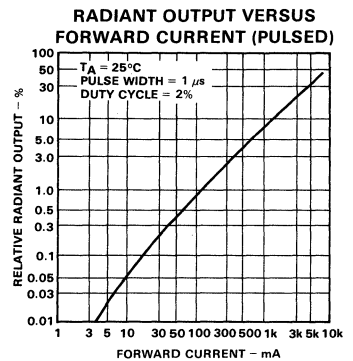
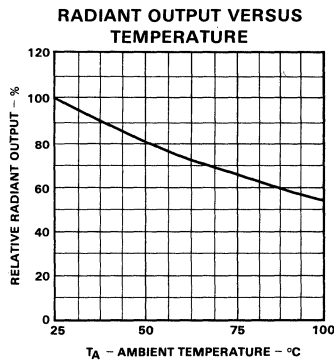
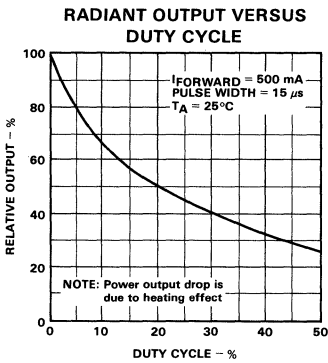
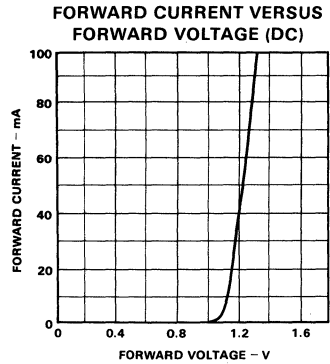
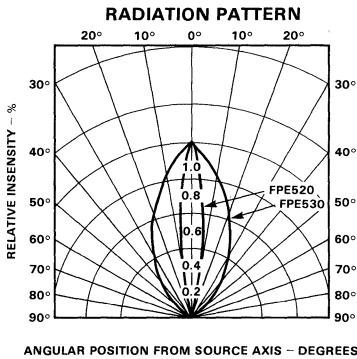
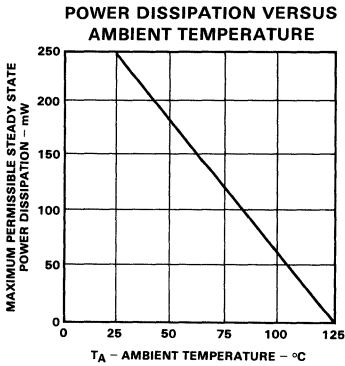


5

ELECTRICAL CHARACTERISTICS: $T_A = 25^\circ\text{C}$, $I_F = 100\text{ mA}$, unless otherwise specified

SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	TEST CONDITIONS
V_F	Forward Voltage		1.35	1.7	V	$I_R = 100\ \mu\text{A}$
V_R	Reverse Voltage	3.0	6.0		V	
I_O	Axial Intensity					
	FPE520	10	50		mW/sr	
	FPE530	1.0	5.0		mW/sr	
P_O	Infrared Total Power Output		5.0		mW	
$\Delta P_O / \Delta T$	Temperature Dependence of Power Output		–0.8		%/°C	
λ_{pk}	Peak Spectral Wavelength		940		nm	
BW	Spectral Bandwidth		50		nm	
$\theta_{1/2}$	Viewing Angle to Half Intensity					
	FPE520		9.0		degrees	
	FPE530		30		degrees	
t_r, t_f	Emission Rise and Fall Time		500		ns	$I_F = 50\text{ mA}$, 10–90%

TYPICAL CHARACTERISTIC CURVES



FPT100/A/B • FPT110/A/B

GENERAL PURPOSE SILICON PLANAR* PHOTOTRANSISTOR

OPTOELECTRONICS PRODUCT GROUP

GENERAL DESCRIPTION – The FPT100 and FPT110 are 3-terminal npn Planar* phototransistors which have exceptionally stable characteristics and high illumination sensitivity. The availability of the base pin gives wide latitude for flexible circuit design. The case is a special plastic compound with transparent resin encapsulation which exhibits stable characteristics under high humidity conditions. The controlled sensitivities offered in the A and B versions gives the circuit designer increased flexibility.

- EXCEPTIONALLY STABLE CHARACTERISTICS
- CONTROLLED SENSITIVITIES

ABSOLUTE MAXIMUM RATINGS

Maximum Temperatures/Humidity

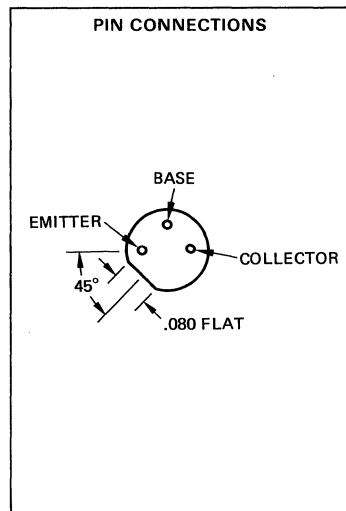
Storage Temperature	–55°C to +100°C
Operating Temperature	–55°C to +85°C
Pin Temperature (Soldering, 5 s)	260°C
Relative Humidity at 65°C	98%

Maximum Power Dissipation (Notes 1 and 2)

Total Dissipation at $T_C = 25^\circ\text{C}$	200 mW
Total Dissipation at $T_A = 25^\circ\text{C}$	100 mW

Maximum Voltages and Current (Note 5)

V_{CB0} Collector to Base Voltage	50 V
V_{CEO} Collector to Emitter Sustaining Voltage (Note 3)	30 V
I_C Collector Current	25 mA



5

ELECTRICAL CHARACTERISTICS: $T_A = 25^\circ\text{C}$

SYMBOL	CHARACTERISTIC	FPT100/A/B			FPT110/A/B			UNITS	TEST CONDITIONS
		MIN	TYP	MAX	MIN	TYP	MAX		
I_{CBO}	Collector Dark Current		0.25	25		0.25	25	nA	$V_{CB} = 10\text{ V}$ (Note 5)
I_{CBO}	Collector Dark Current		0.025	0.5		0.025	0.5	μA	$V_{CB} = 10\text{ V}$, $T_A = 65^\circ\text{C}$ (Note 5)
I_{CEO}	Collector Dark Current		2.0	100		2.0	100	nA	$V_{CE} = 5.0\text{ V}$ (Note 5)
R_{CB}	Responsivity (Tungsten)	0.6	1.6		0.6	1.0		$\mu\text{A}/\text{mW}/\text{cm}^2$	$V_{CB} = 10\text{ V}$ (Notes 3 and 8)
R_{CB}	Responsivity (GaAs)	1.8	4.8		1.8	3.0		$\mu\text{A}/\text{mW}/\text{cm}^2$	$V_{CB} = 10\text{ V}$ (Notes 4 and 8)
$I_{CE(it)}$	Photo Current (Tungsten)	0.2	1.4		0.2	.88		mA	$V_{CE} = 5.0\text{ V}$ $H = 5.0\text{ mW}/\text{cm}^2$ (Notes 3 and 7)
$I_{CE(it)}$	Photo Current (GaAs)	0.6	4.2		0.6	2.7		mA	$V_{CE} = 5.0\text{ V}$ $H = 5.0\text{ mW}/\text{cm}^2$ (Notes 4 and 7)
t_r	Light Current Rise Time		2.8			2.8		μs	(Note 6)
t_f	Light Current Fall Time		2.8			2.8		μs	(Note 6)
$V_{CE(sat)}$	Collector to Emitter Saturation Voltage		0.16	0.3		0.16	0.33	V	$I_C = 500\ \mu\text{A}$ $H = 20\text{ mW}/\text{cm}^2$
BV_{CBO}	Collector to Base Breakdown Voltage	50	120		50	120		V	$I_C = 100\ \mu\text{A}$ (Note 5)
$V_{CEO(sus)}$	Collector to Emitter Sustaining Voltage	30	50		30	50		V	$I_C = 1.0\text{ mA}$ (pulsed) (Note 5)
BV_{ECO}	Emitter to Collector Breakdown		7.0			7.0		V	$I_E = 100\ \mu\text{A}$ (Note 5)

*Planar is a patented Fairchild process.

FAIRCHILD • FPT100/A/B • FPT110/A/B

ELECTRICAL CHARACTERISTICS: $T_A = 25^\circ\text{C}$ unless otherwise noted (Cont'd)

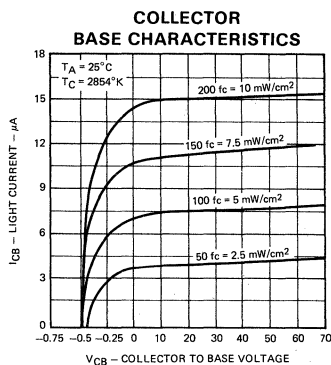
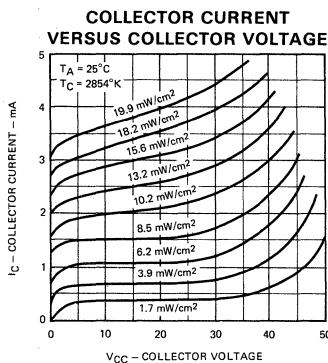
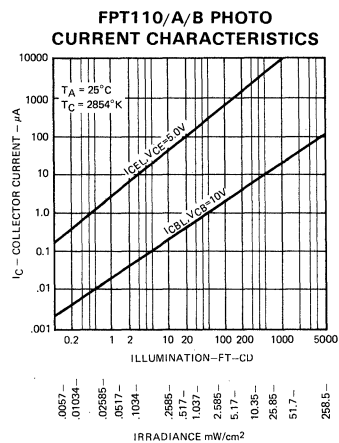
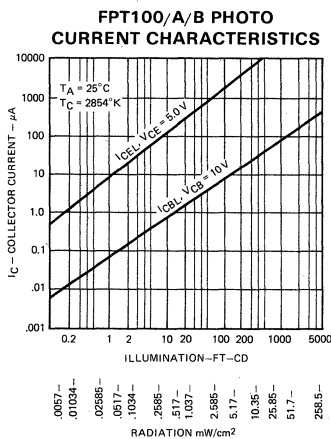
The following values affect the A and B versions only:

SYMBOL	CHARACTERISTIC	MIN	MAX	MIN	MAX	UNITS	TEST CONDITIONS
$I_{CE(it)*}$	Photo Current (Tungsten Source) FPT100A	1.0	3.0			mA	$V_{CE} = 5.0\text{ V}$ (Note 3) $H = 5.0\text{ mW/cm}^2$
	FPT110A			0.6	1.8	mA	
$I_{CE(it)}$	Photo Current (Tungsten Source) FPT100B	1.3	2.6			mA	$V_{CE} = 5.0\text{ V}$ (Note 3) $H = 5.0\text{ mW/cm}^2$
	FPT110B			0.8	1.6	mA	

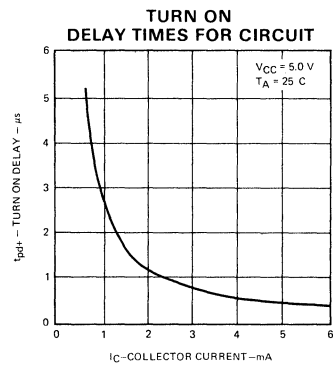
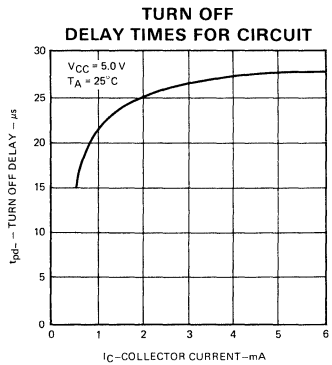
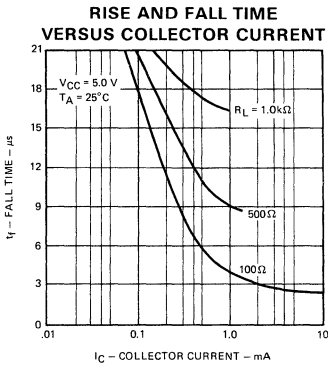
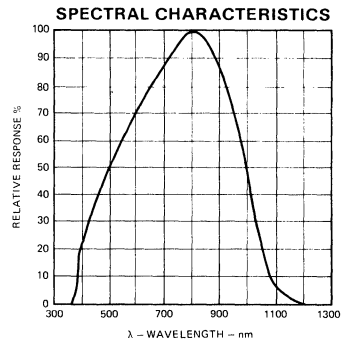
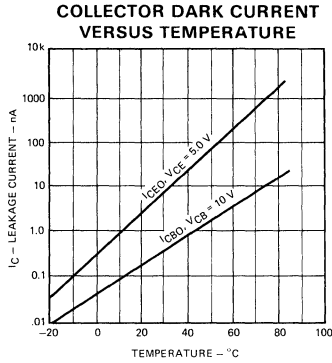
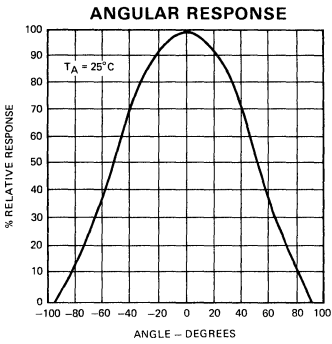
NOTES:

- These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.
- These ratings give a maximum junction temperature of 85°C and junction to case thermal resistance of 300°C/W (derating factor of $3.33\text{ mW/}^\circ\text{C}$), and a junction to ambient thermal resistance of 600°C/W (derating factor of $1.67\text{ mW/}^\circ\text{C}$).
- Measured at noted irradiance as emitted from a tungsten filament lamp at a color temperature of 2854°K . The effective photosensitive area is typically 1.25 mm^2 (FPT100A/B) and 0.78 mm^2 (FPT110A/B).
- These are values obtained at noted irradiance as emitted from a GaAs source at 900 nm .
- Measured with radiation flux intensity of less than $.1\text{ }\mu\text{W/cm}^2$ over the spectrum from 100 to 1500 nm .
- Rise time is defined as the time required for I_{CE} to rise from 10% of peak value. Fall time is defined as the time required for I_{CE} to decrease from 90% to 10% of peak value. Test conditions are: $I_{CE} = 4.0\text{ mA}$, $V_{CE} = 5.0\text{ V}$, $R_L = 100\text{ }\Omega$, GaAs Source.
- No electrical connection to base lead.
- No electrical connection to emitter lead.

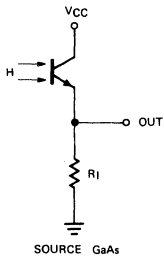
TYPICAL ELECTRICAL CHARACTERISTIC CURVES



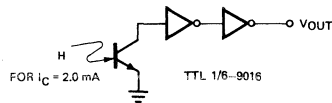
TYPICAL ELECTRICAL CHARACTERISTIC CURVES (Cont'd)



SWITCHING CIRCUIT FOR RISE AND FALL TIMES



CIRCUIT FOR TURN ON AND TURN OFF DATA



FPT101

HERMETIC COAXIAL SILICON PHOTOTRANSISTOR

OPTOELECTRONICS PRODUCT GROUP

GENERAL DESCRIPTION – The FPT101 is a miniature phototransistor in a hermetic welded case. A large photosensitive base combined with a flat window affords exceptional sensitivity without the need for critical alignment. In tape and card reader applications, the flat window permits flush mounting in the wear-plate thereby minimizing cross-talk. The spectral response, extending from 400 to 1100 nm, is compatible with daylight, tungsten and gallium arsenide sources.

- **PRECISION OPTICAL ALIGNMENT**
- **MINIATURE—80 MILS IN DIAMETER**
- **SUITABLE FOR PC BOARD MOUNTING**
- **APPLICATIONS INCLUDE: TAPE AND CARD READERS**

ABSOLUTE MAXIMUM RATINGS

Maximum Temperatures and Humidity

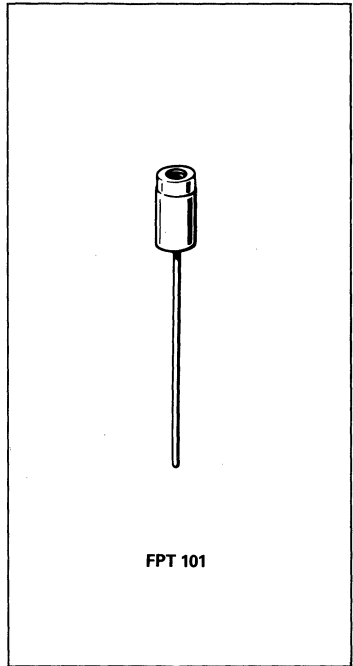
Storage Temperature	-65°C to +150°C
Operating Temperature	-65°C to +150°C
Pin Temperature (Soldering, 10 s)	260°C
Relative Humidity at 65°C	98 %

Maximum Power Dissipation

Total Dissipation at $T_C = 25^\circ\text{C}$	75 mW
Derate Linearly from 25°C	0.6 mW/°C

Maximum Voltages and Currents (Note 1)

V_{CEO}	Collector to Emitter Sustaining Voltage	30 V
V_{ECO}	Emitter to Collector Sustaining Voltage	5 V
I_C	Collector Current	25 mA



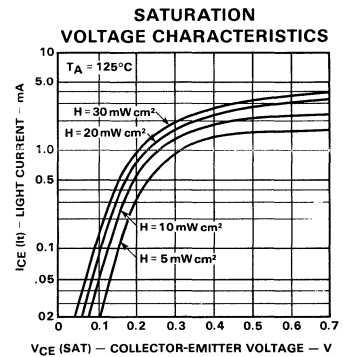
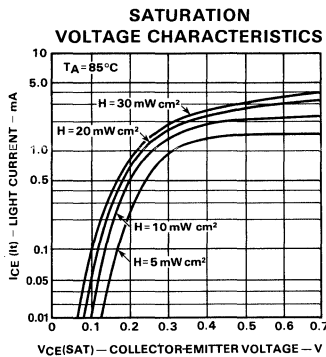
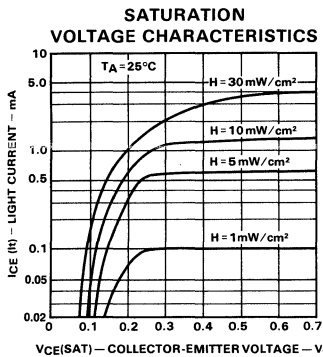
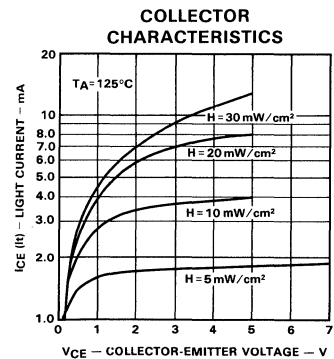
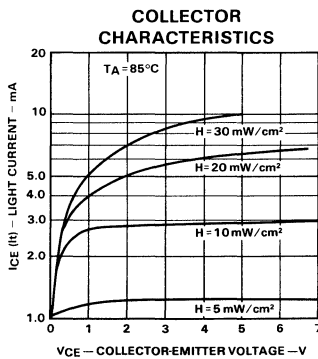
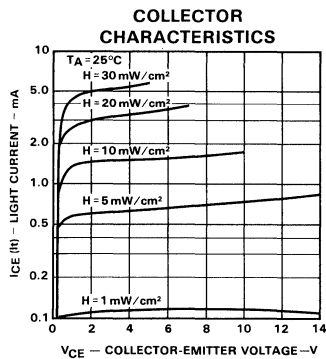
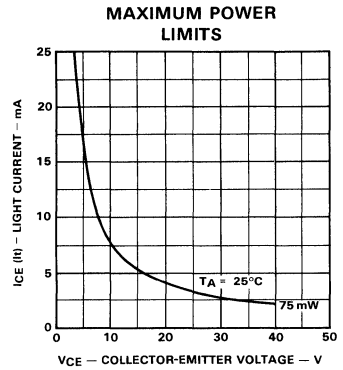
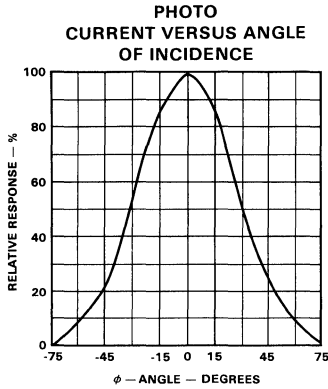
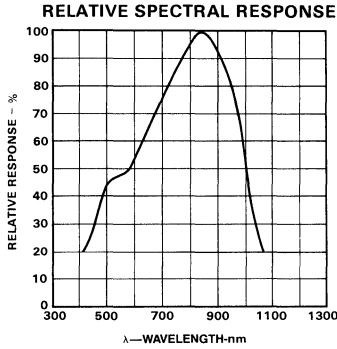
ELECTRICAL CHARACTERISTICS: $T_A = 25^\circ\text{C}$

SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	TEST CONDITIONS
$V_{CEO(sus)}$	Collector-Emitter Sustaining Voltage	30	60		V	$I_C = 0.1 \text{ mA}$, $H < 0.1 \mu\text{W}/\text{cm}^2$
BV_{ECO}	Emitter-Collector Breakdown Voltage		7.0		V	$I_C = 0.1 \text{ mA}$, $H < 0.1 \mu\text{W}/\text{cm}^2$
$V_{CE(sat)}$	Collector Saturation Voltage (Note 2)		0.25	0.3	V	$I_C = 0.4 \text{ mA}$, $H = 20 \text{ mW}/\text{cm}^2$
I_{CEO}	Collector Dark Current		2.0	100	nA	$V_{CE} = 5.0 \text{ V}$, $H < 0.1 \mu\text{W}/\text{cm}^2$
$I_{CE(it)}$	Collector Photo Current (Notes 2 & 4)	0.8	3.5		mA	$V_{CE} = 5.0 \text{ V}$, $H = 20 \text{ mW}/\text{cm}^2$
$I_{CE(it)}$	Collector Photo Current (Notes 2 & 4)		0.8		mA	$V_{CE} = 5.0 \text{ V}$, $H = 5.0 \text{ mW}/\text{cm}^2$

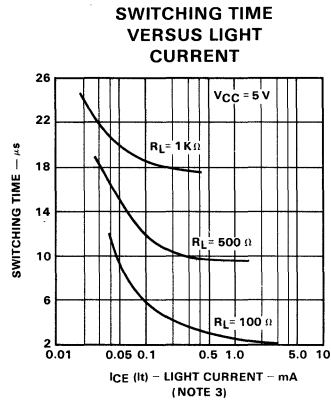
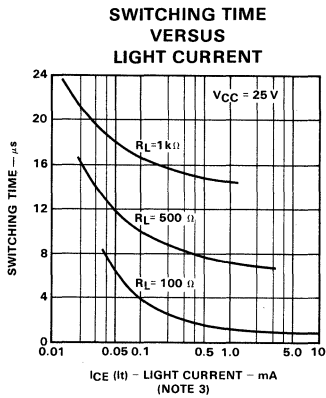
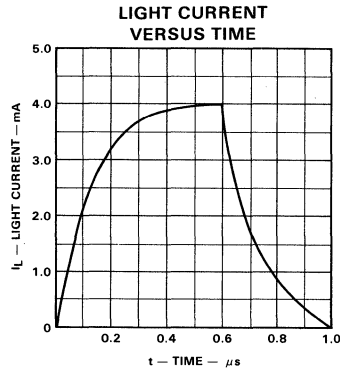
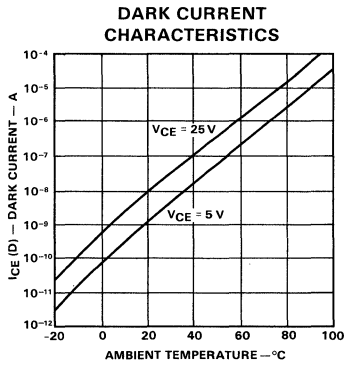
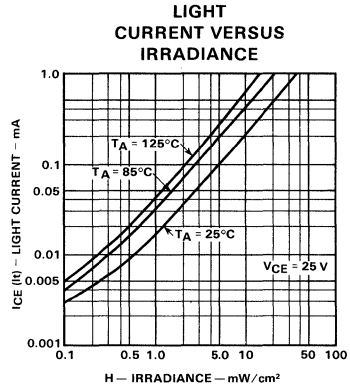
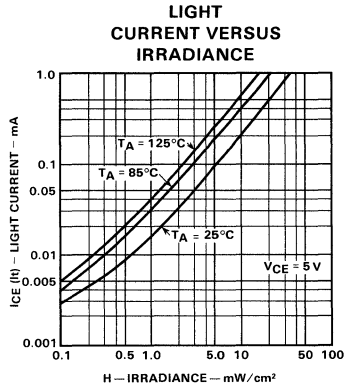
NOTES:

1. These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operation.
2. Irradiation source is an unfiltered tungsten lamp operated at 2854°K color temperature. Unless otherwise stated, all H values refer to this color temperature.
3. Switching time is defined here as the 10% to 90% rise time of I_{CE} for an irradiance step input. The rise and fall times are essentially equal.
4. Silicon radiometric photocurrent efficiency with typical GaAs irradiance is approximately three times greater than with tungsten at 2854°K color temperature. Therefore, all graphs with H as a parameter or variable will apply for GaAs irradiation if the H values are divided by three.
5. Emitter is connected to the case.

TYPICAL ELECTRICAL CHARACTERISTIC CURVES



TYPICAL ELECTRICAL CHARACTERISTIC CURVES (Cont'd)



FPT102

HERMETIC COAXIAL SILICON PHOTODIODE

OPTOELECTRONICS PRODUCT GROUP

GENERAL DESCRIPTION — The FPT102 is a miniature light-sensing diode in a hermetic, welded case. In the reverse-bias mode of operation, excellent photocurrent linearity is obtained. In the photovoltaic mode, the open-circuit voltage varies in a logarithmic manner being most sensitive to low-level light variations.

- SENSITIVE AT LOW LEVEL LIGHT APPLICATIONS
- EXCELLENT PHOTOCURRENT LINEARITY
- FAST RESPONSE TO LIGHT PULSES
- PRECISION OPTICAL ALIGNMENT
- MINIATURE—80 MILS IN DIAMETER

ABSOLUTE MAXIMUM RATINGS

Maximum Temperatures and Humidity

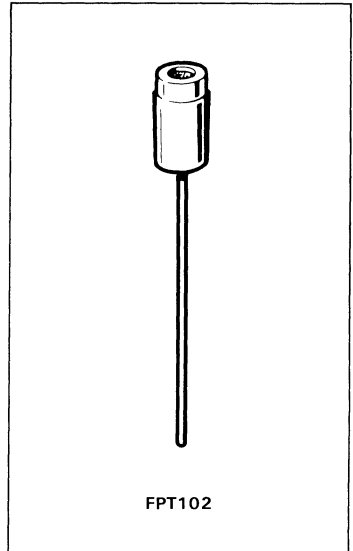
Storage Temperature	-55°C to +150°C
Junction Temperature	-55°C to +100°C
Pin Temperature (Soldering, 10 s)	260°C
Relative Humidity at 65°C	98 %

Maximum Power Dissipation

Total Dissipation at $T_C = 25^\circ\text{C}$	75 mW
Derate Linearly from $T_C = 25^\circ\text{C}$	0.6 mW/°C

Maximum Voltages

V_R Reverse Voltage	50 V
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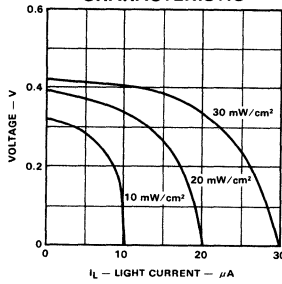
ELECTRICAL CHARACTERISTICS: $T_A = 25^\circ\text{C}$

SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	TEST CONDITIONS
BV	Breakdown Voltage	50	120		V	$I_R = 5.0 \mu\text{A}$, $H \leq 0.1 \mu\text{W}/\text{cm}^2$
V_{OC}	Open Circuit Voltage (Note 1)	380	400		mV	No bias, $H = 20 \text{ mW}/\text{cm}^2$
I_R	Dark Current		0.1	25	nA	$V_R = -10.0 \text{ V}$, $H \leq 0.1 \mu\text{W}/\text{cm}^2$
I_L	Photo Current (Note 1)	12	20		μA	$V_R = -10.0 \text{ V}$, $H = 20 \text{ mW}/\text{cm}^2$
$I_L(\text{sc})$	Short Circuit Current (Note 1)	12	20		μA	No bias, $H = 20 \text{ mW}/\text{cm}^2$
R(Tungsten)	Responsivity (Notes 1 & 2)	0.6	1.0		$\mu\text{A}/\text{mW}/\text{cm}^2$	No bias, $T_C = 2854^\circ\text{K}$
R @ 0.9 μ	Responsivity 0.9 μ (Note 2)		3.0		$\mu\text{A}/\text{mW}/\text{cm}^2$	No bias, GaAs
C_O	Open Circuit Capacitance		70		pF	$V_R = 0$, $H \leq 0.1 \text{ mW}/\text{cm}^2$
C_R	Reversed Bias Capacitance		20		pF	$V_R = -10 \text{ V}$, $H \leq 0.1 \mu\text{W}/\text{cm}^2$
$R(\text{max})$	Responsivity (absolute) at Spectral Peak (Note 2)		0.6		A/W	$V_R = 0$, $\lambda = 0.80 \mu$
NEP	Noise Equivalent Power (Note 2)		1.0×10^{-14}		$\frac{\text{W}}{\text{cm}\sqrt{\text{Hz}}}$	$V_R = -10 \text{ V}$, $\lambda = 0.80 \mu$, $\Delta f = 1.0 \text{ Hz}$
D	Detectivity (Note 2)		8.8×10^{12}		$\frac{\text{cm}\sqrt{\text{Hz}}}{\text{W}}$	$V_R = 10 \text{ V}$, $\lambda = 0.80 \mu$, $f = 1.0 \text{ kHz}$, $\Delta f = 1.0 \text{ Hz}$

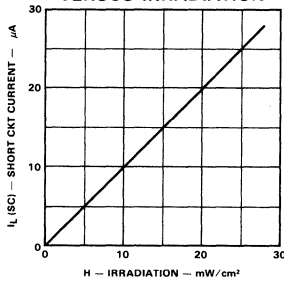
FAIRCHILD • FPT102

TYPICAL ELECTRICAL CHARACTERISTICS

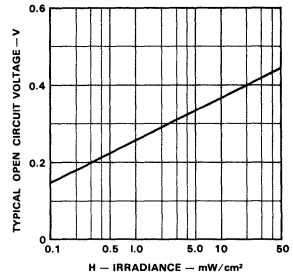
**TYPICAL VOLTAGE
VERSUS CURRENT
CHARACTERISTIC**



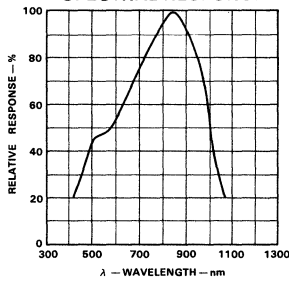
**TYPICAL SHORT
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VERSUS IRRADIATION**



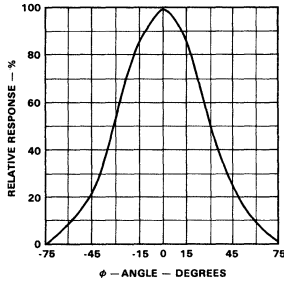
**TYPICAL OPEN
CIRCUIT VOLTAGE VERSUS
IRRADIATION**



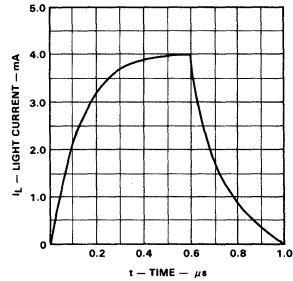
**RELATIVE
SPECTRAL RESPONSE**



**TYPICAL PHOTO
CURRENT VERSUS ANGLE
OF INCIDENCE**



**TYPICAL LIGHT
CURRENT VERSUS TIME**



NOTES:

1. Irradiation source is an unfiltered tungsten lamp operated at 2854°K color temperature.
2. Sensitive Area = $7.75 \times 10^{-3} \text{ cm}^2$. (Response at metalization is negligible.)

FPT120/220/320 • FPT130/230/330

HIGH SENSITIVITY SILICON PHOTOTRANSISTORS

OPTOELECTRONICS PRODUCT GROUP

GENERAL DESCRIPTION — The FPT120/220/320 FPT130/230/330 are silicon nitride protected npn Planar* phototransistors having exceptionally stable characteristics and high illumination sensitivity. The case is made of a special plastic compound with transparent resin encapsulation. The controlled sensitivities offered in the 230, 330, 220 and 320 versions gives the circuit designer increased flexibility.

- HIGH ILLUMINATION SENSITIVITY
- AVAILABILITY OF BASE-PINS FOR FLEXIBLE CIRCUIT DESIGN

ABSOLUTE MAXIMUM RATINGS

Maximum Temperatures/Humidity

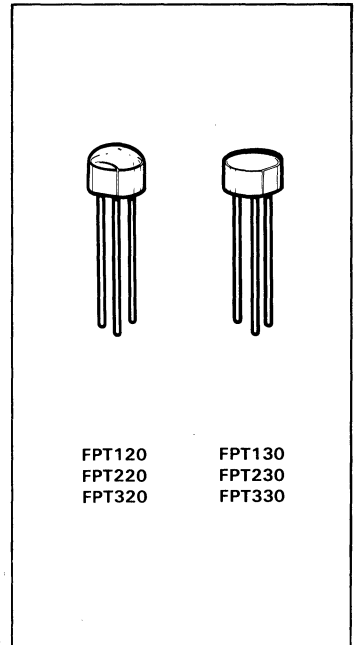
Storage Temperature	-55°C to +100°C
Operating Temperature	-55°C to +85°C
Pin Temperature (Soldering, 10 s)	260°C
Relative Humidity at 65°C	98 %

Maximum Power Dissipation (Note 1)

Total Dissipation at $T_C = 25^\circ\text{C}$	200 mW
Derate Linearly from $T_C = 25^\circ\text{C}$	3.33 mW/°C
Total Dissipation at $T_A = 25^\circ\text{C}$	100 mW
Derate Linearly from $T_A = 25^\circ\text{C}$	1.67 mW/°C

Maximum Voltage and Currents

V_{CEO}	Collector to Emitter Sustaining Voltage (Note 4)	20 V
I_C	Collector Current	25 mA



5

ELECTRICAL CHARACTERISTICS: $T_A = 25^\circ\text{C}$

SYMBOL	CHARACTERISTIC	FPT/120/220/320			FPT/130/230/330			UNITS	TEST CONDITIONS
		MIN	TYP	MAX	MIN	TYP	MAX		
$V_{CEO(sus)}$	Collector-Emitter Sustaining Voltage (Note 4)	20	50		20	50		V	$I_C = 1\text{ mA}$ (Pulsed)
BV_{ECO}	Emitter-Collector Breakdown Voltage (Note 4)		5.0			5.0		V	$I_{EC} = 100\mu\text{A}$
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage, Tungsten Source (Note 2)		0.25	0.55		0.25	0.55	V	$I_C = 1\text{ mA}$ $H = 20\text{ mW/cm}^2$
I_{CEO}	Collector Dark Current (Note 4)		10	100		10	100	nA	$V_{CE} = 5.0\text{ V}$
$I_{CE(it)}$	Photo Current, Tungsten Source (Note 2)	0.4	1.5		0.4	0.9		mA	$V_{CE} = 5.0\text{ V}$ $H = 1\text{ mW/cm}^2$
$I_{CE(it)}$	Photo Current, Tungsten Source (Note 2)		7.5			4.5		mA	$V_{CE} = 5.0\text{ V}$ $H = 5\text{ mW/cm}^2$
$I_{CE(it)}$	Photo Current, GaAs Source (Note 3)	0.7	4.5		0.7	2.7		mA	$V_{CE} = 5.0\text{ V}$ $H = 1\text{ mW/cm}^2$
t_r	Light Current Rise Time (Note 5)		18			18		μs	
t_f	Light Current Fall Time (Note 5)		18			18		μs	

*Planar is a patented Fairchild process.

FAIRCHILD FPT120A • FPT120B • FPT120C • FPT130A • FPT130B

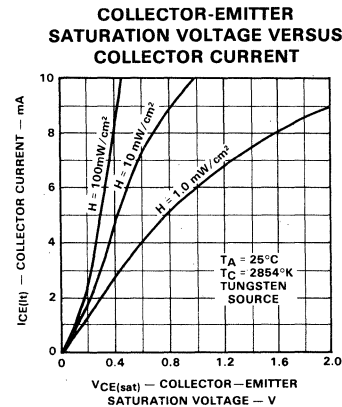
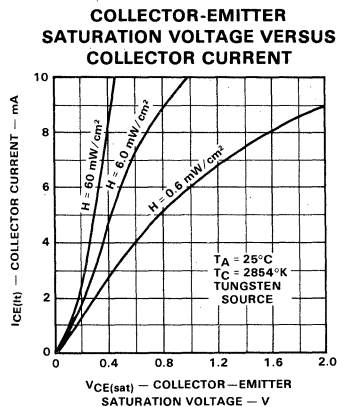
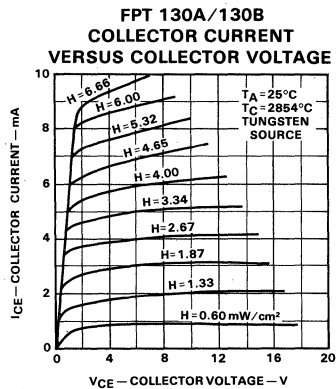
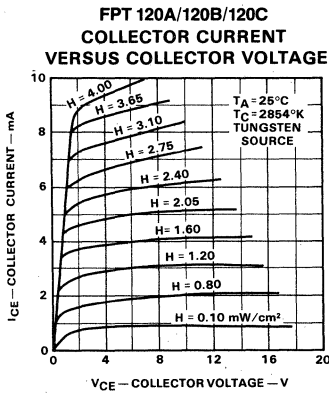
ELECTRICAL CHARACTERISTICS: $T_A = 25^\circ\text{C}$

SYMBOL	CHARACTERISTIC	FPT120A			FPT130A			UNITS	TEST CONDITIONS
		MIN	TYP	MAX	MIN	TYP	MAX		
$I_{CE}(It)$	Photo Current, Tungsten Source (Note 2)	1.5		4.5	0.9		2.7	mA	$V_{CE} = 5.0\text{ V}$ $H = 1\text{ mW/cm}^2$
		FPT120B			FPT130B				
$I_{CE}(It)$	Photo Current, Tungsten Source (Note 2)	2.0		4.0	1.2		2.4	mA	$V_{CE} = 5.0\text{ V}$ $H = 1\text{ mW/cm}^2$
		FPT120C							
$I_{CE}(It)$	Photo Current, Tungsten Source (Note 2)	16		25				mA	$V_{CE} = 5.0\text{ V}$ $H = 5\text{ mW/cm}^2$

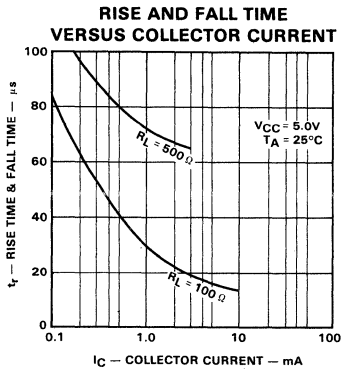
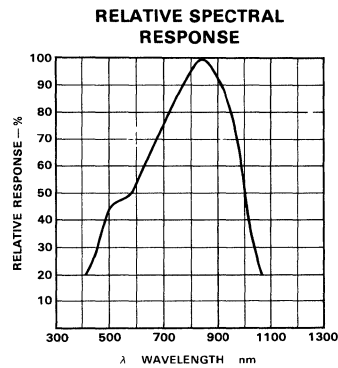
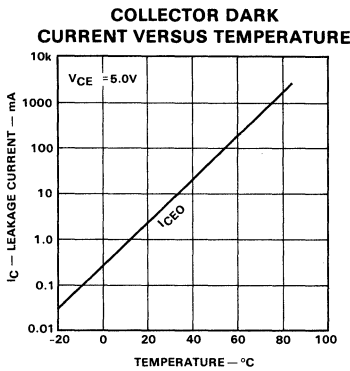
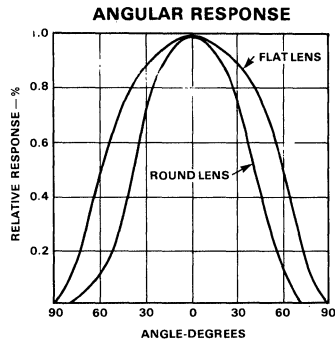
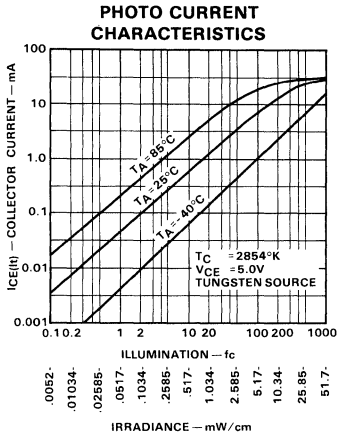
NOTES:

- These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.
- Measured at noted irradiance as emitted from a tungsten filament lamp at a color temperature of 2854°K. The effective photosensitive area is typically 1.25 mm² (FPT120A/B) and 0.78 mm² (FPT130A/B).
- These are values obtained at noted irradiance as emitted from a GaAs source at 900 nm.
- Measured with radiation flux intensity of less than .1 $\mu\text{W/cm}^2$ over the spectrum from 100-1500 nm.
- Rise time is defined as the time required for I_{CE} to rise from 10% to 90% of peak value. Fall time is defined as the time required for I_{CE} to decrease from 90% to 10% of peak value. Test conditions are: $V_{CE} = 5.0\text{ V}$, $I_{CC} = 4.0\text{ mA}$, $R_L = 100\ \Omega$, GaAs source.

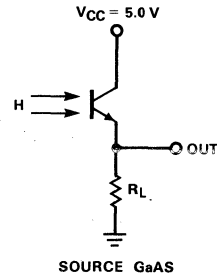
TYPICAL ELECTRICAL CHARACTERISTIC CURVES



TYPICAL ELECTRICAL CHARACTERISTIC CURVES (Cont'd)



SWITCHING TIME MEASUREMENT CIRCUIT



FPT131 • FPT136

GENERAL PURPOSE SILICON PHOTOTRANSISTORS

OPTOELECTRONICS PRODUCT GROUP

GENERAL DESCRIPTION — The FPT131 and FPT136 are 3-terminal npn Planar* phototransistors having exceptionally stable characteristics and high illumination sensitivity. The availability of the base pins gives wide latitude for flexible circuit design. The case is a special plastic compound with transparent resin encapsulation which exhibits stable characteristics under high humidity conditions.

- HIGH ILLUMINATION SENSITIVITY
- AVAILABILITY OF BASE PINS FOR FLEXIBLE CIRCUIT DESIGN
- LOW COST

ABSOLUTE MAXIMUM RATINGS

Maximum Temperature and Humidity

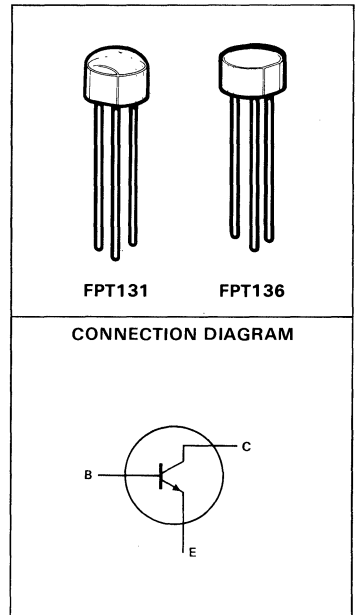
Storage Temperature	-55°C to +100°C
Operating Temperature	-55°C to +85°C
Pin Temperature (Soldering, 10 s)	260°C
Relative Humidity at 65°C	98 %

Maximum Power Dissipation (Note 1)

Total Dissipation at $T_C = 25^\circ\text{C}$	200 mW
Derate Linearly from 25°C	3.33 mW/°C
Total Dissipation at $T_A = 25^\circ\text{C}$	100 mW
Derate Linearly from 25°C	1.67 mW/°C

Maximum Voltages and Current (Note 4)

V_{CBO}	Collector to Base Voltage	20 V
V_{CEO}	Collector to Emitter Sustaining Voltage (Note 4)	15 V
I_C	Collector Current	25 mA

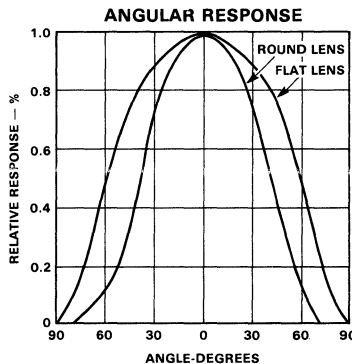
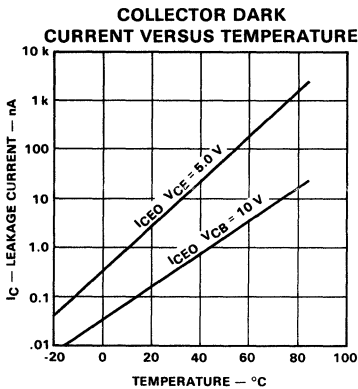
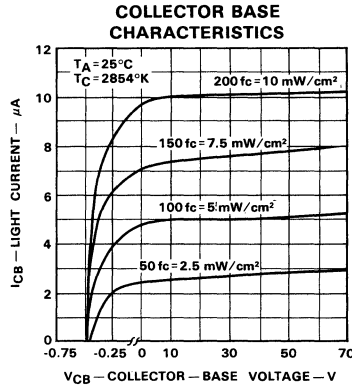
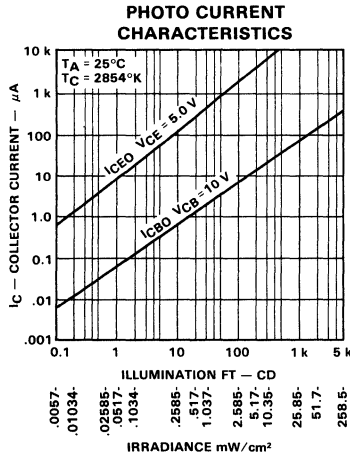
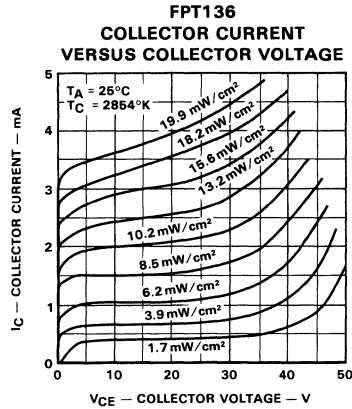
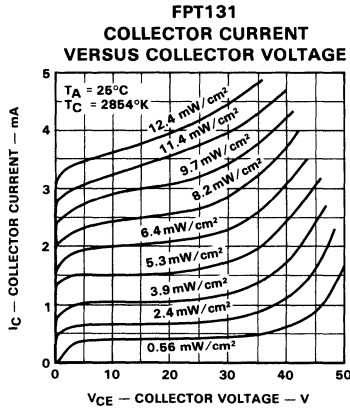


ELECTRICAL CHARACTERISTICS: $T_A = 25^\circ\text{C}$

SYMBOL	CHARACTERISTIC	FPT131			FPT136			UNITS	TEST CONDITIONS
		MIN	TYP	MAX	MIN	TYP	MAX		
$V_{CEO(sus)}$	Collector-Emitter Sustaining Voltage (Note 4)	15	50		15	50		V	$I_C = 1.0 \text{ mA}$ (Pulsed)
BV_{CBO}	Collector-Base Breakdown Voltage (Note 4)	20	120		20	120		V	$I_C = 100 \mu\text{A}$
BV_{ECO}	Emitter-Collector Breakdown Voltage (Note 4)		7.0			7.0		V	$I_{EC} = 100 \mu\text{A}$
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage		0.16	0.7		0.16	0.7	V	$I_C = 500 \mu\text{A}$ $H = 20 \text{ mW/cm}^2$
I_{CEO}	Collector Dark Current (Note 4)		10	500		10	500	nA	$V_{CE} = 5.0 \text{ V}$
I_{CBO}	Collector Dark Current (Note 4)		0.25			0.25		nA	$V_{CB} = 10 \text{ V}$
$I_{CE(t)}$	Photo Current, Tungsten (Notes 2 and 6)	0.1	1.4		0.1	.88		mA	$V_{CE} = 5.0 \text{ V}$ $H = 5.0 \text{ mW/cm}^2$
$I_{CE(t)}$	Photo Current (GaAs Notes 3 and 6)	0.2	4.2		0.2	2.7		mA	$V_{CE} = 5.0 \text{ V}$ $H = 5.0 \text{ mW/cm}^2$
t_r	Light Current Rise Time (Note 5)		2.8			2.8		μs	
t_f	Light Current Fall Time (Note 5)		2.8			2.8		μs	
R_{CB}	Responsivity, Tungsten (Notes 2 and 7)		1.6			1.0		$\mu\text{A/mW/cm}^2$	$V_{CB} = 10 \text{ V}$
R_{CB}	Responsivity, GaAs (Notes 3 and 7)		4.8			3.0		$\mu\text{A/mW/cm}^2$	$V_{CB} = 20 \text{ V}$

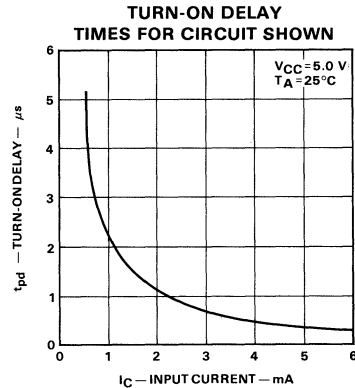
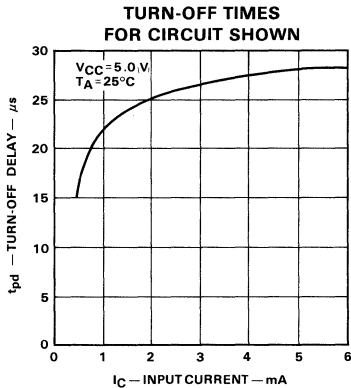
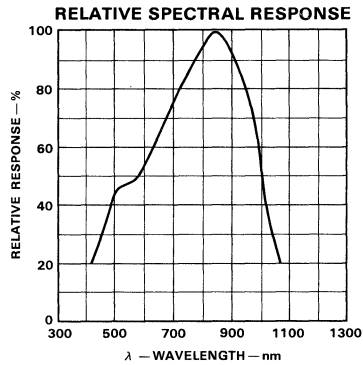
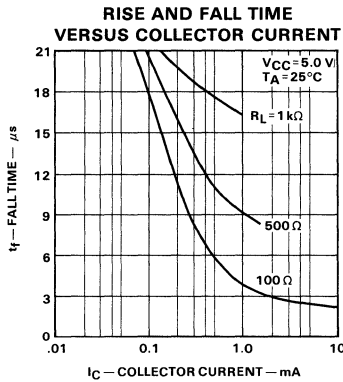
*Planar is a patented Fairchild process.

TYPICAL CHARACTERISTIC CURVES

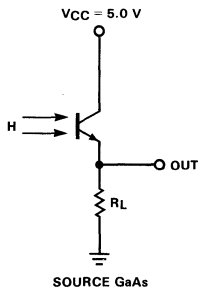


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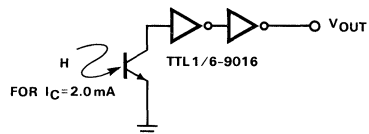
TYPICAL CHARACTERISTIC CURVES (Cont'd)



**SWITCHING CIRCUIT
FOR RISE AND FALL TIMES**



**CIRCUIT FOR TURN-ON
AND TURN-OFF DATA**



NOTES:

1. These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.
2. Measured at noted irradiance as emitted from a tungsten filament lamp at a color temperature of 2854°K. The effective photosensitive area is typically 1.25 mm² (FPT131) and 0.78 mm² (FPT136).
3. These are values obtained at noted irradiance as emitted from a GaAs source at 900 nm.
4. Measured with radiation flux intensity of less than .1 $\mu\text{W}/\text{cm}^2$ over the spectrum from 100-1500 nm.
5. Rise time is defined as the time required for I_{CE} to rise from 10% to 90% of peak value. Fall time is defined as the time required for I_{CE} to decrease from 90% to 10% of peak value. Test conditions are: $I_{CE} = 4.0 \text{ mA}$, $V_{CE} = 5.0 \text{ V}$, $R_L = 100 \Omega$, GaAs source.
6. No electrical connection to base pin.
7. No electrical connection to emitter pin.

FPT132 • FPT137

GENERAL PURPOSE, HIGH SENSITIVITY SILICON PHOTOTRANSISTORS

OPTOELECTRONICS PRODUCT GROUP

GENERAL DESCRIPTION — The FPT132 and FPT137 are silicon nitride protected npn Planar* phototransistors having exceptionally stable characteristics and high illumination sensitivity. The case is made of a special plastic compound with transparent resin encapsulation which exhibits stable characteristics under high humidity conditions.

- HIGH ILLUMINATION SENSITIVITY
- LOW COST

ABSOLUTE MAXIMUM RATINGS

Maximum Temperatures/Humidity

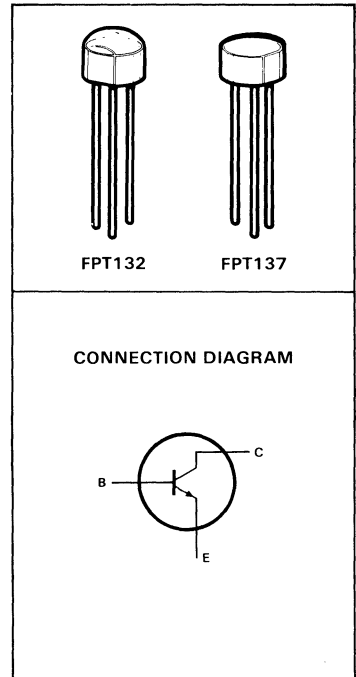
Storage Temperature	-55°C to +100°C
Operating Temperature	-55°C to +85°C
Pin Temperature (Soldering, 5 s)	260°C
Relative Humidity at 65°C	98%

Maximum Power Dissipation (Note 3)

Total Dissipation at $T_C = 25^\circ\text{C}$	200 mW
Derate Linearly from 25°C	3.33 mW/°C
Total Dissipation at $T_A = 25^\circ\text{C}$	100 mW
Derate Linearly from 25°C	1.67 mW/°C

Maximum Voltages and Current (Note 4)

V_{CEO} Collector to Emitter Sustaining Voltage (Note 4)	10 V
I_C Collector Current	25 mA



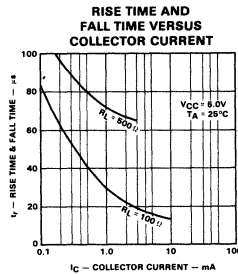
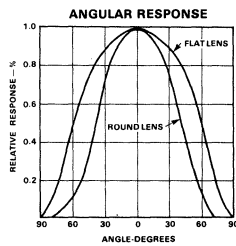
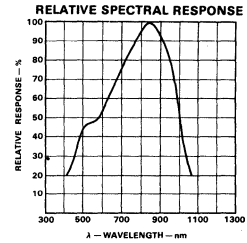
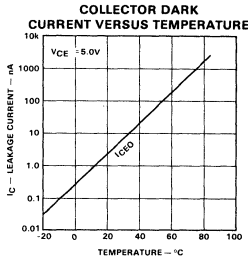
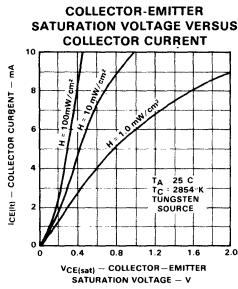
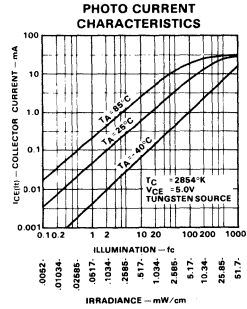
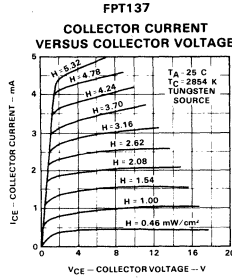
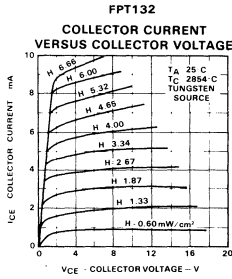
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ELECTRICAL CHARACTERISTICS: $T_A = 25^\circ\text{C}$

SYMBOL	CHARACTERISTIC	FPT132			FPT137			UNITS	TEST CONDITIONS
		MIN	TYP	MAX	MIN	TYP	MAX		
$V_{CEO(sus)}$	Collector-Emitter Sustaining Voltage (Note 4)	10	30		10	30		V	$I_C = 1 \text{ mA}$ (Pulsed)
BV_{ECO}	Emitter-Collector Breakdown Voltage (Note 4)		3.0			3.0		V	$I_{EC} = 100 \mu\text{A}$
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage, Tungsten Source (Note 2)		0.15	0.7		0.15	0.7	V	$I_C = 1 \text{ mA}$, $H = 20 \text{ mW/cm}^2$
I_{CEO}	Collector Dark Current (Note 4)			500			500	nA	$V_{CE} = 5.0 \text{ V}$
$I_{CE(it)}$	Photo Current, Tungsten Source (Note 2)	0.2	1.5		0.2	0.9		mA	$V_{CE} = 5.0 \text{ V}$, $H = 1 \text{ mW/cm}^2$
$I_{CE(it)}$	Photo Current, Tungsten Source (Note 2)		7.5			4.5		mA	$V_{CE} = 5.0 \text{ V}$, $H = 5 \text{ mW/cm}^2$
$I_{CE(it)}$	Photo Current, GaAs Source (Note 3)	0.4	4.5		0.4	2.7		mA	$V_{CE} = 5.0 \text{ V}$, $H = 1 \text{ mW/cm}^2$
t_r	Light Current Rise Time (Note 5)		18			18		μs	
t_f	Light Current Fall Time (Note 5)		18			18		μs	

*Planar is a patented Fairchild process.

TYPICAL CHARACTERISTIC CURVES



NOTES:

1. These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.
2. Measured at noted irradiance as emitted from a tungsten filament lamp at a color temperature of 2854°K. The effective photosensitive area is typically 1.25 mm² (FPT132), and 0.78 mm² (FPT137).
3. These are values obtained at noted irradiance as emitted from a GaAs source at 900 nm.
4. Measured with radiation flux intensity of less than 1 μW/cm² over the spectrum from 100-1500 nm.
5. Rise time is defined as the time required for IC to rise from 10% to 90% of peak value. Fall time is defined as the time required for IC to decrease from 90% to 10% of peak value. Test conditions are: VCE = 5.0 V, IC = 4.0 mA, RL = 100Ω, GaAs source.

FPT400 • FPT410

VERY HIGH SENSITIVITY PHOTO-DARLINGTONS

OPTOELECTRONICS PRODUCT GROUP

GENERAL DESCRIPTION – The FPT400 and FPT410 are 3-terminal npn Planar* photo-DarlingtonS having exceptionally stable characteristics and high illumination sensitivity. The availability of the base pins gives wide latitude for flexible circuit design. The case is a special plastic compound with transparent resin encapsulation which exhibits stable characteristics under high humidity conditions.

- SUPER HIGH ILLUMINATION SENSITIVITY
- EXCEPTIONALLY STABLE CHARACTERISTICS
- EXCELLENT FOR LOW LIGHT LEVEL APPLICATIONS
- HIGH OUTPUT CURRENT

ABSOLUTE MAXIMUM RATINGS

Maximum Temperatures and Humidity

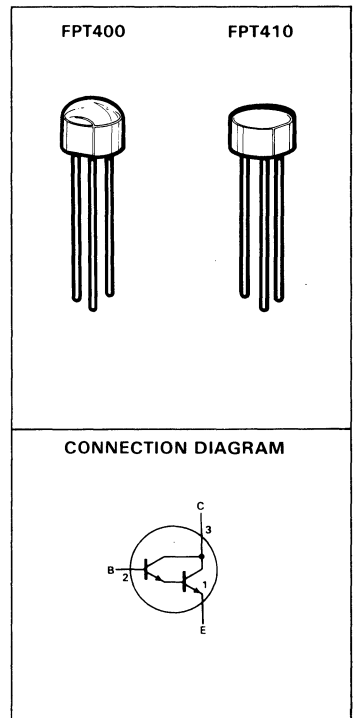
Storage Temperature	-55°C to + 100°C
Operating Temperature	-55°C to +85°C
Relative Humidity at 65°C	98%

Maximum Power Dissipation (Note 7 and 8)

Total Dissipation at $T_C = 25^\circ\text{C}$	200 mW
Derate Linearly from 25°C	3.3 mW/°C
Total Dissipation at $T_A = 25^\circ\text{C}$	100 mW
Derate Linearly from 25°C	1.67 mW/°C

Maximum Voltages and Currents

V_{CB}	Collector to Base Voltage	30 V
V_{CE}	Collector to Emitter Voltage	30 V
I_C	Collector Current	50 mA



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ELECTRICAL CHARACTERISTICS: $T_A = 25^\circ\text{C}$

SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	TEST CONDITIONS
$V_{CEO(sus)}$	Collector-Emitter Sustaining Voltage	30	60		V	$I_C = 1.0 \text{ mA}$ (Note 3)
V_{CBO}	Collector-Base Voltage	30	60		V	$I_C = 100 \mu\text{A}$ (Note 3)
V_{ECO}	Emitter-Collector Voltage		10		V	$I_E = 100 \mu\text{A}$ (Note 3)
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage		0.9	1.0	V	$I_C = 5.0 \text{ mA}$, $H = 5.0 \text{ mW/cm}^2$ (Note 1)
I_{CEO}	Collector Dark Current		10	100	nA	$V_{CE} = 5.0 \text{ V}$ (Note 3)
$I_{CE(t)}$	Photo Current (Tungsten)					
	FPT400	3.0	7.5		mA	$V_{CE} = 5.0 \text{ V}$, $H = 1.0 \text{ mW/cm}^2$
	FPT410	2.0	5.0		mA	(Notes 1, 5)
$I_{CE(t)}$	Photo Current (GaAs)					
	FPT400	6.0	15		mA	$V_{CE} = 5.0 \text{ V}$, $H = 1.0 \text{ mW/cm}^2$
	FPT410	4.0	10		mA	(Notes 2, 5)
t_r	Light Current Rise Time		100		μs	(Note 4)
t_f	Light Current Fall Time		100		μs	(Note 4)

FPT500 • 520 • 540 FPT500A • 520A • 540A

HERMETIC TO-18 SILICON PHOTOTRANSISTORS OPTOELECTRONICS PRODUCT GROUP

GENERAL DESCRIPTION – FPT500/FPT520/FPT540 series are nitride-passivated npn Planar* silicon phototransistors. These devices are packaged in a TO-18 style, hermetically sealed package with lens cap. For most applications two pins are used (Collector and Emitter pins). The availability of base pin gives wide latitude for flexible circuit design. Phototransistors can be used as a photo diode (collector-base) which has an excellent photo current linearity (for analog applications).

- HIGH ILLUMINATION SENSITIVITY
- EXCEPTIONALLY STABLE CHARACTERISTICS
- LARGE RANGE OF CONTROLLED SENSITIVITIES
- HERMETIC METAL PACKAGE
- HIGH OPERATING TEMPERATURE

ABSOLUTE MAXIMUM RATINGS

Maximum Temperature and Humidity

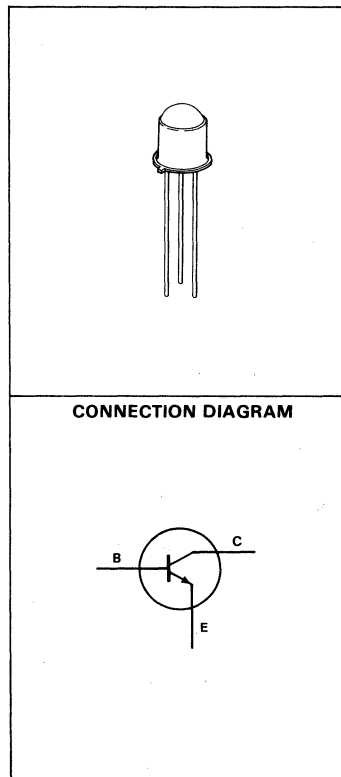
Storage Temperature	-65°C to +200°C
Operating Temperature	-55°C to +150°C
Pin Temperature (Soldering, 5 s)	260°C
Relative Humidity at 65°C	98%

Maximum Power Dissipation

Total Dissipation at $T_C = 25^\circ\text{C}$	600 mW
Derate Linearly from 25°C	4.8 mW/°C
Total Dissipation at $T_A = 25^\circ\text{C}$	300 mW
Derate Linearly from 25°C	2.4 mW/°C

Maximum Voltages and Currents

V_{CB}	Collector to Base Voltage		
	FPT500/FPT500A	60 V	
	FPT520/FPT520A	50 V	
$V_{CE(sus)}$	Collector to Emitter Sustaining Voltage		
	FPT500/500A	45 V	
	FPT520/FPT520A	30 V	
I_C	Collector Current		50 mA
	FPT540/FPT540A	30 V	
	FPT540/FPT540A	12 V	



ELECTRICAL CHARACTERISTICS: $T_A = 25^\circ\text{C}$

SYMBOL	CHARACTERISTIC	FPT500/500A			FPT520/520A			FPT540/540A			UNITS	TEST CONDITIONS
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
$V_{CEO(sus)}$	Collector-Emitter Sustaining Voltage	45	60		30	60		12	30		V	$I_C = 1.0 \text{ mA}$ (Note 3)
V_{CBO}	Collector-Base Voltage	60	100		50	80		30	50		V	$I_C = 100 \mu\text{A}$ (Note 3)
V_{EBO}	Emitter-Collector Voltage		10			10			7.0		V	$I_E = 100 \mu\text{A}$ (Note 3)
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage		0.16	0.33		0.16	0.33				V	$I_C = 500 \mu\text{A}$ (Note 1) $H = 2.0 \text{ mW/cm}^2$
									0.25	0.55	V	$I_C = 1.0 \text{ mA}$ (Note 1) $H = 2.0 \text{ mW/cm}^2$

FAIRCHILD • FPT500 • FPT520 • FPT540 SERIES

ELECTRICAL CHARACTERISTICS: $T_A = 25^\circ\text{C}$ (Cont'd)

SYMBOL	CHARACTERISTIC	FPT500/500A			FPT520/520A			FPT540/540A			UNITS	TEST CONDITIONS	
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX			
I_{CEO}	Collector Dark Current		10	100		10	100		10	100	nA	$V_{CE} = 5.0\text{ V}$ (Note 3) $V_{CB} = 10\text{ V}$ (Note 3) $V_{CB} = 5.0\text{ V}$ (Note 6) $H = 1.0\text{ mW/cm}^2$	
I_{CBO}	Collector Dark Current		0.25	25		0.25	25		0.25	25	nA		
$I_{CB(I_t)}$	Photo Current		10			10			10		μA		
θ_{50}	50% Angular Response		15			15			15		degrees		
t_r	Light Current Rise Time		3.0			8.0			18		μs		(Note 4)
t_f	Light Current Fall Time		3.0			8.0			18		μs		(Note 4)
		FPT500			FPT520			FPT540					
$I_{CE(I_t)}$	Photo Current (Tungsten)	1.0	3.0		5.0	8.0		8.0	15		mA	$V_{CE} = 5.0\text{ V}$ $H = 1.0\text{ mW/cm}^2$ (Notes 1, 5)	
$I_{CE(I_t)}$	Photo Current (GaAs)	3.0	6.0		10	24		16	30		mA		$V_{CE} = 5.0\text{ V}$ $H = 1.0\text{ mW/cm}^2$ (Notes 2, 5)
		FPT500A			FPT520A			FPT540A					
$I_{CE(I_t)}$	Photo Current (Tungsten)	2.0		6.0	6.0		18	10		30	mA	$V_{CE} = 5.0\text{ V}$ $H = 1.0\text{ mW/cm}^2$ (Notes 1, 5)	

NOTES:

1. Measured at noted irradiance as emitted from a Tungsten filament lamp at a color temperature of 2854°K. The effective photosensitive area is typically 7 mm².
2. These are values obtained at noted irradiance as emitted from a GaAs source at 900 nm.
3. Measured with radiation flux intensity of less than 0.1 $\mu\text{W/cm}^2$ over the spectrum from 100-1500 nm.
4. Rise time is defined as the time required for I_{CE} to rise from 10% to 90% of peak value. Fall time is defined as the time required for I_{CE} to decrease from 90% to 10% of peak value. Test conditions are: $V_{CE} = 10\text{ V}$, $I_{CC} = 10\text{ mA}$, $R_L = 100\ \Omega$, GaAs source.
5. No electrical connection to base pin.
6. No electrical connection to emitter pin.

FPT510 • 530 • 550

FPT510A • 530A • 550A

HERMETIC TO-18 SILICON PHOTOTRANSISTORS

OPTOELECTRONICS PRODUCT GROUP

GENERAL DESCRIPTION – FPT510/FPT530/FPT550 series are nitride-passivated npn Planar* silicon phototransistors. These devices are packaged in a TO-18 style, hermetically sealed package with lens cap. For most applications two pins are used (Collector and Emitter pins). The availability of base pin gives wide latitude for flexible circuit design. Phototransistors can be used as a photo diode (collector-base) which has an excellent photo current linearity (for analog applications).

- HIGH ILLUMINATION SENSITIVITY
- EXCEPTIONALLY STABLE CHARACTERISTICS
- LARGE RANGE OF SENSITIVITIES
- HERMETIC METAL PACKAGE
- HIGH OPERATING TEMPERATURE

ABSOLUTE MAXIMUM RATINGS

Maximum Temperature and Humidity

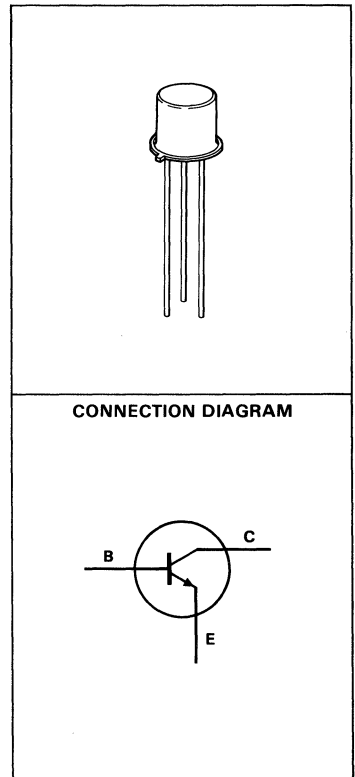
Storage Temperature	-65°C to +200°C
Operating Temperature	-55°C to +150°C
Pin Temperature (Soldering, 5 s)	260°C
Relative Humidity at 65°C	98%

Maximum Power Dissipation

Total Dissipation at $T_C = 25^\circ\text{C}$	600 mW
Derate Linearly from 25°C	4.8 mW/°C
Total Dissipation at $T_A = 25^\circ\text{C}$	300 mW
Derate Linearly from 25°C	2.4 mW/°C

Maximum Voltages and Currents

V_{CB}	Collector to Base Voltage	
	FPT510/FPT510A	60 V
	FPT530/FPT530A	50 V
$V_{CE(sus)}$	Collector to Emitter Sustaining Voltage	
	FPT510/510A	45 V
	FPT530/FPT530A	30 V
I_C	Collector Current	
	FPT550/FPT550A	12 V
		50 mA



ELECTRICAL CHARACTERISTICS: $T_A = 25^\circ\text{C}$

SYMBOL	CHARACTERISTIC	FPT510/510A			FPT530/530A			FPT550/550A			UNITS	TEST CONDITIONS
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
$V_{CE(sus)}$	Collector-Emitter Sustaining Voltage	45	60		30	60		12	30		V	$I_C = 1.0 \text{ mA}$ (Note 3)
V_{CBO}	Collector-Base Voltage	60	100		50	80		30	50		V	$I_C = 100 \mu\text{A}$ (Note 3)
V_{EBO}	Emitter-Collector Voltage		10			10			7.0		V	$I_E = 100 \mu\text{A}$ (Note 3)
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage		0.16	0.33		0.16	0.33				V	$I_C = 500 \mu\text{A}$ (Note 1) $H = 2.0 \text{ mW/cm}^2$
									0.25	0.55	V	$I_C = 1.0 \text{ mA}$ (Note 1) $H = 2.0 \text{ mW/cm}^2$

FAIRCHILD • FPT510 • FPT530 • FPT550

ELECTRICAL CHARACTERISTICS: T_A = 25°C (Cont'd)

SYMBOL	CHARACTERISTIC	FPT510/510A			FPT530/530A			FPT550/550A			UNITS	TEST CONDITIONS
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX		
I _{CEO}	Collector Dark Current		10	100		10	100		10	100	nA	V _{CE} = 5.0 V (Note 3)
I _{CBO}	Collector Dark Current		0.25	25		0.25	25		0.25	25	nA	V _{CB} = 10 V (Note 3)
I _{CB(it)}	Photo Current		5.0			5.0			5.0		μA	V _{CB} = 5.0 V (Note 6) H = 5.0 mW/cm ²
θ ₅₀	50% Angular Response		15			15			15		degrees	
t _r	Light Current Rise Time		3.0			8.0			18		μs	(Note 4)
t _f	Light Current Fall Time		3.0			8.0			18		μs	(Note 4)
		FPT510			FPT530			FPT550				
I _{CE(it)}	Photo Current (Tungsten)	0.5	1.5		3.0	5.0		8.0	10		mA	V _{CE} = 5.0 V H = 5.0 mW/cm ² (Notes 1, 5)
I _{CE(it)}	Photo Current (GaAs)	1.5	4.5		6.0	15		16	30		mA	V _{CE} = 5.0 V H = 5.0 mW/cm ² (Notes 2, 5)
		FPT510A			FPT530A			FPT550A				
I _{CE(it)}	Photo Current (Tungsten)	1.0		3.0	4.0		12	8.0		24	mA	V _{CE} = 5.0 V H = 5.0 mW/cm ² (Notes 1, 5)

NOTES:

1. Measured at noted irradiance as emitted from a Tungsten filament lamp at a color temperature of 2854°K. The effective photosensitive area is typically 7 mm².
2. These are values obtained at noted irradiance as emitted from a GaAs source at 900 nm.
3. Measured with radiation flux intensity of less than 0.1 μW/cm² over the spectrum from 100-1500 nm.
4. Rise time is defined as the time required for I_{CE} to rise from 10% to 90% of peak value. Fall time is defined as the time required for I_{CE} to decrease from 90% to 10% of peak value. Test conditions are: V_{CE} = 10 V, I_{CC} = 10 mA, R_L = 100 Ω, GaAs source.
5. No electrical connection to base pin.
6. No electrical connection to emitter pin.

FPT560 • FPT570

VERY HIGH SENSITIVITY PHOTO-DARLINGTONS OPTOELECTRONICS PRODUCT GROUP

GENERAL DESCRIPTION – FPT560/FPT570 are nitride passivated silicon photo Darlington. Each device is packaged in a TO-18 style, hermetically sealed package with lens cap. For most applications two pins are used (Collector and Emitter pins). The availability of base pin gives wide latitude for flexible circuit design.

- SUPER HIGH ILLUMINATION SENSITIVITY
- EXCEPTIONALLY STABLE CHARACTERISTICS
- EXCELLENT FOR LOW LIGHT LEVEL APPLICATIONS
- HIGH OUTPUT CURRENT

ABSOLUTE MAXIMUM RATINGS

Maximum Temperature and Humidity

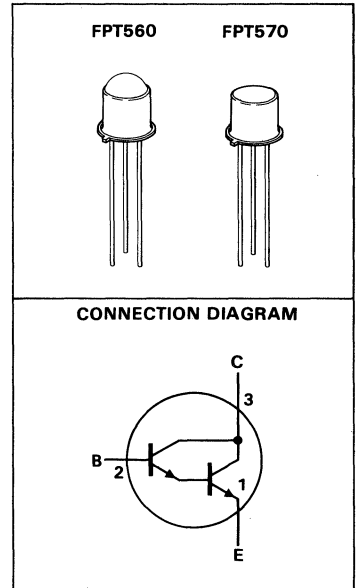
Storage Temperature	-65°C to +200°C
Operating Temperature	-55°C to +150°C
Pin Temperature (Soldering, 5 s)	260°C
Relative Humidity at 65°C	98%

Maximum Power Dissipation

Total Dissipation at $T_C = 25^\circ\text{C}$	600 mW
Derate Linearly from 25°C	4.8 mW/°C
Total Dissipation at $T_A = 25^\circ\text{C}$	300 mW
Derate Linearly from 25°C	2.4 mW/°C

Maximum Voltages and Currents

V_{CB}	Collector to Base Voltage	30 V
V_{CE}	Collector to Emitter Voltage	30 V
I_C	Collector Current	125 mA



ELECTRICAL CHARACTERISTICS: $T_A = 25^\circ\text{C}$

SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	TEST CONDITIONS
$V_{CEO(sus)}$	Collector-Emitter Sustaining Voltage	30	60		V	$I_C = 1.0 \text{ mA}$ (Note 3)
V_{CBO}	Collector-Base Voltage	30	60		V	$I_C = 100 \mu\text{A}$ (Note 3)
V_{ECO}	Emitter-Collector Voltage		10		V	$I_E = 100 \mu\text{A}$ (Note 3)
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage		0.9	1.0	V	$I_C = 25 \text{ mA}$, $H = 2.0 \text{ mW/cm}^2$ (Note 1)
I_{CEO}	Collector Dark Current		10	100	nA	$V_{CE} = 5.0 \text{ V}$ (Note 3)
$I_{CE(I_t)}$	Photo Current (Tungsten)					
	FPT560	10	30		mA	$V_{CE} = 5.0 \text{ V}$, $H = 1.0 \text{ mW/cm}^2$
	FPT570	1.0	6.0		mA	(Notes 1, 5)
$I_{CE(I_t)}$	Photo Current (GaAs)					
	FPT560	30	90		mA	$V_{CE} = 5.0 \text{ V}$, $H = 1.0 \text{ mW/cm}^2$
	FPT570	3.0	18		mA	(Notes 2, 5)
θ_{50}	50% Response Angle		15		degrees	
t_r	Light Current Rise Time		100		μs	(Note 4)
t_f	Light Current Fall Time		100		μs	(Note 4)

NOTES:

1. Measured at noted irradiance as emitted from a Tungsten filament lamp at a color temperature of 2854°K. The effective photosensitive area is typically 7 mm².
2. These are values obtained at noted irradiance as emitted from a GaAs source at 900 nm.
3. Measured with radiation flux intensity of less than 0.1 $\mu\text{W/cm}^2$ over the spectrum from 100-1500 nm.
4. Rise time is defined as the time required for I_{CE} to rise from 10% to 90% of peak value. Fall time is defined as the time required for I_{CE} to decrease from 90% to 10% of peak value. Test conditions are: $V_{CE} = 10 \text{ V}$, $I_{CC} = 10 \text{ mA}$, $R_L = 100 \Omega$, GaAs source.
5. No electrical connection to base pin.
6. No electrical connection to emitter pin.

FPT610 • FPT630

MINIATURE CERAMIC SILICON PHOTOTRANSISTORS

OPTOELECTRONICS PRODUCT GROUP

GENERAL DESCRIPTION – The FPT610 and FPT630 are miniature phototransistors having exceptional stable characteristics. They utilize a ceramic case with transparent resin encapsulation. The spectral response, extending from 400 to 1100 nm, is compatible with daylight, tungsten and gallium arsenide sources.

- HIGH ILLUMINATION SENSITIVITY
- EXCEPTIONALLY STABLE CHARACTERISTICS
- CAN BE STAKED ON .087" CENTERS
- MINIATURE – 85 x 185 x 95 MILS HIGH

ABSOLUTE MAXIMUM RATINGS

Maximum Temperature and Humidity

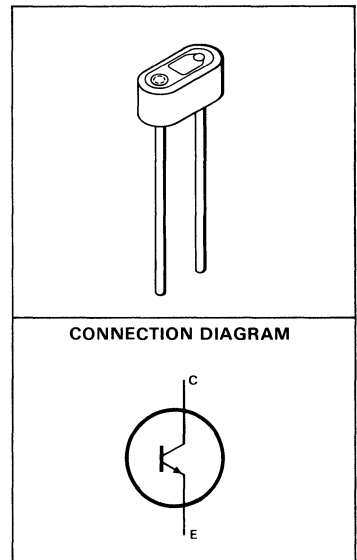
Storage Temperature	-40°C to +100°C
Operating Temperature	-40°C to +100°C
Pin Temperature (Soldering, 5 s)	260°C
Relative Humidity at 65°C	98%

Maximum Power Dissipation

Total Dissipation at $T_A = 25^\circ\text{C}$	100 mW
Derate Linearly from 25°C	1.33 mW/°C

Maximum Voltages and Currents

$V_{CE(sus)}$ Collector to Emitter Sustaining Voltage	
FPT610	30 V
FPT630	20 V
I_C Collector Current	50 mA



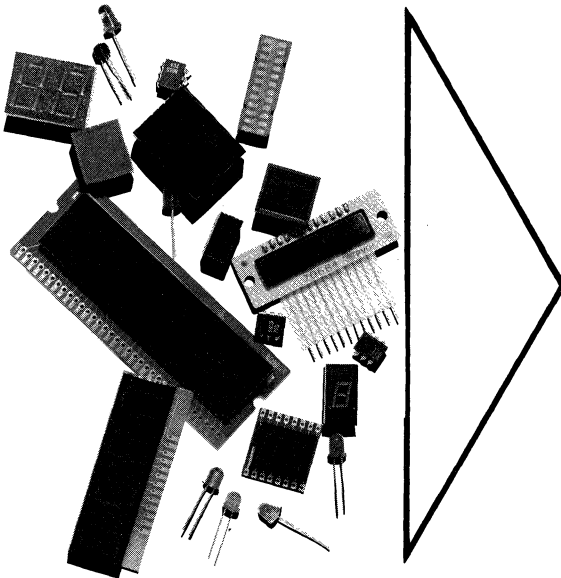
5

ELECTRICAL CHARACTERISTICS: $T_A = 25^\circ\text{C}$

SYMBOL	CHARACTERISTIC	FPT610			FPT630			UNITS	TEST CONDITIONS
		MIN	TYP	MAX	MIN	TYP	MAX		
$V_{CE(sus)}$	Collector-Emitter Sustaining Voltage (Note 1)	30	60		20	40		V	$I_C = 1.0 \text{ mA}$
V_{ECO}	Emitter-Collector Voltage (Note 1)		10			10		V	$I_E = 100 \mu\text{A}$
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage (Note 2)		0.16	0.33		0.16	0.33	V	$I_C = 500 \mu\text{A}$ $H = 20 \text{ mW/cm}^2$
I_{CEO}	Collector Dark Current (Note 1)		10	100		10	100	nA	$V_{CE} = 5.0 \text{ V}$
$I_{CE(tt)}$	Photo Current (Tungsten) (Note 2)	0.2	1.0		2.0	5.0		mA	$V_{CE} = 5.0 \text{ V}$ $H = 5.0 \text{ mW/cm}^2$
$I_{CE(tt)}$	Photo Current (GaAs) (Note 3)	0.4	3.0		4.0	15		mA	$V_{CE} = 5.0 \text{ V}$ $H = 5.0 \text{ mW/cm}^2$
t_r	Rise Time (Note 4)		3.0			18		μs	$I_C = 2.0 \text{ mA}$ $R_L = 100 \Omega$
t_f	Fall Time (Note 4)		3.0			18		μs	$I_C = 2.0 \text{ mA}$ $R_L = 100 \Omega$

NOTES:

1. Measured with radiation flux intensity of less than $0.1 \mu\text{W/cm}^2$ over the spectrum from 100 – 1500 nm.
2. Measured at noted irradiance as emitted from a Tungsten filament lamp at a color temperature of 2854°K.
3. These are values obtained at noted irradiance as emitted from A GaAs source at 900 nm.
4. Rise time is defined as the time required for I_{CE} to rise from 10% to 90% of peak value. Fall time is defined as the time required for I_{CE} to decrease from 90% to 10% of peak value. Test conditions are: $I_{CE} = 4.0 \text{ mA}$, $V_{CE} = 5.0 \text{ V}$, $R_L = 100 \Omega$, GaAs Source.



OPTOELECTRONIC TECHNOLOGY	1
DISCRETE LED DIGIT RELIABILITY	2
VISIBLE LED LAMPS AND MOUNTING HARDWARE	3
SEVEN-SEGMENT DISPLAYS AND DISPLAY ARRAYS	4
PHOTOTRANSISTORS, INFRARED EMITTERS, AND SENSORS	5
PHOTOCOUPLERS	6
PACKAGE OUTLINES	7
DEFINITIONS OF SYMBOLS AND TERMS	8
FAIRCHILD FIELD SALES OFFICES, SALES REPRESENTATIVES AND DISTRIBUTOR LOCATIONS	9

CHAPTER 6

INTRODUCTION

Phototransistor operation is a result of the photo-effect in certain types of semiconductors. Light of the proper wavelength generates hole-electron pairs within the transistor, and an applied voltage causes these carriers to move, resulting in current flow. The intensity of the applied light determines the number of carrier pairs and, therefore, the magnitude of the resultant current.

In a phototransistor, the actual carrier generation takes place in the vicinity of the collector-base junction. A hole generated in the base remains there, while a hole generated in the collector is drawn into the base by the strong field at the junction. The same process results in electrons tending to accumulate in the collector. However, charge does not actually accumulate; rather, it tries to distribute evenly throughout the bulk regions. Consequently, holes diffuse across the base region in the direction of the base-emitter junction. When the holes reach this junction, they are injected into the emitter, causing the emitter in turn to inject electrons into the base. Since the emitter injection efficiency is much greater than that of the base, each injected hole results in many injected electrons. At this point, normal transistor action occurs, with the emitter-injector electrons migrating across the base and being down into the collector. The injected electrons combine with the photo-induced electrons and appear as the terminal-collector current.

A phototransistor may thus be considered to be a diffused-junction, photo-sensitive diode in parallel with the collector-base junction of a silicon npn transistor. As the current increases, the collector voltage decreases. When V_{CE} is equal to V_{BE} , the photocurrent source becomes a photovoltaic source and allows the phototransistor to saturate.

A phototransistor may be used as a photodiode simply by using the collector and base leads and leaving the emitter open. Although this reduces sensitivity and efficiency, it does increase speed. Photodiode operation is generally required for switching and digital applications; phototransistor operation is used for analog circuits.

INFRARED-EMITTING LEDs

An infrared-emitting LED (IRLED) is identical to a visible LED, except that zinc is diffused into the gallium arsenide compound. The resulting pn junction emits light in the 890-nanometer wave-length range. This light is invisible to the human eye, but is ideally matched to the spectral response of silicon photodetectors. When used in conjunction with photodiodes or phototransistors, IRLEDs form a system offering useful ac and dc characteristics. For both large, fixed equipment and portable, battery-operated equipment, this combination of devices offers the following features:

- Low cost
- High-speed operation
- High reliability
- Low power requirements
- Small size
- Integrated circuit compatibility.

COUPLER CROSS REFERENCE KEY

COMPETITOR:

GE	General Electric
HP	Hewlett-Packard
LIT	Litronix
MON	Monsanto
MOT	Motorola
TI	Texas Instruments

MIN CTR:

Minimum current transfer ratio with $V_{CE} = 10 \text{ V}$, $I_F = 10 \text{ mA}$

MIN ISO VOLTAGE:

Minimum isolation voltage (peak) in volts (dc)

TYPICAL RESPONSE TIME:

Typical rise time (t_r) and fall time (t_f) in microseconds under test conditions $R_L = 100 \ \Omega$, $I_C = 2 \text{ mA}$, $V_{CE} = 10 \text{ V}$

CODE:	NC-P	Not crossable because of package differences
	NC-E	Not crossable because of electrical differences
	A	Fairchild device is a direct replacement
	B	Fairchild device is easily crossable with minor electrical deviations as noted
	C	Fairchild device is easily crossable with minor mechanical deviations as noted
	D	Significant electrical differences between devices as noted
	E	Significant mechanical differences between devices as noted
	X	Direct replacement available 2nd quarter 1978
	Y	Device could be easily crossed with high volume order.

NOTES:	1	Competitor device is 8 lead plastic dip package
	2	Competitor device has different pin-out
	3	Competitor device is logic gate with open collector
	4	Competitor device is TO-18 metal can package
	5	Competitor device is reliability conditioned
	6	Competitor device is dual channel
	7	Package dimension difference between devices
	8	FSC device has transistor output
	9	Competitor device is slotted coupler
	10	Isolation voltage on competitor device is tested 1 second rms
	11	Competitor device has special electrical: $V_{CEO} = 80 \text{ V}$, $V_{CBO} = 80 \text{ V}$, $V_{ECO} = 7 \text{ V}$
	12	Competitor device specified with special test circuit
	13	Competitor device has 2 emitters; ac or polarity insensitive inputs
	14	Competitor device has $BV_{CEO} = 55 \text{ V}$ minimum
	15	Competitor device has $V_F = 1.0 \text{ V}$ typical, 1.15 V max at $I_F = .5 \text{ mA}$
	16	Competitor device is a reflective array
	17	Competitor device is a matched emitter-detector pair
	18	Competitor device is in a clear epoxy package
	19	Competitor device has 4 channels in a 16 lead plastic dip package
	20	Competitor device has $BV_{CEO} = 80 \text{ V}$ min.
	21	Competitor device is a DTL/TTL compatible optically isolated gate
	22	Competitor device has TTL compatible input and output
	23	Competitor device has 16 pin dual inline ceramic package
	24	Competitor device has hermetic package
	25	Motorola device has 20% CTR min. GE device is a 10% CTR min.
	26	Motorola device has isolation voltage of 2500 V_{dc} min.
	27	Same device as HP 6N137
	28	Same device as HP 6N138
	29	Same device as HP 6N139
	30	Response time test condition/measurement difference
	31	Same device as HP 6N135
	32	Same device as HP 6N136

COUPLER CROSS REFERENCE KEY (cont'd)

NOTES (cont'd):

- 33 Same device as HCPL-2502
- 34 Same device as HCPL-2530
- 35 Same device as HCPL-2531
- 36 Same device as HCPL-2601
- 37 Same device as HCPL-2630
- 38 Same device as 6N134
- 39 Same device as 6N134TXV
- 40 Same device as 6N134TXVB
- 41 FCS cross is selected from device listed
- 42 High V_{CE0} couplers (200 V-300 V)
- 43 Competition specifications not available at this time
- 44 Min ISO voltage test condition/measurement difference
- 45 Min CTR test condition/measurement difference

COUPLER CROSS REFERENCE

DEVICE	COMPETITOR	OUTPUT DEVICE	MIN CTR (%)	MIN ISO VOLTAGE (V)	TYPICAL RESPONSE TIME		FAIRCHILD DEVICE	CODE	NOTES
					(t_r)	(t_f)			
4N22	TI	Transistor	25	1000	15	15		NC-P	2,24
4N23	TI	Transistor	60	1000	15	15		NC-P	2,24
4N24	TI	Transistor	100	1000	15	15		NC-P	2,24
4N25	MON/GE/MOT	Transistor	20	2500	2.5	2.6	4N25	A	
4N25A	GE/MOT	Transistor	20	1775	2.5	2.6	4N25	A/Y	10,26
4N26	MON/GE/MOT	Transistor	20	1500	2.5	2.6	4N26	A	
4N27	MON/GE/MOT	Transistor	10	1500	2.5	2.6	4N27	A	
4N28	MON/GE/MOT	Transistor	10	500	2.5	2.6	4N28	A	
4N29	MON/GE/MOT	Darlington	100	2500	.6	17	4N29	A	30
4N29A	GE/MOT	Darlington	100	1775	.6	17	4N29	A/Y	10,26
4N30	MON/GE/MOT	Darlington	100	1500	.6	17	4N30	A	30
4N31	MON/GE/MOT	Darlington	50	1500	.6	17	4N31	A	30
4N32	MON/GE/MOT	Darlington	500	2500	.6	45	4N32	A	30
4N32A	GE/MOT	Darlington	500	1775	.6	45	4N32	A/Y	10,26
4N33	MON/GE/MOT	Darlington	500	1500	.6	45	4N33	A	30
4N35	MON/GE/MOT	Transistor	100	3550	5	5	4N35	A	
4N36	MON/GE/MOT	Transistor	100	2500	5	5	4N36	A	
4N37	MON/GE/MOT	Transistor	100	1500	5	5	4N37	A	
4N38	GE/MOT	Transistor	10	1500	5	5		Y	11,25
4N38A	GE/MOT	Transistor	10	2500	5	5		Y	11,25,26
4N39	GE	SCR		1500				NC-E	
4N40	GE	SCR		1500				NC-E	
4N45	HP	Darlington	200	3000	5	150		NC-E	2,30
4N46	HP	Darlington	200	3000	5	150		NC-E	2,30
6N134	HP	Logic Gate		1500	.065	.055		NC-E	6,22,23,24
6N134TXV	HP	Logic Gate		1500	.065	.055		NC-E	6,22,23,24
6N134TXVB	HP	Logic Gate		1500	.065	.055		NC-E	5,6,22,23,24
6N135	HP	Transistor	7	3000	.5	.4		NC-E	1,2,30
6N136	HP	Transistor	19	3000	.2	.3		NC-E	1,2,30
6N137	HP	Logic Gate	600	3000	.025	.025		NC-E	1,2,21,30
6N138	HP	Photo Diode	300	3000	5	5		NC-E	1,2,30
6N139	HP	Photo Diode	400	3000	1	4		NC-E	1,2,30
5082-4350	HP	Photo Circuit	7	3000	.5	.4		NC-E	1,2,30,31
5082-4351	HP	Transistor	19	3000	.2	.3		NC-E	1,2,30,32
5082-4352	HP	Transistor	15	3000	.2	.3		NC-E	1,2,30,33
5082-4354	HP	Transistor	7	3000	.3	.4		NC-E	1,2,6,30,34
5082-4355	HP	Transistor	19	3000	.2	.3		NC-E	1,2,6,30,35
5082-4360	HP	Logic Gate	600	3000	.025	.025		NC-E	1,2,21,27,30

COUPLER CROSS REFERENCE KEY (cont'd)

DEVICE	COMPETITOR	OUTPUT DEVICE	MIN CTR (%)	MIN ISO VOLTAGE (V)	TYPICAL RESPONSE TIME (tr — tf) (μs)		FAIRCHILD DEVICE	CODE	NOTES
5082-4361	HP	Logic Gate		3000	.025	.015		NC-E	1,2,22,30,36
5082-4364	HP	Gate		3000	.025	.025		NC-E	1,2,6,30,37
5082-4365	HP	Logic Gate		1500	.065	.055		NC-E	6,22,23,24,38
5082-4370	HP	Photo Diode	300	3000	5	5		NC-E	1,2,28,30
5082-4371	HP	Photo Diode	400	3000	1	4		NC-E	1,2,29,30
HCPL-2502	HP	Transistor	15	3000	.2	.3		NC-E	1,2,30
HCPL-2530	HP	Transistor	7	3000	.3	.4		NC-E	1,2,6,30
HCPL-2531	HP	Transistor	19	3000	.2	.3		NC-E	1,2,6,30
HCPL-2601	HP	Logic Gate		3000	.025	.025		NC-E	1,2,22,30
HCPL-2602	HP	Photo Circuit		3000	.025	.015		NC-E	1,2,30
HCPL-2630	HP	Gate		3000	.025	.025		NC-E	1,2,30
HCPL-2730	HP	Photo Circuit	300	3000	5	10		NC-E	1,2,6,22,30
HCPL-2731	HP	Photo Circuit	400	3000	5	10		NC-E	1,2,6,22,30
HCPL-2770	HP	Photo Circuit	300	1500	10	2		NC-E	23,24,30
TX4365	HP	Logic Gate		1500	.065	.055		NC-E	6,22,23,24,39
TXB4365	HP	Logic Gate		1500	.065	.055		NC-E	5,6,22,23,24,4
TXHCPL2770	HP	Photo Circuit	300	1500	10	2		NC-E	23,24,30
TXBHCPL2770	HP	Photo Circuit	300	1500	10	2		NC-E	5,23,24,30
H11A1	GE	Transistor	50	2500	2	2	H11A1	A	
H11A2	GE	Transistor	20	1500	2	2	H11A2	A	
H11A3	GE	Transistor	20	2500	2	2	H11A3	A	
H11A4	GE	Transistor	10	1500	2	2	H11A4	A	
H11A5	GE	Transistor	30	1500	2	2	FCD820A	Y	41
H11A10	GE	Transistor	10	1500	5	5	FCD810A	Y	12,41
H11A520	GE	Transistor	20	5000	5	5	FCD820D	A	
H11A550	GE	Transistor	50	5000	5	5	FCD825D	A	
H11A5100	GE	Transistor	100	5000	5	5	4N35	D/Y	41
H11AA1	GE	Transistor	20	1500				NC-E	13
H11AA2	GE	Transistor	10	1500				NC-E	13
H11B1	GE	Darlington	500	2500	125	100	H11B1	A	
H11B2	GE	Darlington	200	1500	125	100	H11B2	A	
H11B3	GE	Darlington	100	1500	125	100	FCD850	A	
H11B255	GE	Darlington	100	1500	125	100	FCD855	B	14
H11BX522	GE	Darlington	200	2500			FCD860C	B	15
H11C1	GE	SCR		2500				NC-E	
H11C2	GE	SCR		2100				NC-E	
H11C3	GE	SCR		1500				NC-E	
H11C4	GE	SCR		2500				NC-E	
H11C5	GE	SCR		2100				NC-E	
H11C6	GE	SCR		1500				NC-E	
H11D1	GE	Transistor	20	2500	5	5		NC-E	42
H11D2	GE	Transistor	20	1500	5	5		NC-E	42
H11D3	GE	Transistor	20	1500	5	5		NC-E	42
H11D4	GE	Transistor	10	1500	5	5		NC-E	42
H13A1	GE	Transistor			5	5		NC-P	9
H13A2	GE	Transistor			5	5		NC-P	9
H13B1	GE	Darlington			150	150		NC-P	9
H13B2	GE	Darlington			150	150		NC-P	9
H15A1	GE	Transistor	20	5650	3	3	FPA108	D	7,16
H15A2	GE	Transistor	10	5650	3	3	FPA108	D	7,16
H15B1	GE	Darlington	400	5650	125	100		D/Y	7,16,30
H15B2	GE	Darlington	200	5650	125	100		D/Y	7,16,30
H17A1	GE	Transistor			5	5	FPT610	E	17
							FPE106		
H17B1	GE	Darlington			150	150	FP106	E	8,17,30
							FPT610		
H19A1	GE	Transistor			5	5		NC-P	17,18
H19B1	GE	Darlington			150	150		NC-P	17,18
H74A1	GE	Transistor		1500				NC-E	22
H74C1	GE	SCR		1500				NC-E	
H74C2	GE	SCR		1500				NC-E	
IL1	LIT	Transistor	20	2500	2	2	IL1	A	
IL5	LIT	Transistor	50	2500	2	2	FCD825B	A	30
IL12	LIT	Transistor	10	1000	2	2	IL12	A	
IL15	LIT	Transistor	6	1500	2	2	IL15	A	

6

COUPLER CROSS REFERENCE KEY (cont'd)

DEVICE	COMPETITOR	OUTPUT DEVICE	MIN CTR (%)	MIN ISO VOLTAGE (V)	TYPICAL RESPONSE TIME		FAIRCHILD DEVICE	CODE	NOTES
					(t _r)	(t _f)			
IL16	LIT	Transistor	6	1500	2	2	IL16	A	
IL74	LIT	Transistor	125	1500	6	25	IL74	A	30
IL100	LIT	Photo Circuit (K)	1000 Typ	2500	.015	.015		NC-E	1,30
IL101	LIT	Photo Circuit (K)	1000 Typ	1500	.015	.015		NC-E	1,30
ILA30	LIT	Darlington	100	1500	10	35	MCA230	A	30
ILA55	LIT	Darlington	100	1500	10	35	MCA255	A	30
ILD74	LIT	Transistor	125	1500	6	25		NC-E	1,6,30
ILQ74	LIT	Transistor	125	1500	6	25		NC-E	19,30
ILCA2-30	LIT	Darlington	100	1500	10	35	MCA230	A	30
ILCA2-55	LIT	Darlington	100	1500	10	35	MCA255	A	30
ILCT6	LIT	Transistor	50	1500	2.4	2.4		NC-P	1,6
MCA7	MON	Darlington	0.1		600	600		D/Y	2,7,8,16
MCA8	MON	Darlington	15		300	1000		NC-P	9
MCA81	MON	Darlington	4		150	200		NC-P	9
MCA230	MON	Darlington	100	1500	5	35	MCA230	A	
MCA231	MON	Darlington	200	1500	5	35	MCA231	A	
MCA255	MON	Darlington	100	1500	5	35	MCA255	A	
MCL600	MON	Logic Gate						NC-E	1,43
MCL601	MON	Logic Gate		2000	.01	.01		NC-E	1,3
MCL610	MON	Logic Gate						NC-E	1,43
MCL611	MON	Logic Gate		2000	.01	.01		NC-E	1,3
MCT2	MON	Transistor	20	1500	2.5	2.6	MCT2	A	
MCT2E	MON	Transistor	20	2500	2.5	2.6	MCT2	A	
MCT4	MON	Transistor	15	1000	2	2		NC-P	2,4
MCT4R	MON	Transistor	15	1000	2	2		NC-P	2,4,5
MCT6	MON	Transistor	20	1500	2.4	2.4		X	1,2,6
MCT8	MON	Transistor			3	4		NC-P	9
MCT26	MON	Transistor	6	1500	2	2	MCT26	A	
MCT66	MON	Transistor	6	1500	2.4	2.4		X	1,2,6
MCT210	MON	Transistor	150	4000	4	5	4N35	D/Y	41
MCS2	MON	SCR		1500				NC-E	
MCS2400	MON	SCR		1500				NC-E	
MCS6200	MON	Dual SCR		1500				NC-E	1
MCS6201	MON	Dual SCR		2500				NC-E	1
MCT271	MON	Transistor							43
MCT272	MON	Transistor							43
MCT273	MON	Transistor							43
MCT274	MON	Transistor							43
MCT275	MON	Transistor							43
MCT276	MON	Transistor							43
MCT277	MON	Transistor							43
MCT81	MON	Transistor			3	4		NC-P	9
MOC119	MOT	Darlington	300	1500			TIL119	A	
MOC1005	MOT	Transistor	20	5000			FCD820C	A	
MOC1006	MOT	Transistor	10	5000			FCD810C	A	
MOC1200	MOT	Darlington	100	1500			4N30	A	
MOC8030	MOT	Darlington	300	1500				NC-E	20
MOC8050	MOT	Darlington	500	1500				NC-E	20
MOC3000	MOT	Photo Circuit		5000				NC-E	
MOC3001	MOT	Photo Circuit		5000				NC-E	
MOC3002	MOT	Photo Circuit	5000					NC-E	
MOC3003	MOT	Photo Circuit	5000					NC-E	
MOC5000	MOT	Photo Circuit	1500	.250	.65			NC-E	
MOC5001	MOT	Photo Circuit		500	.3	.4		NC-E	
TIL102	TI	Transistor	25	1000	3	3		NC-P	2,24,30
TIL103	TI	Transistor	100	1000	6	6		NC-P	2,24,30
TIL107	TI	Transistor	3	1000	5	5		NC-P	2,24,30
TIL108	TI	Transistor	10	1000	5	5		NC-P	2,24,30
TIL109	TI	Transistor	.7	5000	5	5		NC-P	2,30
TIL111	TI	Transistor	12	1500	2	2	TIL111	A	
TIL112	TI	Transistor	2	1500	2	2	TIL112	A	
TIL113	TI	Darlington	300	1500	50	50	TIL113	A	30
TIL114	TI	Transistor	12	2500	2	2	TIL114	A	
TIL115	TI	Transistor	2	1500	2	2	TIL115	A	
TIL116	TI	Transistor	20	2500	2	2	TIL116	A	
TIL117	TI	Transistor	50	2500	2	2	TIL117	A	

COUPLER CROSS REFERENCE

DEVICE	COMPETITOR	OUTPUT DEVICE	MIN CTR (%)	MIN ISO VOLTAGE (V)	TYPICAL RESPONSE TIME		FAIRCHILD DEVICE	CODE	NOTES
					(t_r)	(t_f)			
TIL118	TI	Transistor	10	1500	2	2	TIL118	A	
TIL119	TI	Darlington	300	1500	50	50	TIL119	A	30
TIL120	TI	Transistor	25	1000	3	3		NC-P	2,24
TIL121	TI	Transistor	50	1000	6	6		NC-P	2,24

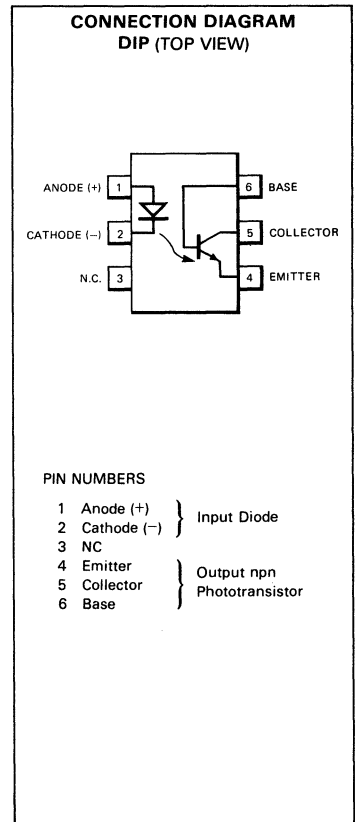
FCD810 • FCD810C

OPTICALLY-COUPLED ISOLATOR

OPTOELECTRONICS PRODUCT GROUP

GENERAL DESCRIPTION – The FCD810 series of optoisolators combines a gallium arsenide infrared emitting diode and a silicon npn phototransistor in close proximity. Optical intercoupling provides a high degree of ac and dc isolation. A capability for continuous operation of the input diode results in a frequency response extending to dc. Connection to the transistor base is also provided for design flexibility.

- GLASSOLATED™
- 1500 V TO 6000 V MINIMUM ISOLATION INPUT-TO-OUTPUT
- $10^{11} \Omega$ ISOLATION RESISTANCE
- LOW COUPLING CAPACITANCE – TYPICALLY 1.0 pF



ABSOLUTE MAXIMUM RATINGS

Storage Temperature	-55°C to +150°C
Operating Temperature	-55°C to +100°C
Pin Temperature (Soldering, 5 s)	260°C
Total Package Power Dissipation at $T_A = 25^\circ\text{C}$ (LED plus Detector)	250 mW
Derate Linearly from 25°C	3.3 mW/°C

INPUT DIODE

V_R	Reverse Voltage	3.0 V
I_F	Forward Current	60 mA
i_f	Peak Forward Current (1 μs pulse width, 300 pps)	3.0 A
P_D	Power Dissipation at $T_A = 25^\circ\text{C}$	100 mW
	Derate Linearly from 25°C	1.33 mW/°C

OUTPUT TRANSISTOR

V_{CE}	Collector to Emitter Voltage	20 V
V_{CB}	Collector to Base Voltage	50 V
I_C	Collector Current	25 mA
P_D	Power Dissipation at $T_A = 25^\circ\text{C}$	150 mW
	Derate Linearly from 25°C	2.0 mW/°C

ELECTRICAL CHARACTERISTICS – INPUT DIODE: $T_A = 25^\circ\text{C}$

SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	TEST CONDITIONS
V_F	Forward Voltage		1.2	1.5	V	$I_F = 10 \text{ mA}$
BV_R	Reverse Breakdown Voltage	3.0	8.0		V	$I_R = 1.0 \text{ mA}$

FAIRCHILD • FCD810 • FCD810C

ELECTRICAL CHARACTERISTICS – OUTPUT TRANSISTOR: $T_A = 25^\circ\text{C}$

SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	TEST CONDITIONS
V_{CE0}	Collector-Emitter Voltage	20	50		V	$I_C = 1.0\text{ mA}, I_F = 0$
V_{CB0}	Collector-Base Voltage	50			V	$I_C = 100\ \mu\text{A}, I_F = 0$
I_{CE0}	Collector-Emitter Leakage Current			100	nA	$V_{CE} = 10\text{ V}, I_F = 0$
I_{CB0}	Collector-Base Leakage Current			100	nA	$V_{CB} = 10\text{ V}, I_F = 0$
h_{FE}	Forward Current Gain	50	250			$V_{CE} = 5.0\text{ V}, I_C = 100\ \mu\text{A}$
C_{cb}	Collector-Base Capacitance		20		pF	$V_{CB} = 10\text{ V}$
C_{eb}	Emitter-Base Capacitance		10		pF	$V_{EB} = 0$

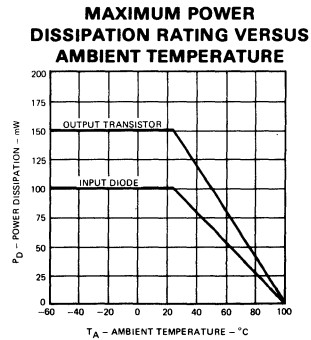
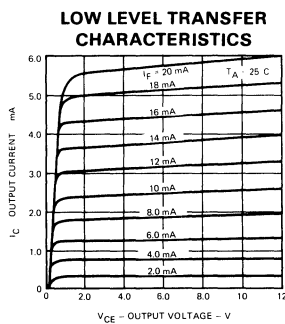
ELECTRICAL CHARACTERISTICS – COUPLED: $T_A = 25^\circ\text{C}$

SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	TEST CONDITIONS
V_{IO}	Input-to-Output Voltage					
	FCD810	1500			V_{rms}	
	FCD810C	5000			V_{pk}	
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage		0.3	0.7	V	$I_C = 2.6\text{ mA}, I_F = 50\text{ mA}$
$I_C/I_F(CTR)$	Collector Current Transfer Ratio (Note 1)	10	25		%	$V_{CE} = 10\text{ V}, I_F = 10\text{ mA}$
R_{IO}	Input-to-Output Resistance	10^{11}			Ω	$V_{IO} = 500\text{ V}$
C_{IO}	Input-to-Output Capacitance		1.0		pF	$f = 1.0\text{ MHz}$
t_r, t_f	Collector Rise and Fall Times (Note 2)		4.0		μs	$I_C = 2.0\text{ mA}, V_{CE} = 10\text{ V}, R_L = 100\ \Omega$

NOTES:

- Collector current transfer ratio is defined as the ratio of the collector current to the forward bias input current.
- Rise time is defined as the time for the collector current to rise from 10% to 90% of peak value. Fall time is defined as the time required for the current to decrease from 90% to 10% of peak value.

TYPICAL ELECTRICAL CHARACTERISTIC CURVES



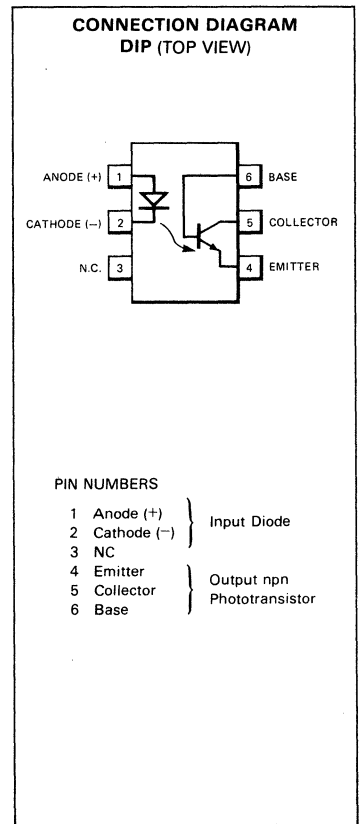
FCD820 • FCD820C

OPTICALLY-COUPLED ISOLATOR

OPTOELECTRONICS PRODUCT GROUP

GENERAL DESCRIPTION – The FCD820 series of optoisolators combines a gallium arsenide infrared emitting diode and a silicon npn phototransistor in close proximity. Optical intercoupling provides a high degree of ac and dc isolation. A capability for continuous operation of the input diode results in a frequency response extending to dc. Connection to the transistor base is also provided for design flexibility. The FCD820 is covered under U.L. component recognition program, reference file E55299.

- **GLASSLATED™**
- **HIGH CURRENT TRANSFER RATIO – TYPICALLY 50%**
- **1500 V TO 6000 V MINIMUM ISOLATION INPUT-TO-OUTPUT**
- **$10^{11} \Omega$ ISOLATION RESISTANCE**
- **LOW COUPLING CAPACITANCE – TYPICALLY 1.0 pF**



ABSOLUTE MAXIMUM RATINGS

Storage Temperature	-55°C to +150°C
Operating Temperature	-55°C to +100°C
Pin Temperature (Soldering, 5 s)	260°C
Total Package Power Dissipation at $T_A = 25^\circ\text{C}$ (LED plus Detector)	250 mW
Derate Linearly from 25°C	3.3 mW/°C

INPUT DIODE

V_R	Reverse Voltage	3.0 V
I_F	Forward Current	60 mA
i_f	Peak Forward Current (1 μs pulse width, 300 pps)	3.0 A
P_D	Power Dissipation at $T_A = 25^\circ\text{C}$	100 mW
	Derate Linearly from 25°C	1.33 mW/°C

OUTPUT TRANSISTOR

V_{CE}	Collector to Emitter Voltage	30 V
V_{CB}	Collector to Base Voltage	70 V
I_C	Collector Current	25 mA
P_D	Power Dissipation at $T_A = 25^\circ\text{C}$	150 mW
	Derate Linearly from 25°C	2.0 mW/°C

ELECTRICAL CHARACTERISTICS – INPUT DIODE: $T_A = 25^\circ\text{C}$

SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	TEST CONDITIONS
V_F	Forward Voltage		1.2	1.5	V	$I_F = 60 \text{ mA}$
BV_R	Reverse Breakdown Voltage	3.0	8.0		V	$I_R = 10 \mu\text{A}$

FAIRCHILD • FCD820 • FCD820C

ELECTRICAL CHARACTERISTICS – OUTPUT TRANSISTOR: $T_A = 25^\circ\text{C}$

SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	TEST CONDITIONS
V_{CE0}	Collector-Emitter Voltage	30	65		V	$I_C = 1.0\text{ mA}$, $I_F = 0$
V_{CBO}	Collector-Base Voltage	70	165		V	$I_C = 100\ \mu\text{A}$, $I_F = 0$
I_{CEO}	Collector-Emitter Leakage Current			50	nA	$V_{CE} = 10\text{ V}$, $I_F = 0$
I_{CBO}	Collector-Base Leakage Current			20	nA	$V_{CB} = 10\text{ V}$, $I_F = 0$
h_{FE}	Forward Current Gain	100	250			$V_{CE} = 5.0\text{ V}$, $I_C = 100\ \mu\text{A}$
C_{cb}	Collector-Base Capacitance		20		pF	$V_{CB} = 10\text{ V}$
C_{eb}	Emitter-Base Capacitance		10		pF	$V_{EB} = 0$

ELECTRICAL CHARACTERISTICS – COUPLED: $T_A = 25^\circ\text{C}$

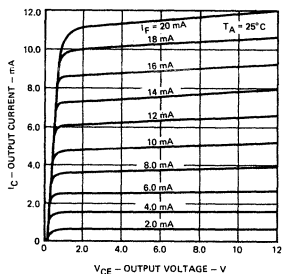
SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	TEST CONDITIONS
V_{IO}	Input-to-Output Voltage FCD820 FCD820C	1500 5000			V_{rms} V_{pk}	
$V_{CE(SAT)}$	Collector-Emitter Saturation Voltage		0.24	0.40	V	$I_C = 2.2\text{ mA}$, $I_F = 15\text{ mA}$ (FCD820, $I_C = 2.0\text{ mA}$, $I_F = 10\text{ mA}$)
$I_C/I_F(CTR)$	Collector Current Transfer Ratio (Note 1)	20	50		%	$V_{CE} = 10\text{ V}$, $I_F = 10\text{ mA}$ (FCD820, $V_{CE} = 0.4\text{ V}$)
R_{IO}	Input-to-Output Resistance	10^{11}			Ω	$V_{IO} = 500\text{ V}$
C_{IO}	Input-to-Output Capacitance		1.0		pF	$f = 1.0\text{ MHz}$
t_r, t_f	Collector Rise and Fall Times (Note 2)		2.5		μs	$I_C = 2.0\text{ mA}$, $V_{CE} = 10\text{ V}$, $R_L = 100\ \Omega$

NOTES:

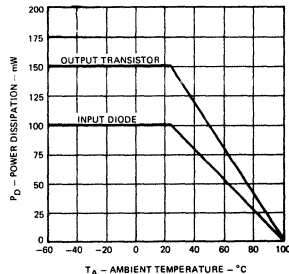
- Collector current transfer ratio is defined as the ratio of the collector current to the forward bias input current.
- Rise time is defined as the time for the collector current to rise from 10% to 90% of peak value. Fall time is defined as the time required for the current to decrease from 90% to 10% of peak value.

TYPICAL ELECTRICAL CHARACTERISTIC CURVES

LOW LEVEL TRANSFER CHARACTERISTICS



MAXIMUM POWER DISSIPATION RATING VERSUS AMBIENT TEMPERATURE



FCD825 • FCD825C

OPTICALLY – COUPLED ISOLATOR

OPTOELECTRONICS PRODUCT GROUP

GENERAL DESCRIPTION – The FCD825 series of optoisolators have a npn silicon Planar* phototransistor and a gallium arsenide diode in close proximity. Optical intercoupling provides a high degree of ac and dc isolation. A capability for continuous operation of the input diode results in a frequency response extending to dc. Connection to the transistor base is also provided for design flexibility.

- GLASSOLATED™
- HIGH CURRENT TRANSFER RATIO – TYPICALLY 80%
- 1500 V TO 6000 V MINIMUM ISOLATION INPUT-TO-OUTPUT
- $10^{11} \Omega$ ISOLATION RESISTANCE
- LOW COUPLING CAPACITANCE – TYPICALLY 1.0 pF

ABSOLUTE MAXIMUM RATINGS

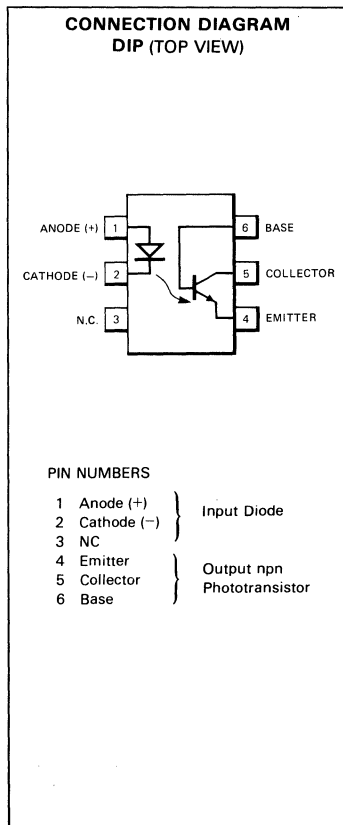
Storage Temperature	–55°C to +150°C
Operating Temperature	–55°C to +100°C
Pin Temperature (Soldering, 5 s)	260°C
Total Package Power Dissipation at $T_A = 25^\circ\text{C}$ (LED plus Detector)	250 mW
Derate Linearly from 25°C	3.3 mW/°C

INPUT DIODE

V_R	Reverse Voltage	3.0 V
I_F	Forward Current	60 mA
i_f	Peak Forward Current (1 μs pulse width, 300 pps)	3.0 A
P_D	Power Dissipation at $T_A = 25^\circ\text{C}$	100 mW
	Derate Linearly from 25°C	1.33 mW/°C

OUTPUT TRANSISTOR

V_{CE}	Collector to Emitter Voltage	30 V
V_{CB}	Collector to Base Voltage	70 V
I_C	Collector Current	25 mA
P_D	Power Dissipation at $T_A = 25^\circ\text{C}$	150 mW
	Derate Linearly from 25°C	2.0 mW/°C



ELECTRICAL CHARACTERISTICS – INPUT DIODE: $T_A = 25^\circ\text{C}$

SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	TEST CONDITIONS
V_F	Forward Voltage		1.3	1.5	V	$I_F = 60 \text{ mA}$
BV_R	Reverse Breakdown Voltage	3.0	8.0		V	$I_R = 10 \mu\text{A}$

*Planar is a patented Fairchild process.

FAIRCHILD • FCD825 • FCD825C

ELECTRICAL CHARACTERISTICS – OUTPUT TRANSISTOR: $T_A = 25^\circ\text{C}$

SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	TEST CONDITIONS
V_{CE0}	Collector-Emitter Voltage	30	50		V	$I_C = 1.0 \text{ mA}, I_F = 0$
V_{CBO}	Collector-Base Voltage	70	150		V	$I_C = 10 \mu\text{A}, I_F = 0$
I_{CE0}	Collector-Emitter Leakage Current		2.0	50	nA	$V_{CE} = 10 \text{ V}, I_F = 0$
I_{CBO}	Collector-Base Leakage Current			20	nA	$V_{CB} = 10 \text{ V}, I_F = 0$
h_{FE}	Forward Current Gain	100	350			$V_{CE} = 5.0 \text{ V}, I_C = 100 \mu\text{A}$
C_{cb}	Collector-Base Capacitance		20		pF	$V_{CB} = 10 \text{ V}$
C_{eb}	Emitter-Base Capacitance		10		pF	$V_{EB} = 0$

ELECTRICAL CHARACTERISTICS – COUPLED: $T_A = 25^\circ\text{C}$

SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	TEST CONDITIONS
V_{IO}	Input-to-Output Voltage FCD825 FCD825C	1500 5000			V_{rms} V_{pk}	
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage		0.24	0.4	V	$I_C = 2.0 \text{ mA}, I_F = 10 \text{ mA}$
$I_C/I_F(\text{CTR})$	Collector Current Transfer Ratio (Note 1)	50	80		%	$V_{CE} = 10 \text{ V}, I_F = 10 \text{ mA}$
R_{IO}	Input-to-Output Resistance	10^{11}			Ω	$V_{IO} = 500 \text{ V}$
C_{IO}	Input-to-Output Capacitance		1.0		pF	$f = 1.0 \text{ MHz}$
t_r, t_f	Collector Rise and Fall Times (Note 2)		3.5		μs	$I_C = 2.0 \text{ mA}, V_{CE} = 10 \text{ V}, R_L = 100 \Omega$

NOTES:

- Collector current transfer ratio is defined as the ratio of the collector current to the forward bias input current.
- Rise time is defined as the time for the collector current to rise from 10% to 90% of peak value. Fall time is defined as the time required for the current to decrease from 90% to 10% of peak value.

FCD830 • FCD830C

OPTICALLY - COUPLED ISOLATOR

OPTOELECTRONICS PRODUCT GROUP

GENERAL DESCRIPTION – The FCD830 series of optoisolators have a npn silicon Planar* phototransistor in close proximity with a gallium arsenide diode. Optical coupling provides a high degree of ac and dc isolation. A capability for continuous operation of the input diode results in a frequency response extending to dc. Connection to the transistor base is also provided for design flexibility.

- GLASSOLATED™
- HIGH CURRENT TRANSFER RATIO – TYPICALLY 50%
- 1500 V TO 6000 V MINIMUM ISOLATION INPUT-TO-OUTPUT
- 10¹¹ ISOLATION RESISTANCE
- LOW COUPLING CAPACITANCE – TYPICALLY 1.0 pF
- HIGH SPEED

ABSOLUTE MAXIMUM RATINGS

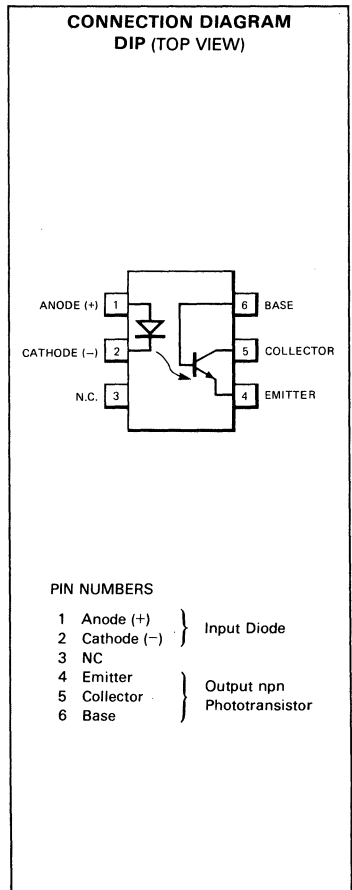
Storage Temperature	–55°C to +150°C
Operating Temperature	–55°C to +100°C
Pin Temperature (Soldering, 5 s)	260°C
Total Package Power Dissipation at T _A = 25°C (LED plus Detector)	250 mW
Derate Linearly from 25°C	3.3 mW/°C

INPUT DIODE

V _R	Reverse Voltage	3.0 V
I _F	Forward Current	60 mA
i _f	Peak Forward Current (1 μs pulse width, 300 pps)	3.0 A
P _D	Power Dissipation at T _A = 25°C	100 mW
	Derate Linearly from 25°C	1.33 mW/°C

OUTPUT TRANSISTOR

V _{CE}	Collector to Emitter Voltage	30 V
V _{CB}	Collector to Base Voltage	70 V
I _C	Collector Current	20 mA
P _D	Power Dissipation at T _A = 25°C	150 mW
	Derate Linearly from 25°C	2.6 mW/°C



ELECTRICAL CHARACTERISTICS – INPUT DIODE: T_A = 25°C

SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	TEST CONDITIONS
V _F	Forward Voltage		1.3	1.5	V	I _F = 60 mA
BV _R	Reverse Breakdown Voltage	3.0	8.0		V	I _R = 10 μA

*Planar is a patented Fairchild process.

FAIRCHILD • FCD830 • FCD830C

ELECTRICAL CHARACTERISTICS – OUTPUT TRANSISTOR: $T_A = 25^\circ\text{C}$

SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	TEST CONDITIONS
V_{CE0}	Collector-Emitter Voltage	30	65		V	$I_C = 1.0 \text{ mA}, I_F = 0$
V_{CBO}	Collector-Base Voltage	70	165		V	$I_C = 10 \mu\text{A}, I_F = 0$
I_{CE0}	Collector-Emitter Leakage Current		2.0	50	nA	$V_{CE} = 10 \text{ V}, I_F = 0$
I_{CBO}	Collector-Base Leakage Current		0.1	20	nA	$V_{CB} = 10 \text{ V}, I_F = 0$
h_{FE}	Forward Current Gain	100				$V_{CE} = 5.0 \text{ V}, I_C = 100 \mu\text{A}$
C_{cb}	Collector-Base Capacitance		7.5		pF	$V_{CB} = 10 \text{ V}$
C_{eb}	Emitter-Base Capacitance		10		pF	$V_{EB} = 0$

ELECTRICAL CHARACTERISTICS – COUPLED: $T_A = 25^\circ\text{C}$

SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	TEST CONDITIONS
V_{IO}	Input-to-Output Voltage					
	FCD830	1500			V_{rms}	
	FCD830C	5000			V_{pk}	
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage		0.24	0.40	V	$I_C = 2.2 \text{ mA}, I_F = 15 \text{ mA}$ (FCD830, $I_C = 2.0 \text{ mA}, I_F = 10 \text{ mA}$)
I_C/I_F (CTR)	Collector Current Transfer Ratio (Note 1)	20	50		%	$V_{CE} = 10 \text{ V}, I_F = 10 \text{ mA}$ (FCD830, $V_{CE} = 0.4 \text{ V}$)
R_{IO}	Input-to-Output Resistance	10^{11}			Ω	$V_{IO} = 500 \text{ V}$
C_{IO}	Input-to-Output Capacitance		1.0		pF	$f = 1.0 \text{ MHz}$
t_r, t_f	Collector Rise and Fall Times (Note 2)		1.6	2.0	μs	$I_C = 2.0 \text{ mA}, V_{CC} = 10 \text{ V}, R_L = 100 \Omega$

NOTES:

- Collector current transfer ratio is defined as the ratio of the collector current to the forward bias input current.
- Rise time is defined as the time for the collector current to rise from 10% to 90% of peak value. Fall time is defined as the time required for the current to decrease from 90% to 10% of peak value.

FCD831 • FCD831C

OPTICALLY — COUPLED ISOLATOR

OPTOELECTRONICS PRODUCT GROUP

GENERAL DESCRIPTION — The FCD831 series of optoisolators combines a gallium arsenide infrared emitting diode and a silicon npn phototransistor in close proximity. Optical intercoupling provides a high degree of ac and dc isolation. A capability for continuous operation of the input diode results in a frequency response extending to dc. Connection to the transistor base is also provided for design flexibility.

- GLASSOLATED™
- 1500 V TO 6000 V MINIMUM ISOLATION INPUT-TO-OUTPUT
- 10¹¹ Ω ISOLATION RESISTANCE
- LOW COUPLING CAPACITANCE — TYPICALLY 1.0 pF
- HIGH SPEED

ABSOLUTE MAXIMUM RATINGS

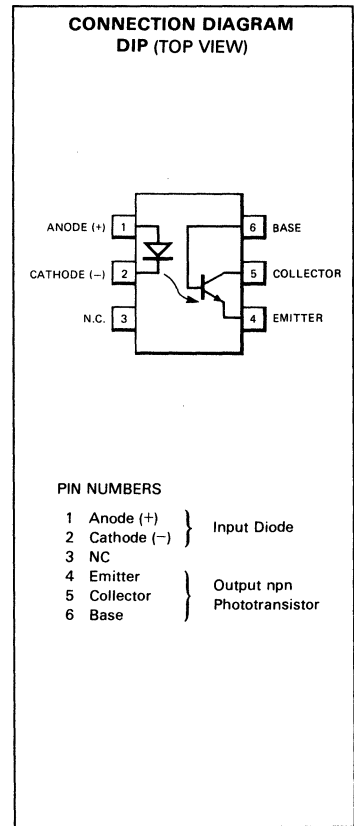
Storage Temperature	-55°C to +150°C
Operating Temperature	-55°C to +100°C
Pin Temperature (Soldering, 5 s)	260°C
Total Package Power Dissipation at T _A = 25°C	250 mW
(LED plus Detector)	
Derate Linearly from 25°C	3.3 mW/°C

INPUT DIODE

V _R	Reverse Voltage	3.0 V
I _F	Forward Current	60 mA
i _f	Peak Forward Current (1 μs pulse width, 300 pps)	3.0 A
P _D	Power Dissipation at T _A = 25°C	100 mW
	Derate Linearly from 25°C	1.33 mW/°C

OUTPUT TRANSISTOR

V _{CE}	Collector to Emitter Voltage	30 V
V _{CB}	Collector to Base Voltage	70 V
I _C	Collector Current	20 mA
P _D	Power Dissipation at T _A = 25°C	150 mW
	Derate Linearly from 25°C	2.0 mW/°C



ELECTRICAL CHARACTERISTICS — INPUT DIODE: T_A = 25°C

SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	TEST CONDITIONS
V _F	Forward Voltage		1.3	1.5	V	I _F = 60 mA
BV _R	Reverse Breakdown Voltage	3.0	8.0		V	I _R = 10 μA

FAIRCHILD • FCD831 • FCD831C

ELECTRICAL CHARACTERISTICS – OUTPUT TRANSISTOR: $T_A = 25^\circ\text{C}$

SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	TEST CONDITIONS
V_{CE0}	Collector-Emitter Voltage	30	65		V	$I_C = 1.0 \text{ mA}, I_F = 0$
V_{CB0}	Collector-Base Voltage	70	165		V	$I_C = 10 \mu\text{A}, I_F = 0$
I_{CE0}	Collector-Emitter Leakage Current		2.0		nA	$V_{CE} = 10 \text{ V}, I_F = 0$
I_{CB0}	Collector-Base Leakage Current		0.1	50	nA	$V_{CB} = 10 \text{ V}, I_F = 0$
h_{FE}	Forward Current Gain		250	20		$V_{CE} = 5.0 \text{ V}, I_C = 100 \mu\text{A}$
C_{cb}	Collector-Base Capacitance	100	7.5		pF	$V_{CB} = 10 \text{ V}$
C_{eb}	Emitter-Base Capacitance		10		pF	$V_{EB} = 0$

ELECTRICAL CHARACTERISTICS – COUPLED: $T_A = 25^\circ\text{C}$

SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	TEST CONDITIONS
V_{IO}	Input-to-Output Voltage FCD831 FCD831C	1500 5000			V_{rms} V_{pk}	
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage		0.30	0.5	V	$I_C = 2.0 \text{ mA}, I_F = 50 \text{ mA}$
$I_C/I_F(\text{CTR})$	Collector Current Transfer Ratio (Note 1)	10	15		%	$V_{CE} = 10 \text{ V}, I_F = 10 \text{ mA}$
R_{IO}	Input-to-Output Resistance	10^{11}			Ω	$V_{IO} = 500 \text{ V}$
C_{IO}	Input-to-Output Capacitance		1.0		pF	$f = 1.0 \text{ MHz}$
t_r, t_f	Collector Rise and Fall Times (Note 2)		1.6	2.0	μs	$I_C = 2.0 \text{ mA}, V_{CE} = 10 \text{ V}, R_L = 100 \Omega$

NOTES:

- Collector current transfer ratio is defined as the ratio of the collector current to the forward bias input current.
- Rise time is defined as the time for the collector current to rise from 10% to 90% of peak value. Fall time is defined as the time required for the current to decrease from 90% to 10% of peak value.

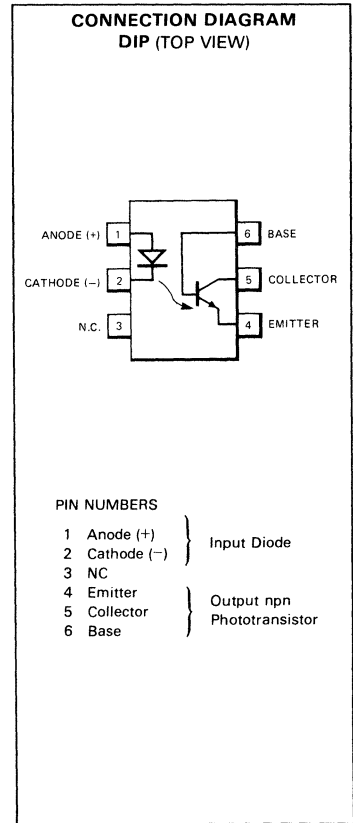
FCD836 • FCD836C

OPTICALLY - COUPLED ISOLATOR

OPTOELECTRONICS PRODUCT GROUP

GENERAL DESCRIPTION – The FCD836 series of optoisolators combines a gallium arsenide infrared emitting diode and a silicon npn phototransistor in close proximity. Optical intercoupling provides a high degree of ac and dc isolation. A capability for continuous operation of the input diode results in a frequency response extending to dc. Connection to the transistor base is also provided for design flexibility.

- GLASSOLATED™
- 1500 V TO 6000 V MINIMUM ISOLATION INPUT-TO-OUTPUT
- 10¹¹ Ω ISOLATION RESISTANCE
- LOW COUPLING CAPACITANCE – TYPICALLY 1.0 pF
- HIGH SPEED



ABSOLUTE MAXIMUM RATINGS

Storage Temperature	-55°C to +150°C
Operating Temperature	-55°C to +100°C
Pin Temperature (Soldering, 5 s)	260°C
Total Package Power Dissipation at T _A = 25°C (LED plus Detector)	250 mW
Derate Linearly from 25°C	3.3 mW/°C

INPUT DIODE

V _R	Reverse Voltage	3.0 V
I _F	Forward Current	60 mA
i _f	Peak Forward Current (1 μs pulse width, 300 pps)	3.0 A
P _D	Power Dissipation at T _A = 25°C	100 mW
	Derate Linearly from 25°C	1.33 mW/°C

OUTPUT TRANSISTOR

V _{CE}	Collector to Emitter Voltage	20 V
V _{CB}	Collector to Base Voltage	30 V
I _C	Collector Current	20 mA
P _D	Power Dissipation at T _A = 25°C	150 mW
	Derate Linearly from 25°C	2.0 mW/°C

ELECTRICAL CHARACTERISTICS – INPUT DIODE: T_A = 25°C

SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	TEST CONDITIONS
V _F	Forward Voltage		1.3	1.5	V	I _F = 10 mA
BV _R	Reverse Breakdown Voltage	3.0	8.0		V	I _R = 10 μA

FAIRCHILD • FCD836 • FCD836C

ELECTRICAL CHARACTERISTICS – OUTPUT TRANSISTOR: $T_A = 25^\circ\text{C}$

SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	TEST CONDITIONS
V_{CEO}	Collector-Emitter Voltage	20	50		V	$I_C = 1.0\text{ mA}, I_F = 0$
V_{CBO}	Collector-Base Voltage	30	60		V	$I_C = 10\ \mu\text{A}, I_F = 0$
I_{CEO}	Collector-Emitter Leakage Current		2.0	100	nA	$V_{CE} = 10\text{ V}, I_F = 0$
I_{CBO}	Collector-Base Leakage Current		0.1	20	nA	$V_{CB} = 10\text{ V}, I_F = 0$
h_{FE}	Forward Current Gain	50	250			$V_{CE} = 5.0\text{ V}, I_C = 100\ \mu\text{A}$
C_{cb}	Collector-Base Capacitance		7.5		pF	$V_{CB} = 10\text{ V}$
C_{eb}	Emitter-Base Capacitance		10		pF	$V_{EB} = 0$

ELECTRICAL CHARACTERISTICS – COUPLED: $T_A = 25^\circ\text{C}$

SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	TEST CONDITIONS
V_{IO}	Input-to-Output Voltage FCD836 FCD836C	1500 5000			V_{rms} V_{pk}	
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage		0.35	0.7	V	$I_C = 2.0\text{ mA}, I_F = 50\text{ mA}$
$I_C/I_F(\text{CTR})$	Collector Current Transfer Ratio (Note 1)	6.0	10		%	$V_{CE} = 10\text{ V}, I_F = 10\text{ mA}$
R_{IO}	Input-to-Output Resistance	10^{11}			Ω	$V_{IO} = 500\text{ V}$
C_{IO}	Input-to-Output Capacitance		1.0		pF	$f = 1.0\text{ MHz}$
t_r, t_f	Collector Rise and Fall Times (Note 2)		1.6	2.0	μs	$I_C = 2.0\text{ mA}, V_{CE} = 10\text{ V}, R_L = 100\ \Omega$

NOTES:

- Collector current transfer ratio is defined as the ratio of the collector current to the forward bias input current.
- Rise time is defined as the time for the collector current to rise from 10% to 90% of peak value. Fall time is defined as the time required for the current to decrease from 90% to 10% of peak value.

FCD850 · FCD850C FCD855 · FCD855C

OPTICALLY – COUPLED DARLINGTON ISOLATOR OPTOELECTRONICS PRODUCT GROUP

GENERAL DESCRIPTION — The FCD850, FCD855 series of optoisolators have a npn silicon Planar* Darlington phototransistor coupled to a gallium arsenide diode. Each is mounted in a 6-pin plastic dual in-line package. The FCD850/FCD850C has a minimum collector-emitter breakdown voltage of 30 V; the FCD855/FCD855C has a minimum collector-emitter breakdown voltage of 55 V.

- GLASSOLATED™
- HIGH CURRENT TRANSFER RATIO
- 5000 V TO 6000 V MINIMUM ISOLATION INPUT-TO-OUTPUT
- $10^{11} \Omega$ ISOLATION RESISTANCE
- LOW COUPLING CAPACITANCE – TYPICALLY 1.0 pF

ABSOLUTE MAXIMUM RATINGS

Storage Temperature	-55°C to +150°C
Operating Temperature	-55°C to +100°C
Pin Temperature (Soldering, 10 s)	260°C
Total Package Power Dissipation at $T_A = 25^\circ\text{C}$ (LED plus Detector)	250 mW
Derate Linearly from 25°C	3.3 mW/°C

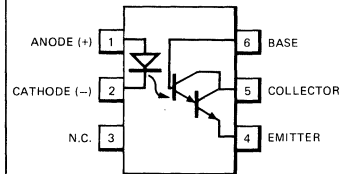
INPUT DIODE

V_R	Reverse Voltage	3.0 V
I_F	Forward Current	60 mA
i_f	Peak Forward Current (1 μs pulse width, 300 pps)	3.0 A
P_D	Power Dissipation at $T_A = 25^\circ\text{C}$	150 mW
	Derate Linearly from 25°C	1.33 mW/°C

OUTPUT TRANSISTOR (DARLINGTON)

		FCD850	FCD855
V_{CE}	Collector to Emitter Voltage	30 V	55 V
V_{CB}	Collector to Base Voltage	30 V	55 V
V_{EC}	Emitter to Collector Voltage	7.0 V	7.0 V
I_C	Collector Current	125 mA	125 mA
P_D	Power Dissipation at $T_A = 25^\circ\text{C}$	150 mW	150 mW
	Derate Linearly from 25°C	2.0 mW/°C	2.0 mW/°C

CONNECTION DIAGRAM DIP (TOP VIEW)



PIN NUMBERS

1 Anode (+)	} Input Diode
2 Cathode (-)	
3 N.C.	
4 Emitter	} Output npn Phototransistor
5 Collector	
6 Base	

ELECTRICAL CHARACTERISTICS – INPUT DIODE: $T_A = 25^\circ\text{C}$

SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	TEST CONDITIONS
V_F	Forward Voltage		1.25	1.5	V	$I_F = 20 \text{ mA}$
BV_R	Reverse Breakdown Voltage	3.0	5.0		V	$I_R = 10 \mu\text{A}$
C	Capacitance		150		pF	$V_R = 0 \text{ V}, f = 1 \text{ MHz}$

*Planar is a patented Fairchild process.

FAIRCHILD • FCD850 • FCD855 SERIES

ELECTRICAL CHARACTERISTICS – OUTPUT TRANSISTOR: $T_A = 25^\circ\text{C}$

SYMBOL	CHARACTERISTIC	MIN.	TYP	MAX	UNITS	TEST CONDITIONS
V_{CEO}	Collector-Emitter Voltage					
	FCD850, FCD850C	30			V	$I_C = 100 \mu\text{A}, I_F = 0$
	FCD855, FCD855C	55			V	$I_C = 100 \mu\text{A}, I_F = 0$
V_{ECO}	Emitter-Collector Voltage	7.0			V	$I_E = 100 \mu\text{A}, I_F = 0$
V_{EBO}	Emitter-Base Voltage	8.0			V	$I_E = 100 \mu\text{A}, I_F = 0$
I_{CEO}	Collector-Emitter Leakage Current			100	nA	$V_{CE} = 10 \text{ V}, I_F = 0$
h_{FE}	Forward Current Gain		7000			$V_{CE} = 5.0 \text{ V}, I_C = 25 \text{ mA}$
C_{cb}	Collector-Base Capacitance		25		pF	$V_{CB} = 10 \text{ V}$

ELECTRICAL CHARACTERISTICS – COUPLED: $T_A = 25^\circ\text{C}$

SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	TEST CONDITIONS
V_{IO}	Input-to-Output Voltage (Note 1)					
	FCD850, FCD855	1500			V_{rms}	
	FCD850C, FCD855C	5000			V_{pk}	
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage			1.0	V	$I_C = 50 \text{ mA}, I_F = 50 \text{ mA}$
I_C	Collector Output Current	10	150		mA	$V_{CE} = 5.0 \text{ V}, I_F = 10 \text{ mA}$
R_{IO}	Input-to-Output Resistance		10^{11}		Ω	$V_{IO} = 500 \text{ V}$
C_{IO}	Input-to-Output Capacitance		1.5		pF	$V_{IO} = 0, f = 1.0 \text{ MHz}$
t_r	Rise Time (Note 2)		15		μs	$I_C = 125 \text{ mA}, V_{CC} = 13.5 \text{ V}, R_L = 100 \Omega$
t_f	Fall Time (Note 2)		150		μs	$I_C = 125 \text{ mA}, V_{CC} = 13.5 \text{ V}, R_L = 100 \Omega$

NOTES:

- Isolation voltage defined as min of 5 seconds continuous application.
- Rise time is defined as the time for the collector current to rise from 10% to 90% of peak value. Fall time is defined as the time required for the current to decrease from 90% to 10% of peak value.

FCD860 • FCD860C FCD865 • FCD865C

OPTICALLY-COUPLED DARLINGTON ISOLATOR OPTOELECTRONICS PRODUCT GROUP

GENERAL DESCRIPTION – The FCD860, FCD865 series of optoisolators have a npn silicon Planar* Darlington phototransistor coupled to a gallium arsenide diode. Each is mounted in a 6-pin plastic dual in-line package. The series was designed specifically as a high sensitivity type for operation in the 1.0 mA input region.

- GLASSOLATED™
- HIGH CURRENT TRANSFER RATIO AT LOW INPUT CURRENT
- 5000 V TO 6000 V MINIMUM ISOLATION INPUT-TO-OUTPUT
- $10^{11} \Omega$ ISOLATION RESISTANCE
- LOW COUPLING CAPACITANCE – TYPICALLY 1.5 pF

ABSOLUTE MAXIMUM RATINGS

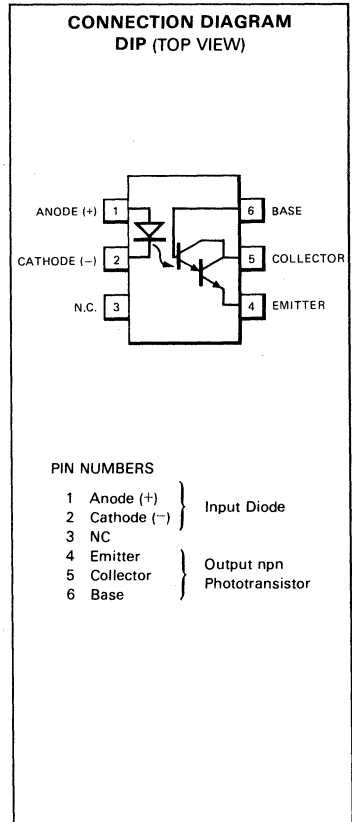
Storage Temperature	-55°C to +150°C
Operating Temperature	-55°C to +100°C
Pin Temperature (Soldering, 10 s)	260°C
Total Package Power Dissipation at $T_A = 25^\circ\text{C}$ (LED plus Detector)	250 mW
Derate Linearly from 25°C	3.3 mW/°C

INPUT DIODE

V_R	Reverse Voltage	3.0 V
I_F	Forward Current	80 mA
i_f	Peak Forward Current (1 μs pulse width, 300 pps)	3.0 A
P_D	Power Dissipation at $T_A = 25^\circ\text{C}$	150 mW
	Derate Linearly from 25°C	2.0 mW/°C

OUTPUT TRANSISTOR (DARLINGTON)

V_{CE}	Collector to Emitter Voltage	30 V
V_{CB}	Collector to Base Voltage	30 V
V_{EC}	Emitter to Collector Voltage	7.0 V
P_D	Power Dissipation at $T_A = 25^\circ\text{C}$ (I_C max 100 mA at $V_{CE} = 1.5$ V)	150 mW
	Derate Linearly from 25°C	2.0 mW/°C



ELECTRICAL CHARACTERISTICS – INPUT DIODE: $T_A = 25^\circ\text{C}$

SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	TEST CONDITIONS
V_F	Forward Voltage		1.25	1.5	V	$I_F = 20$ mA $I_R = 10$ μA $V_R = 0$ V, $f = 1$ MHz
BV_R	Reverse Breakdown Voltage	3.0	5.0		V	
C	Capacitance		150		pF	

*Planar is a patented Fairchild process.

FAIRCHILD • FCD860 • FCD865 SERIES

ELECTRICAL CHARACTERISTICS – OUTPUT TRANSISTOR: $T_A = 25^\circ\text{C}$ (DARLINGTON)

SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	TEST CONDITIONS
V_{CE0}	Collector-Emitter Voltage	30			V	$I_C = 1.0\text{ mA}, I_F = 0$
V_{CB0}	Collector-Base Voltage	30			V	$I_C = 10\ \mu\text{A}, I_F = 0$
V_{ECO}	Emitter-Collector Voltage	7.0			V	$I_E = 100\ \mu\text{A}, I_F = 0$
V_{EBO}	Emitter-Base Voltage	6.0	8.0		V	$I_E = 100\ \mu\text{A}, I_F = 0$
I_{CEO}	Collector-Emitter Leakage Current			100	nA	$V_{CE} = 10\text{ V}, I_F = 0$
h_{FE}	Forward Current Gain		20k			$V_{CE} = 5.0\text{ V}, I_C = 25\text{ mA}$

ELECTRICAL CHARACTERISTICS – COUPLED: $T_A = 25^\circ\text{C}$

SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	TEST CONDITIONS
V_{IO}	Input-to-Output Voltage (Note 1) FCD860, FCD865 FCD860C, FCD865C	1500 5000			V_{rms} V_{pk}	
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage			1.0	V	$I_C = 2.0\text{ mA}, I_F = 1.0\text{ mA}$
I_C	Collector Output Current FCD860, FCD860C FCD865, FCD865C	2.0 2.0			mA mA	$V_{CE} = 1.0\text{ V}, I_F = 1.0\text{ mA}$ $V_{CE} = 1.0\text{ V}, I_F = 0.5\text{ mA}$
R_{IO}	Input-to-Output Resistance		10^{11}		Ω	$V_{IO} = 500\text{ V}$
C_{IO}	Input-to-Output Capacitance		1.5		pF	$V_{IO} = 0, f = 1.0\text{ MHz}$
t_r, t_f	Rise and Fall Times (Note 2)		80		μs	$I_C = 10\text{ mA}, V_{CC} = 10\text{ V}, R_L = 100\ \Omega$

NOTES:

1. Isolation voltage defined as min of 5 seconds continuous application.
2. Rise time is defined as the time for the collector current to rise from 10% to 90% of peak value. Fall time is defined as the time required for the current to decrease from 90% to 10% of peak value.

FCD880 • FCD885

DUAL OPTICALLY-COUPLED ISOLATOR

OPTOELECTRONICS PRODUCT GROUP

GENERAL DESCRIPTION — The FCD 880 and FCD 885 comprise two distinct optoisolators with transistor output, in a single 8-pin dual in-line package. Each channel consists of a gallium arsenide emitter optically coupled to a photo-transistor.

- HIGH CURRENT TRANSFER RATIO
- 2500 V MINIMUM ISOLATION INPUT-TO-OUTPUT
- $10^{11} \Omega$ ISOLATION RESISTANCE
- LOW COUPLING CAPACITANCE — TYPICALLY 1.0 pF
- I/O COMPATIBLE WITH INTEGRATED CIRCUITS
- TWO PACKAGES FITS INTO A STANDARD 16-PIN DIP SOCKET

ABSOLUTE MAXIMUM RATINGS

Storage Temperature	-55°C to +150°C
Operating Temperature	-55°C to +100°C
Pin Temperature (Soldering, 5 s)	260°C
Total Package Power Dissipation at $T_A = 25^\circ\text{C}$	400 mW
Derate Linearly from 25°C	5.3 mW/°C

INPUT DIODE (EACH CHANNEL)

V_R	Reverse Voltage	3.0V
I_F	Forward Current	60 mA
i_f	Peak Forward Current (1 μs pulse, 300 pps)	3.0 A
P_D	Power Dissipation at $T_A = 25^\circ\text{C}$	100 mW
	Derate Linearly from 50°C	2 mW/°C

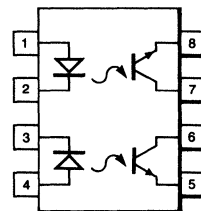
OUTPUT TRANSISTOR (EACH CHANNEL)

V_{CE}	Collector to Emitter Voltage	30 V
V_{ECO}	Emitter to Collector Voltage	6.0 V
P_D	Power Dissipation at $T_A = 25^\circ\text{C}$	150 mW
	Derate Linearly from 25°C	2 mW/°C
I_C	Collector Current	30 mA

ELECTRICAL CHARACTERISTICS — INPUT DIODE: $T_A = 25^\circ\text{C}$

SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	TEST CONDITIONS
V_F	Forward Voltage		1.25	1.5	V	$I_F = 60 \text{ mA}$
V_R	Reverse Voltage	3.0	5.5		V	$I_R = 10 \mu\text{A}$
C_j	Junction Capacitance		100		pF	$V_F = 0 \text{ V}$

CONNECTION DIAGRAM
DIP (TOP VIEW)



PIN NUMBER	
1 ANODE	CHANNEL #1
2 CATHODE	
3 CATHODE	CHANNEL #2
4 ANODE	
5 EMITTER	CHANNEL #1
6 COLLECTOR	
7 COLLECTOR	CHANNEL #2
8 EMITTER	

FAIRCHILD • FCD880 • FCD885

ELECTRICAL CHARACTERISTICS — OUTPUT TRANSISTOR: T_A = 25°C

SYMBOL	CHARACTERISTIC	FCD880			FCD885			UNITS	TEST CONDITIONS
		MIN	TYP	MAX	MIN	TYP	MAX		
V _{CE0}	Collector-Emitter Voltage	30	65		30	65		V	I _C = 1.0 mA, I _F = 0
V _{EC0}	Emitter-Collector Voltage	6.0	10		6.0	10		V	I _C = 100 μA
I _{CE0}	Collector-Emitter Leakage Current		5.0	100		5.0	100	nA	V _{CE} = 10 V, I _F = 0
C _{CE}	Collector-Emitter Capacitance		8.0			8.0		pF	V _{CE} = 0

ELECTRICAL CHARACTERISTICS — COUPLED: T_A = 25°C

SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	TEST CONDITIONS
V _{IO}	Input-to-Output Voltage	2500	4000		V	
V _{CE(sat)}	Collector-Emitter Saturation Voltage					
	FCD880		0.24	0.4	V	I _C = 2.0 mA, I _F = 16 mA
	FCD885		0.2	0.3	V	I _C = 250 μA, I _F = 20 mA
I _C /I _F (CTR)	Collector Current Transfer Ratio (Note 1)					
	FCD880	30	50		%	V _{CE} = 10 V, I _F = 10 mA
	FCD885	10	20		%	V _{CE} = 10 V, I _F = 10 mA
R _{IO}	Input-to-Output Resistance		10 ¹¹		Ω	V _{IO} = 500 V
C _{IO}	Input-to-Output Capacitance		1.0		pF	f = 1.0 MHz
t _r , t _f	Collector Rise and Fall Times (Note 2)		2.0		μs	I _C = 2.0 mA, V _{CE} = 10 V, R _L = 100 Ω

NOTES:

- Collector current transfer ratio is defined as the ratio of the collector current to the forward bias input current.
- Rise time is defined as the time for the collector current to rise from 10% to 90% of peak value. Fall time is defined as the time required for the current to decrease from 90% to 10% of peak value.

H11A1 • H11A2 • H11A3 • H11A4

OPTICALLY - COUPLED ISOLATOR

OPTOELECTRONICS PRODUCT GROUP

GENERAL DESCRIPTION – The H11A1, H11A2, H11A3 and H11A4 optical isolators are electrical and mechanical replacements for the General Electric series. Optical intercoupling provides a high degree of ac and dc isolation. A capability for continuous operation of the input diode results in a frequency response extending to dc. Connection to the base is also provided for design flexibility.

- GLASSOLATED™
- ELECTRICALLY EQUIVALENT TO GE DEVICES
- PIN-FOR-PIN EQUIVALENT TO GE DEVICES
- AVAILABILITY OF BASE PIN FOR FLEXIBLE DESIGN

ABSOLUTE MAXIMUM RATINGS

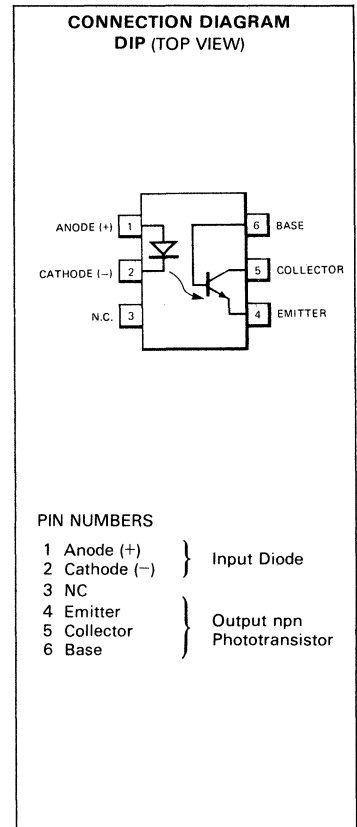
Storage Temperature	-55°C to +150°C
Operating Temperature	-55°C to +100°C
Pin Temperature (Soldering, 5 s)	260°C
Total Package Power Dissipation at $T_A = 25^\circ\text{C}$ (LED plus Detector)	250 mW
Derate Linearly from 25°C	3.3 mW/°C

INPUT DIODE

V_R	Reverse Voltage	3.0 V
I_F	Forward Current	60 mA
i_f	Peak Forward Current (1 μs pulse width, 300 pps)	3.0 A
P_D	Power Dissipation at $T_A = 25^\circ\text{C}$	100 mW
	Derate Linearly from 25°C	1.33 mW/°C

OUTPUT TRANSISTOR

V_{CE}	Collector to Emitter Voltage	30 V
V_{CB}	Collector to Base Voltage	70 V
I_C	Collector Current	100 mA
P_D	Power Dissipation at $T_A = 25^\circ\text{C}$	150 mW
	Derate Linearly from 25°C	2.0 mW/°C



ELECTRICAL CHARACTERISTICS – INPUT DIODE: $T_A = 25^\circ\text{C}$

SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	TEST CONDITIONS
V_F	Forward Voltage		1.1	1.5	V	$I_F = 10 \text{ mA}$
I_R	Reverse Current			10	μA	$V_R = 3.0 \text{ V}$

FAIRCHILD • H11A1 • H11A2 • H11A3 • H11A4

ELECTRICAL CHARACTERISTICS – OUTPUT TRANSISTOR: $T_A = 25^\circ\text{C}$

SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	TEST CONDITIONS
V_{CE0}	Collector-Emitter Voltage	30			V	$I_C = 10 \text{ mA}, I_F = 0$
V_{CB0}	Collector-Base Voltage	70			V	$I_C = 100 \mu\text{A}, I_F = 0$
V_{ECO}	Emitter-Collector Voltage	7.0			V	$I_E = 100 \mu\text{A}, I_F = 0$
I_{CEO}	Collector-Emitter Leakage Current		5.0	50	nA	$V_{CE} = 10 \text{ V}, I_F = 0$

ELECTRICAL CHARACTERISTICS – COUPLED: $T_A = 25^\circ\text{C}$

SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	TEST CONDITIONS
V_{ISO}	Isolation Voltage (Note-3)					
	H11A1, H11A3	2500			V	Peak
	H11A2, H11A4	1500			V	Peak
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage		0.1	0.4	V	$I_C = 0.5 \text{ mA}, I_F = 50 \text{ mA}$
$I_C/I_F(\text{CTR})$	Collector Current Transfer Ratio (Note 1)					$V_{CE} = 10 \text{ V}, I_F = 10 \text{ mA}$
	H11A1	50			%	
	H11A2, H11A3	20			%	
	H11A4	10			%	
R_{IO}	Input-to-Output Resistance	10^{11}			Ω	$V_{IO} = 500 \text{ V}$
C_{IO}	Input-to-Output Capacitance		2.0		pF	$f = 1.0 \text{ MHz}$
t_r, t_f	Collector Rise and Fall Times (Note 2)		2.0		μs	$I_C = 2.0 \text{ mA}, V_{CE} = 10 \text{ V}, R_L = 100 \Omega$

NOTES:

- Collector current transfer ratio is defined as the ratio of the collector current to the forward bias input current.
- Rise time is defined as the time for the collector current to rise from 10% to 90% of peak value. Fall time is defined as the time required for the current to decrease from 90% to 10% of peak value.
- Isolation voltage defined as min. of 5 sec. continuous application.

H11B1 • H11B2

OPTICALLY-COUPLED DARLINGTON ISOLATOR

OPTOELECTRONICS PRODUCT GROUP

GENERAL DESCRIPTION – The H11B1 and H11B2 optical isolators are electrical and mechanical replacements for the General Electric series. Optical intercoupling provides a high degree of ac and dc isolation. A capability for continuous operation of the input diode results in a frequency response extending to dc. Connection to the base is also provided for design flexibility.

- GLASSOLATED™
- ELECTRICALLY EQUIVALENT TO GE DEVICES
- PIN-FOR-PIN EQUIVALENT TO GE DEVICES
- AVAILABILITY OF BASE PIN FOR FLEXIBLE DESIGN

ABSOLUTE MAXIMUM RATINGS

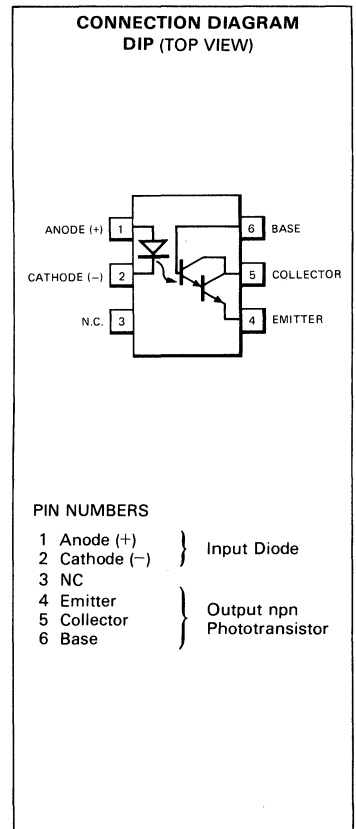
Storage Temperature	–55°C to +150°C
Operating Temperature	–55°C to +100°C
Pin Temperature (Soldering, 10 s)	260°C
Total Package Power Dissipation at $T_A = 25^\circ\text{C}$ (LED plus Detector)	250 mW
Derate Linearly from 25°C	3.3 mW/°C

INPUT DIODE

I_F	Forward dc Current Continuous	60 mA
V_R	Reverse Voltage	3.0 V
I_f	Peak Forward Current (1 μs pulse width, 300 pps)	3.0 A
P_D	Power Dissipation at $T_A = 25^\circ\text{C}$	100 mW
	Derate Linearly from 25°C	1.33 mW/°C

OUTPUT TRANSISTOR (DARLINGTON)

V_{CEO}	Collector to Emitter Voltage	25 V
V_{CBO}	Collector to Base Voltage	30 V
V_{ECO}	Emitter to Collector Voltage	7.0 V
P_D	Power Dissipation at $T_A = 25^\circ\text{C}$ (Max I_C 100 mA at $V_{CE} = 1.5$ V)	150 mW
	Derate Linearly from 25°C	2.0 mW/°C



ELECTRICAL CHARACTERISTICS – INPUT DIODE: $T_A = 25^\circ\text{C}$

SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	TEST CONDITIONS
V_F	Forward Voltage		1.2	1.5	V	$I_F = 10$ mA
I_R	Reverse Current			10	μA	$V_R = 3.0$ V
C	Capacitance		150		pF	$V_R = 0$ V, $f = 1$ MHz

FAIRCHILD • H11B1 • H11B2

ELECTRICAL CHARACTERISTICS – OUTPUT TRANSISTOR (DARLINGTON): $T_A = 25^\circ\text{C}$

SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	TEST CONDITIONS
V_{CE0}	Collector-Emitter Breakdown Voltage	25			V	$I_C = 10\text{ mA}$, $I_F = 0$
V_{ECO}	Emitter-Collector Breakdown Voltage	7.0			V	$I_E = 100\ \mu\text{A}$, $I_F = 0$
V_{CBO}	Collector-Base Breakdown Voltage	30			V	$I_C = 100\ \mu\text{A}$
I_{CEO}	Collector-Emitter Leakage Current			100	nA	$V_{CE} = 10\text{ V}$, $I_F = 0$
C_{CE}	Capacitance Collector-Emitter Junction		6.0		pF	$V_{CE} = 10\text{ V}$, $f = 1.0\text{ MHz}$

ELECTRICAL CHARACTERISTICS – COUPLED: $T_A = 25^\circ\text{C}$

SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	TEST CONDITIONS
I_C	Collector Output Current (Pulsed)					
	H11B1	50			mA	$I_F = 10\text{ mA}$, $V_{CE} = 5\text{ V}$
H11B2	20			mA		
V_{ISO}	Isolation Voltage (Note 2)					
	H11B1	2500			V	Peak
H11B2	1500				V	Peak
R_{ISO}	Isolation Resistance		10^{11}		Ω	$V = 500\text{ V}$
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage			1.0	V	$I_C = 1.0\text{ mA}$, $I_F = 1.0\text{ mA}$
C_{ISO}	Isolation Capacitance		2.0		pF	$V = 0$, $f = 1.0\text{ MHz}$
t_{on}	Turn-on Time (Note 1)		125		μs	$I_C = 10\text{ mA}$, $V_{CC} = 10\text{ V}$, $R_L = 100\ \Omega$
t_{off}	Turn-off Time		100		μs	$I_C = 10\text{ mA}$, $V_{CC} = 10\text{ V}$, $R_L = 100\ \Omega$

NOTES:

- Turn-on time is defined as the time for the (base collector) current to rise from 10% to 90% of peak value. Turn-off time is defined as the time required for the current to decrease from 90% to 10% of peak value.
- Isolation voltage defined as min of 5 seconds continuous application.

IL1 • IL12 • IL15 • IL16 • IL74

OPTICALLY-COUPLED ISOLATORS

OPTOELECTRONICS PRODUCT GROUP

GENERAL DESCRIPTION – The IL1, IL12, IL15, IL16 and IL74 series of optically coupled isolators are electrical and mechanical replacements for the Litronix series. Optical intercoupling provides a high degree of ac and dc isolation. A capability for continuous operation of the input diode results in a frequency response extending to dc. Connection to the base is also provided for design flexibility.

- GLASSOLATED™
- HIGH CURRENT TRANSFER RATIO
- $10^{11} \Omega$ ISOLATION RESISTANCE
- LOW COUPLING CAPACITANCE – TYPICALLY 1.0 pF

ABSOLUTE MAXIMUM RATINGS

Storage Temperature	-55°C to +150°C
Operating Temperature	-55°C to +100°C
Pin Temperature (Soldering, 5 s)	260°C
Total Package Power Dissipation at $T_A = 25^\circ\text{C}$ (LED plus Detector)	200 mW
Derate Linearly from 25°C	2.6 mW/°C

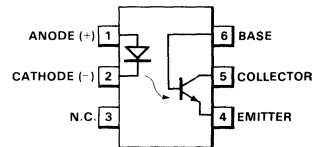
INPUT DIODE

V_R	Reverse Voltage	3.0 V
I_F	Forward Current	60 mA
i_f	Peak Forward Current (1 μs pulse width, 300 pps)	3.0 A
P_D	Power Dissipation at $T_A = 25^\circ\text{C}$	100 mW
	Derate Linearly from 25°C	1.33 mW/°C

OUTPUT TRANSISTOR

V_{CE}	Collector to Emitter Voltage	30 V
V_{CB}	Collector to Base Voltage	70 V
P_D	Power Dissipation at $T_A = 25^\circ\text{C}$	150 mW
	Derate Linearly from 25°C	2.0 mW/°C

**CONNECTION DIAGRAM
DIP (TOP VIEW)**



PIN NUMBERS

1 Anode (+)	} Input Diode
2 Cathode (-)	
3 NC	
4 Emitter	} Output npn Phototransistor
5 Collector	
6 Base	

ELECTRICAL CHARACTERISTICS – INPUT DIODE: $T_A = 25^\circ\text{C}$

SYMBOL	CHARACTERISTICS	MIN	TYP	MAX	UNITS	TEST CONDITIONS
V_F	Forward Voltage					
	IL1, IL15, IL16		1.3	1.5	V	$I_F = 60 \text{ mA}$
	IL12		1.3	1.5	V	$I_F = 10 \text{ mA}$
BV_R	Reverse Breakdown Voltage					
	IL74		1.5	1.75	V	$I_F = 10 \text{ mA}$
	IL1, IL15, IL16	3			V	$I_R = 10 \mu\text{A}$
	IL12	3			V	$I_R = 100 \mu\text{A}$

FAIRCHILD • IL1 • IL12 • IL15 • IL16 • IL74

ELECTRICAL CHARACTERISTICS – OUTPUT TRANSISTOR: T_A = 25°C

SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	TEST CONDITIONS
V _{CEO}	Collector-Emitter Voltage					
	IL1, IL15, IL16	30	50		V	I _C = 1.0 mA, I _F = 0
V _{ECO}	Emitter-Collector Voltage					
	IL12, IL74	20	40		V	I _C = 1.0 mA, I _F = 0
I _{CEO}	Collector-Emitter Leakage Current					
	IL1, IL15, IL16	7.0			V	I _E = 100 μA, I _F = 0
	IL12	4.0			V	I _E = 100 μA, I _F = 0
h _{FE}	Forward Current Gain					
	IL1			50	nA	V _{CE} = 10 V, I _F = 0
	IL12			250	nA	V _{CE} = 5.0 V, I _F = 0
	IL15, IL16			100	nA	V _{CE} = 5.0 V, I _F = 0
	IL74			500	nA	V _{CE} = 5.0 V, I _F = 0
	IL12	50				V _{CE} = 5.0 V, I _C = 100 μA

ELECTRICAL CHARACTERISTICS – COUPLED: T_A = 25°C

SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	TEST CONDITIONS
V _{IO}	Input-to-Output Voltage					
	IL1	2500			V	
	IL12	1000			V	
V _{CE(sat)}	Collector-Emitter Saturation Voltage					
	IL15, IL16, IL74	1500			V	
	IL1			0.5	V	I _F = 16 mA, I _C = 1.6 mA
I _C /I _F (CTR)	Collector Current Transfer Ratio (Note 1)					
	IL15, IL16			0.5	V	I _F = 50 mA, I _C = 2 mA
	IL74			0.5	V	I _F = 16 mA, I _C = 2 mA
C _{IO}	Input-to-Output Capacitance					
	IL1	20			%	V _{CE} = 10 V, I _F = 10 mA
	IL12	10			%	V _{CE} = 5.0 V, I _F = 10 mA
	IL15	6.0			%	V _{CE} = 10 V, I _F = 10 mA
	IL16	6.0		30	%	V _{CE} = 10 V, I _F = 10 mA
	IL74	12.5			%	V _{CE} = 5.0 V, I _F = 16 mA
	IL12, IL15, IL16			2.0	pF	f = 1.0 MHz

NOTES: 1. Collector current transfer ratio is defined as the ratio of the collector current to the forward bias input current.

6

MCA230 • MCA231 • MCA255

OPTICALLY-COUPLED DARLINGTON ISOLATOR

OPTOELECTRONICS PRODUCT GROUP

GENERAL DESCRIPTION – The MCA230, MCA231 and MCA255 series of optically coupled isolators are electrical and mechanical replacements for the Monsanto series. Optical intercoupling provides a high degree of ac and dc isolation. Connection to the base is also provided for design flexibility.

- **GLASSOLATED™**
- **HIGH CURRENT TRANSFER RATIO AT LOW INPUT CURRENT**
- **$10^{11} \Omega$ ISOLATION RESISTANCE**
- **LOW COUPLING CAPACITANCE – TYPICALLY 1.5 pF**

ABSOLUTE MAXIMUM RATINGS

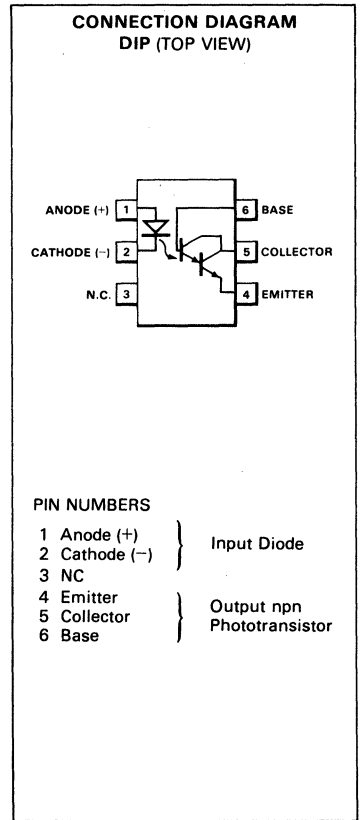
Storage Temperature	–55°C to +150°C
Operating Temperature	–55°C to +100°C
Pin Temperature (Soldering, 10 s)	260°C
Total Package Power Dissipation at $T_A = 25^\circ\text{C}$ (LED plus Detector)	300 mW
Derate Linearly from 25°C	4.0 mW/°C

INPUT DIODE

V_R	Reverse Voltage	3.0 V
I_F	Forward Current	60 mA
i_f	Peak Forward Current (1 μs pulse width, 300 pps)	3.0 A
P_D	Power Dissipation at $T_A = 25^\circ\text{C}$	90 mW
	Derate Linearly from 55°C	2.0 mW/°C

OUTPUT TRANSISTOR (DARLINGTON)

		MCA230/231	MCA255
V_{CE}	Collector to Emitter Voltage	30 V	55 V
V_{CB}	Collector to Base Voltage	30 V	55 V
P_D	Power Dissipation at $T_A = 25^\circ\text{C}$	210 mW	210 mW
	Derate Linearly from 25°C	2.8 mW/°C	2.8 mW/°C



ELECTRICAL CHARACTERISTICS – INPUT DIODE: $T_A = 25^\circ\text{C}$

SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	TEST CONDITIONS
V_F	Forward Voltage		1.2	1.5	V	$I_F = 20 \text{ mA}$
BV_R	Reverse Breakdown Voltage	3.0	5.0		V	$I_R = 10 \mu\text{A}$

FAIRCHILD • MCA230 • MCA231 • MCA255

ELECTRICAL CHARACTERISTICS – OUTPUT TRANSISTOR: T_A = 25°C

SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	TEST CONDITIONS
V _{CEO}	Collector-Emitter Voltage					
	MCA230/230	30			V	I _C = 0.1 mA, I _F = 0
	MCA231	30			V	I _C = 1.0 mA, I _F = 0
V _{CBO}	Collector-Base Voltage					
	MCA230/231	30			V	I _C = 10 mA, I _F = 0
	MCA255	55				I _C = 0.1 mA, I _F = 0
I _{CEO}	Collector-Emitter Leakage Current		1.0	100	nA	V _{CE} = 10 V, I _F = 0
h _{FE}	Forward Current Gain		25,000			V _{CE} = 5.0 V, I _C = 500 μA
V _{EBO}	Emitter-Base Voltage					I _E = 10 μA
	MCA230/255	8			V	
	MCA231	6			V	

ELECTRICAL CHARACTERISTICS – COUPLED: T_A = 25°C

SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	TEST CONDITIONS
I _C	Collector Output Current					
	MCA230	10	40		mA	V _{CE} = 5.0 V, I _F = 10 mA
	MCA231	2.0	4.0		mA	V _{CE} = 1.0 V, I _F = 1.0 mA
V _{ISO}	Isolation Voltage	1500	2000		V _{dc}	V _{CE} = 5.0 V, I _F = 10 mA
	Isolation Resistance		10 ¹¹		Ω	V = 500 V
	Collector-Emitter Saturation Voltage					
V _{CE(sat)}	MCA230, MCA255		0.8	1.0	V	I _C = 50 mA, I _F = 50 mA
	MCA231		0.8	1.0	V	I _C = 2.0 mA, I _F = 1.0 mA
	MCA231		0.8	1.0	V	I _C = 2 mA, I _F = 1 mA
	MCA231		0.8	1.0	V	I _C = 10 mA, I _F = 5 mA
	MCA231		0.9	1.2	V	I _C = 40 mA, I _F = 10 mA
t _{on}	Turn-on Time		40		μs	I _C = 1.0 mA, V _{CC} = 10 V, R _L = 100 Ω
t _{off}	Turn-off Time (See Note 1)		50		μs	

NOTES:

- Collector current transfer ratio is defined as the ratio of the collector current to the forward bias input current.
- Rise time is defined as the time for the collector current to rise from 10% to 90% of peak value. Fall time is defined as the time required for the current to decrease from 90% to 10% of peak value.

MCT2 • MCT2E • MCT26

OPTICALLY-COUPLED ISOLATOR

OPTOELECTRONICS PRODUCT GROUP

GENERAL DESCRIPTION – The MCT2, MCT2E and MCT26 optical isolators are electrical and mechanical replacements for the Monsanto series. Optical intercoupling provides a high degree of ac and dc isolation. A capability for continuous operation of the input diode results in a frequency response extending to dc. Connection to the base is also provided for design flexibility.

- GLASSOLATED™
- ELECTRICALLY EQUIVALENT TO MONSANTO DEVICES
- PIN-FOR-PIN EQUIVALENT TO MONSANTO DEVICES
- AVAILABILITY OF BASE PIN FOR FLEXIBLE DESIGN

ABSOLUTE MAXIMUM RATINGS

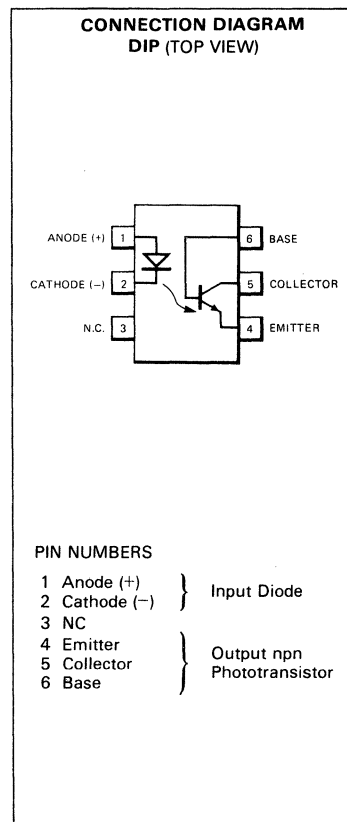
Storage Temperature	-55°C to +150°C
Operating Temperature	-55°C to +100°C
Pin Temperature (Soldering, 5 s)	260°C
Total Package Power Dissipation at $T_A = 25^\circ\text{C}$ (LED plus Detector)	250 mW
Derate Linearly from 25°C	3.3 mW/°C

INPUT DIODE

V_R	Reverse Voltage	3.0 V
I_F	Forward Current	60 mA
i_f	Peak Forward Current (1 μs pulse width, 300 pps)	3.0 A
P_D	Power Dissipation at $T_A = 25^\circ\text{C}$	200 mW
	Derate Linearly from 25°C	2.6 mW/°C

OUTPUT TRANSISTOR

V_{CE}	Collector to Emitter Voltage	30 V
V_{CB}	Collector to Base Voltage	30 V
V_{ECO}	Emitter to Collector Voltage	7.0 V
P_D	Power Dissipation at $T_A = 25^\circ\text{C}$	200 mW
	Derate Linearly from 25°C	2.6 mW/°C



ELECTRICAL CHARACTERISTICS – INPUT DIODE: $T_A = 25^\circ\text{C}$

SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	TEST CONDITIONS
V_F	Forward Voltage		1.25	1.5	V	$I_F = 20 \text{ mA}$
BV_R	Reverse Breakdown Voltage	3.0	5.5		V	$I_R = 10 \mu\text{A}$

FAIRCHILD • MCT2 • MCT2E • MCT26

ELECTRICAL CHARACTERISTICS – OUTPUT TRANSISTOR: T_A = 25°C

SYMBOL	CHARACTERISTIC	MCT2/MCT2E			MCT26			UNITS	TEST CONDITIONS
		MIN	TYP	MAX	MIN	TYP	MAX		
V _{CEO}	Collector-Emitter Voltage	30	65		30	75		V	I _C = 1.0 mA, I _F = 0
V _{CBO}	Collector-Base Voltage	70	165		30	100		V	I _C = 100 μA
V _{ECO}	Emitter-Collector Voltage	7.0	14		7.0	12		V	I _C = 100 μA
I _{CEO}	Collector-Emitter Leakage Current		5.0	50		5.0	100	nA	V _{CE} = 10 V, I _F = 0
I _{CBO}	Collector-Base Leakage Current		0.1	20		1.0	100	nA	V _{CE} = 5.0 V, I _F = 0
h _{FE}	Forward Current Gain	100	250		100	150		nA	V _{CB} = 10 V, I _F = 0
C _{ce}	Collector-Emitter Capacitance		8.0			8.0		pF	V _{CE} = 5.0 V, I _C = 100 μA
C _{cb}	Collector-Base Capacitance		20					pF	V _{CE} = 0
C _{eb}	Emitter-Base Capacitance		10					pF	V _{CB} = 10 V
									V _{BE} = 0

ELECTRICAL CHARACTERISTICS – COUPLED: T_A = 25°C

SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	TEST CONDITIONS
V _{IO}	Input-to-Output Voltage					
	MCT2	1500	2300		V _{dc}	f = 60 Hz
	MCT2E	2500			V _{dc}	
	MCT26	1500	2500		V _{dc}	
	MCT2	800			V _{rms}	
V _{CE(sat)}	Collector-Emitter Saturation Voltage					
	MCT2, MCT2E		0.24	0.4	V	I _C = 2.0 mA, I _F = 16 mA
	MCT26		0.2	0.3	V	I _C = 250 μA, I _F = 20 mA
I _C /I _F (CTR)	Collector Current Transfer Ratio (Note 1)					
	MCT2, MCT2E	20	50		%	V _{CE} = 10 V, I _F = 10 mA
	MCT26	6	14		%	
R _{IO}	Input-to-Output Resistance					
	MCT2		10 ¹¹		Ω	V _{IO} = 500 V
	MCT2E		10 ¹¹	10 ¹²	Ω	
C _{IO}	Input-to-Output Capacitance					
	MCT2, MCT2E		1.0		pF	f = 1.0 MHz
	MCT26		1.0	2.0	pF	
t _r , t _f	Collector Rise and Fall Times (Note 2)					
	MCT26		2.0		μs	I _C = 2.0 mA, V _{CE} = 10 V

NOTES:

- Collector current transfer ratio is defined as the ratio of the collector current to the forward bias input current.
- Rise time is defined as the time for the collector current to rise from 10% to 90% of peak value. Fall time is defined as the time required for the current to decrease from 90% to 10% of peak value.

MOC1000 • MOC1001 • MOC1002 • MOC1003

OPTICALLY-COUPLED ISOLATOR

OPTOELECTRONICS PRODUCT GROUP

GENERAL DESCRIPTION – The MOC1000, MOC1001, MOC1002 and MOC1003 are gallium arsenide light emitting diodes coupled to a silicon phototransistor. They are designed for applications requiring electrical isolation, high-current transfer ratios, small package size and low cost (i.e., interfacing and coupling systems, phase and feedback controls, solid state relays and general purpose switching circuits).

- EXCELLENT FREQUENCY RESPONSE – 300 kHz (TYP)
- HIGH TRANSFER RATIO – 60% (TYP) MOC1000, MOC1001
- ECONOMICAL, COMPACT, DUAL IN-LINE PLASTIC PACKAGE
- FAST SWITCHING – 2.8 μ s (TYP)
- GLASSOLATED™
- ELECTRICALLY EQUIVALENT TO MOTOROLA DEVICES
- PIN-FOR-PIN EQUIVALENT TO MOTOROLA DEVICES
- AVAILABILITY OF BASE PIN FOR FLEXIBLE DESIGN

ABSOLUTE MAXIMUM RATINGS

Storage Temperature	-55°C to +150°C
Operating Temperature	-55°C to +100°C
Pin Temperature (Soldering, 5 s)	260°C
Total Package Power Dissipation at $T_A = 25^\circ\text{C}$ (LED plus Detector)	250 mW
Derate Linearly from 25°C	3.3 mW/°C

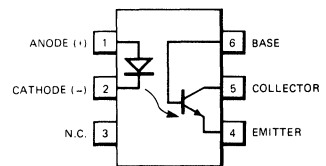
INPUT DIODE

V_R	Reverse Voltage	3.0 V
I_F	Forward Current	80 mA
i_f	Peak Forward Current (1 μ s pulse width, 300 pps)	3.0 A
P_D	Power Dissipation at $T_A = 25^\circ\text{C}$	150 mW
	Derate Linearly from 25°C	2.0 mW/°C

OUTPUT TRANSISTOR

V_{CE}	Collector to Emitter Voltage	30 V
V_{CB}	Collector to Base Voltage	70 V
P_D	Power Dissipation at $T_A = 25^\circ\text{C}$	150 mW
	Derate Linearly from 25°C	2.0 mW/°C

**CONNECTION DIAGRAM
DIP (TOP VIEW)**



PIN NUMBERS

1 Anode (+)	}	Input Diode
2 Cathode (-)		
3 NC		
4 Emitter	}	Output npn Phototransistor
5 Collector		
6 Base		

ELECTRICAL CHARACTERISTICS – INPUT DIODE: $T_A = 25^\circ\text{C}$

SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	TEST CONDITIONS
V_F	Forward Voltage		1.2	1.5	V	$I_F = 50$ mA, Pulsed
I_R	Reverse Current		0.05	100	μ A	$V_R = 3.0$ V, $R_L = 1.0$ M Ω

FAIRCHILD • MOC1000 • MOC1001 • MOC1002 • MOC1003

ELECTRICAL CHARACTERISTICS – OUTPUT TRANSISTOR: $T_A = 25^\circ\text{C}$

SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	TEST CONDITIONS
V_{CE0}	Collector-Emitter Voltage	30			V	$I_C = 1.0 \text{ mA}, I_B = 0$
V_{CBO}	Collector-Base Voltage	70			V	$I_C = 100 \mu\text{A}, I_B = 0$
V_{ECO}	Emitter-Collector Voltage	7.0			V	$I_E = 100 \mu\text{A}, I_B = 0$
I_{CEO}	Collector-Emitter Leakage Current		3.5	50	nA	$V_{CE} = 10 \text{ V}, I_F = 0$
I_{CBO}	Collector-Base Leakage Current			20	nA	$V_{CB} = 10 \text{ V}, I_F = 0$
h_{FE}	Forward Current Gain		200			$V_{CE} = 5.0 \text{ V}, I_C = 100 \mu\text{A}$

ELECTRICAL CHARACTERISTICS – COUPLED: $T_A = 25^\circ\text{C}$

SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	TEST CONDITIONS
V_{IO}	Input-to-Output Voltage					
	MOC1000, MOC1002	1500			V_{pk}	
	MOC1001	2500			V_{pk}	
	MOC1003	500			V_{pk}	
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage		0.2	0.5	V	$I_C = 2.0 \text{ mA}, I_F = 50 \text{ mA}$
$I_C/I_F(CTR)$	Collector Current Transfer Ratio (Note 1)					$V_{CE} = 10 \text{ V}, I_F = 10 \text{ mA}$
	MOC1000, MOC1001	20	60		%	
	MOC1002, MOC1003	10	30		%	
R_{IO}	Input-to-Output Resistance		10^{11}		Ω	$V_{IO} = 500 \text{ V}$
C_{IO}	Input-to-Output Capacitance		1.3		pF	$f = 1.0 \text{ MHz}, V = \phi$
t_r, t_f	Collector Rise and Fall Times (Note 2)		2.8		μs	$I_C = 2.0 \text{ mA}, V_{CE} = 10 \text{ V}, R_L = 100 \Omega$

NOTES:

- Collector current transfer ratio is defined as the ratio of the collector current to the forward bias input current.
- Rise time is defined as the time for the collector current to rise from 10% to 90% of peak value. Fall time is defined as the time required for the current to decrease from 90% to 10% of peak value.

TIL111 • TIL114 • TIL116 • TIL117

OPTICALLY-COUPLED ISOLATOR

OPTOELECTRONICS PRODUCT GROUP

GENERAL DESCRIPTION – The TIL111, TIL114, TIL116 and TIL117 series of optically coupled isolators are electrical and mechanical replacement for the Texas Instruments series. Optical intercoupling provides a high degree of ac and dc isolation. Connection to the base is also provided for design flexibility.

- GLASSOLATED™
- HIGH CURRENT TRANSFER RATIO
- HIGH-SPEED SWITCHING – TYPICALLY 2 μ s
- 10^{11} Ω ISOLATION RESISTANCE
- LOW COUPLING CAPACITANCE – TYPICALLY 1.0 pF

ABSOLUTE MAXIMUM RATINGS

Storage Temperature	-55°C to +150°C
Operating Temperature	-55°C to +100°C
Pin Temperature (Soldering, 5 s)	260°C
Total Package Power Dissipation at $T_A = 25^\circ\text{C}$	250 mW
(LED plus Detector)	
Derate Linearly from 25°C	3.3 mW/°C

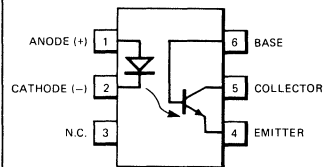
INPUT DIODE

V_R	Reverse Voltage	3.0 V
I_F	Forward Current	100 mA
i_f	Peak Forward Current (1 μ s pulse width, 300 pps)	3.0 A
P_D	Power Dissipation at $T_A = 25^\circ\text{C}$	150 mW
	Derate Linearly from 25°C	2.6 mW/°C

OUTPUT TRANSISTOR

V_{CE}	Collector to Emitter Voltage	30 V
V_{CB}	Collector to Base Voltage	70 V
P_D	Power Dissipation at $T_A = 25^\circ\text{C}$	150 mW
	Derate Linearly from 25°C	2.6 mW/°C

CONNECTION DIAGRAM DIP (TOP VIEW)



PIN NUMBERS

1 Anode (+)	} Input Diode
2 Cathode (-)	
3 NC	
4 Emitter	} Output npn Phototransistor
5 Collector	
6 Base	

ELECTRICAL CHARACTERISTICS – INPUT DIODE: $T_A = 25^\circ\text{C}$

SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	TEST CONDITIONS
V_F	Forward Voltage					
	TIL111, TIL114, TIL117		1.2	1.4	V	$I_F = 16$ mA
	TIL116		1.2	1.5	V	$I_F = 60$ mA
BV_R	Reverse Breakdown Voltage	3.0	5.0		V	$I_R = 10$ μ A

FAIRCHILD • TIL111 • TIL114 • TIL116 • TIL117

ELECTRICAL CHARACTERISTICS – OUTPUT TRANSISTOR: $T_A = 25^\circ\text{C}$

SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	TEST CONDITIONS
V _{CEO}	Collector-Emitter Voltage	30			V	$I_C = 1.0 \text{ mA}, I_F = 0$
V _{CBO}	Collector-Base Voltage	70			V	$I_C = 10 \mu\text{A}, I_F = 0$
V _{EBO}	Emitter-Base Voltage	7			V	$I_E = 10 \mu\text{A}$
I _{CEO}	Collector-Emitter Leakage Current		1.0	50	nA	$V_{CE} = 10 \text{ V}, I_F = 0$
I _{CBO}	Collector-Base Leakage Current		0.1	20	nA	$V_{CB} = 10 \text{ V}, I_F = 0$
h _{FE}	Forward Current Gain					
	TIL111, TIL114	100	300			$V_{CE} = 5 \text{ V}, I_C = 10 \text{ mA}$
	TIL116	100	300			$V_{CE} = 5 \text{ V}, I_C = 100 \mu\text{A}$
	TIL117	200	550			$V_{CE} = 5 \text{ V}, I_C = 10 \text{ mA}$

ELECTRICAL CHARACTERISTICS – COUPLED: $T_A = 25^\circ\text{C}$

SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	TEST CONDITIONS
I _C	Collector Output Current					
	TIL111, TIL114	2.0	7.0		mA	$V_{CE} = 0.4 \text{ V}, I_F = 16 \text{ mA}$
	TIL116	2.0	5.0		mA	$V_{CE} = 10 \text{ V}, I_F = 10 \text{ mA}$
	TIL117	5.0	9.0		mA	$V_{CE} = 10 \text{ V}, I_F = 10 \text{ mA}$
I _B	Collector-Base Current	10	20		μA	$V_{CB} = 0.4 \text{ V}, I_F = 16 \text{ mA}$
V _{ISO}	Isolation Voltage					
	TIL111	1500			V _{dc}	
	TIL114, TIL116, TIL117	2500			V _{dc}	
R _{ISO}	Isolation Resistance	10^{11}			Ω	$V = 500 \text{ V}$
V _{CE(sat)}	Collector-Emitter Saturation Voltage					
	TIL111, TIL114		0.25	0.4	V	$I_C = 2.0 \text{ mA}, I_F = 16 \text{ mA}$
	TIL116		0.25	0.4	V	$I_C = 2.2 \text{ mA}, I_F = 15 \text{ mA}$
	TIL117		0.25	0.4	V	$I_C = 0.5 \text{ mA}, I_F = 10 \text{ mA}$
C _{ISO}	Isolation Capacitance		1.0	1.3	pF	$V = 0, f = 1.0 \text{ MHz}$
t _{on, toff}	Turn-on, Turn-off Time					$I_C = 2.0 \text{ mA}, V_{CC} = 10 \text{ V}, R_L = 100 \Omega$ (See Note 2)
	TIL111, TIL114		2	5	μs	
	TIL116		2	7	μs	
	TIL117		2	9	μs	

NOTES:

- Collector current transfer ratio is defined as the ratio of the collector current to the forward bias input current.
- Rise time is defined as the time for the collector current to rise from 10% to 90% of peak value. Fall time is defined as the time required for the current to decrease from 90% to 10% of peak value.

TIL112 • TIL115 • TIL118

OPTICALLY-COUPLED ISOLATOR

OPTOELECTRONICS PRODUCT GROUP

GENERAL DESCRIPTION – The TIL112, TIL115 and TIL118 series of optical isolators are electrical and mechanical replacements for the Texas Instrument series. Optical intercoupling provides a high degree of ac and dc isolation. Connection to the base is also provided for design flexibility.

- GLASSOLATED™
- HIGH CURRENT TRANSFER RATIO
- HIGH-SPEED SWITCHING – TYPICALLY 2 μ s
- 10^{11} Ω ISOLATION RESISTANCE
- LOW COUPLING CAPACITANCE – TYPICALLY 1.0 pF

ABSOLUTE MAXIMUM RATINGS

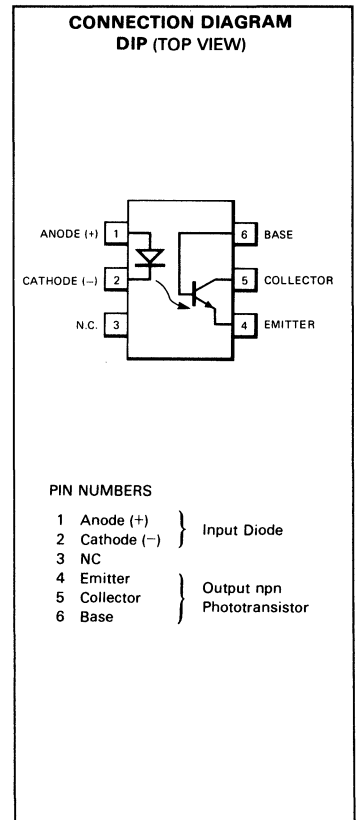
Storage Temperature	-55°C to +150°C
Operating Temperature	-55°C to +100°C
Pin Temperature (Soldering, 5 s)	260°C
Total Package Power Dissipation at $T_A = 25^\circ\text{C}$ (LED plus Detector)	250 mW
Derate Linearly from 25°C	3.3 mW/°C

INPUT DIODE

V_R	Reverse Voltage	3.0 V
I_F	Forward Current	100 mA
i_f	Peak Forward Current (1 μ s pulse width, 300 pps)	3.0 A
P_D	Power Dissipation at $T_A = 25^\circ\text{C}$	150 mW
	Derate Linearly from 25°C	2.0 mW/°C

OUTPUT TRANSISTOR

V_{CE}	Collector to Emitter Voltage	20 V
V_{CB}	Collector to Base Voltage	30 V
P_D	Power Dissipation at $T_A = 25^\circ\text{C}$	150 mW
	Derate Linearly from 25°C	2.0 mW/°C



ELECTRICAL CHARACTERISTICS – INPUT DIODE: $T_A = 25^\circ\text{C}$

SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	TEST CONDITIONS
V_F	Forward Voltage		1.2	1.5	V	$I_F = 10$ mA
BV_R	Reverse Breakdown Voltage	3.0	5.0		V	$I_R = 10$ μ A

FAIRCHILD • TIL112 • TIL115 • TIL118

ELECTRICAL CHARACTERISTICS – OUTPUT TRANSISTOR: $T_A = 25^\circ\text{C}$

SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	TEST CONDITIONS
V _{CEO}	Collector-Emitter Voltage	20			V	I _C = 1.0 mA, I _F = 0
V _{CB0}	Collector-Base Voltage	30			V	I _C = 10 μ A, I _F = 0
V _{EBO}	Emitter-Collector Voltage (V _{ECO} on TIL118)	4.0			V	I _E = 10 μ A, I _F = 0
I _{CEO}	Collector-Emitter Leakage Current		1.0	100	nA	V _{CE} = 5.0 V, I _F = 0
I _{CBO}	Collector-Base Leakage Current		0.1	50	nA	V _{CB} = 5.0 V, I _F = 0
h _{FE}	Forward Current Gain	50	200			V _{CE} = 5.0 V, I _C = 10 μ A

ELECTRICAL CHARACTERISTICS – COUPLED: $T_A = 25^\circ\text{C}$

SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	TEST CONDITIONS
I _C	Collector Output Current					
	TIL112, TIL115	0.2	2.0		mA	V _{CE} = 5.0 V, I _F = 10 mA
	TIL118	1.0	2.0		mA	V _{CE} = 5.0 V, I _F = 10 mA
I _B	Collector-Base Current					
	TIL112, TIL115	2	10		μ A	V _{CB} = 5.0 V, I _F = 10 mA
V _{ISO}	Isolation Voltage					
	TIL112, TIL118	1500			V _{dC}	
	TIL115	2500			V _{dC}	
R _{ISO}	Isolation Resistance		10 ¹¹		Ω	V = 500 V
C _{ISO}	Isolation Capacitance			2	pF	f = 1 MHz
V _{CE(sat)}	Collector-Emitter Saturation Voltage			0.5	V	I _C = 2.0 mA, I _F = 50 mA
t _{on}	Turn-on Time		2.0	15	μ s	I _C = 2.0 mA, V _{CC} = 10 V, R _L = 100 Ω
t _{off}	Turn-off Time (See Note 1)		2.0	15	μ s	I _C = 2.0 mA, V _{CC} = 10 V, R _L = 100 Ω

NOTES:

- Collector current transfer ratio is defined as the ratio of the collector current to the forward bias input current.
- Rise time is defined as the time for the collector current to rise from 10% to 90% of peak value. Fall time is defined as the time required for the current to decrease from 90% to 10% of peak value.

TIL113 • TIL119

OPTICALLY—COUPLED DARLINGTON ISOLATOR

OPTOELECTRONICS PRODUCT GROUP

GENERAL DESCRIPTION — The TIL113 and TIL119 optical isolators are electrical and mechanical replacements for the Texas Instrument series. Optical coupling provides a high degree of ac and dc isolation. A capability for continuous operation of the input diode results in a frequency response extending to dc. Connection to the base is also provided for design flexibility.

- GLASSOLATED™
- ELECTRICALLY EQUIVALENT TO TI DEVICES
- PIN-FOR-PIN EQUIVALENT
- AVAILABILITY OF BASE PIN FOR FLEXIBLE DESIGN

ABSOLUTE MAXIMUM RATINGS

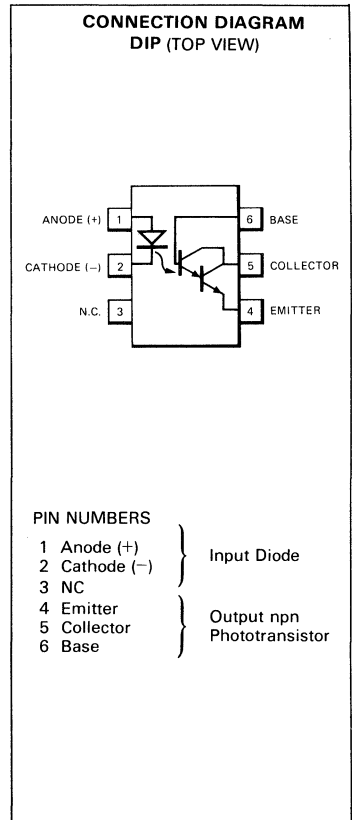
Storage Temperature	-55°C to +150°C
Operating Temperature	-55°C to +100°C
Pin Temperature (Soldering, 10 s)	260°C
Total Package Power Dissipation at $T_A = 25^\circ\text{C}$ (LED plus Detector)	250 mW
Derate Linearly from 25°C	3.3 mW/°C

INPUT DIODE

I_F	Forward dc Current Continuous	100 mA
V_R	Reverse Voltage	3.0 V
I_f	Peak Forward Current (1 μs pulse width, 300 pps)	3.0 A
P_D	Power Dissipation at $T_A = 25^\circ\text{C}$	150 mW
	Derate Linearly from 25°C	2.0 mW/°C

OUTPUT TRANSISTOR (DARLINGTON)

V_{CEO}	Collector to Emitter Voltage	30 V
V_{CBO}	Collector to Base Voltage	30 V
V_{ECO}	Emitter to Collector Voltage	7.0 V
P_D	Power Dissipation at $T_A = 25^\circ\text{C}$ (Max I_C 100 mA at $V_{CE} = 1.5$ V)	150 mW
	Derate Linearly from 25°C	2.0 mW/°C



ELECTRICAL CHARACTERISTICS — INPUT DIODE: $T_A = 25^\circ\text{C}$

SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	TEST CONDITIONS
V_F	Forward Voltage			1.5	V	$I_F = 10$ mA $V_R = 3.0$ V
I_R	Reverse Current			100	μA	

FAIRCHILD • TIL113 • TIL119

ELECTRICAL CHARACTERISTICS – OUTPUT TRANSISTOR (DARLINGTON): $T_A = 25^\circ\text{C}$

SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	TEST CONDITIONS
V_{CE0}	Collector-Emitter Breakdown Voltage	30			V	$I_C = 1.0\text{ mA}, I_F = 0$
V_{CBO}	Collector-Base Breakdown Voltage TIL113	30				$I_C = 10\ \mu\text{A}, I_F = 0$
V_{ECO}	Emitter-Collector Breakdown Voltage TIL119	7.0			V	$I_E = 10\ \mu\text{A}, I_F = 0$
V_{EBO}	Emitter-Base Breakdown Voltage TIL113	7.0			V	$I_E = 10\ \mu\text{A}, I_F = 0$
I_{CEO}	Collector-Emitter Leakage Current				nA	$V_{CE} = 10\text{ V}, I_F = 0$
h_{FE}	DC Forward Current Gain TIL113		15,000			$V_{CE} = 1.0\text{ V}, I_C = 10\text{ mA}, I_F = \phi$

ELECTRICAL CHARACTERISTICS – COUPLED ($T_A = 25^\circ\text{C}$)

SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	TEST CONDITIONS
I_C	Collector Output Current (Pulsed) TIL113	30	100		mA	$I_F = 10\text{ mA}, V_{CE} = 1.0\text{ V}$
	TIL119	30	160		mA	$I_F = 10\text{ mA}, V_{CE} = 2.0\text{ V}$
V_{ISO}	Isolation Voltage (Note 2)	1500			V	Peak
R_{ISO}	Isolation Resistance	10^{11}			Ω	$V = 500\text{ V}$
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage TIL113			1.0	V	$I_C = 125\text{ mA}, I_B = 0, I_F = 50\text{ mA}$
	TIL119			1.0	V	$I_C = 10\text{ mA}, I_F = 10\text{ mA}$
C_{ISO}	Isolation Capacitance		1.0	1.3	pF	$V = 0, f = 1.0\text{ MHz}$
t_{on}, t_{off}	Turn-on, Turn-off Time (Note 1) TIL113		50		μs	$I_C = 125\text{ mA}, V_{CC} = 15\text{ V}, R_L = 100\ \Omega$
t_{on}, t_{off}	Turn-on, Turn-off Time (Note 1) TIL119		50		μs	$I_C = 2.5\text{ mA}, V_{CC} = 10\text{ V}, R_L = 100\ \Omega$

NOTES:

1. Turn-on time is defined as the time for the (base collector) current to rise from 10% to 90% of peak value. Turn-off time is defined as the time required for the current to decrease from 90% to 10% of peak value.
2. Isolation voltage defined as min of 5 seconds continuous application.

4N25 • 4N26 • 4N27 • 4N28

OPTICALLY-COUPLED ISOLATOR

OPTOELECTRONICS PRODUCT GROUP

GENERAL DESCRIPTION – The 4N25, 4N26, 4N27 and 4N28 series of optoisolators have a npn silicon Planar* phototransistor coupled to a gallium arsenide diode. Each is mounted in a 6-pin plastic dual in-line package.

- GLASSOLATED™
- HIGH CURRENT TRANSFER RATIO – TYPICALLY 50%
- 500 V TO 2500 V MINIMUM ISOLATION INPUT-TO-OUTPUT
- $10^{11} \Omega$ ISOLATION RESISTANCE
- LOW COUPLING CAPACITANCE – TYPICALLY 1.0 pF

ABSOLUTE MAXIMUM RATINGS

Storage Temperature**	-55°C to 150°C
Operating Temperature	-55°C to 100°C
Pin Temperature (Soldering, 10 s)**	260°C
Total Package Power Dissipation at $T_A = 25^\circ\text{C}^{**}$ (LED plus Detector)	250 mW
Derate Linearly from 25°C**	3.3 mW/°C

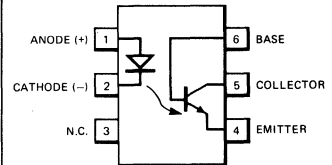
INPUT DIODE

V_R^{**}	Reverse Voltage	3.0 V
I_F^{**}	Forward Current	80 mA
i_f^{**}	Peak Forward Current (1 μs pulse width, 300 pps)	3.0 A
P_D^{**}	Power Dissipation at $T_A = 25^\circ\text{C}$	150 mW
	Derate Linearly from 25°C	2.0 mW/°C

OUTPUT TRANSISTOR

V_{CE}^{**}	Collector to Emitter Voltage	30 V
V_{CB}^{**}	Collector to Base Voltage	70 V
V_{EC}^{**}	Emitter to Collector Voltage	7.0 V
P_D^{**}	Power Dissipation at $T_A = 25^\circ\text{C}$	150 mW
	Derate Linearly from 25°C	2.0 mW/°C

**CONNECTION DIAGRAM
DIP (TOP VIEW)**



PIN NUMBERS

1 Anode (+)	} Input Diode
2 Cathode (-)	
3 NC	
4 Emitter	} Output npn Phototransistor
5 Collector	
6 Base	

ELECTRICAL CHARACTERISTICS – INPUT DIODE: $T_A = 25^\circ\text{C}$

SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	TEST CONDITIONS
V_F^{**}	Forward Voltage		1.2	1.5	V	$I_F = 50 \text{ mA}$ $V_R = 3.0 \text{ V}$, $R_L = 1 \text{ M}\Omega$ $V_R = 0 \text{ V}$, $f = 1 \text{ MHz}$
I_R^{**}	Reverse Leakage Current		0.05	100	μA	
C	Capacitance		150		pF	

**Indicates JEDEC registered values.

*Planar is a patented Fairchild process.

FAIRCHILD • 4N25 • 4N26 • 4N27 • 4N28

ELECTRICAL CHARACTERISTICS – OUTPUT TRANSISTOR: $T_A = 25^\circ\text{C}$

SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	TEST CONDITIONS
V_{CE}^{**}	Collector-Emitter Voltage	30	65		V	$I_C = 1.0\text{ mA}, I_B = 0$
V_{CBO}^{**}	Collector-Base Voltage	70	165		V	$I_C = 100\ \mu\text{A}, I_E = 0$
V_{ECO}^{**}	Emitter-Collector Voltage	7.0	14		V	$I_E = 100\ \mu\text{A}, I_B = 0$
I_{CEO}^{**}	Collector-Emitter Leakage Current					
	4N25, 4N26, 4N27		3.5	50	nA	$V_{CE} = 10\text{ V}, \text{Base Open}$
	4N28			100	nA	$V_{CE} = 10\text{ V}, \text{Base Open}$
I_{CBO}^{**}	Collector-Base Leakage Current		0.1	20	nA	$V_{CB} = 10\text{ V}, \text{Emitter Open}$
h_{FE}	Forward Current Gain		250			$V_{CE} = 5.0\text{ V}, I_C = 500\ \mu\text{A}$
C_{cb}	Collector-Base Capacitance		65		pF	$V_{CB} = 0, f = 1\text{ MHz}$

ELECTRICAL CHARACTERISTICS – COUPLED: $T_A = 25^\circ\text{C}$

SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	TEST CONDITIONS
V_{IO}^{**}	Input-to-Output Voltage					
	4N25	2500			V_{pk}	
	4N26, 4N27	1500			V_{pk}	
	4N28	500			V_{pk}	
$V_{CE(sat)}^{**}$	Collector-Emitter Saturation Voltage		0.2	0.5	V	$I_C = 2.0\text{ mA}, I_F = 50\text{ mA}$
I_C^{**}	Collector Output Current					
	4N25, 4N26	2.0	5.0		mA	$V_{CE} = 10\text{ V}, I_F = 10\text{ mA}, I_B = 0$
	4N27, 4N28	1.0	3.0		mA	$V_{CE} = 10\text{ V}, I_F = 10\text{ mA}, I_B = 0$
R_{IO}	Input-to-Output Resistance		10^{11}		Ω	$V_{IO} = 500\text{ V}$
BW	Collector Bandwidth		300		kHz	$I_C = 2.0\text{ mA}, V_{CC} = 10\text{ V}, R_L = 100\ \Omega$
C_{IO}	Input-to-Output Capacitance		1.3		pF	$V_{IO} = 0, f = 1.0\text{ MHz}$

**Indicates JEDEC registered values.

4N29 • 4N30 • 4N31 • 4N32 • 4N33

OPTICALLY-COUPLED DARLINGTON ISOLATOR

OPTOELECTRONICS PRODUCTS GROUP

GENERAL DESCRIPTION – The 4N29, 4N30, 4N31, 4N32 and 4N33 series of optoisolators have a npn silicon Planar* photo-Darlington transistor coupled to a gallium arsenide diode. Each is mounted in a six pin plastic DIP package.

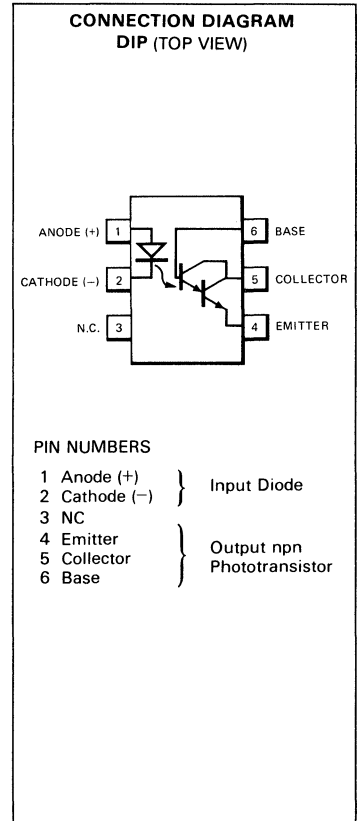
- HIGH CURRENT TRANSFER RATIO
- 1500 or 2500 V MINIMUM ISOLATION INPUT-TO-OUTPUT
- $10^{11} \Omega$ ISOLATION RESISTANCE
- LOW COUPLING CAPACITANCE

ABSOLUTE MAXIMUM RATINGS

Storage Temperature**	-55°C to 150°C
Operating Temperature	-55°C to 100°C
Pin Temperature (Soldering, 10 s)**	260°C
Total Package Power Dissipation at $T_A = 25^\circ\text{C}$ (LED plus Detector)**	250 mW
Derate Linearly from 25°C**	3.3 mW/°C
INPUT DIODE**	
I_F Forward dc Current Continuous	80 mA
V_R Reverse Voltage	3.0 V
i_f Peak Forward Current (1 μs pulse width, 300 pps)	3.0 A
P_D Power Dissipation at $T_A = 25^\circ\text{C}$	150 mW
	Derate Linearly from 25°C
	2.0 mW/°C

OUTPUT TRANSISTOR (DARLINGTON)**

V_{CE0} Collector to Emitter Voltage	30 V
V_{CB0} Collector to Base Voltage	50 V
V_{EB0} Emitter to Base Voltage	8.0 V
V_{ECO} Emitter to Collector Voltage	5.0 V
P_D Power Dissipation at $T_A = 25^\circ\text{C}$	150 mW
	Derate Linearly from 25°C
	2.0 mW/°C



ELECTRICAL CHARACTERISTICS – INPUT DIODE: $T_A = 25^\circ\text{C}$

SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	TEST CONDITIONS
V_F^{**}	Forward Voltage		1.2	1.5	V	$I = 50 \text{ mA}$
I_R^{**}	Reverse Leakage Current		0.05	100	μA	$V_R = 3.0 \text{ V}$
C	Capacitance		150		pF	$V_R = 0 \text{ V}, f = 1 \text{ MHz}$

FAIRCHILD • 4N29 • 4N30 • 4N31 • 4N32 • 4N33

ELECTRICAL CHARACTERISTICS – OUTPUT TRANSISTOR (DARLINGTON): $T_A = 25^\circ\text{C}$

SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	TEST CONDITIONS
BV_{CEO}^{**}	Collector-Emitter Breakdown Voltage	30	70		V	$I_C = 100 \mu\text{A}, I_B = 0$
BV_{CBO}^{**}	Collector-Base Breakdown Voltage	30			V	$I_C = 100 \mu\text{A}, I_E = 0$
BV_{ECO}^{**}	Emitter-Collector Breakdown Voltage	5.0			V	$I_E = 100 \mu\text{A}, I_B = 0$
I_{CEO}^{**}	Collector-Emitter Dark Current			100	nA	$V_{CE} = 10 \text{ V}, \text{Base Open}$
h_{FE}	DC Current Gain		2000			$V_{CE} = 5.0 \text{ V}, I_C = 500 \mu\text{A}$

ELECTRICAL CHARACTERISTICS – COUPLED: $T_A = 25^\circ\text{C}$

SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	TEST CONDITIONS
I_C^{**}	Collector Output Current					
	4N32, 4N33	50			mA	$V_{CE} = 10 \text{ V}, I_F = 10 \text{ mA}$
	4N29, 4N30	10			mA	$V_{CE} = 10 \text{ V}, I_F = 10 \text{ mA}$
	4N31	5.0			mA	$V_{CE} = 10 \text{ V}, I_F = 10 \text{ mA}$
V_{ISO}^{**}	Isolation Voltage				Vdc	
	4N29, 4N32	2500			Vdc	
	4N30, 4N31, 4N33	1500			Vdc	
R_{ISO}^{**}	Isolation Resistance		10^{11}		Ω	$V = 500 \text{ V}$
$V_{CE(sat)}^{**}$	Collector-Emitter Saturation Voltage					
	4N31			1.2	V	$I_C = 2.0 \text{ mA}, I_F = 8.0 \text{ mA}$
	4N29, 4N30, 4N32, 4N33			1.0	V	$I_C = 2.0 \text{ mA}, I_F = 8.0 \text{ mA}$
C_{ISO}	Isolation Capacitance		1.5		pF	$V = 0, f = 1.0 \text{ MHz}$
t_{on}	Turn-on Time		10		μs	$I_C = 50 \text{ mA}, V_{CC} = 10 \text{ V}, R_L = 180 \Omega,$ $I_F = 200 \text{ mA}$
t_{off}	Turn-off Time (See Note 1)		20	45	μs	$I_C = 50 \text{ mA}, V_{CC} = 10 \text{ V}, R_L = 180 \Omega,$ $I_F = 200 \text{ mA}$
		4N29, 4N30, 4N31		60	120	
	4N32, 4N33				μs	

*Planar is a patented Fairchild process.

**Indicates JEDEC Registered Data.

NOTE:

1. Turn-on time is defined as the time for the (base collector) current to rise from 10% to 90% of peak value. Turn-off time is defined as the time required for the current to decrease from 90% to 10% of peak value.

4N35 • 4N36 • 4N37

OPTICALLY-COUPLED ISOLATOR

OPTOELECTRONICS PRODUCTS GROUP

GENERAL DESCRIPTION – The 4N35, 4N36 and 4N37 series of optoisolators have a npn silicon Planar* phototransistor in close proximity to a gallium arsenide diode. Optical coupling provides a high degree of ac and dc isolation. A capability for continuous operation of the input diode results in a frequency response extending to dc. Connection to the transistor base is also provided for design flexibility. This isolator series is covered under U.L. component recognition program, reference file E55299.

- **GLASSOLATED™**
- **HIGH CURRENT TRANSFER RATIO – MINIMUM 100%**
- **1500 V TO 3500 V MINIMUM ISOLATION INPUT-TO-OUTPUT**
- **10¹¹ Ω ISOLATION RESISTANCE**
- **LOW COUPLING CAPACITANCE – TYPICALLY 1.0 pF**

ABSOLUTE MAXIMUM RATINGS

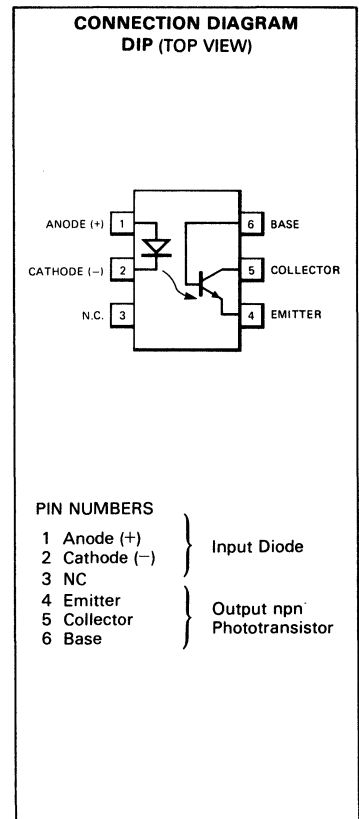
Storage Temperature**	–55°C to +150°C
Operating Temperature	–55°C to +100°C
Pin Temperature (Soldering, 10 s)**	260°C
Relative Humidity at 85°C**	85%

INPUT DIODE

V_R^{**}	Reverse Voltage	6.0 V
I_F^{**}	Forward Current	60 mA
i_f^{**}	Peak Forward Current (1 μ s pulse width, 300 pps)	3.0 A
P_D^{**}	Power Dissipation at $T_A = 25^\circ\text{C}$	100 mW
	Derate Linearly from 25°C	1.33 mW/°C

OUTPUT TRANSISTOR

V_{CE}^{**}	Collector to Emitter Voltage	30 V
V_{CB}^{**}	Collector to Base Voltage	70 V
V_{EC}^{**}	Emitter to Collector Voltage	7.0 V
I_C^{**}	Collector Current	100 mA
P_D^{**}	Power Dissipation at $T_A = 25^\circ\text{C}$	300 mW
	Derate Linearly from 25°C	4.0 mW/°C



ELECTRICAL CHARACTERISTICS – INPUT DIODE: $T_A = 25^\circ\text{C}$

SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	TEST CONDITIONS
V_F^{**}	Forward Voltage	0.8		1.5	V	$I_F = 10\text{ mA}$ $V_R = 6.0\text{ V}$ $V_R = 0\text{ V}, f = 1\text{ MHz}$
I_R^{**}	Reverse Leakage Current		.01	10	μA	
C	Capacitance			100	pF	

**Indicates JEDEC registered values.

*Planar is a patented Fairchild process.

FAIRCHILD • 4N35 • 4N36 • 4N37

ELECTRICAL CHARACTERISTICS – OUTPUT TRANSISTOR: $T_A = 25^\circ\text{C}$

SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	TEST CONDITIONS
V_{CE}^{**}	Collector-Emitter Voltage	30	65		V	$I_C = 10\text{ mA}$
V_{CBO}^{**}	Collector-Base Voltage	70	165		V	$I_C = 100\ \mu\text{A}$
V_{ECO}^{**}	Emitter-Collector Voltage	7.0	14		V	$I_E = 100\ \mu\text{A}, I_F = 0$
I_{CEO}^*	Collector-Emitter Leakage Current		5	50	nA	$V_{CE} = 10\text{ V}, I_F = 0$
I_{CEO}^{**}	Collector-Emitter Leakage Current			500	μA	$V_{CE} = 30\text{ V}, I_F = 0, T_A = 100^\circ\text{C}$
h_{FE}	Forward Current Gain	100	250			$V_{CE} = 5.0\text{ V}, I_C = 100\ \mu\text{A}$
C_{cb}	Collector-Base Capacitance		25		pF	$V_{CB} = 10$

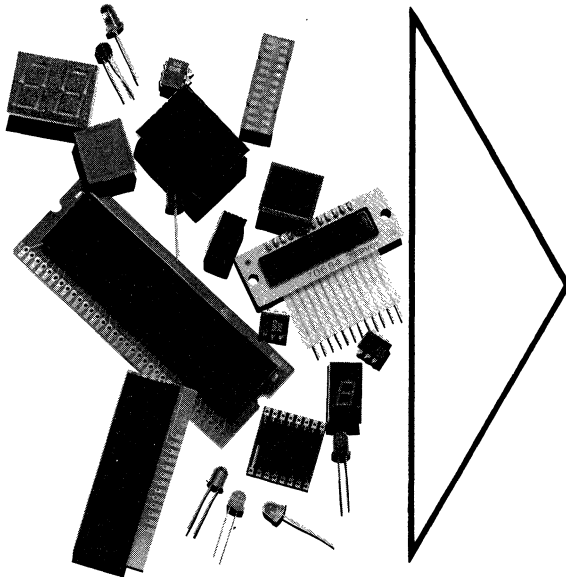
ELECTRICAL CHARACTERISTICS – COUPLED: $T_A = 25^\circ\text{C}$

SYMBOL	CHARACTERISTIC	MIN	TYP	MAX	UNITS	TEST CONDITIONS
I_{IO}^{**}	Input-to-Output Current					Pulse Width = 8 ms
	4N35			100	μA	$V_{IO} = 3550\text{ V}$
	4N36			100	μA	$V_{IO} = 2500\text{ V}$
	4N37			100	μA	$V_{IO} = 1500\text{ V}$
$V_{CE(sat)}^{**}$	Collector-Emitter Saturation Voltage			0.3	V	$I_C = 0.5\text{ mA}, I_F = 10\text{ mA}$
$I_C/I_F(\text{CTR})^{**}$	Collector Current Transfer Ratio (Note 1)	100			%	$V_{CE} = 10\text{ V}, I_F = 10\text{ mA}$
$I_C/I_F(\text{CTR})^{**}$	Collector Current Transfer Ratio (Note 1)	40			%	$V_{CE} = 10\text{ V}, I_F = 10\text{ mA}$ $T_A = -55^\circ\text{C to } 100^\circ\text{C}$
R_{IO}^{**}	Input-to-Output Resistance	10^{11}			Ω	$V_{IO} = 500\text{ V}$
C_{IO}^{**}	Input-to-Output Capacitance		1.0	2.5	pF	$V_{IO} = 0, f = 1.0\text{ MHz}$
t_{on}	Turn-on Time		5	10	μs	$I_C = 2.0\text{ mA}, V_{CC} = 10\text{ V}, R_L = 100\ \Omega$
t_{off}	Turn-off Time		5	10	μs	$I_C = 2.0\text{ mA}, V_{CC} = 10\text{ V}, R_L = 100\ \Omega$

**Indicates JEDEC registered values.

NOTES:

- Collector current transfer ratio is defined as the ratio of the collector current to the forward bias input current.



OPTOELECTRONIC TECHNOLOGY 1

DISCRETE LED DIGIT RELIABILITY 2

VISIBLE LED LAMPS AND MOUNTING HARDWARE 3

SEVEN-SEGMENT DISPLAYS AND DISPLAY ARRAYS 4

PHOTOTRANSISTORS, INFRARED EMITTERS, AND SENSORS 5

PHOTOCOUPLERS 6

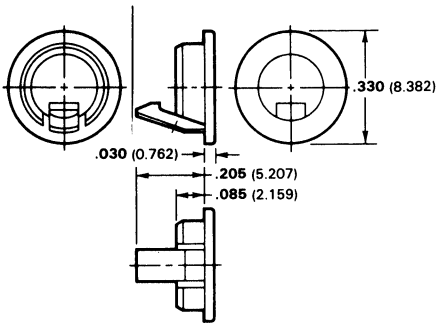
PACKAGE OUTLINES 7

DEFINITIONS OF SYMBOLS AND TERMS 8

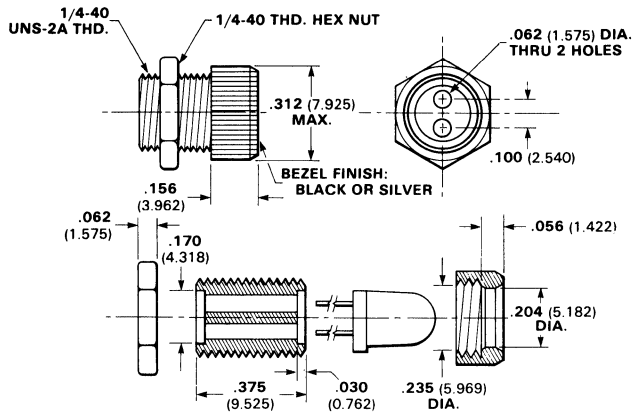
FAIRCHILD FIELD SALES OFFICES, SALES REPRESENTATIVES AND DISTRIBUTOR LOCATIONS 9

FAIRCHILD PACKAGE OUTLINES

Opto - 1



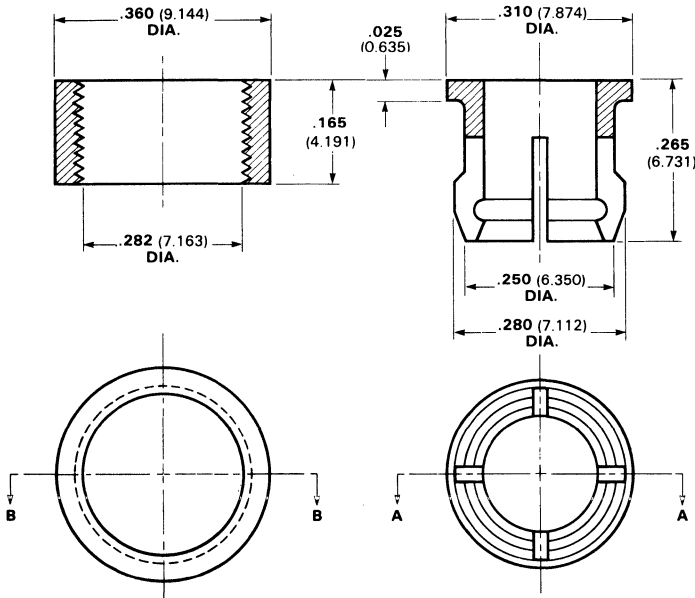
Opto - 2



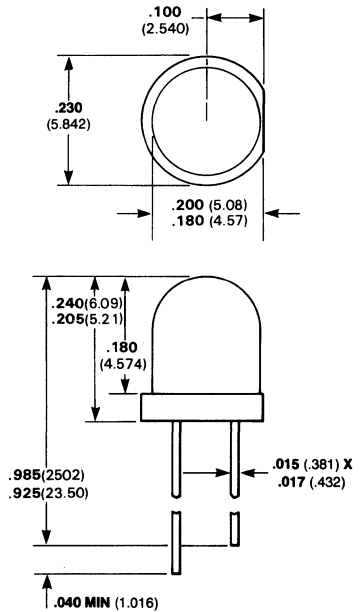
NOTES:

All dimensions in inches (bold) and millimeters (parentheses)

Opto - 3



Opto - 4



NOTES:

All dimensions in inches (bold) and millimeters (parentheses)

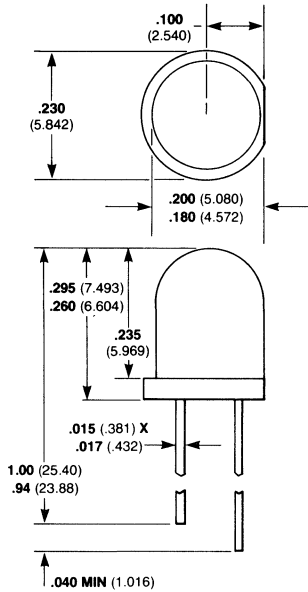
NOTES:

All dimensions in inches (bold) and millimeters (parentheses)

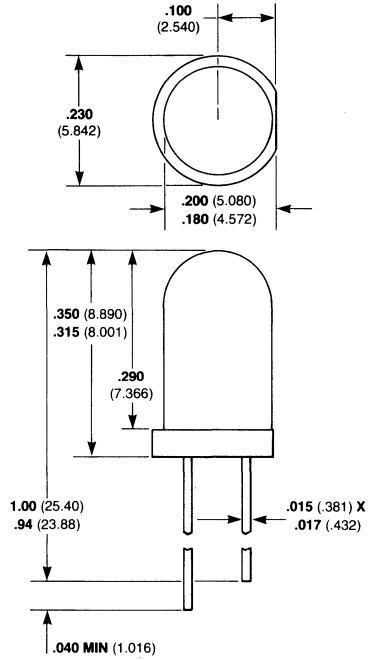
Tolerance unless specified = $\pm .015 (\pm .381)$

FAIRCHILD PACKAGE OUTLINES

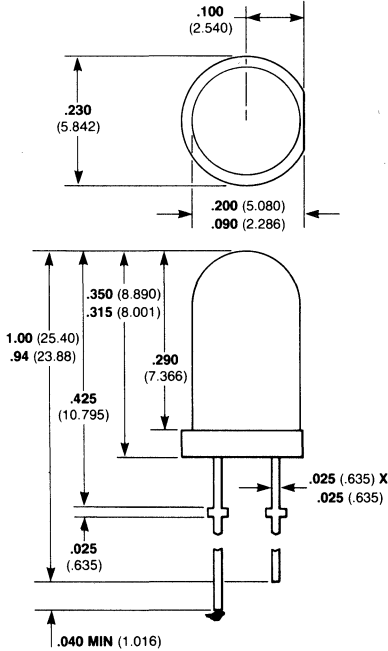
Opto-5



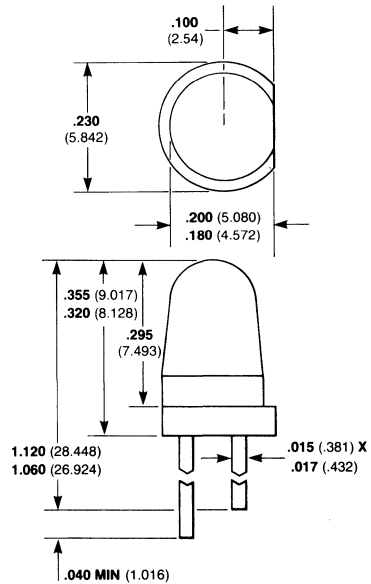
Opto-6



Opto-7



Opto-8

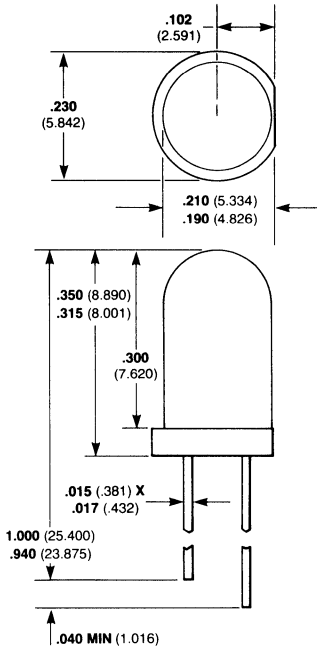


NOTES:

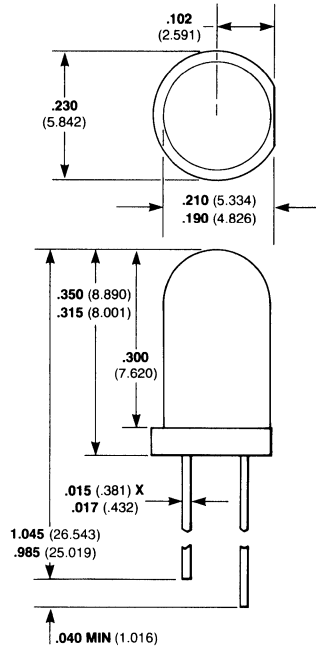
All dimensions in inches (bold) and millimeters (parentheses)
Tolerance unless specified = $\pm .015$ ($\pm .381$)

FAIRCHILD PACKAGE OUTLINES

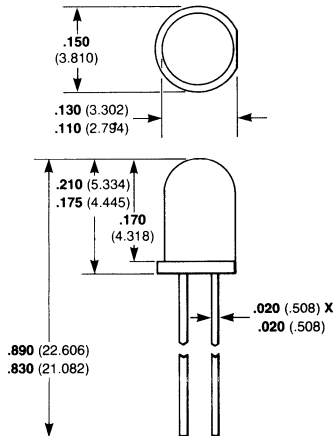
Opto - 9



Opto - 10



Opto - 11

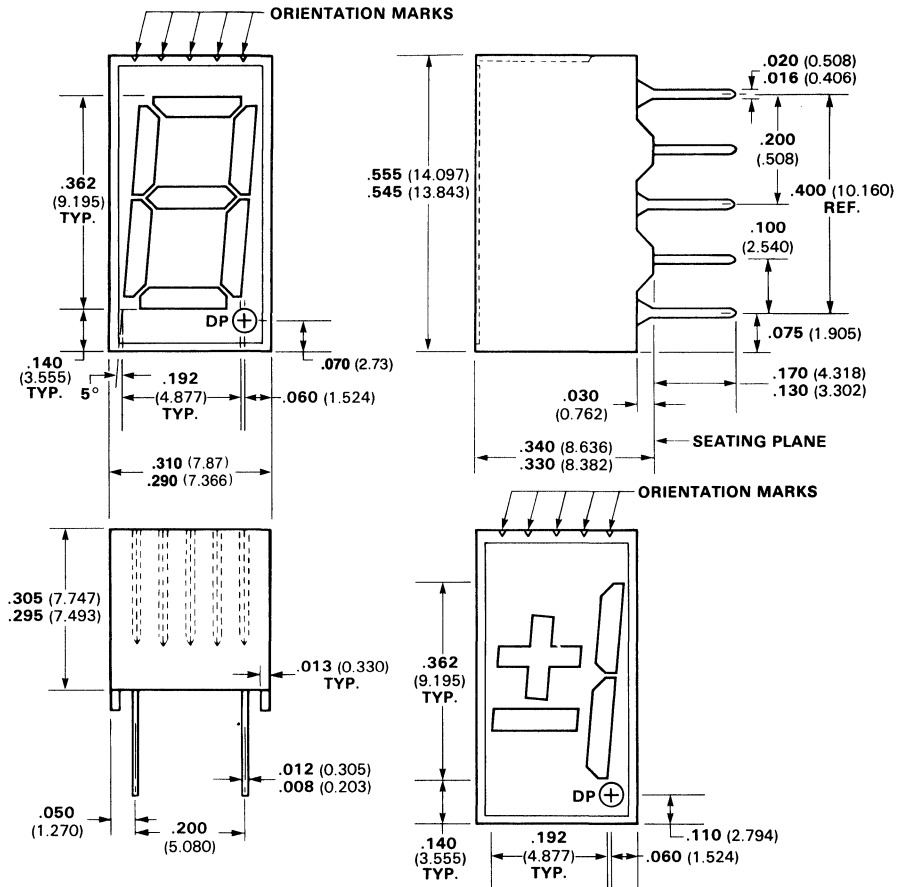


NOTES:

All dimensions in inches (bold) and millimeters (parentheses)
Tolerance unless specified = $\pm .015$ ($\pm .381$)

FAIRCHILD PACKAGE OUTLINES

Opto - 12



NOTES:

All dimensions in inches (bold) and millimeters (parentheses)

For polarity indication the top surface is ribbed.

The unit LED segments cannot necessarily be seen through the lens cap.

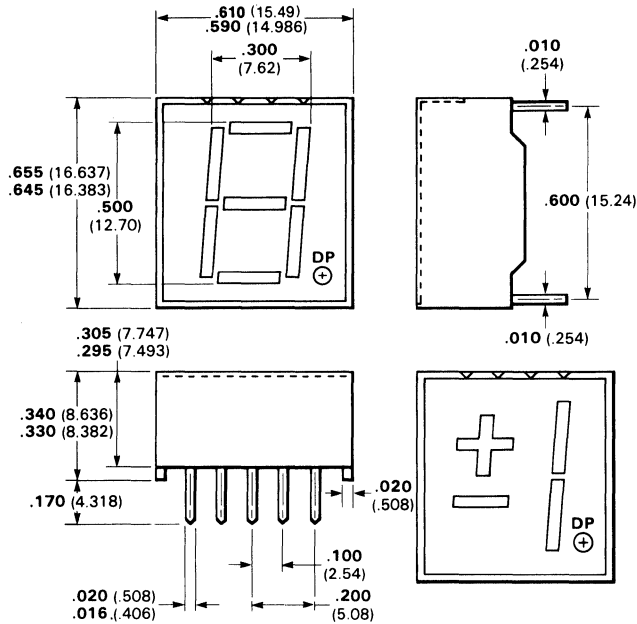
Lens cap color is red for red LED.

Pins 1 and 6 are common.

All dimensions are $\pm .015$ inch.

FAIRCHILD PACKAGE OUTLINES

Opto - 13

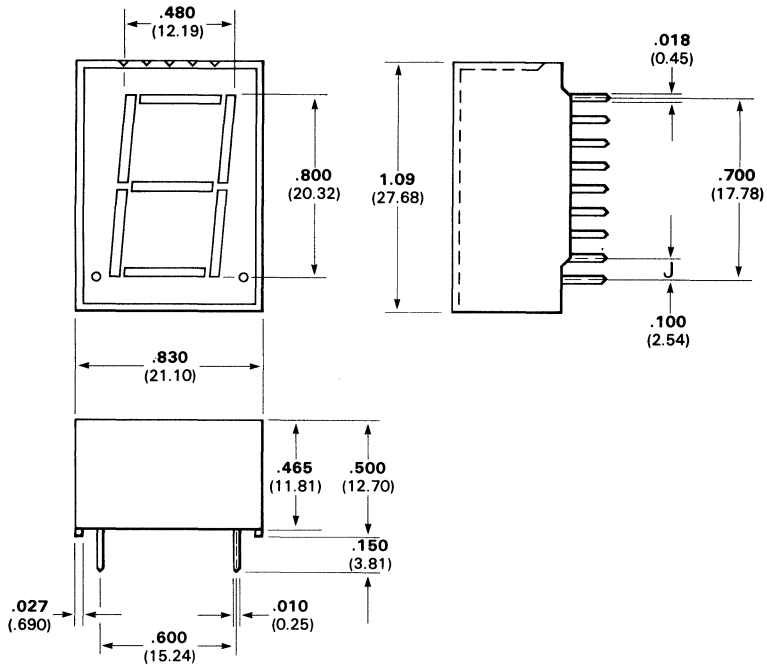


NOTES:

- All dimensions in inches (bold) and millimeters (parentheses)
- For polarity indication the surface is ribbed.
- The unlit LED segments cannot necessarily be seen through the lens cap.
- Lens cap color is red for red LED
- Pins 3 and 8 are common
- All dimensions are $\pm .015$ inch

FAIRCHILD PACKAGE OUTLINES

Opto - 14



NOTES:

All dimensions in inches (bold) and millimeters (parentheses)

For polarity indication the surface is ribbed.

The unlit LED segments cannot necessarily be seen through the lens cap.

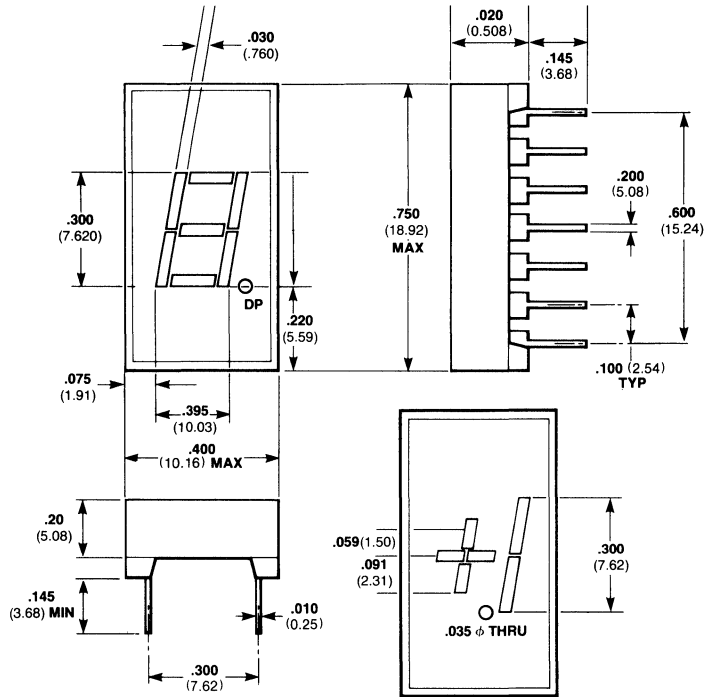
Lens cap color is red for red LED

Pins 4, 6, 12 and 17 are common

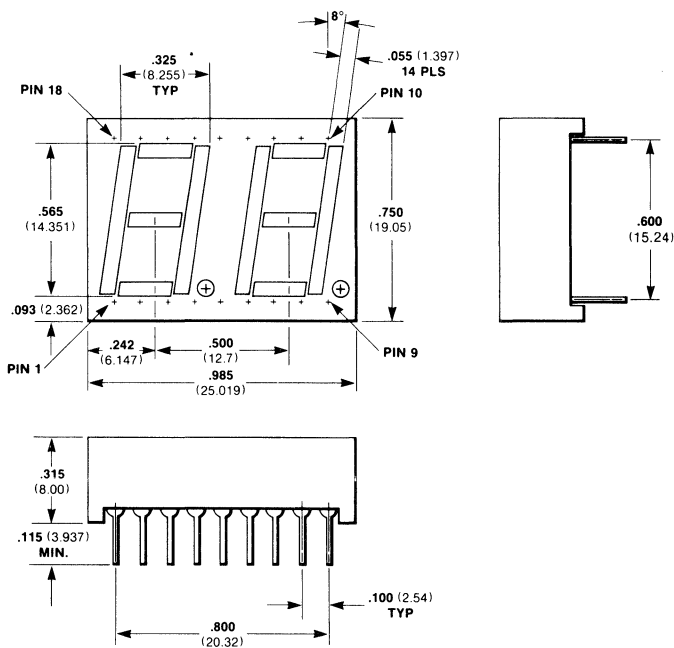
All dimensions are ± 0.015 inch

FAIRCHILD PACKAGE OUTLINES

Opto - 15



Opto - 16

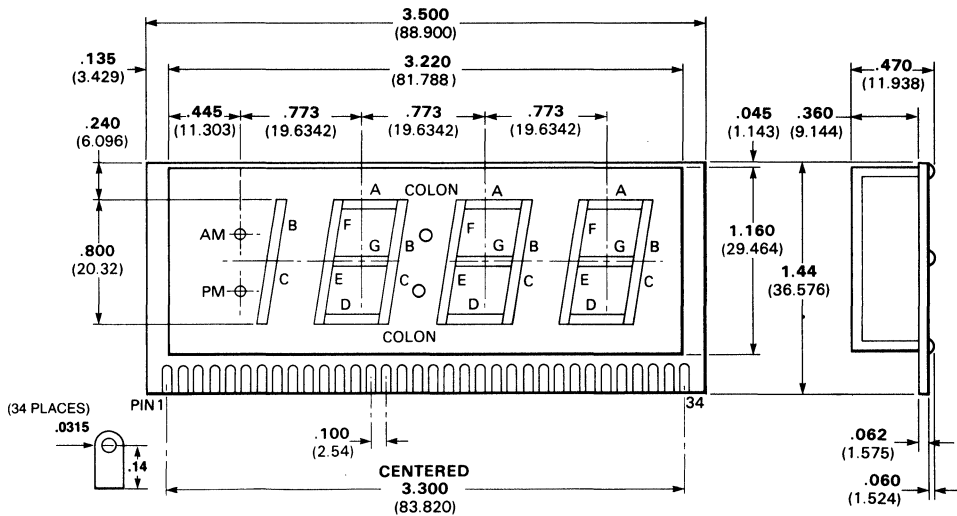


NOTES:

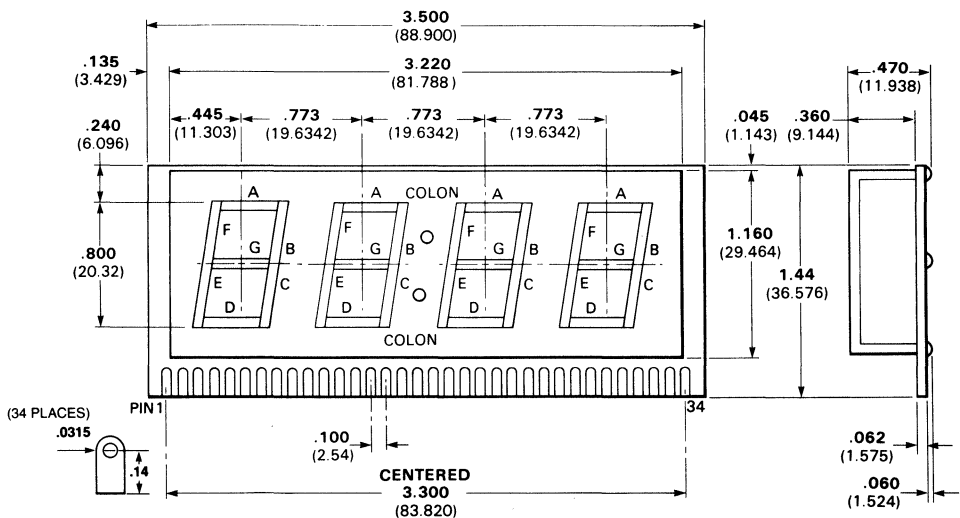
All dimensions in inches (bold) and millimeters (parentheses)

FAIRCHILD PACKAGE OUTLINES

Opto - 17



Opto - 18

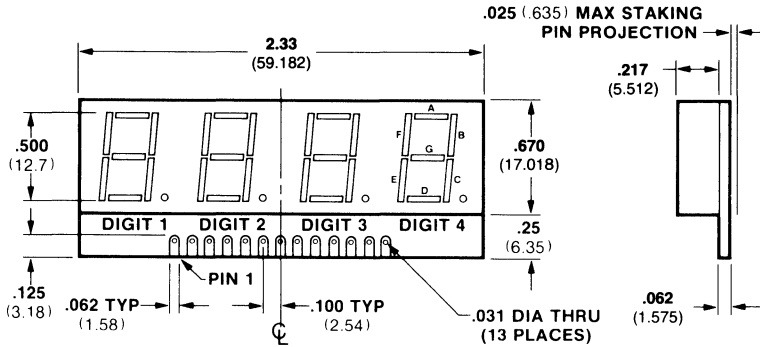


NOTES:

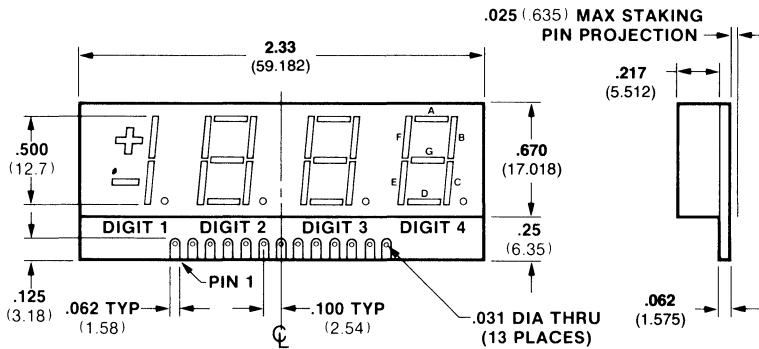
All dimensions in inches (bold) and millimeters (parentheses)

FAIRCHILD PACKAGE OUTLINES

Opto-20



Opto-21

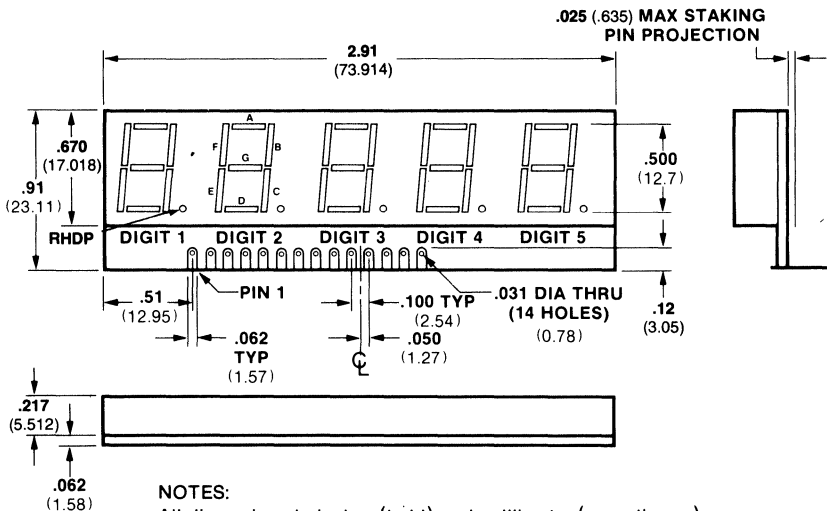


NOTES:

All dimensions in inches (bold) and millimeters (parentheses)

FAIRCHILD PACKAGE OUTLINES

Opto - 22



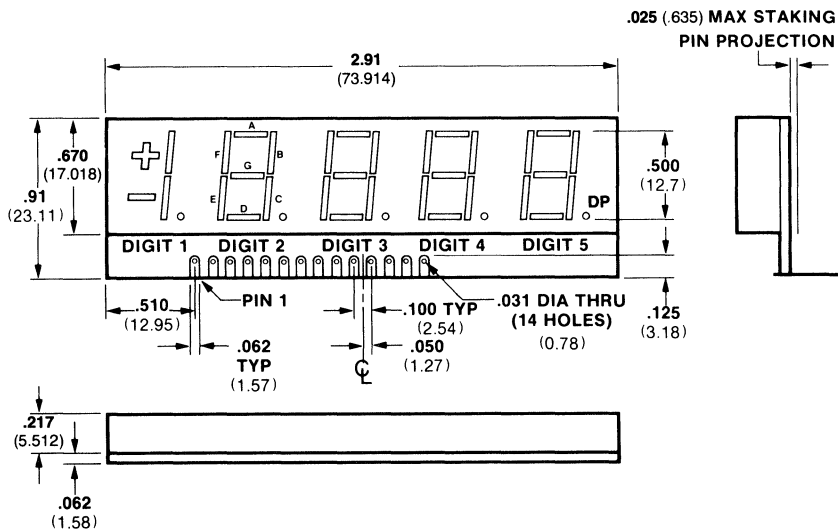
NOTES:

All dimensions in inches (bold) and millimeter (parentheses)

Tolerance unless specified:

.xx = ±.010 (0.25) .xxx = ±.005 (0.125)

Opto - 23

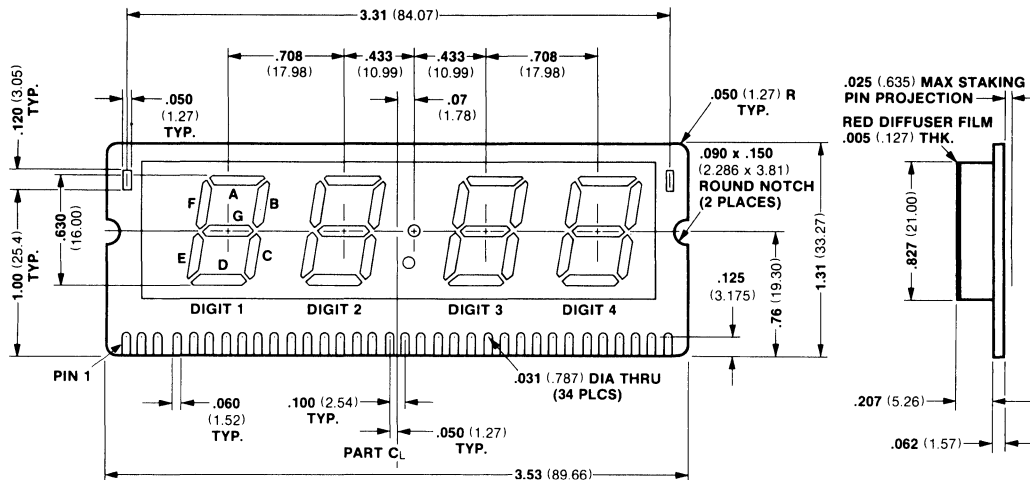


NOTES:

All dimensions in inches (bold) and millimeters (parentheses)

FAIRCHILD PACKAGE OUTLINES

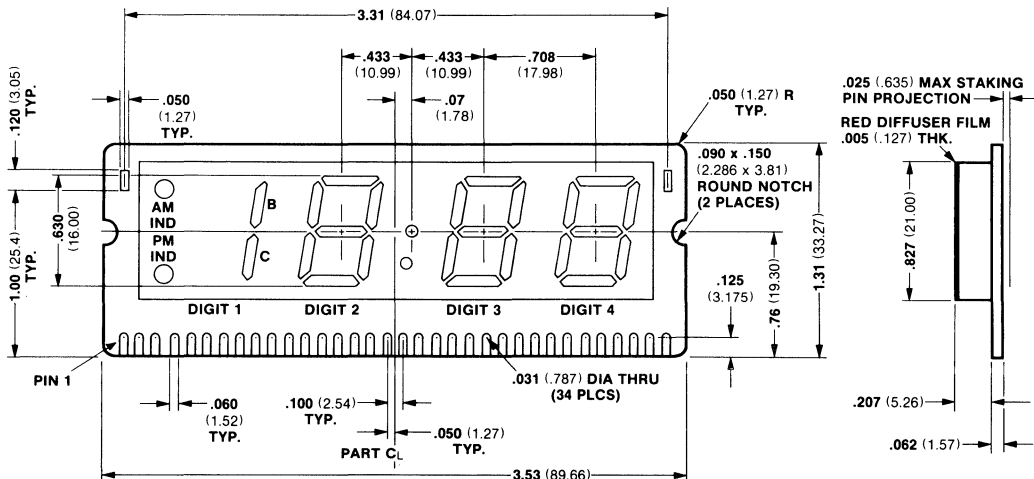
Opto-24



NOTE:

All dimensions in inches (bold) and millimeters (parentheses)
 Colon cathodes tied to digits 3 & 4

Opto-25

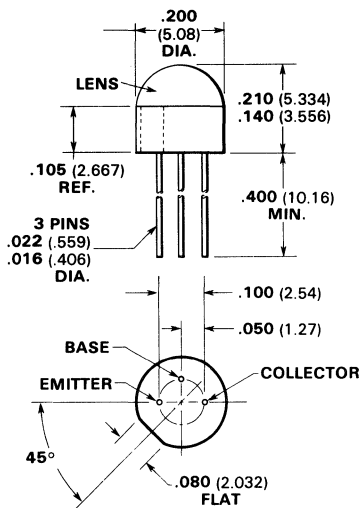


NOTE:

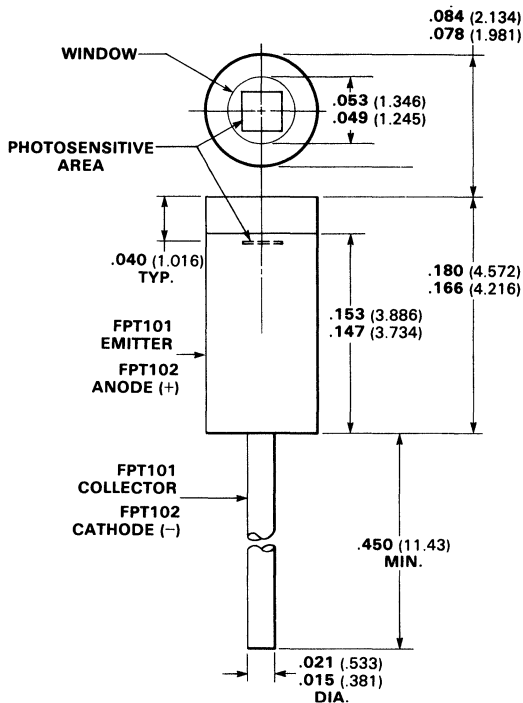
All dimensions in inches (bold) and millimeters (parentheses)
 AM/PM Ind. cathodes tied to digits 1 & 2.
 Colon cathodes tied to digits 3 & 4.

FAIRCHILD PACKAGE OUTLINES

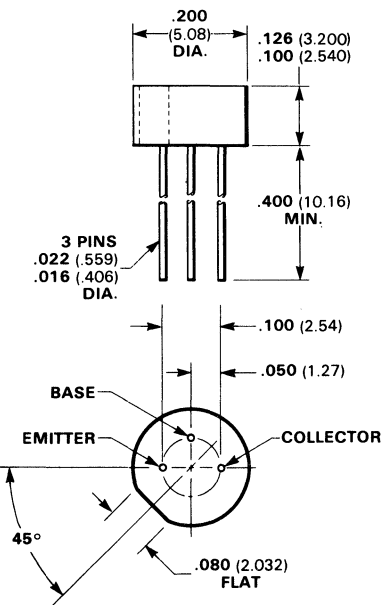
Opto - 26



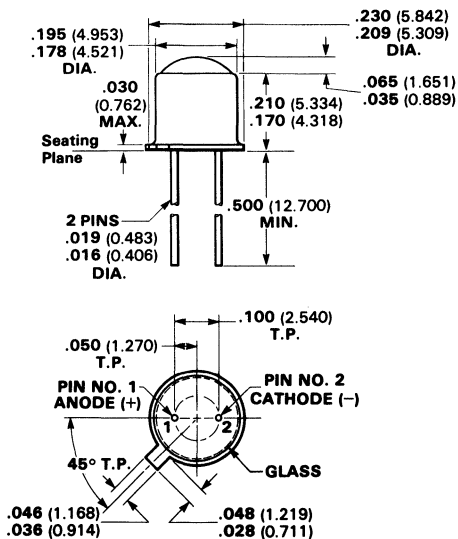
Opto - 27



Opto - 28



Opto - 29

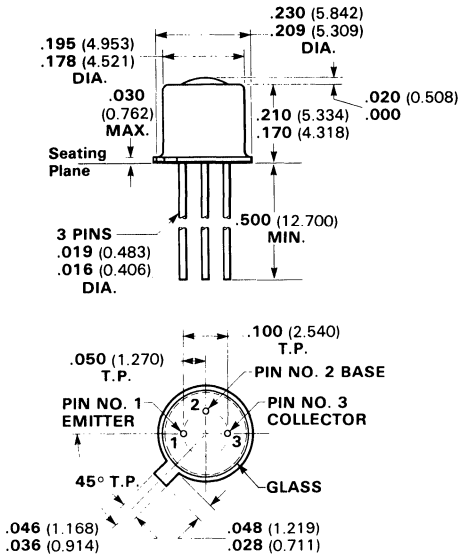


NOTES:

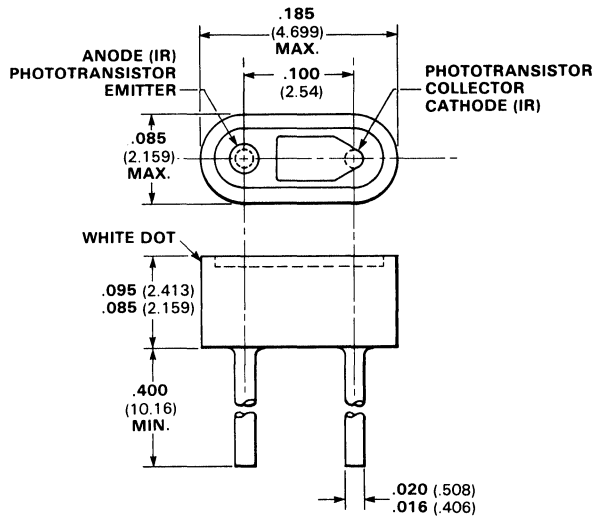
All dimensions in inches (bold) and millimeters (parentheses)

FAIRCHILD PACKAGE OUTLINES

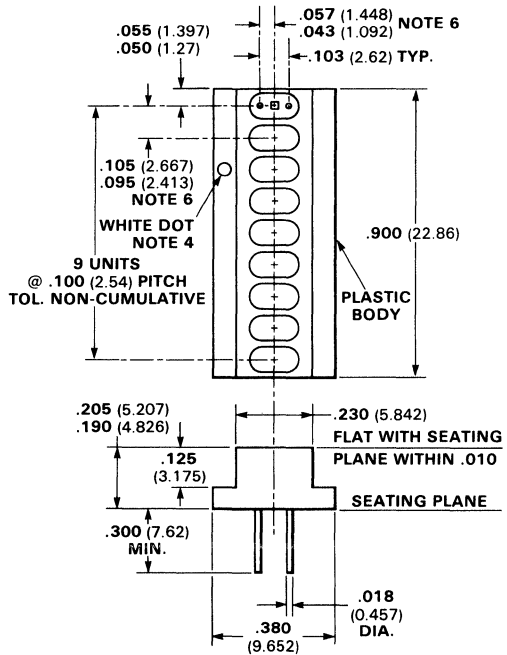
Opto - 30



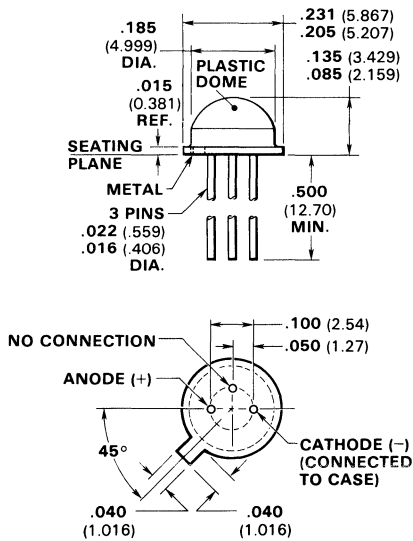
Opto - 31



Opto - 33



Opto - 32

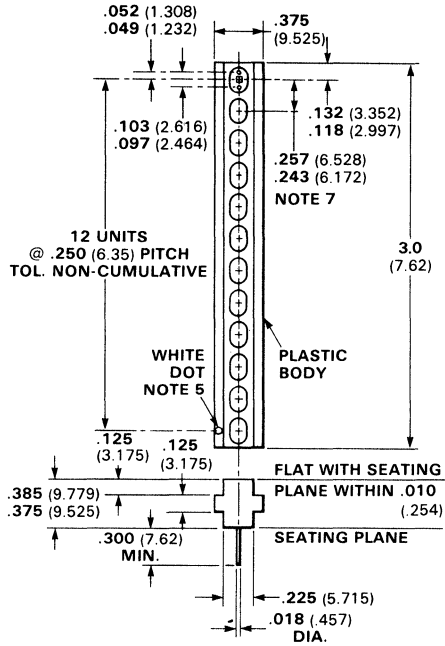


NOTES:

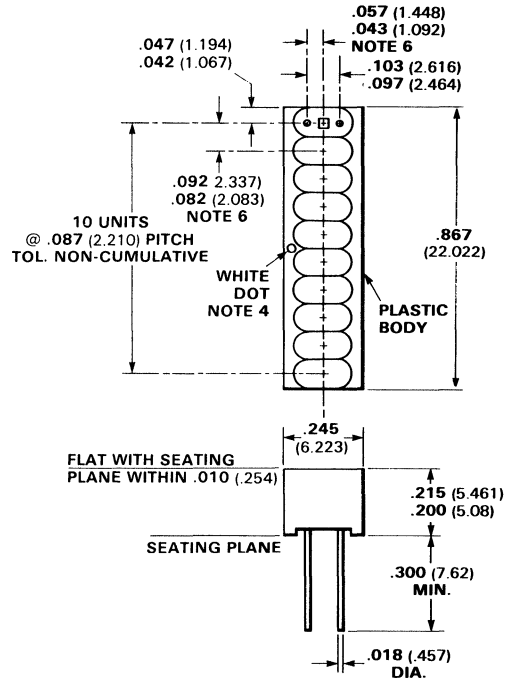
All dimensions in inches (bold) and millimeters (parentheses)

FAIRCHILD PACKAGE OUTLINES

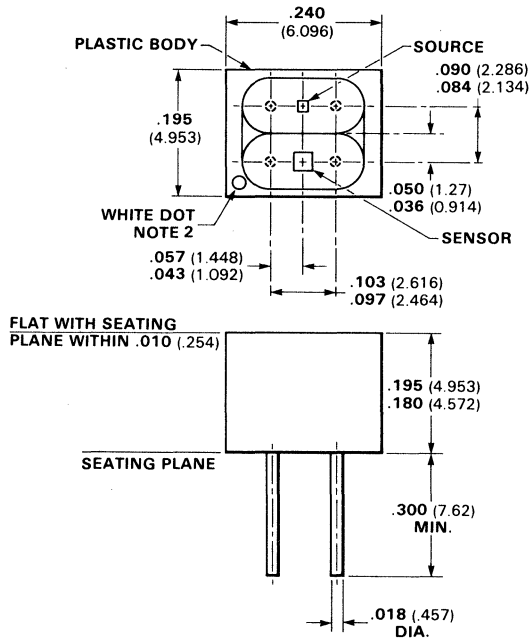
Opto - 34



Opto - 35



Opto - 36

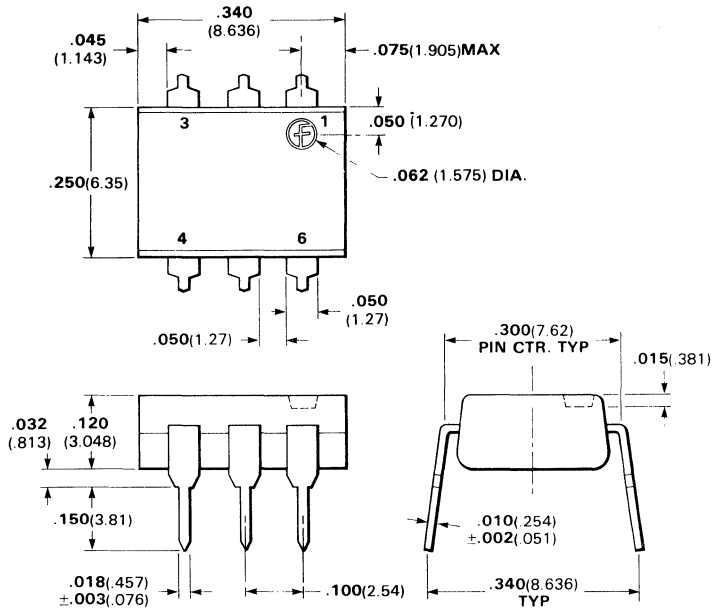


NOTES:

All dimensions in inches (bold) and millimeters (parentheses)

FAIRCHILD PACKAGE OUTLINES

Opto - 37

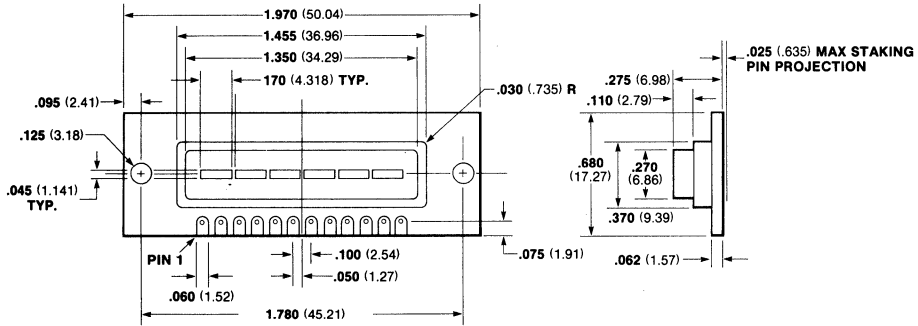


NOTES:

All dimensions in inches (bold) and millimeters (parentheses)

FAIRCHILD PACKAGE OUTLINES

Opto 43

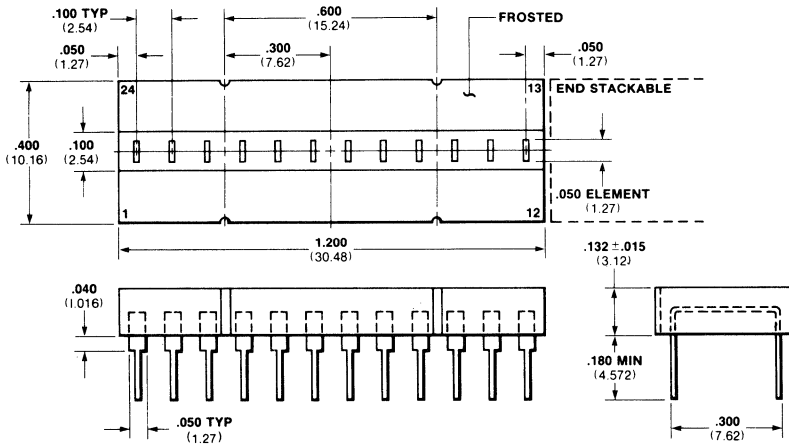


TOLERANCE $\pm .015$

NOTES:

1. All dimensions in inches (**bold**) and millimeters (parentheses)
2. Each segment has separate Anode/Cathode
3. Lens cap color is red for red LED.
4. Marking (on back): FNA0006
XXX
(XXX = date code)

Opto 44

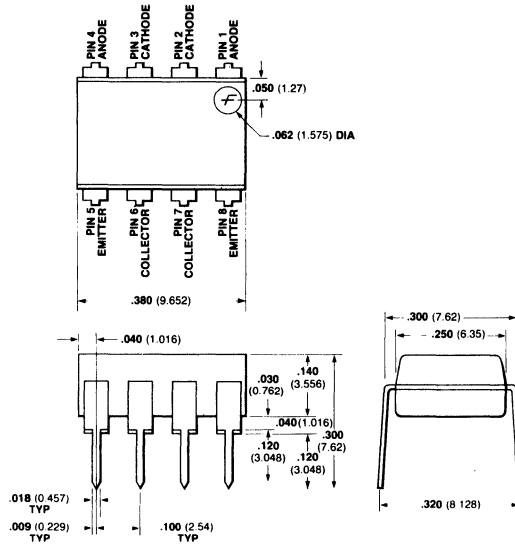


NOTE:

All dimensions in inches (**bold**) and millimeters (parentheses)
Tolerance $\pm .015$

FAIRCHILD PACKAGE OUTLINES

Opto 45

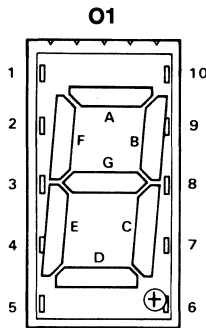


NOTES:

All dimensions in inches (bold) and millimeters (parentheses)

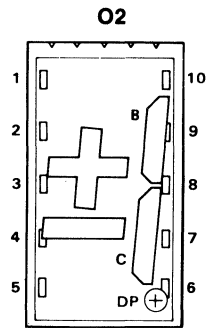
Package weight is 0.4 gram

OPTOELECTRONICS



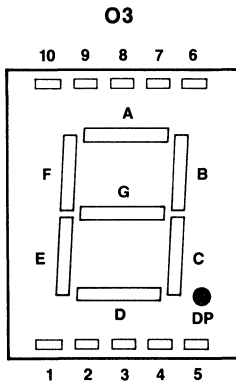
PIN FND350/357/360/367

- 1 Common-Cathode
- 2 Segment F
- 3 Segment G
- 4 Segment E
- 5 Segment D
- 6 Common-Cathode
- 7 Decimal Point
- 8 Segment C
- 9 Segment B
- 10 Segment A

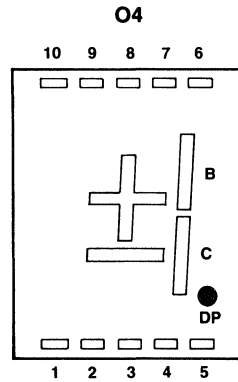


PIN FND351/358/361/368

- 1 Common-Cathode
- 2 Plus Sign
- 3 Minus Sign
- 4 NC
- 5 Omitted
- 6 Common-Cathode
- 7 Decimal Point
- 8 Segment C
- 9 Segment B
- 10 NC



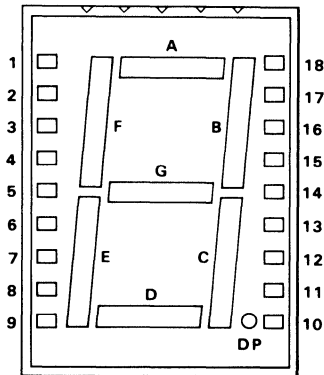
- | | |
|-----------------------|--------------------|
| PIN FND507/537 | FND500/530 |
| 547/557/567 | 540/550/560 |
| 1 Segment E | Segment E |
| 2 Segment D | Segment D |
| 3 Comm-Anode | Comm-Cathode |
| 4 Segment C | Segment C |
| 5 Decimal Point | Decimal Point |
| 6 Segment B | Segment B |
| 7 Segment A | Segment A |
| 8 Comm-Anode | Comm-Cathode |
| 9 Segment F | Segment F |
| 10 Segment G | Segment G |



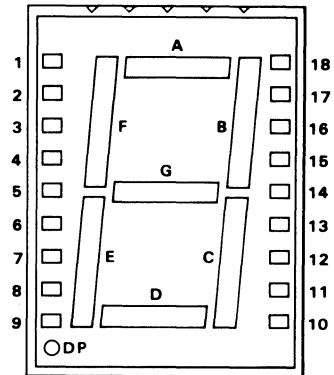
- | | |
|-----------------------|--------------------|
| PIN FND501/531 | FND508/538 |
| 541/551/561 | 548/558/568 |
| 1 Minus | Minus |
| 2 Cathode ± | Anode ± |
| 3 Segment C | Segment C |
| 4 Cathode 1/DP | Anode 1/DP |
| 5 Decimal Point | Decimal Point |
| 6 Segment B | Segment B |
| 7 Cathode 1/DP | Anode 1/DP |
| 8 Cathode ± | Anode ± |
| 9 Plus | Plus |
| 10 NC | NC |

OPTOELECTRONICS

O5



O6

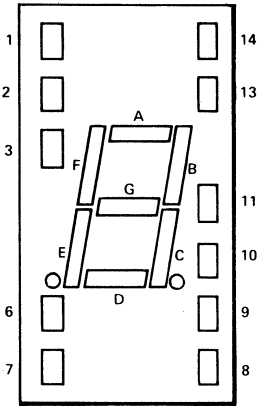


PIN	FND800	FND807
1	Omitted	Omitted
2	Segment A	Segment A
3	Segment F	Segment F
4	Common-Cath.	Common-Anode
5	Segment E	Segment E
6	Common-Cath.	Common-Anode
7	NC	NC
8	Omitted	Omitted
9	Omitted	Omitted
10	Decimal Point	Decimal Point
11	Segment D	Segment D
12	Common-Cath.	Common-Anode
13	Segment C	Segment C
14	Segment G	Segment G
15	Segment B	Segment B
16	Omitted	Omitted
17	Common-Cath.	Common-Anode
18	Omitted	Omitted

PIN	FND850	FND847
1	Omitted	Omitted
2	Segment A	Segment A
3	Segment F	Segment F
4	Common-Cath.	Common-Anode
5	Segment E	Segment E
6	Common-Cath.	Common-Anode
7	DP	DP
8	Omitted	Omitted
9	Omitted	Omitted
10	NC	NC
11	Segment D	Segment D
12	Common-Cath.	Common-Anode
13	Segment C	Segment C
14	Segment G	Segment G
15	Segment B	Segment B
16	Omitted	Omitted
17	Common-Cath.	Common-Anode
18	Omitted	Omitted

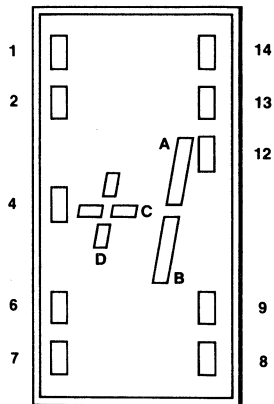
OPTOELECTRONICS

07



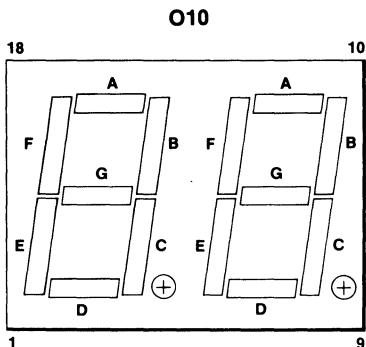
PIN	MAN71A	MAN72A
1	Cathode A	Cathode A
2	Cathode F	Cathode F
3	Common-Anode	Common-Anode
4	No pin	No pin
5	No pin	No pin
6	NC	Cathode DP
7	Cathode E	Cathode E
8	Cathode D	Cathode D
9	Common-Anode	NC
10	Cathode C	Cathode C
11	Cathode G	Cathode G
12	No pin	No pin
13	Cathode B	Cathode B
14	Common-Anode	Common-Anode

09

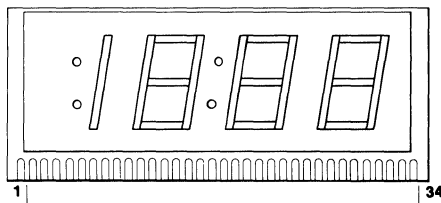


PIN	MAN74A
1	Anode F
2	Anode G
3	No pin
4	Common-Cathode
5	No pin
6	Anode E
7	Anode D
8	Anode C
9	Anode DP
10	No pin
11	No pin
12	Common-Cathode
13	Anode B
14	Anode A

OPTOELECTRONICS



O11



PIN FND6710

- 1 E Cath. Digit 1
- 2 D Cath. Digit 1
- 3 C Cath. Digit 1
- 4 DP Cath. Digit 1
- 5 E Cath. Digit 2
- 6 D Cath. Digit 2
- 7 G Cath. Digit 2
- 8 C Cath. Digit 2
- 9 DP Cath. Digit 2
- 10 B Cath. Digit 2
- 11 A Cath. Digit 2
- 12 F Cath. Digit 2
- 13 Digit 2 Anode
- 14 Digit 1 Anode
- 15 B Cath. Digit 1
- 16 A Cath. Digit 1
- 17 G Cath. Digit 1
- 18 F Cath. Digit 1

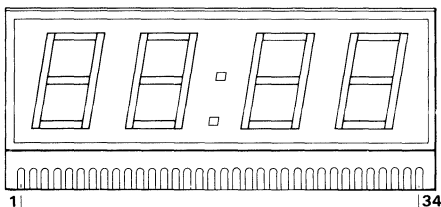
FND6740

- C Cath. Digit 1
- D Cath. Digit 1
- B Cath. Digit 1
- DP Cath. Digit 1
- E Cath. Digit 2
- D Cath. Digit 2
- G Cath. Digit 2
- C Cath. Digit 2
- DP Cath. Digit 2
- B Cath. Digit 2
- A Cath. Digit 2
- F Cath. Digit 2
- Digit 2 Anode
- Digit 1 Anode
- A Cath. Digit 1
- NC
- NC
- NC

PIN FCS8000

- | | |
|-------------|--------------|
| 1 NC | 18 10 Min. F |
| 2 NC | 19 10 Min. E |
| 3 Indicator | 20 10 Min. G |
| 4 NC | 21 10 Min. A |
| 5 Indicator | 22 10 Min. D |
| 6 10 Hrs. C | 23 10 Min. B |
| 7 10 Hrs. B | 24 10 Min. C |
| 8 NC | 25 NC |
| 9 Hrs. F | 26 Min. F |
| 10 Hrs. G | 27 Min. E |
| 11 Hrs. E | 28 Min. G |
| 12 Hrs. A | 29 Min. A |
| 13 Hrs. B | 30 Min. B |
| 14 Hrs. D | 31 Min. C |
| 15 Hrs. C | 32 Min. D |
| 16 Colons | 33 NC |
| 17 NC | 34 VLED |

O12

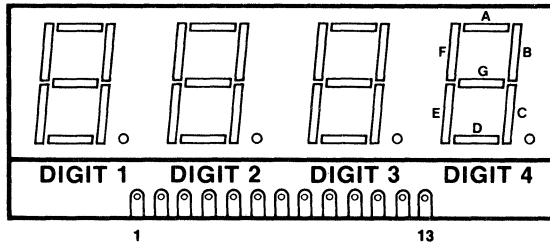


PIN FCS8024

- | | |
|-------------|--------------|
| 1 10 Hrs. A | 18 10 Min. F |
| 2 10 Hrs. E | 19 10 Min. E |
| 3 10 Hrs. D | 20 10 Min. G |
| 4 10 Hrs. G | 21 10 Min. A |
| 5 10 Hrs. F | 22 10 Min. D |
| 6 10 Hrs. C | 23 10 Min. B |
| 7 10 Hrs. B | 24 10 Min. C |
| 8 NC | 25 NC |
| 9 Hrs. F | 26 Min. F |
| 10 Hrs. G | 27 Min. E |
| 11 Hrs. E | 28 Min. G |
| 12 Hrs. A | 29 Min. A |
| 13 Hrs. B | 30 Min. B |
| 14 Hrs. D | 31 Min. C |
| 15 Hrs. C | 32 Min. D |
| 16 Colons | 33 NC |
| 17 NC | 34 VLED |

OPTOELECTRONICS

O13



PIN FNA5420

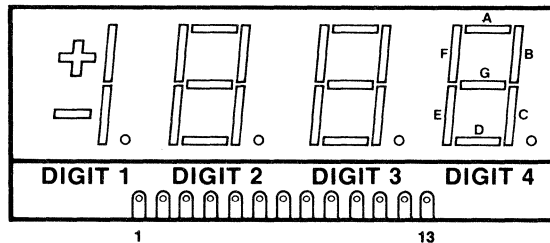
- 1 Digit 1 Com. Anode
- 2 Seg. G
- 3 NC
- 4 Seg. F
- 5 Seg. D
- 6 Digit 2 Com. Anode
- 7 Seg. A
- 8 Seg. B
- 9 Digit 3 Com. Anode
- 10 RNDP
- 11 Seg. C
- 12 Seg. E
- 13 Digit 4 Com. Anode

FNA5427

- Digit 1 Com. Cath.
- Seg. G "Plus" Sign Anode
- NC
- Seg. F
- Seg. D "Minus" Sign Anode
- Digit 2 Com. Cath.
- Seg. A
- Seg. B
- Digit 3 Com. Cath.
- RHDP
- Seg. C
- Seg. E
- Digit 4 Com. Cath.

Preliminary Pin Assignment

O14



PIN FNA5428

- 1 Digit 1 Com. Anode
- 2 Seg. G "Plus" Sign Cathode
- 3 NC
- 4 Seg. F
- 5 Seg. D "Minus" Sign Cath.
- 6 Digit 2 Com. Anode
- 7 Seg. A
- 8 Seg. B
- 9 Digit 3 Com. Anode
- 10 RHDP
- 11 Seg. C
- 12 Seg. E
- 13 Digit 4 Com. Anode

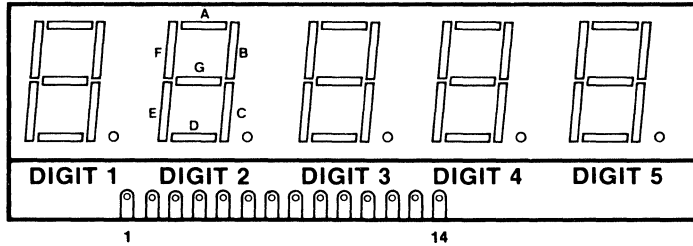
FNA5421

- Digit 1 Com. Cath.
- Seg. G
- LHDP
- Seg. F
- Seg. D
- Digit 2 Com. Cath.
- Seg. A
- Seg. B
- Digit 3 Com. Cath.
- RHDP
- Seg. C
- Seg. E
- Digit 4 Com. Cath.

Preliminary Pin Assignment

OPTOELECTRONICS

O15



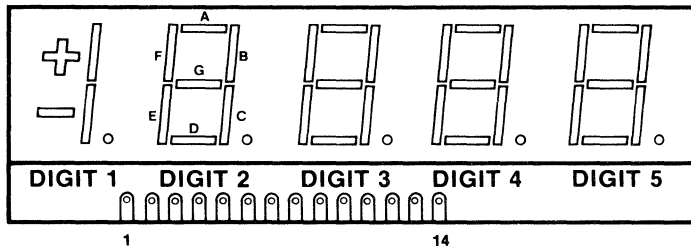
PIN FNA5520*

- 1 LHDP Anodes
- 2 Digit 1 Com. Cathodes
- 3 Seg. G, "Plus" Sign Anodes
- 4 Seg. F Anodes
- 5 Seg. D, "Minus" Sign Anodes
- 6 Digit 2 com. Cathodes
- 7 Seg. A Anodes
- 8 Seg. B Anodes
- 9 Digit 3 Com. Cathodes
- 10 RHDP Anodes
- 11 Seg. C Anodes
- 12 Seg. E Anodes
- 13 Digit 4 Com. Cathodes
- 14 Digit 5 Com. Cathodes

FNA5527*

- LHDP Cathodes
- Digit 1 Com. Anode
- Seg. G, "Plus Sign Cath.
- Seg. F Cath.
- Seg. D, "Minus" Sign Cath.
- Digit 2 Com. Anode
- Seg. A Cath.
- Seg. B Cath.
- Digit 3 Com. Anode
- RHDP Cath.
- Seg. C Cath.
- Seg. E Cath.
- Digit 4 Com. Anode
- Digit 5 Com. Anode

O16



PIN FNA5521

- 1 NC
- 2 Com. Cath. Digit 1
- 3 Seg. G/"Plus" Ind. Anodes
- 4 Seg. F Anodes
- 5 Seg. D Anodes/Minus
- 6 Com. Cath. Digit 2
- 7 Seg. A Anodes
- 8 Seg. B Anodes
- 9 Com. Cath. Digit 3
- 10 DP Anodes
- 11 Seg. C Anodes
- 12 Seg. E Anodes
- 13 Com. Cath. Digit 4
- 14 Com. Cath. Digit 5

FNA5528*

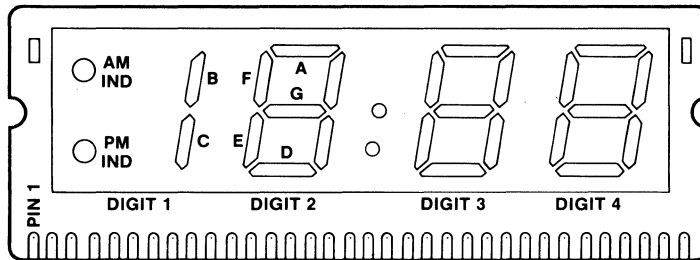
- NC
- Com. Anode Digit 1
- Seg. G, "Plus" Sign Cath.
- Seg. F Cath.
- Seg. D Cath.
- Digit 2 Com. Anode
- Seg. A Cath.
- Seg. B Cath.
- Digit 3 Com. Anode
- DP Cath.
- Seg. C Cath.
- Seg. E Cath.
- Digit 4 Com. Anode
- Digit 5 Com. Anode

*Preliminary Pin Assignment

FAIRCHILD LOGIC/CONNECTION DIAGRAMS

OPTOELECTRONICS

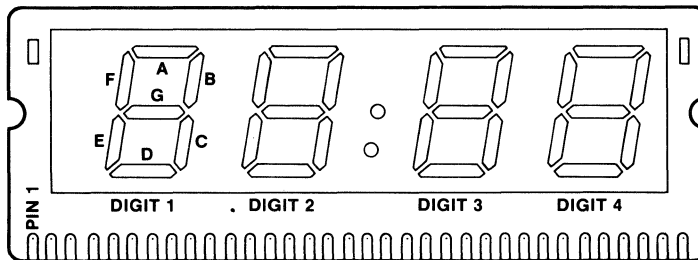
O17



PIN FCS6400

1 Com. Cath. Digits 1 & 2	13 Segment A2 Anode	25 Segment E3 Anode
2 NC	14 Segment B2 Anode	26 Segment C3
3 N/C	15 Segment E2 Anode	27 Segment F4
4 Segment A1 Anode	16 Segment D2 Anode	28 Segment G4 Anode
5 Segment F1 Anode	17 Segment C2 Anode	29 Segment A4 Anode
6 Segment G1 Anode	18 Colon Anode	30 Segment B4 Anode
7 Segment E1 Anode	19 Colon Anode	31 Segment E4 Anode
8 Segment D1	20 Segment F3 Anode	32 Segment D4 Anode
9 Segment C1 Anode	21 Segment G3 Anode	33 Segment C4 Anode
10 Segment B1 Anode	22 Segment A3 Anode	34 Com. Cath. Digits 3 & 4
11 Segment F2 Anode	23 Segment B3 Anode	
12 Segment G2 Anode	24 Segment D3 Anode	

O18

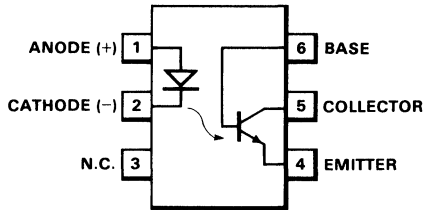


PIN FCS6401

1 Com. Cath. Digits 1 & 2	13 Segment A2 Anode	25 Segment E3 Anode
2 PM IND. Anode	14 Segment B2 Anode	26 Segment C3 Anode
3 AM IND.	15 Segment E2 Anode	27 Segment F4 Anode
4 N/C	16 Segment D2 Anode	28 Segment G4 Anode
5 N/C	17 Segment C2 Anode	29 Segment A4 Anode
6 N/C	18 Colon Anode	30 Segment B4 Anode
7 N/C	19 Colon Anode	31 Segment E4 Anode
8 N/C	20 Segment F3 Anode	32 Segment D4 Anode
9 Segment C1 Anode	21 Segment G3 Anode	33 Segment C4 Anode
10 Segment B1 Anode	22 Segment A3 Anode	34 Com. Cath. Digits 3 & 4
11 Segment F2 Anode	23 Segment B3 Anode	
12 Segment G2 Anode	24 Segment D3 Anode	

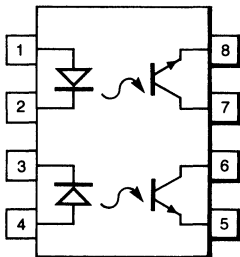
OPTOELECTRONICS

024

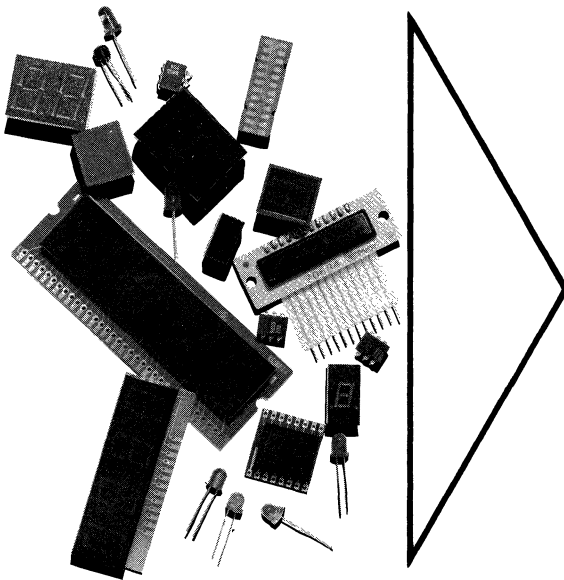


- PIN**
- 1 Anode (+)
 - 2 Cathode (-)
 - 3 NC
 - 4 Emitter
 - 5 Collector
 - 6 Base
- } Input Diode
- } Output npn Phototransistor

025



- PIN**
- 1 ANODE
 - 2 CATHODE
 - 3 CATHODE
 - 4 ANODE
 - 5 EMITTER
 - 6 COLLECTOR
 - 7 COLLECTOR
 - 8 EMITTER
- CHANNEL #1
- CHANNEL #2
- CHANNEL #1
- CHANNEL #2



OPTOELECTRONIC TECHNOLOGY

1

DISCRETE LED DIGIT RELIABILITY

2

VISIBLE LED LAMPS AND
MOUNTING HARDWARE

3

SEVEN-SEGMENT DISPLAYS
AND DISPLAY ARRAYS

4

PHOTOTRANSISTORS, INFRARED
EMITTERS, AND SENSORS

5

PHOTOCOUPLERS

6

PACKAGE OUTLINES

7

DEFINITIONS OF SYMBOLS AND
TERMS

8

FAIRCHILD FIELD SALES OFFICES,
SALES REPRESENTATIVES AND
DISTRIBUTOR LOCATIONS

9

— OPTO —

DEFINITION OF SYMBOLS AND TERMS

Angstrom (Å)

A unit of length particularly for measuring electromagnetic wavelengths; one angstrom = 10^{-10} meters = 10^{-4} microns = 3.937×10^{-9} in.

Angular Alignment

A measure of the deviation of the optical axis from the mechanical axis.

Area Source

A source with a diameter greater than 10% of the distance between it and the detector.

Axial Intensity (I_0):

The ratio of the flux emitted by a source and contained within an incremental on axis solid angle subtended by a sensor [units: lumens/steradian (photometric) or watts/steradian (radiometric)]

B_L (also "B")

A photometric unit of luminance in (lumens/steradian)/ft² or foot-Lamberts.

Blackbody

A 100% efficient radiator and absorber of radiant energy used as a standard for all irradiance measurements.

Blackbody Luminous Efficiency

As a function of temperature, the efficiency of an incandescent blackbody in terms of visible light.

Candela

A photometric unit of luminous intensity (in lumens per steradian) defined as 1/60 the intensity of a one cm² blackbody radiator at platinum's solidification temperature (2,046° K).

Candela/cm²

Luminance unit called "stilb".

($1/\pi$) candela/cm²

Luminance unit called "Lambert".

Color Temperature

The temperature of a blackbody whose radiation has the same visible color as that of a given non-blackbody radiator. TYPICAL UNIT: K (formerly °K).

Conversion Efficiency (of a Photoemissive Device)

The ratio of maximum available luminous or radiant flux output to total input power.

Critical Angle

The maximum angle of incidence for which light will be transmitted from one medium to another. Light approaching the interface at angles greater than the critical angle will be reflected back into the first medium.

Dark Current (I_D)

The current which flows in a photodetector when there is no incident radiation on the detector.

D-C Transfer Ratio (of an Optically Coupled Isolator)

The ratio of the dc output current to the dc input current.

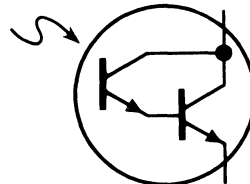
Darlington Amplifier

A composite configuration of transistors which provides a high input impedance and a high degree of amplification.

Darlington Connector Phototransistor

A phototransistor the collector and emitter of which are connected to the collector and base, respectively, of a second transistor. The emitter current of the input transistor is amplified by the second transistor and the device has very high sensitivity to light.

GRAPHIC SYMBOL:

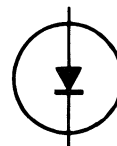


Delay Time (t_d)

The time interval from the point at which the leading edge of the input pulse has reached 10% of its maximum amplitude to the point at which the leading edge of the output pulse has reached 10% of its maximum amplitude.

Diode

A semiconductor device which passes current in only one direction.



DEFINITION OF SYMBOLS AND TERMS CONT.

Duty Cycle

A measure of the effect of a pulsed input to a lamp. Expressed as a percentage of on time as compared to total time.

E

Photometric unit of illuminance in lumens/ft² (footcandle)

Emission Beam Angle Between Half-Power Points (θ_{HP})

The angle centered on the optical axis of a light-emitting diode within which the relative radiant power output or photon intensity is not less than half of the maximum output or intensity.

Fall Time (t_f)

The time duration during which the trailing edge of a pulse is decreasing from 90% to 10% of its maximum amplitude.

Flux

Power passing through a surface (energy per unit time); number of photons passing through a surface per unit time. Expressed in lumens or watts.

Flux Density

A measure of the strength of a wave; flux per unit area normal to the direction of the flux; number of photons passing through a surface per unit time per unit area. Expressed in watts/cm² or lumens/ft².

Foot-candle

Unit of illumination. Defined as the illuminance on a surface of one square foot on which there is a uniformly distributed flux of one lumen, or lumens/ft².

Foot-lambert

Unit of luminance or brightness. Defined as the uniform luminance of a surface emitting or reflecting light at the rate of one lumen per square foot.

Forward Voltage (V_F)

The voltage across a semiconductor diode associated with the flow of forward current. The p-region is at a positive potential with respect to the n-region.

GaAs, GaAsP, GaP

The most commonly used emitter materials are gallium arsenide (GaAs), gallium arsenide phosphide (GaAsP) and gallium phosphide (GaP).

H

Irradiance or radiation flux density in watts/cm² (radiometric unit).

Half intensity beam angle (θ_{HI})

The angle within which the radiant intensity is not less than half the maximum.

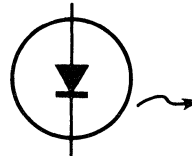
Illumination (E_v)

The luminous flux density incident on a surface; the ratio of flux to area of illuminated surface.

TYPICAL UNITS: lm/ft², lx = lm/m² .1 lm/ft² = 10.764 lx.

Infrared Light-Emitting Diode (Infrared Emitter)

An optoelectronic device containing a semiconductor p-n junction which emits radiant energy in the 0.78- μ m to 100- μ m wavelength region when forward-biased.



Irradiance (H or E_e)

The radiant flux density incident on a surface; the ratio of flux to area of irradiated surface.

TYPICAL UNITS: W/ft², W/m². 1 W/ft² = 10.764 W/m².

Light

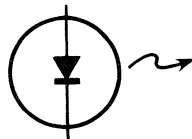
For the purpose of these definitions, radiant energy transmitted by wave motion with wavelengths from about 0.3 μ m to 30 μ m; this includes visible wavelengths (0.38 μ m to 0.78 μ m) and those wavelengths, such as ultraviolet and infrared, which can be handled by optical techniques used for the visible region. In more restricted usage, radiant energy within the limits of the visual spectrum.

Light Current (I_L)

The current that flows through a photosensitive device, such as a phototransistor or a photodiode, when it is exposed to illumination or irradiance.

Light-Emitting Diode (LED)

Light-emitting diode that emits visible light.



Lumen

Unit of flux; flux through one steradian from a uniform point source of one candle.

DEFINITION OF SYMBOLS AND TERMS CON'T.

Luminescence

Emission of light due to any other cause than high temperature (incandescence).

Luminance (L) (Photometric Brightness)

The luminous intensity of a surface in a given direction per unit of projected area of the surface as viewed from that direction.

TYPICAL UNITS: fL, cd/ft², cd/m². $1 \text{ fL} = (1/\pi) \text{ cd/ft}^2 = 3.4263 \text{ cd/m}^2$.

Luminous Flux (Φ_v)

The time rate of flow of light.

TYPICAL UNIT: lm

NOTE: Luminous flux is related to radiant flux by the eye-response curve of the International Commission on Illumination (CIE). At the peak response ($\lambda = 555 \text{ nm}$), $1 \text{ W} = 680 \text{ lm}$.

Luminous Intensity (I_v)

Luminous flux per unit solid angle in a given direction.

TYPICAL UNIT: cd. $1 \text{ cd} = 1 \text{ lm/sr}$

Off-State Collector Current (of an Optically Coupled Isolator) ($I_{C(\text{off})}$)

The output current when the input current is zero.

On-State Collector Current (of an Optically Coupled Isolator) ($I_{C(\text{on})}$)

The output current when the input current is above a threshold level. An increase in the input current will usually result in a corresponding increase in the on-state collector current.

Optical Axis

A line about which the radiant-energy pattern is centered; usually perpendicular to the active area.

Optically Coupled Isolator

An optoelectronic device consisting of a photoemissive device and a photodetector integrated into a single entity and intended for the transfer of a signal from the input to the output.

Photocurrent

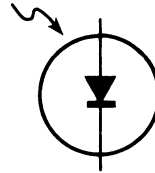
The difference between light current (I_L) and dark current (I_D) in a photodetector.

Photodetector

A device which senses incident radiation.

Photodiode

A solid state device, much like an ordinary diode except that incident light on the pn junction causes the device to conduct. It acts as an open circuit (ideally) in the dark. The photodiode is characterized by a linear relationship between input radiation and output current. It has faster switching speeds than a phototransistor.



Photometric Axis

The direction from the source of radiant energy in which the measurement of photometric parameters is performed

Photometric Brightness

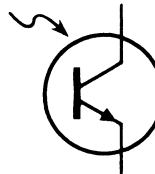
See Luminance.

Photon

A quantum (the smallest possible unit) of radiant energy; a photon carries q quantity of energy equal to Planck's constant times the frequency.

Phototransistor

Solid state device similar to an ordinary transistor except that light incident on the pn junctions controls the response of this device; offers built-in gain and greater sensitivity than photodiodes.



Point Source

Radiation source whose maximum dimension is less than 1/10 the distance between source and receiver.

Quantum Efficiency (of a Photosensitive Device)

The ratio of the number of carriers generated to the number of photons incident upon the active region.

Radiant Flux (Φ_e)

The time rate of flow of radiant energy.
TYPICAL UNIT: W

DEFINITION OF SYMBOLS AND TERMS CONT.

Radiant Pulse Fall Time (t_f)

The time required for a photometric quantity to change from 90% to 10% of its peak value for a step change in electrical input.

Radiant Pulse Time (t_r)

The time required for a photometric quantity to change from 10% to 90% of its peak value for a step change in electrical input.

Rise Time (t_r)

The time duration during which the leading edge of a pulse is increasing from 10% to 90% of its maximum amplitude.

Spectral Output (of a Light-Emitting Diode)

A description of the radiant-energy or light-emission characteristic versus wavelength. This information is usually given by stating the wavelength at peak emission and the bandwidth between half-power points or by means of a curve.

Spectral Distribution of Energy (E_λ)

A plot showing the variation of spectral emission with wavelength.

Spectral Response (of a Photosensitive Device)

A curve of the electrical-output characteristic versus wavelength of radiant energy incident upon the device.

Steradian

Solid angle subtending an area on the surface of a sphere equal to the square of the radius; there are 4π steradians in a sphere.

Storage Time (t_s)

The time interval from a point at which the trailing edge of the input pulse has dropped to 90% of its maximum amplitude to a point at which the trailing edge of the output pulse has dropped to 90% of its maximum amplitude.

Threshold Voltage

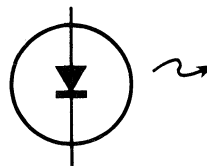
Voltage at which a pn junction begins to pass a current; in a solid state lamp, the voltage at which light is first emitted.

Visible Emission, Visible Light

Radiation which is characterized by wavelengths of about $0.38 \mu\text{m}$ to $0.78 \mu\text{m}$.

Visible-Light-Emitting Diode (VLED)

An optoelectronic device containing a semiconductor junction which emits visible light when forward-biased.



Wavelength at Peak Emission (λ_p)

The wavelength at which the power output from a light-emitting diode is maximum

TYPICAL UNITS: \AA , μm , nm. $1 \text{\AA} = 10^{-4} \mu\text{m} = 0.1 \text{ nm}$.

Radiation and Illumination Sources

The effect of a radiation source on a photodevice is dependent on the device spectral response and the spectral distribution of energy from the source. To discuss such energy, two related sets of terminology are available. The first, radiometric, is a physical system, and the second, photometric, is a physiological system, which defines energy relative to its visual effect.

The defining factor for the photometric system is the spectral response curve of a standard observer, whereas the defining spectral response of the radiometric system can be imagined as unit response for all wavelengths.

2Steradian: The solid equivalent of a radian

DEFINITION OF SYMBOLS AND TERMS CON'T.

CONVERSION TABLE

Symbol	Unit	Note
A	Ampere	
Å	Angstrom	$1 \text{ Å} = 10^{-10} \text{ m} = 10^{-4} \mu\text{m} = 0.1 \text{ nm}$
cd	Candela	$1 \text{ cd} = 1 \text{ lm/sr}$
°C	Degree Celsius	
°K		See K
ft	Foot	
fc	Footcandle	The equivalent unit lm/ft^2 is preferred
fL	Footlambert	$1 \text{ fL} = (1/\pi) \text{ cd/ft}^2 = 3.4263 \text{ cd/m}^2$
Hz	Hertz	
in	Inch	
K-	Kelvin	Formerly °K, degree Kelvin
L	Lambert	
lm	Lumen	
lx	Lux	$1 \text{ lx} = 1 \text{ lm/m}^2$
m	Meter	
μ	Micron	The equivalent unit μm is preferred
nt	Nit	$1 \text{ nt} = 1 \text{ cd/m}^2$
Ω	Ohm	
s	Second	
sr	Steradian	
sb	Stilb	$1 \text{ sb} = 1 \text{ cd/cm}^2$
V	Voit	
W	Watt	

UNITS OF MEASUREMENT

TO CONVERT FROM:	TO:	MULTIPLY BY:
Angstroms	Nanometers Millimicrons	0.1
Angstroms	Microns Micrometers	0.0001
Nanometers Millimicrons	Angstroms	10
Microns Micrometers	Angstroms	10,000
Nanometers Millimicrons	Microns Micrometers	.001
Microns Micrometers	Nanometers Millimicrons	1000

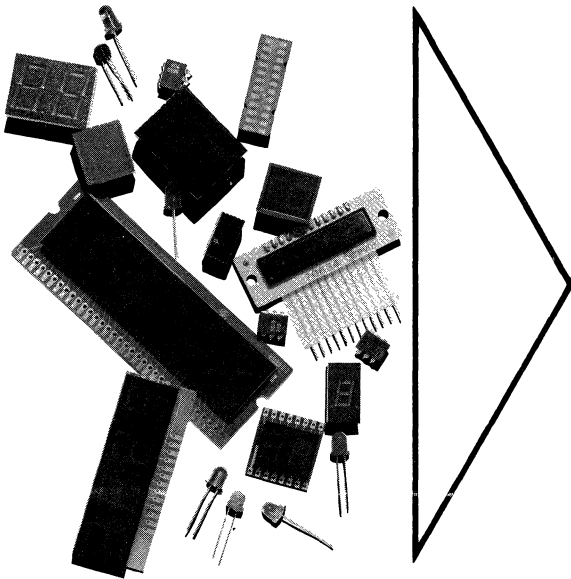
Description	Radiometric all wavelengths	Photometric visible light
Total Flux	Radiant Flux, P, in Watts	Luminous Flux, F, in Lumens
Emitted Flux Density at a Source Surface	Radiant Emittance, W, in Watts/cm ²	Luminous Emittance, L, in Lumens/ft ² (foot-lamberts), or lumens/cm ² (Lamberts)
Source Intensity (Point Source)	Radiant Intensity, I _r , in Watts/Steradian	Luminous Intensity, I _L , in Lumens/Steradian (Candela)
Source Intensity (Area Source)	Radiance, Br, in (Watts/Steradian) /cm ²	Luminance, BL, in (Lumens/Steradian) /ft ² (footlambert)
Flux Density Incident on a Receiver Surface	Irradiance, H, in Watts/cm ²	Illuminance, E, in Lumens/ft ² (footcandle)

POINT SOURCE RELATIONSHIPS

Description	Radiometric	Photometric
Point Source Intensity	I _r , Watts/Steradian	I _L , Lumens/Steradian
Incident Flux Density	$H \text{ (Irradiance)} = I_r/r^2$ watts/distance ²	$E \text{ (Illuminance)} = I_L/r^2$ lumens/distance ²
Total Flux Output of Point Source	$P = 4\pi I_r$ Watts	$F = 4\pi I_L$ Lumens

DESIGN RELATIONSHIPS FOR AN AREA SOURCE

Description	Radiometric	Photometric
Source Intensity	Br, Watts/cm ² /steradian	BL, Lumens/cm ² /steradian
Emitted Flux Density	$W = \pi B_r$, Watts/cm ²	$L = \pi B_L$, Lumens/cm ²
Incident Flux Density	$H = \frac{B_r A_s}{r^2 + d/2^2}$, Watts/cm ²	$E = \frac{B_L A_s}{r^2 + d/2^2}$, Lumens/cm ²



OPTOELECTRONIC TECHNOLOGY

1

DISCRETE LED DIGIT RELIABILITY

2

VISIBLE LED LAMPS AND
MOUNTING HARDWARE

3

SEVEN-SEGMENT DISPLAYS
AND DISPLAY ARRAYS

4

PHOTOTRANSISTORS, INFRARED
EMITTERS, AND SENSORS

5

PHOTOCOUPLERS

6

PACKAGE OUTLINES

7

DEFINITIONS OF SYMBOLS AND
TERMS

8

FAIRCHILD FIELD SALES OFFICES,
SALES REPRESENTATIVES AND
DISTRIBUTOR LOCATIONS

9

FAIRCHILD FRANCHISED DISTRIBUTORS UNITED STATES AND CANADA

ALABAMA

HALLMARK ELECTRONICS
4739 Commercial Drive
Huntsville, Alabama 35805
Tel: 205-837-8700 TWX: 810-726-2187

HAMILTON/AVNET ELECTRONICS
805 Oster Drive, N.W.
Huntsville, Alabama 35805
Tel: 205-533-1170
Telex: None — use HAMAVLECB DAL 73-0511
(Regional Hq. in Dallas, Texas)

ARIZONA

HAMILTON/AVNET ELECTRONICS
2615 S. 21st Street
Phoenix, Arizona 85034
Tel: 602-275-7851 TWX: 910-951-1535

LIBERTY ELECTRONICS
8155 North 24th Ave.
Phoenix, Arizona 85021
Tel: 602-249-2232 TWX: 910-951-4282

STERLING ELECTRONICS
P.O. Drawer 20867 (zip code 85036)
2001 E. University Drive
Phoenix, Arizona 85034
Tel: 602-258-4531 Telex: 667317

CALIFORNIA

AVNET ELECTRONICS
350 McCormick Avenue
Costa Mesa, California 92626
Tel: 714-754-6111 (Orange County)
213-558-2345 (Los Angeles)
TWX: 910-595-1928

BELL INDUSTRIES

Electronic Distributor Division
1161 N. Fair Oaks Avenue
Sunnyvale, California 94086
Tel: 408-734-8570 TWX: 910-339-9378

ELMAR ELECTRONICS

2288 Charleston Rd.
Mountain View, California 94042
Tel: 415-961-3611 TWX: 910-379-6437

G. S. MARSHALL COMPANY
8005 Deering Avenue
Canoga Park, California 91304
Tel: 213-999-5001

G. S. MARSHALL COMPANY
9674 Telstar Avenue
El Monte, California 91731
Tel: 213-686-0141 TWX: 910-587-1565

G. S. MARSHALL COMPANY
17975 Skypark Blvd.
Irvine, California 92707
Tel: 714-556-6400

G. S. MARSHALL COMPANY
8057 Raytheon Rd. Suite 1
San Diego, California 92111
Tel: 714-278-6350 TWX: 910-335-1191

HAMILTON ELECTRO SALES
10912 W. Washington Blvd.
Culver City, California 90230
Tel: 213-558-2121 TWX: 910-340-6364

HAMILTON/AVNET ELECTRONICS
575 E. Middlefield Road
Mountain View, California 94040
Tel: 415-961-7000 TWX: 910-379-6486

HAMILTON/AVNET ELECTRONICS
8917 Complex Drive
San Diego, California 92123
Tel: 714-279-2421
Telex: HAMAVELECD SDG 69-5415

LIBERTY ELECTRONICS

124 Maryland Street
El Segundo, California 90245
Tel: 213-322-8100 TWX: 910-348-7111

LIBERTY ELECTRONICS/SAN DIEGO
8248 Mercury Court
San Diego, California 92111
Tel: 714-565-9171 TWX: 910-335-1590

COLORADO

CENTURY ELECTRONICS
8155 West 48th Avenue
Wheatridge, Colorado 80033
Tel: 303-424-1985 TWX: 910-938-0393

CRAMER ELECTRONICS
5465 East Evans Place at Hudson
Denver, Colorado 80222
Tel: 303-758-2100

ELMAR ELECTRONICS
6777 E. 50th Avenue
Commerce City, Colorado 80022
Tel: 303-287-9611 TWX: 910-936-0770

G. S. MARSHALL COMPANY
5633 Kendall Court
Arvada, Colorado 80002
Tel: 303-423-9670 TWX: 910-938-2902

HAMILTON/AVNET ELECTRONICS
5921 N. Broadway
Denver, Colorado 80216
Tel: 303-534-1212 TWX: 910-931-0510

CONNECTICUT

CRAMER ELECTRONICS
35 Dodge Avenue
Wharton Brook Industrial Center
North Haven, Connecticut 06473
Tel: 203-239-5641

HAMILTON/AVNET ELECTRONICS
643 Danbury Road
Georgetown, Connecticut 06829
Tel: 203-762-0361
TWX: None — use 710-897-1405
(Regional Hq. in Mt. Laurel, N.J.)

HARVEY ELECTRONICS
112 Main Street
Norwalk, Connecticut 06851
Tel: 203-853-1515

SCHWEBER ELECTRONICS
Finance Drive
Commerce Industrial Park
Danbury, Connecticut 06810
Tel: 203-792-3500

FLORIDA

CRAMER ELECTRONICS
4035 N. 29th Avenue
Hollywood, Florida 33020
Tel: 305-923-8181

CRAMER ELECTRONICS
345 North Graham Avenue
Orlando, Florida 32814
Tel: 305-894-1511

HALLMARK ELECTRONICS
1302 W. McNab Road
Ft. Lauderdale, Florida 33309
Tel: 305-971-9280 TWX: 510-956-3092

HALLMARK ELECTRONICS
7233 Lake Ellenor Drive
Orlando, Florida 32809
Tel: 305-855-4020 TWX: 810-850-0183

HAMILTON/AVNET ELECTRONICS
6800 N.W. 20th Avenue
Ft. Lauderdale, Florida 33309
Tel: 305-971-2900 TWX: 510-954-9808

SCHWEBER ELECTRONICS
2830 North 28th Terrace
Hollywood, Florida 33020
Tel: 305-927-0511 TWX: 510-954-0304

GEORGIA

HAMILTON/AVNET ELECTRONICS
6700 Interstate 85 Access Road, Suite 1 E
Norcross, Ga. 30071
Tel: 404-448-0800
Telex: None — use HAMAVLECB DAL 73 0511
(Regional Hq. in Dallas, Texas)

LYKES ELECTRONICS CORP.
6447 Atlantic Blvd.
Norcross, Georgia 30071
Tel: 404-449-9400

ILLINOIS

HALLMARK ELECTRONICS INC.
180 Crossen Avenue
Elk Grove Village, Illinois 60007
Tel: 312-437-8800

HAMILTON/AVNET ELECTRONICS
3901 N. 25th Avenue
Schiller Park, Illinois 60176
Tel: 312-678-6310 TWX: 910-227-0600

KIERULFF ELECTRONICS
85 Gordon Street
Elk Grove Village, Illinois 60007
Tel: 312-640-0200 TWX: 910-227-3166

SCHWEBER ELECTRONICS, INC.
1275 Bummel Avenue
Elk Grove Village, Ill. 60007
Tel: 312-593-2740 TWX: 910-222-3453

SEMICONDUCTOR SPECIALISTS, INC
(mailing address)
O'Hare International Airport
P.O. Box 66125
Chicago, Illinois 60666

(shipping address)
195 Spangler Avenue
Elmhurst Industrial Park
Elmhurst, Illinois 60126
Tel: 312-279-1000 TWX: 910-254-0169

INDIANA

GRAHAM ELECTRONICS SUPPLY, INC.
133 So. Pennsylvania Street
Indianapolis, Indiana 46204
Tel: 317-634-8486 TWX: 810-341-3481

PIONEER INDIANA ELECTRONICS, INC.
6408 Castleplace Drive
Indianapolis, Indiana 46250
Tel: 317-849-7300 TWX: 810-260-1794

KANSAS

HALLMARK ELECTRONICS, INC.
11870 West 91st Street
Shawnee Mission, Kansas 66214
Tel: 913-888-4746

HAMILTON/AVNET ELECTRONICS
37 Lenexa Industrial Center
9900 Pflumm Road
Lenexa, Kansas 66215
Tel: 913-888-8900
Telex: None — use HAMAVLECB DAL 73-0511
(Regional Hq. in Dallas, Texas)

LOUISIANA

STERLING ELECTRONICS CORP.
4613 Fairfield
Metairie, Louisiana 70002
Tel: 504-887-7610
Telex: STERLE LEC MRE 58-328

MARYLAND

HALLMARK ELECTRONICS, INC.
6655 Amberton Drive
Baltimore, Maryland 21227
Tel: 301-796-9300

HAMILTON/AVNET ELECTRONICS
(mailing address)
Friendship International Airport
P.O. Box 8647
Baltimore, Maryland 21240

(shipping address)
7235 Standard Drive
Hanover, Maryland 21076
Tel: 301-796-5000 TWX: 710-862-1861
Telex: HAMAVELECA HNVE 87-968

PIONEER WASHINGTON ELECTRONICS, INC.
9100 Gaither Road
Gaithersburg, Maryland 20760
Tel: 301-948-0710 TWX: 710-828-9784

SCHWEBER ELECTRONICS
5640 Fisher Lane
Rockville, Maryland 20852
Tel: 301-881-2970 TWX: 710-828-0536

MASSACHUSETTS

CRAMER ELECTRONICS
85 Wells Avenue
Newton Centre, Massachusetts 02159
Tel: 617-964-4000

GERBER ELECTRONICS
852 Providence Highway
U.S. Route 1
Dedham, Massachusetts 02026
Tel: 617-329-2400

HAMILTON/AVNET ELECTRONICS
100 E. Commerce Way
Woburn, Massachusetts 01801
Tel: 617-933-8000 TWX: 710-332-1201

HARVEY ELECTRONICS
44 Hartwell Ave.
Lexington, Massachusetts 02173
Tel: 617-861-9200 TWX: 710-326-6617

SCHWEBER ELECTRONICS
213 Third Avenue
Waltham, Massachusetts 02154
Tel: 617-890-8484

FAIRCHILD FRANCHISED DISTRIBUTORS (Cont'd)

UNITED STATES AND CANADA

MICHIGAN

HAMILTON/AVNET ELECTRONICS
12870 Farmington Rd.
Livonia, Michigan 48150
Tel: 313-522-4700 TWX: 810-242-8775

PIONEER/DETROIT

13485 Starnford
Livonia, Michigan 48150
Tel: 313-525-1800

SCHWEBER ELECTRONICS

86 Executive Drive
Troy, Michigan 48084
Tel: 313-583-9242

SHERIDAN SALES CO.

24543 Indoplex Drive
(P.O. Box 529)
Farmington, Mich. 48024
Tel: 313-477-3800

MINNESOTA

HAMILTON/AVNET ELECTRONICS
7583 Washington Ave. South
Edina, Minnesota 55435
Tel: 612-941-3801
TWX: None — use 910-227-0060
(Regional Hq. in Chicago, Ill.)

SCHWEBER ELECTRONICS

7402 Washington Ave. South
Eden Prairie, Minnesota 55343
Tel: 612-941-5280

SEMICONDUCTOR SPECIALISTS, INC.

8030 Cedar Avenue South
Minneapolis, Minnesota 55420
Tel: 612-854-8841 TWX: 910-576-2812

MISSOURI

HALLMARK ELECTRONICS, INC.
13789 Rider Trail
Earth City, Missouri 63045
Tel: 314-291-5350

HAMILTON/AVNET ELECTRONICS

364 Brookes Lane
Hazelwood, Missouri 63042
Tel: 314-731-1144 TWX: 910-762-0606

NEW JERSEY

HAMILTON/AVNET ELECTRONICS
218 Little Falls Road
Cedar Grove, New Jersey 07009
Tel: 201-239-0800 TWX: 710-994-5787

HAMILTON/AVNET ELECTRONICS

113 Gauthier Drive
East Gate Industrial Park
Mt. Laurel, N.J. 08057
Tel: 609-234-2133 TWX: 710-897-1405

SCHWEBER ELECTRONICS

43 Belmont Drive
Somerset, N.J. 08873
Tel: 201-469-6008 TWX: 710-480-4733

STERLING ELECTRONICS

774 Pfeiffer Blvd.
Perth Amboy, N.J. 08861
Tel: 201-442-8000 Telex: 138-679

WILSHIRE ELECTRONICS

855 Industrial Highway, Unit 5
Cinnaminson, New Jersey 08077
Tel: 215-627-1920

WILSHIRE ELECTRONICS

1111 Paulison Avenue
Clifton, New Jersey 07011
Tel: 201-365-2600 TWX: 710-989-7052

NEW MEXICO

CENTURY ELECTRONICS
121 Elizabeth, N.E.
Albuquerque, New Mexico 87123
Tel: 505-292-2700 TWX: 910-989-0625

HAMILTON/AVNET ELECTRONICS

2450 Baylor Dr. S.E.
Albuquerque, New Mexico 87119
Tel: 505-765-1500
TWX: None — use 910-379-6486
(Regional Hq. in Mt. View, Ca.)

NEW YORK

CRAMER ELECTRONICS
129 Oser Avenue
Hauppauge, N.Y. 11787
Tel: 516-231-5662

CRAMER ELECTRONICS

6716 Joy Road
E. Syracuse, N.Y. 13057
Tel: 315-437-6671

COMPONENTS PLUS, INC.

40 Oser Avenue
Hauppauge, L.I., New York 11787
Tel: 516-231-9200 TWX: 510-227-9869

HAMILTON/AVNET ELECTRONICS

167 Clay Road
Rochester, New York 14623
Tel: 716-442-7820
TWX: None — use 710-332-1201
(Regional Hq. in Burlington, Ma.)

HAMILTON/AVNET ELECTRONICS

6500 Joy Road
E. Syracuse, New York 13057
Tel: 315-437-2642 TWX: 710-541-0959

HAMILTON/AVNET ELECTRONICS

70 State Street
Westbury, L.I., New York 11590
Tel: 516-333-5800 TWX: 510-222-8237

ROCHESTER RADIO SUPPLY CO., INC.

140 W. Main Street
(P.O. Box 1971)
Rochester, New York 14603
Tel: 716-454-7800

SCHWEBER ELECTRONICS

Jericho Turnpike
Westbury, L.I., New York 11590
Tel: 516-334-7474 TWX: 510-222-3660

SCHWEBER ELECTRONICS, INC.

2 Town Line Circle
Rochester, New York 14623
Tel: 716-461-4000

JACO ELECTRONICS, INC.

145 Oser Ave.
Hauppauge, L.I., New York 11787
Tel: 516-273-1234 TWX: 510-227-6232

SUMMIT DISTRIBUTORS, INC.

916 Main Street
Buffalo, New York 14202
Tel: 716-884-3450 TWX: 710-522-1692

NORTH CAROLINA

CRAMER ELECTRONICS
938 Burke Street
Winston Salem, N.C. 27102
Tel: 919-725-8711

HAMILTON/AVNET

2803 Industrial Drive
Raleigh, North Carolina 27609
Tel: 919-829-8030

HALLMARK ELECTRONICS

1208 Front Street, Bldg. K
Raleigh, North Carolina 27609
Tel: 919-832-4465 TWX: 510-928-1831

KIRKMAN ELECTRONICS, INC.

901 W. Second Street
Winston Salem, North Carolina 27108
Tel: 919-722-9131

PIONEER/CAROLINA ELECTRONICS

2906 Baltic Avenue
Greensboro, North Carolina 27406
Tel: 919-273-4441

OHIO

HAMILTON/AVNET ELECTRONICS
761 Beta Drive, Suite E
Cleveland, Ohio 44143
Tel: 216-461-1400
TWX: None — use 910-227-0060
(Regional Hq. in Chicago, Ill.)

HAMILTON/AVNET ELECTRONICS

118 Westpark Road
Dayton, Ohio 45459
Tel: 513-433-0610 TWX: 810-450-2531

PIONEER/CLEVELAND

4800 East 131st Street
Cleveland, Ohio 44105
Tel: 216-587-3600

PIONEER/DAYTON

1900 Troy Street
Dayton, Ohio 45404
Tel: 513-236-9900 TWX: 810-459-1622

SCHWEBER ELECTRONICS

23880 Commerce Park Road
Beachwood, Ohio 44122
Tel: 216-464-2970 TWX: 810-427-9441

SHERIDAN SALES COMPANY

23224 Commerce Park Road
Beachwood, Ohio 44122
Tel: 216-831-0130 TWX: 810-427-2957

SHERIDAN SALES CO.

(mailing address)
P.O. Box 37826
Cincinnati, Ohio 45222

(shipping address)

10 Knollcrest Drive
Reading, Ohio 45237
Tel: 513-761-5432 TWX: 810-461-2670

OKLAHOMA

HALLMARK ELECTRONICS
4846 South 83rd East Avenue
Tulsa, Oklahoma 74145
Tel: 918-835-6458 TWX: 910-845-2290

RADIO INC. INDUSTRIAL ELECTRONICS

1000 South Main
Tulsa, Oklahoma 74119
Tel: 918-587-9123

PENNSYLVANIA

HALLMARK ELECTRONICS, INC.
458 Pike Road
Huntingdon Valley, Pennsylvania 19006
Tel: 215-355-7300 TWX: 510-667-1727

PIONEER/DELAWARE VALLEY ELECTRONICS

141 Gibraltar Road
Horsham, Pa. 19044
Tel: 609-541-1120 TWX: 510-665-6778

PIONEER ELECTRONICS, INC.

560 Alpha Drive
Pittsburgh, Pennsylvania 15238
Tel: 412-782-2300 TWX: 710-795-3122

SCHWEBER ELECTRONICS

101 Rock Road
Horsham, Pennsylvania 19044
Tel: 215-441-0600

SHERIDAN SALES COMPANY

1717 Penn. Ave.
Suite 5009
Pittsburgh, Pennsylvania 15221
Tel: 412-244-1640

SOUTH CAROLINA

DIXIE ELECTRONICS, INC.
P.O. Box 408 (Zip Code 29202)
1900 Barnwell Street
Columbia, South Carolina 29201
Tel: 803-779-5332

TEXAS

ALLIED ELECTRONICS
401 East 8th Street
Fort Worth, Texas 76102
Tel: 817-336-5401

CRAMER ELECTRONICS

13740 Midway Road, Suite 700
Dallas, Texas 75240
Tel: 214-661-9300

HALLMARK ELECTRONICS CORP.

10109 McKalla Place Suite F
Austin, Texas 78758
Tel: 512-837-2814

HALLMARK ELECTRONICS

9333 Forest Lane
Dallas, Texas 75231
Tel: 214-231-6111

HALLMARK ELECTRONICS, INC.

8000 Westglen
Houston, Texas 77063
Tel: 713-781-6100

HAMILTON/AVNET ELECTRONICS

4445 Sigma Road
Dallas, Texas 75240
Tel: 214-661-8661
Telex: HAMAVLECB DAL 73-0511

HAMILTON/AVNET ELECTRONICS

3939 Ann Arbor
Houston, Texas 77042
Tel: 713-780-1771
Telex: HAMAVLECB HOU 76-2589

FAIRCHILD FRANCHISED DISTRIBUTORS (Cont'd)

UNITED STATES AND CANADA

SCHWEBER ELECTRONICS, INC.
14177 Proton Road
Dallas, Texas 75240
Tel: 214-661-5010 TWX: 910-860-5493

SCHWEBER ELECTRONICS, INC.
7420 Harwin Drive
Houston, Texas 77036
Tel: 713-784-3600 TWX: 910-881-1109

STERLING ELECTRONICS
4201 Southwest Freeway
Houston, Texas 77027
Tel: 713-627-9800 TWX: 901-881-5042
Telex: STELECO HOUA 77-5299

UTAH
CENTURY ELECTRONICS
2258 South 2700 West
Salt Lake City, Utah 84119
Tel: 801-487-8551 TWX: 910-925-5686

HAMILTON/AVNET ELECTRONICS
1585 West 2100 South
Salt Lake City, Utah 84119
Tel: 801-972-2800
TWX: None — use 910-379-6486
(Regional Hq. in Mt. View, Ca.)

WASHINGTON
HAMILTON/AVNET ELECTRONICS
13407 Northrup Way
Bellevue, Washington 98005
Tel: 206-746-8750 TWX: 910-443-2449

LIBERTY ELECTRONICS
1750 132nd Ave. N.E.
Bellevue, Washington 98005
Tel: 206-453-8300 TWX: 910-444-1379

RADAR ELECTRIC CO., INC.
168 Western Avenue West
Seattle, Washington 98119
Tel: 206-282-2511 TWX: 910-444-2052

WISCONSIN
HAMILTON/AVNET ELECTRONICS
2975 Moorland Road
New Berlin, Wisconsin 53151
Tel: 414-784-4510

MARSH ELECTRONICS, INC.
1563 South 100 Street
Milwaukee, Wisconsin 53214
Tel: 414-475-6000

SEMICONDUCTOR SPECIALISTS, INC.
10855 W. Potter Road
Wauwatosa, Wisconsin 53226
Tel: 414-257-1330 TWX: 910-262-3022

CANADA
CAM GARD SUPPLY LTD.
640 42nd Avenue S.E.
Calgary, Alberta, T2G 1Y6, Canada
Tel: 403-287-0520 Telex: 03-822811

CAM GARD SUPPLY LTD.
10505 111th Street
Edmonton, Alberta T5H 3E8, Canada
Tel: 403-426-1805 Telex: 03-72960

CAM GARD SUPPLY LTD.
4910 52nd Street
Red Deer, Alberta, T4N 2C8, Canada
Tel: 403-346-2088

CAM GARD SUPPLY LTD.
825 Notre Dame Drive
Kamloops, British Columbia, V2C 5N8, Canada
Tel: 604-372-3338

CAM GARD SUPPLY LTD.
1777 Ellice Avenue
Winnipeg, Manitoba, R3H 0W5, Canada
Tel: 204-786-8401 Telex: 07-57622

CAM GARD SUPPLY LTD.
Rookwood Avenue
Fredericton, New Brunswick, E3B 4Y9, Canada
Tel: 506-455-8891

CAM GARD SUPPLY LTD.
15 Mount Royal Blvd.
Moncton, New Brunswick, E1C 8N6, Canada
Tel: 506-855-2200

CAM GARD SUPPLY LTD.
Courtenay Center
Saint John, New Brunswick, E2L 2X6, Canada
Tel: 506-657-4666 Telex: 01-447489

CAM GARD SUPPLY LTD.
3065 Robie Street
Halifax, Nova Scotia, B3K 4P6, Canada
Tel: 902-454-8581 Telex: 01-921528

CAM GARD SUPPLY LTD.
1303 Scarth Street
Regina, Saskatchewan, S4R 2E7, Canada
Tel: 306-525-1317 Telex: 07-12667

CAM GARD SUPPLY LTD.
1501 Ontario Avenue
Saskatoon, Saskatchewan, S7K 1S7, Canada
Tel: 306-652-6424 Telex: 07-42825

**ELECTRO SONIC INDUSTRIAL SALES
(TORONTO) LTD.**
1100 Gordon Baker Rd.
Willowdale, Ontario, M2H 3B3, Canada
Tel: 416-494-1666
Telex: ESSCO TOR 06-22030

FUTURE ELECTRONICS CORPORATION
130 Albert Street
Ottawa, Ontario, K1P 5G4, Canada
Tel: 613-232-7757

FUTURE ELECTRONICS CORPORATION
44 Fasket Drive, Unit 24
Rexdale, Ontario, M9W 1K5, Canada
Tel: 416-677-7820

FUTURE ELECTRONICS CORPORATION
5647 Ferrier Street
Montreal, Quebec, H4P 2K5, Canada
Tel: 514-735-5775

**HAMILTON/AVNET INTERNATIONAL
(CANADA) LTD.**
6291 Dorman Rd., Unit 16
Mississauga, Ontario, K1Z 1H2, Canada
Tel: 416-677-7432 TWX: 610-492-8867

**HAMILTON/AVNET INTERNATIONAL
(CANADA) LTD.**
1735 Courtwood Crescent
Ottawa, Ontario, K1Z 5L9, Canada
Tel: 613-226-1700

**HAMILTON/AVNET INTERNATIONAL
(CANADA) LTD.**
2670 Paulus Street
St. Laurent, Quebec, H4S 1G2, Canada
Tel: 514-331-6443 TWX: 610-421-3731

R.A.E. INDUSTRIAL ELECTRONICS, LTD.
1629 Main Street
Vancouver, British Columbia, V6A 2W5, Canada
Tel: 604-687-2621 TWX: 610-929-3065
Telex: RAE-VCR 04-54550

SEMAP ELECTRONICS LTD.
625 Marshall Ave., Suite 2
Dorval, Quebec, H9P 1E1, Canada
Tel: 514-636-4614 TWX: 610-422-3048

SEMAP ELECTRONICS LTD.
1111 Finch Avech Ave. W., Suite 102
Downsview, Ontario, M3J 2E5, Canada
Tel: 416-635-9880 TWX: 610-492-2510

SEMAP ELECTRONICS LTD.
1485 Laperriere Ave.
Ottawa, Ontario, K1Z 7S8, Canada
Tel: 613-722-6571 TWX: 610-562-8966

FAIRCHILD SALES REPRESENTATIVES UNITED STATES AND CANADA

ALABAMA

CARTWRIGHT & BEAN, INC.
2400 Bob Wallace Ave., Suite 201
Huntsville, Alabama 35805
Tel: 205-533-3509

CALIFORNIA

CELTEC COMPANY
18009 Sky Park Circle Suite B
Irvine, California 92715
Tel: 714-557-5021

CELTEC COMPANY
15300 Ventura Blvd., Room 200
Sherman Oaks, California 91403
Tel: 213-990-3440 TWX: 910-495-2010

CELTEC COMPANY
7867 Convoy Court, Suite 312
San Diego, California 92111
Tel: 714-279-7961 TWX: 910-335-1512

MAGNA SALES, INC.
3212 Scott Blvd.
Santa Clara, California 95050
Tel: 408-985-1750 TWX: 910-338-0241

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2552 Ridge Road
Littleton, Colorado 80120
Tel: 303-794-8381 TWX: 910-935-0719

CONNECTICUT

PHOENIX SALES COMPANY
389 Main Street
Ridgefield, Connecticut 06877
Tel: 203-438-9644 TWX: 710-467-0662

FLORIDA

LECTROMECH, INC.
303 Whooping Loop
Altamonte Springs, Florida 32701
Tel: 305-831-1577 TWX: 810-853-0262

LECTROMECH, INC.
2741 North 29th Avenue, Suite 218
Hollywood, Florida 33020
Tel: 305-920-2291 TWX: 510-954-9793

LECTROMECH, INC.
2280 U.S. Highway 19 North
Suite 119 Bldg L
Clearwater, Florida 33515

GEORGIA

CARTWRIGHT & BEAN, INC.
P.O. Box 52846 (Zip Code 30355)
90 W. Wieuca Square, Suite 155
Atlanta, Georgia 30342
Tel: 404-255-5262 TWX: 810-751-3220

ILLINOIS

MICRO SALES, INC.
2258-B Landmeir Road
Elk Grove Village, Illinois 60007
Tel: 312-956-1000 TWX: 910-222-1833

INDIANA

LESLIE M. DEVOE COMPANY
4215 East 82nd Street Suite D
Indianapolis, Indiana 46250
Tel: 317-842-3245 TWX: 810-260-1435

IOWA

B.C. ELECTRONICS SALES, INC.
4403 First Avenue S.E., Suite 412
Cedar Rapids, Iowa 52402
Tel: 313-393-5818

KANSAS

B.C. ELECTRONIC SALES, INC.
P.O. Box 788
11495 Lenexa Drive
Olathe, Kansas 66061
Tel: 913-888-6680 TWX: 910-749-6414

MARYLAND

DELTA III ASSOCIATES
5801 Annapolis Road, Suite 500
Bladensburg, Maryland 20710
Tel: 301-779-0977 TWX: 710-826-9654

MASSACHUSETTS

SPECTRUM ASSOCIATES, INC.
888 Worcester Street
Wellesley, Massachusetts 02181
Tel: 617-237-2796 TWX: 710-348-0424

MICHIGAN

RATHSBURG ASSOCIATES
16621 E. Warren Ave.
Detroit, Michigan 48224
Tel: 313-882-1717 Telex: 23-5229

MINNESOTA

PSI COMPANY
7710 Computer Avenue
Minneapolis, Minnesota 55435
Tel: 612-835-1777 TWX: 910-576-3483

MISSISSIPPI

CARTWRIGHT & BEAN, INC.
P.O. Box 16728
5250 Galaxy Drive, Suite J
Jackson, Mississippi 39207
Tel: 601-981-1368

MISSOURI

B.C. ELECTRONIC SALES, INC.
300 Brookes Drive, Suite 105
Hazelwood, Missouri 63042
Tel: 314-731-1255 TWX: 910-762-0600

NEW JERSEY

LORAC SALES, INC.
580 Valley Road
Wayne, New Jersey 07470
Tel: 201-696-8875 TWX: 710-988-5846

NEW YORK

LORAC SALES, INC.
550 Old Country Road, Room 410
Hicksville, New York 11801
Tel: 516-681-8746 TWX: 510-224-6480

TRI-TECH ELECTRONICS, INC.

3215 East Main Street
Endwell, New York 13760
Tel: 607-754-1094 TWX: 510-252-0891

TRI-TECH ELECTRONICS, INC.

290 Perinton Hills Office Park
Fairport, New York 14450
Tel: 716-223-5720

TRI-TECH ELECTRONICS, INC.

6836 East Genesee Street
Fayetteville, New York 13066
Tel: 315-446-2881 TWX: 710-541-0604

TRI-TECH ELECTRONICS, INC.

15 College View Avenue
Poughkeepsie, New York 12603
Tel: 914-473-3880

NORTH CAROLINA

CARTWRIGHT & BEAN, INC.
1165 Commercial Ave.
Charlotte, North Carolina 28205
Tel: 704-377-5673

CARTWRIGHT & BEAN, INC.

P.O. Box 18465
3949 Browning Place
Raleigh, North Carolina 27609
Tel: 919-781-6560

OHIO

THE LYONS CORPORATION
4812 Frederick Road, Suite 105
Dayton, Ohio 45414
Tel: 513-278-0714

THE LYONS CORPORATION

6151 Wilson Mills Road, Suite 101
Highland Heights, Ohio 44143
Tel: 216-461-8288

OKLAHOMA

TECHNICAL MARKETING
9717 East 42nd Street, Suite 210
Tulsa, Oklahoma 74101
Tel: 918-622-5984

OREGON

QUADRA CORPORATION
19145 S.W. Murphy Ct.
Aloha, Oregon 97005
Tel: 503-225-0350 TWX: 910-443-2318

PENNSYLVANIA

BGR ASSOCIATES
2500 Office Center
2500 Maryland Road
Willow Grove, Pennsylvania 19090
Tel: 215-657-3301

TENNESSEE

CARTWRIGHT & BEAN, INC.
P.O. Box 4760
560 S. Cooper Street
Memphis, Tennessee 38104
Tel: 901-276-4442

CARTWRIGHT & BEAN, INC.

8501 Kingston Pike
Knoxville, Tennessee 37919
Tel: 615-693-7450

TEXAS

TECHNICAL MARKETING
4445 Alpha Road, Suite 102
Dallas, Texas 75240
Tel: 214-387-3601 TWX: 910-860-5158

TECHNICAL MARKETING

6430 Hillcroft, Suite 104
Houston, Texas 77036
Tel: 713-777-9228

UTAH

SIMPSON ASSOCIATES, INC.
P.O. Box 151430
Salt Lake City, Utah 84115
Tel: 801-486-3731

WASHINGTON

QUADRA CORPORATION
14825 N.E. 40th Street
Suite 340
Redmond, Washington 98052
Tel: 206-883-3550 TWX: 910-449-2592

WISCONSIN

LARSEN ASSOCIATES
10855 West Potter Road
Wauwatosa, Wisconsin 53226
Tel: 414-258-0529 TWX: 910-262-3160

CANADA

R.N. LONGMAN SALES, INC. (L.S.I.)
1590 Matheson Blvd, Unit 26-A
Mississauga, Ontario, L4W 1J1, Canada
Tel: 416-625-6770 TWX: 610-492-4311

R.N. LONGMAN SALES, INC. (L.S.I.)
1385 Mazurette Street West, Suite 3
Montreal, Quebec, H4N 1G8, Canada
Tel: 514-382-2552 TWX: 610-421-3178

FAIRCHILD SALES OFFICES UNITED STATES AND CANADA

ALABAMA

Huntsville Office*
Executive Plaza
Suite 107
4717 University Drive, N.W.
Huntsville, Alabama 35805
Tel: 205-837-8960

ARIZONA

Phoenix Office
4414 N. 19th Avenue 85015
Suite G
Tel: 602-264-4948 TWX: 910-951-1544

CALIFORNIA

Los Angeles Office*
Crocker Bank Bldg.
15760 Ventura Blvd. Suite 1027
Encino 91436
Tel: 213-990-9800 TWX: 910-495-1776

Santa Ana Office*

2101 East Forth St. 92705
Bldg. B, Suite 185
Tel: 714-558-1881 TWX: 910-595-1109

Santa Clara Office*

3212-3214 Scott Blvd.
Santa Clara, 95050
Tel: 408-244-1400 TWX: 910-338-0241

FLORIDA

Ft. Lauderdale Office
Executive Plaza
Suite 300-B
1001 Northwest 62nd Street
Ft. Lauderdale, Florida 33309
Tel: 305-771-0320 TWX: 510-955-4098

Orlando Office*

Crane's Roost Office Park
303 Whooping Loop
Altamonte Springs 32701
Tel: 305-834-7000 TWX: 810-850-0152

GEORGIA

Atlanta Office*
1641 Wellshire Lane
Dunwoody, Ga. 30338
Tel: 404-394-5298

ILLINOIS

Chicago Office*
The Tower - Suite 610
Rolling Meadows 60008
Tel: 312-640-1000

INDIANA

Ft. Wayne Office
2118 Inwood Drive 46805
Suite 111
Tel: 219-483-6453 TWX: 810-332-1507

Indianapolis Office*

Room 205
7202 N. Shadeland 46250
Tel: 317-849-5412 TWX: 810-260-1793

KANSAS

Kansas City Office
Corporate Woods
10875 Grandview, Suite 2255
Overland Park 66210
Tel: 913-649-3974

MARYLAND

Bladensburg Office
5801 Annapolis Road 20710
Suite 500
Tel: 301-779-0954 TWX: 710-826-9654

MASSACHUSETTS

Boston Office*
888 Worcester Street
Wellesley Hills 02181
Tel: 617-237-3400 TWX: 710-348-0424

MICHIGAN

Detroit Office*
Johnston Building, Suite 24
20793 Farmington Road
Farmington Hills 48024
Tel: 313-478-7400 TWX: 810-242-2973

MINNESOTA

Minneapolis Office*
7500 Parklawn Avenue
Room 251
Edina 55435
Tel: 612-835-3322 TWX: 910-576-2944

NEW JERSEY

Wayne Office
580 Valley Road 07490
Suite 1
Tel: 201-696-7070

NEW MEXICO

Albuquerque Office
2403 San Mateo N.E. 87110
Plaza 13
Tel: 505-265-5601 TWX: 910-989-1186

NEW YORK

Melville Office*
275 Broadhollow Road 11746
Tel: 516-293-2900 TWX: 510-224-6480

Poughkeepsie Office

15 College View Ave. 12603
Tel: 914-452-4200 TWX: 510-248-0030

Rochester Office*

260 Perinton Hills Office Park
Fairport 14450
Tel: 716-223-7700

OHIO

Dayton Office
4812 Frederick Road 45414
Suite 105
Tel: 513-278-8278 TWX: 810-459-1803

OKLAHOMA

Tulsa Office
9717 E. 42nd Street 74101
Suite 210
Tel: 918-663-7131

PENNSYLVANIA

Philadelphia Office*
2500 Office Center
2500 Maryland Road
Willow Grove, Pa. 19090
Tel: 215-657-2711

TEXAS

Dallas Office*
13771 N. Central Expressway 75231
Suite 809
Tel: 214-234-3391 TWX: 910-867-4757

Houston Office*

6430 Hillcroft 77081
Suite 102
Tel: 713-771-3547 TWX: 910-881-6278

CANADA

Toronto Regional Office
Fairchild Semiconductor
1590 Matheson Blvd. Unit 26
Mississauga, Ontario L4W 1J1, Canada
Tel: 416-625-7070 TWX: 610-492-4311

INTERNATIONAL FAIRCHILD SALES OFFICES

AUSTRALIA

Fairchild Australia Pty Ltd.
72 Whiting Street
Artarmon 2064
New South Wales
Australia
Tel: Sydney (02)-438-2733

(mailing address)
P.O. Box 450
North Sydney 2060
New South Wales
Australia

AUSTRIA AND EASTERN EUROPE

Fairchild Electronics
A-1010 Wien
Schwedenplatz 2
Tel: 0222 635821 Telex: 75096

BRAZIL

Fairchild Semicondutores Ltda
Caixa Postal 30407
Rua Alagoas, 663
01242 Sao Paulo, Brazil
Tel: 66-9092 Telex: 011-23831
Cable: FAIRLEC

FRANCE

Fairchild Camera & Instrument S.A.
121, Avenue d'Italie
75003-Paris, France
Tel: 00331-548 55 66
Telex: 0042 200614 or 260937

GERMANY

Fairchild Camera and Instrument (Deutschland)
8046 Garching Hochbruck
Daimlerstr 15
Munich, Germany
Tel: (089) 320031 Telex: 52 4831 fair d

Fairchild Camera and Instrument (Deutschland)
3000 Hannover
Koenigsworther Strasse 23
Hanover, Germany
Tel: 0511 17844 Telex: 09 22922

Fairchild Camera and Instrument (Deutschland)
7251 Leonberg
Poststrabe 37
Tel: 07152 41026 Telex: 07 245711

Fairchild Camera and Instrument (Deutschland)
85 Nuernberg
Waldluststrasse 1
Tel: 0911 407005 Telex: 06 23665

HONG KONG

Fairchild Semiconductor (HK) Ltd.
135 Hoi Bun Road
Kwun Tong
Kowloon, Hong Kong
Tel: K-890271 Telex: HKG-531

ITALY

Fairchild Semiconduttori, S.P.A.
Via Flamenia Vecchia 653
00191 Roma, Italy
Tel: 06 327 4006 Telex: 63046 (FAIR ROM)

Fairchild Semiconduttori S.P.A.
Via Rosellini, 12
20124 Milano, Italy
Tel: 02 6887451 Telex: 36522

JAPAN

TDK-Fairchild
Pola Bldg. 7th Floor
1-15-21 Shibuya
Tokyo 150, Japan
Tel: 03 400 8351 Telex: 242173

KOREA

Fairchild Semikor Ltd.
551-1 Shin Dae Bank-Dong
Kwan Ak-Ku
Seoul 151, Korea
Tel: 697741 & 691410 Telex: FAIRKOR 22705

(mailing address)
Central P.O. Box 2806

MEXICO

Fairchild Mexicana S.A.
Blvd. Adolfo Lopez Mateos No. 163
Mexico 19, D.F.
Tel: 905-563-5411 Telex: 017-71-038

SCANDINAVIA

Fairchild Semiconductor AB
Svartengsgatan 6
S-11620 Stockholm
Sweden
Tel: 8-449255 Telex: 17759

SINGAPORE

Fairchild Semiconductor Pty Ltd.
No. 11, Lorong 3
Toa Payoh
Singapore 12
Tel: 531-066 Telex: FAIRSIN-RS 21376

TAIWAN

Fairchild Semiconductor (Taiwan) Ltd.
Hsietsu Building, Room 502
47 Chung Shan North Road
Sec. 3 Taipei, Taiwan
Tel: 573205 thru 573207

BENELUX

Fairchild Semiconductor
Pardislaan 39
Eindhoven, Holland
Tel: 00-31-40-446909 Telex: 00-1451024

UNITED KINGDOM

Fairchild Camera and Instrument (UK) Ltd.
Semiconductor Division
230 High Street
Potters Bar
Hertfordshire EN6 5BU
England
Tel: 0707 51111 Telex: 0051 262835

Fairchild Semiconductor Ltd.
Shiel House
Craigshall
Livingston
West Lothian, Scotland
Tel: Livingston 0589 32891 Telex: 72629

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